

Power Panel 300/400

User's Manual

Version: **1.40 (Feb. 2008)**

Model number: **MAPP300.400-ENG**

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Chapter 1 • General

Information:

B&R does its best to keep the printed versions of its user's manuals as current as possible. However, any newer versions of the User's Manual can always be downloaded in electronic form (pdf) from the B&R homepage www.br-automation.com.

1. Manual history

Version	Date	Change
0.10 Preliminary	Oct. 31, 2006	- First version
1.00	Nov. 21, 2006	Changes / new features - Contents of delivery for individual components expanded. - "Standards and certifications" on page 319 added. - "Touch screen" on page 367 added. - "Mylar" on page 369 added. - "Glossary" on page 379 added. - 2 GB USB flash drive 5MMUSB.2048-00 from SanDisk added. - Document now includes the chm tag "Filename". - Model numbers for Windows CE, Windows XPe and the HMI Drivers & Utilities DVD added. - Rear view of devices 5PP320.0571-29, 5PP320.0573-39, 5PP320.1043-39 and 5PP320.1214-39 added. - Text changes: General device interfaces on device interfaces. - "Distribution of resources" on page 304 added. - "VESA mode support" on page 314 added. - "Power Panel 400 with Automation Runtime" on page 307 added. - aPCI slot cover added. - "Legend strip templates" on page 342 added. - HMI Drivers & Utilities DVD 5SWHMI.0000-00 added. - "Mounting orientation" on page 245 added. - "Null modem cable 9A0017.0x" on page 360 added. - "Mounting compatibilities" on page 371 added.

Table 1: Manual history

Version	Date	Change
1.10	Feb. 22, 2007	Changes / new features - Rear view of device 5PP320.1505-39 added. - Driver support information modified. - Section "Automation Runtime and SMC" removed. - Images of battery exchange changed. - CompactFlash 8192 MB SSI is enabled. - Image of Ethernet connection changed. - Label description and images changed (there is no longer a safety sticker). - aPCI slot cover section removed. - HMI Drivers and Utilities DVD section removed. - Technical data (L1 cache, L2 cache, Touch Controller, SRAM on BIOS devices) revised. - Figure text added for Figure 149. - Windows CE description updated. - Serial number sticker changed. - "Distribution of resources" on page 304 updated. - "Automation Runtime summary screen - Ex. 4PP420.1043-75" on page 307 changed. - Rear views added. - Chapter "Power Panel 300 with BIOS" on page 247 updated.
1.20	April 20, 2007	Changes / new features - USB flash drive 5MMUSB.0256-00 and USB flash drive 5MMUSB.1024-00 cancelled - "Automation Runtime summary screen - Ex. 4PP420.1043-75" on page 307 updated. - Rear views for devices 4PP420.0571-A5, 4PP451.0571-65 and 4PP481.1043-B5 added. - Section "USB flash drive" on page 356 updated. - Chapter "Power Panel 300 with BIOS" on page 247 updated.
1.30	May 04, 2007	Changes / new features - Chapter 4 "Software" on page 247 updated.
1.40	Oct. 11, 2007	Changes / new features - New PP300/400 devices added (4PP320.0571-01, 4PP320.0571-35, 4PP320.1043-31, 4PP320.1505-31, 5PP320.0571-39, 4PP420.0571-75, 4PP420.0571-B5, 4PP451.0571-75, 4PP452.0571-75). - Battery information expanded ("Changing the battery" on page 364). - New model numbers for Windows CE and Windows XP added. - Windows CE and Windows XP information updated. - Additional temperature humidity diagram information - Section 3 "Preventing after-image effect in LCD/TFT monitors" on page 366 added - Section "Touch screen calibration:" on page 246 added - Section 2.6.2 "Environmental conditions - dust, humidity, aggressive gases" on page 21 added - Section "Replacement CMOS batteries" on page 339 updated. - Real-time clock specifications updated in technical data of individual components (footnote, cross-reference to overview of time references, text). - Extensive changes

Table 1: Manual history (cont.)

2. Safety guidelines

2.1 Intended use

Programmable logic controllers (PLCs), operating and monitoring devices (industrial PCs, Power Panels, Mobile Panels, etc.), and B&R uninterruptible power supplies have been designed, developed, and manufactured for conventional use in industry. They were not designed, developed, and manufactured for any use involving serious risks or hazards that could lead to death, injury, serious physical damage, or loss of any kind without the implementation of exceptionally stringent safety precautions. In particular, such risks and hazards include the use of these devices to monitor nuclear reactions in nuclear power plants, as well as flight control systems, flight safety, the control of mass transit systems, medical life support systems and the control of weapons systems.

2.2 Protection against electrostatic discharges

Electrical components that are vulnerable to electrostatic discharge (ESD) must be handled accordingly.

2.2.1 Packaging

- Electrical components with housing
... do not require special ESD packaging, but must be handled properly (see "Electrical components with housing").
- Electrical components without housing
... must be protected by ESD-suitable packaging.

2.2.2 Guidelines for proper ESD handling

Electrical components with housing

- Do not touch the contacts of connectors on connected cables.
- Do not touch the contact tips on the circuit boards.

Electrical components without housing

In addition to "Electrical components with housing", the following also applies:

- Any persons handling electrical components or devices that will be installed in the electrical components must be grounded.
- Components can only be touched on the small sides or on the front plate.
- Components should always be stored in a suitable medium (ESD packaging, conductive foam, etc.).
Metallic surfaces are not suitable storage surfaces!

General • Safety guidelines

- Electrostatic discharges should be avoided on the components (e.g. through charged plastics).
- A minimum distance of 10 cm must be kept from monitors and TV sets.
- Measurement devices and equipment must be grounded.
- Measurement probes on potential-free measurement devices must be discharged on sufficiently grounded surfaces before taking measurements.

Individual components

- ESD protective measures for individual components are thoroughly integrated at B&R (conductive floors, footwear, arm bands, etc.).

The increased ESD protective measures for individual components are not necessary for our customers for handling B&R products.

2.3 Policy and procedures

Electronic devices are generally not failsafe. In the event of a failure on the programmable control system, operating or monitoring device, or uninterruptible power supply, the user is responsible for ensuring that other devices that may be connected, e.g. motors, are in a secure state.

Both when using programmable logic controllers and when using operating and monitoring devices as control systems in conjunction with a soft PLC (e.g. B&R Automation Runtime or comparable products) or a slot PLC (e.g. B&R LS251 or comparable products), the safety precautions applying to industrial control systems (e.g. the provision of safety devices such as emergency stop circuits, etc.) must be observed in accordance with applicable national and international regulations. The same applies for all other devices connected to the system, such as drives.

All tasks such as installation, commissioning, and maintenance are only permitted to be carried out by qualified personnel. Qualified personnel are persons who are familiar with the transport, mounting, installation, commissioning, and operation of the product and who have the appropriate qualifications (e.g. IEC 60364). National accident prevention guidelines must be followed.

The safety guidelines, connection descriptions (rating plate and documentation) and limit values listed in the technical data must be read carefully and must be observed before installation and commissioning.

2.4 Transport and storage

During transport and storage, devices must be protected from excessive stress (mechanical load, temperature, humidity, aggressive atmosphere, etc.).

2.5 Installation

- Installation must take place according to the documentation, using suitable equipment and tools.
- Devices must be installed without voltage applied and by qualified personnel.
- General safety regulations and nationally applicable accident prevention guidelines must be observed.
- Electrical installation must be carried out according to the relevant guidelines (e.g. line cross section, fuse, protective ground connection).

2.6 Operation

2.6.1 Protection against touching electrical parts

To operate programmable logic controllers, operating and monitoring devices, and uninterruptible power supplies, certain components must carry dangerous voltage levels of over 42 VDC. A life-threatening electrical shock could occur if you come into contact with these parts. This could result in death, severe injury or material damage.

Before turning on the programmable logic controller, the operating and monitoring devices and the uninterruptible power supply, ensure that the housing is properly grounded (PE rail). The ground connection must be established when testing the operating and monitoring devices or the uninterruptible power supply, even when operating them for only a short time.

Before turning the device on, make sure that all voltage-carrying parts are securely covered. During operation, all covers must remain closed.

2.6.2 Environmental conditions - dust, humidity, aggressive gases

Use of operating and monitoring devices (e.g. industrial PCs, power panels, mobile panels, etc.) and uninterruptible power supplies in very dusty environments should be avoided. Dust collection on the devices influences their function and, especially in systems with active cooling (fans), sufficient cooling cannot be guaranteed.

The presence of aggressive gases in the environment can also lead to malfunctions. When combined with high temperature and humidity, aggressive gases - e.g. with sulfuric, nitric and chloric components- spur chemical processes that can damage electronic components very quickly. Signs of the presence of aggressive gases are blackened copper surfaces and cables on existing installations.

For operation in dusty or humid conditions, correctly installed (cutout installation) operating and monitoring devices like Automation Panel or Power Panel are protected on the front side. The rear side of all devices must be protected from dust and humidity and must be cleaned at suitable intervals.

2.6.3 Programs, viruses and dangerous programs

The system is subject to potential danger each time data is exchanged or software is installed from a data medium (e.g. diskette, CD-ROM, USB flash drive, etc.), a network connection, or the Internet. The user is responsible for assessing these dangers, implementing preventative measures such as virus protection programs, firewalls, etc. and obtaining software from reliable sources.

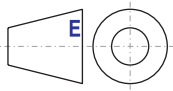
3. Organization of safety notices

The safety notices in this manual are organized as follows:

Safety notice	Description
Danger!	Disregarding the safety regulations and guidelines can be life-threatening.
Caution!	Disregarding the safety regulations and guidelines can result in severe injury or major damage to material.
Warning!	Disregarding the safety regulations and guidelines can result in injury or damage to material.
Information:	Important information for preventing errors.

Table 2: Organization of safety notices

4. Guidelines



European dimension standards apply to all dimensions (e.g. dimension diagrams, etc.).

5. Model numbers

5.1 Power Panel 300 with BIOS

Model number	Short description	Note
5PP320.0571-29	Power Panel PP320 BIOS 5.7" QVGA, touch screen 5.7" QVGA color LC display with touch screen (resistive), 256 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 42
5PP320.0571-39	Power Panel PP320 BIOS 5.7" QVGA, touch screen 5.7" QVGA color TFT display with touch screen (resistive), 256 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 48
5PP320.0573-39	Power Panel PP320 BIOS 5.7" VGA, touch screen 5.7" VGA color TFT display with touch screen (resistive), 256 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 54
5PP320.1043-39	Power Panel PP320 BIOS 10.4" VGA, touch screen 10.4" VGA color TFT display with touch screen (resistive), 256 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 60
5PP320.1214-39	Power Panel PP320 BIOS 12.1" SVGA, touch screen 12.1" SVGA color TFT display with touch screen (resistive), 256 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 66
5PP320.1505-39	Power Panel PP320 BIOS 15" XGA, touch screen 15" XGA color TFT display with touch screen (resistive), 256 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 72

Table 3: Model number overview - Power Panel 300 devices

5.2 Power Panel 300 with Automation Runtime

Model number	Short description	Note
4PP320.0571-01	Power Panel PP320 BIOS 5.7" QVGA, touch screen 5.7" QVGA b/w LC display with touch screen (resistive); 128 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 88
4PP320.0571-35	Power Panel PP320 BIOS 5.7" QVGA, touch screen 5.7" QVGA color TFT display with touch screen (resistive); 128 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 94
4PP320.1043-31	Power Panel PP320 BIOS 10.4" VGA, touch screen 10.4" VGA color TFT display with touch screen (resistive); 128 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 100
4PP320.1505-31	Power Panel PP320 BIOS 15" XGA, touch screen 15" XGA color TFT display with touch screen (resistive); 128 MB SDRAM; CompactFlash slot (type I), ETH 10/100, RS 232, 2xUSB; metal housing, IP65 protection (front side); 24VDC (Order screw clamp OTB103.9 or cage clamp OTB103.91 separately.)	See page 106

Table 4: Model number overview - Power Panel 300 devices

5.3 Power Panel 400 with Automation Runtime

Model number	Short description	Note
4PP420.0571-45	Power Panel PP420 5.7" QVGA, 1 aPCI, touch screen 5.7" QVGA b/w LC display with touch screen (resistive); 1 aPCI slot; 128 MB SDRAM; 512KB SRAM; CompactFlash slot (Type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order 0TB103.9 screw clamp or 0TB103.91 cage clamp separately).	See page 122
4PP420.0571-65	Power Panel PP420 5.7" QVGA, 1 aPCI, touch screen 5.7" QVGA color LC display with touch screen (resistive); 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM, CompactFlash slot (type I), ETH 10/100, RS232, 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 128
4PP420.0571-75	Power Panel PP420 5.7" QVGA, 1 aPCI, touch screen 5.7" QVGA color LC display with touch screen (resistive); 1 aPCI slots; 128 MB SDRAM; 512 KB SRAM, CompactFlash slot (type I), ETH 10/100, RS232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 134
4PP420.0571-A5	Power Panel PP420 5.7" QVGA, 2 aPCI, touch screen 5.7" QVGA color LC display with touch screen (resistive); 2 aPCI slots; 128 MB SDRAM; 512 KB SRAM, CompactFlash slot (type I), ETH 10/100, RS232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 140
4PP420.0571-B5	Power Panel PP420 5.7" QVGA, 2 aPCI, touch screen 5.7" QVGA color LC display with touch screen (resistive); 2 aPCI slots; 128 MB SDRAM; 512 KB SRAM, CompactFlash slot (type I), ETH 10/100, RS232, 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 146
4PP420.0573-75	Power Panel PP420 5.7" VGA, 1 aPCI, touch screen 5.7" VGA color TFT display with touch screen (resistive); 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM, CompactFlash slot (type I), ETH 10/100, RS232, 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 152
4PP420.1043-75	Power Panel PP420 10.4" VGA, 1 aPCI, touch screen 10.4" VGA color TFT display with touch screen (resistive); 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM, CompactFlash slot (type I), ETH 10/100, RS232, 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 158
4PP420.1043-B5	Power Panel PP420 10.4" VGA, 2 aPCI, touch screen 10.4" VGA color TFT display with touch screen (resistive); 2 aPCI slots; 128 MB SDRAM; 512 KB SRAM, CompactFlash slot (type I), ETH 10/100, RS232, 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 164
4PP420.1505-75	Power Panel PP420 15" XGA, 1 aPCI, touch screen 15" XGA color TFT display with touch screen (resistive); 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (Type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order 0TB103.9 screw clamp or 0TB103.91 cage clamp separately).	See page 170
4PP420.1505-B5	Power Panel PP420 15" XGA, 2 aPCI, touch screen 15" XGA color TFT display with touch screen (resistive); 2 aPCI slots; 128 MB SDRAM; 512 KB SRAM, CompactFlash slot (type I), ETH 10/100, RS232, 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 176

Table 5: Model number overview - Power Panel 400 devices

General • Model numbers

Model number	Short description	Note
4PP451.0571-65	Power Panel PP451 5.7" QVGA, 1 aPCI, keys 5.7" QVGA color LC display; 6 softkeys; 16 function and 20 system keys; 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 182
4PP451.0571-75	Power Panel PP451 5.7" QVGA, 1 aPCI, keys 5.7" QVGA color TFT display; 6 softkeys; 16 function and 20 system keys; 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 188
4PP452.0571-65	Power Panel PP452 5.7" QVGA, 1 aPCI, keys 5.7" QVGA color LC display; 20 function and 20 system keys; 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 194
4PP452.0571-75	Power Panel PP452 5.7" QVGA, 1 aPCI, keys 5.7" QVGA color TFT display; 20 function and 20 system keys; 1 aPCI slot; 64 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 200
4PP480.1043-75	Power Panel PP480 10.4" VGA, 1 aPCI, touch screen, keys 10.4" VGA color TFT display with touch screen (resistive); 10 softkeys and 12 function keys; 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (Type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order 0TB103.9 screw clamps or 0TB103.91 cage clamps separately).	See page 206
4PP480.1505-75	Power Panel PP480 15" XGA, 1 aPCI, touch screen, keys 15" XGA color TFT display with touch screen (resistive); 12 softkeys and 20 function keys; 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 212
4PP481.1043-75	Power Panel PP481 10.4" VGA, 1 aPCI, touch screen, keys 10.4" VGA TFT color display with touch screen (resistive); 10 softkeys, 28 function keys and 20 system keys; 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order 0TB103.9 screw clamp or 0TB103.91 cage clamps separately).	See page 218
4PP481.1043-B5	Power Panel PP481 10.4" VGA, 2 aPCI, touch screen, keys 10.4" VGA TFT color display with touch screen (resistive); 10 softkeys, 28 function keys and 20 system keys; 2 aPCI slots; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 224
4PP481.1505-75	Power Panel PP481 15" XGA, 1 aPCI, touch screen, keys 15" XGA color TFT display with touch screen (resistive); 12 softkeys, 20 function keys and 92 system keys; 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 230
4PP482.1043-75	Power Panel PP482 10.4" VGA, 1 aPCI, touch screen, keys 10.4" VGA color TFT display with touch screen (resistive); 44 function keys and 20 system keys; 1 aPCI slot; 128 MB SDRAM; 512 KB SRAM; CompactFlash slot (type I); ETH 10/100; RS232; 2xUSB; battery; metal housing, IP65 protection (front side); 24 VDC (Order screw clamp 0TB103.9 or cage clamp 0TB103.91 separately.)	See page 236

Table 5: Model number overview - Power Panel 400 devices (cont.)

5.4 Software

Model number	Short description	Note
5SWWCE.0521-ENG	WinCE5.0 Pro PP300 LX800 Microsoft Windows CE 5.0 Professional, English; for PP300 BIOS devices 5PP320.0571-29, 5PP320.0571-39, 5PP320.0573-39, 5PP320.1043-39, 5PP320.1214-39, 5PP320.1505-39, order CompactFlash separately (at least 128 MB).	See page 310
5SWWCE.0621-ENG	WinCE5.0 ProPlus PP300 LX800 Microsoft Windows CE 5.0 Professional Plus, English; for PP300 BIOS devices 5PP320.0571-29, 5PP320.0571-39, 5PP320.0573-39, 5PP320.1043-39, 5PP320.1214-39, 5PP320.1505-39, order CompactFlash separately (at least 128 MB).	See page 310
5SWWXP.0421-ENG	WinXPe FP2007 PP300 LX800 Microsoft Windows XP embedded, English, Feature Pack 2007; for PP300 BIOS devices 5PP320.0571-29, 5PP320.0571-39, 5PP320.0573-39, 5PP320.1043-39, 5PP320.1214-39, 5PP320.1505-39, order CompactFlash separately (at least 512 MB). Only delivered with a new Power Panel.	See page 312

Table 6: Model number overview - Software

5.5 Accessories

Model number	Short description	Note
0AC201.9	Lithium batteries, 5 pcs. Lithium batteries, 5 pcs., 3 V / 950 mAh, button cell	See page 339
4A0006.00-000	Lithium battery (1x) Lithium battery, 1 pc., 3 V / 950 mAh, button cell	See page 339
0TB103.9	Plug 24V 5.08 3-pin screw clamps 24 VDC 3-pin connector, female. Screw clamps, 3.31 mm ² , protected against vibration by the screw flange	See page 340
0TB103.91	Plug 24V 5.08 3-pin cage clamps 24 VDC 3-pin connector, female. Cage clamps, 3.31 mm ² , protected against vibration by the screw flange	See page 340
5AC900.057X-00	Legend strips 3x 5.7" vertical1 Legend strip template for Power Panel 4PP451.0571-65. For 3 devices.	See page 342
5AC900.057X-01	Legend strips 2x 5.7" horizontal2 Legend strip template for Power Panel 4PP452.0571-65. For 2 devices.	See page 342
5AC900.104X-00	Legend strip 1x 10.4" Vertical1 Legend strip template for Power Panel 4PP451.1043-75 and 4PP481.1043-B5. For 1 device.	See page 342
5AC900.104X-01	Legend strip 1x 10.4" Horizontal2 Legend strip template for Power Panel 4PP482.1043-75. For 1 device.	See page 342
5AC900.104X-02	Legend strips 3x 10.4" Horizontal1 Legend strip template for Power Panel 4PP480.1043-75. For 3 devices.	See page 342
5AC900.150X-00	Legend strips 4x 15" Legend strip template for Power Panel 4PP481.1505-75 and 4PP480.1505-75. For 4 devices.	See page 342
5CFCRD.0064-03	CompactFlash 64 MB SSI CompactFlash card with 64 MB SLC NAND flash and IDE/ATA interface	See page 344
5CFCRD.0128-03	CompactFlash 128 MB SSI CompactFlash card with 128 MB SLC NAND flash and IDE/ATA interface	See page 344

Table 7: Model number overview - Accessories

General • Model numbers

Model number	Short description	Note
5CFCRD.0256-03	CompactFlash 256 MB SSI CompactFlash card with 256 MB SLC NAND flash and IDE/ATA interface	See page 344
5CFCRD.0512-03	CompactFlash 512 MB SSI CompactFlash card with 512 MB SLC NAND flash and IDE/ATA interface	See page 344
5CFCRD.1024-03	CompactFlash 1024 MB SSI CompactFlash card with 1024 MB SLC NAND flash and IDE/ATA interface	See page 344
5CFCRD.2048-03	CompactFlash 2048 MB SSI CompactFlash card with 2048 MB SLC NAND flash and IDE/ATA interface	See page 344
5CFCRD.4096-03	CompactFlash 4096 MB SSI CompactFlash card with 4096 MB SLC NAND flash and IDE/ATA interface	See page 344
5CFCRD.8192-03	CompactFlash 8192 MB SSI CompactFlash card with 8192 MB SLC NAND flash and IDE/ATA interface	See page 344
5MMUSB.2048-00	USB flash drive 2 GB SanDisk USB 2.0 flash drive 2 GB	See page 356
9A0017.01	RS232 DB9 null modem cable 0.6 m Null modem cable RS232 0.6 m to connect UPS and IPC (9-pin DSUB socket - 9-pin DSUB socket)	See page 360
9A0017.02	RS232 DB9 null modem cable 1.8 m Null modem cable RS232 1.8 m to connect UPS and IPC (9-pin DSUB socket - 9-pin DSUB socket)	See page 360

Table 7: Model number overview - Accessories (cont.)

Chapter 2 • Technical data

1. General

The new Power Panel 300/400 generation expands upon B&R's proven Power Panel 100/200 line. With more than twice the computing power, the new generation covers a performance range that until recently could only be handled by industrial PCs.

For the Power Panel 300 and the Power Panel 400, B&R also implements the proven product lines of BIOS devices (Power Panel 300) and embedded devices (Power Panel 300 and Power Panel 400). Power Panel 300 devices can be delivered with the Windows XP embedded and Windows CE operating systems. They cover the entire range of PC systems, from simple thin clients and web terminals to full SCADA systems. Power Panel 300 and Power Panel 400 products are designed to automate complete systems. Integrated control functionality and drive technology act together with modular interfaces for connecting peripheral devices in the process. Models ranging from 5.7" QVGA to 15" XGA meet all requirements for series machine manufacturing. There is a new combination of 5.7" diagonal and VGA TFT display. It allows a great deal of information to be displayed in a small amount of space and images can be shown in detail. Entries are made either via touch screen or function keys.



Figure 1: Power Panel 300 and Power Panel 400 devices

1.1 Features

- 24 VDC supply voltage
- 2 USB 2.0 connections
- Ethernet 10/100 MBit interface
- CompactFlash card (type I) slot
- RS232 interface, modem-capable, not electrically isolated
- 2 operating mode switches (2 x 16 digit)
- 2 status LEDs (User or CompactFlash card access)
- ATX power supply compatibility
- Power button
- Fan-free operation
- Touch screen (analog resistive), function keys or both¹⁾
- Horizontal and vertical mounting orientations, numeric and alphanumeric keys¹⁾
- Maximum 2 aPCI slots (see B&R System 2005 User's Manual for available aPCI interface modules)¹⁾
- BIOS or Automation Runtime operating system¹⁾
- Real-time clock (battery-buffered)¹⁾
- Up to 256 MB SDRAM main memory¹⁾

¹⁾ Depending on the design of the particular Power Panel device.

1.2 Advantages of Power Panel 300/400 over Power Panel 100/200

1.2.1 Electrical

- More powerful processor (Geode LX800 = more than twice the performance)
- 180° rotated power supply plug
- Insyde BIOS
- Power button
- ATX compatible power supply
- USB 2.0 support
- Different network controller
- MTCX controller
- Lower power consumption

1.2.2 Mechanical

- Mechanically mounting compatible (see "Mounting compatibilities" on page 371) - but connections are not compatible (locations of interfaces, plugs, and keys have changed).

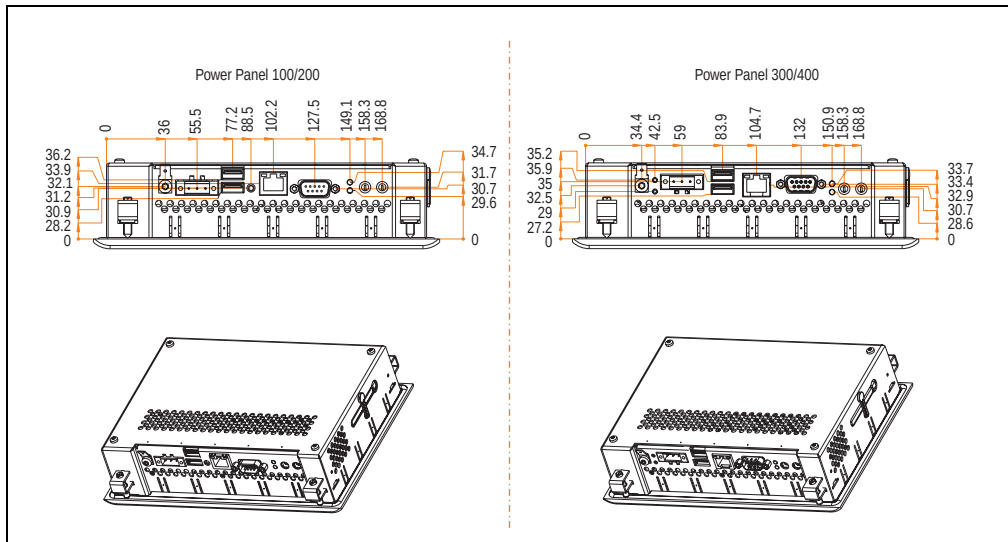


Figure 2: Different plug and key positions (PP100/200 - PP300/400)

2. Power Panel 300 with BIOS

2.1 Device interfaces

The following section provides a description of all interfaces and plugs possible with a Power Panel 300 device with BIOS.

2.1.1 Supply voltage

Input voltage: 18 - 30 VDC

The 3-pin socket required for the supply voltage connection is not included in delivery. This can be ordered from B&R using the model number OTB103.9 (screw clamps) or OTB103.91 (cage clamps).

The pin assignments can be found either in the following table or printed onto the Power Panel plate. The supply voltage is internally protected so that the device cannot be damaged if there is an overload (fuse replacement necessary) or if the voltage supply is connected incorrectly (reverse polarity protection - fuse replacement not necessary).

Supply voltage	
Protected against reverse polarity	
Pin	Description
1	-
2	Functional grounding
3	+
Accessories	
OTB103.9	Plug 24 V 5.08 3p screw clamps
OTB103.91	Plug 24 V 5.08 3p cage clamps



Figure 3: Supply voltage connection

Ground

Important!

The pin's connection to the functional ground (pin 2, e.g. switching cabinet) should be as short as possible. We recommend using the largest possible conductor cross section on the supply plug.

2.1.2 Functional grounding clip

Next to the supply voltage plug there is a functional grounding clip. The grounding clip (functional ground) must be connected with a central grounding point on the switching cabinet using a 6.3 mm blade connector via the shortest distance and with as little resistance as possible (e.g. copper strip, but must be at least 2.5 mm²).

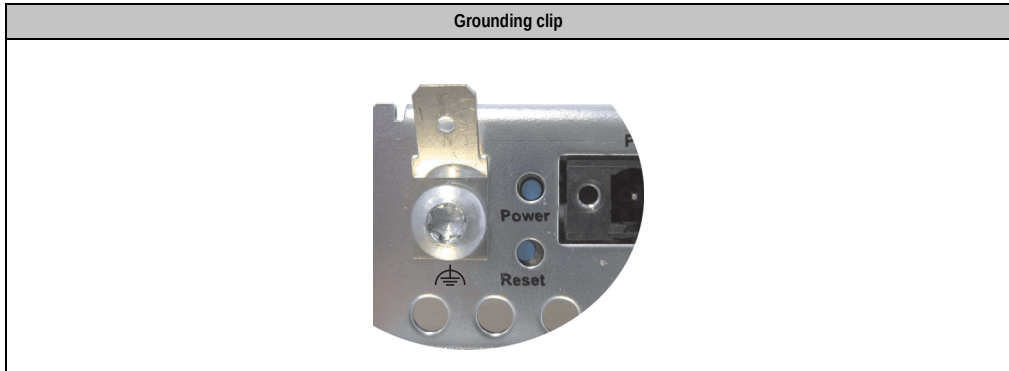


Figure 4: Functional grounding clip

2.1.3 Serial interface COM

The Power Panel is equipped with a PC-compatible serial interface with a 16-byte FIFO buffer. This non-electrically isolated interface is primarily intended for programming Power Panel devices using Automation Studio.

The RS232 can also be used as a general interface (e.g. third-party connections, barcode reader, etc.).

Serial interface (COM)	
Type	RS232, modem-capable, not electrically isolated
UART	16C550 compatible, 16-byte FIFO
Transfer rate	Up to 115 kBaud
Pin	Assignment
1	DCD
2	RxD
3	TxD
4	DTR
5	GND
6	DSR
7	RTS
8	CTS
9	RI

9-pin DSUB connector



Table 8: Pin assignments - COM

2.1.4 USB port

The Power Panel 300/400 devices have a USB 2.0 (Universal Serial Bus) host controller with multiple USB ports, two of which are on the outside for easy user access.

Universal serial bus		
Transfer rate ¹⁾	Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s)	2x USB Type A, female 
Power supply	Max. 500 mA per port ²⁾	
Maximum cable length	5 m (not including hub)	

Table 9: USB port

1) The actual value depends on the operating system or diver being used.

2) For safety, every USB port is equipped with a maintenance free "USB current-limiting circuit breaker" (max. 500 mA)

Warning!

Peripheral USB devices can be connected to the USB interfaces. Due to the vast number of USB devices available on the market, B&R cannot guarantee their performance. B&R does assure the performance of all USB devices that they provide.

Important!

Because of general PC specifications, this interface should be handled with extreme care with regard to EMC, location of cables, etc.

2.1.5 Mode/Node switches

Power Panel devices are equipped with 2 hex switches that serve as operating mode switches. Switch positions 01 to FD are available for any purpose in an application and can be evaluated by the application program.

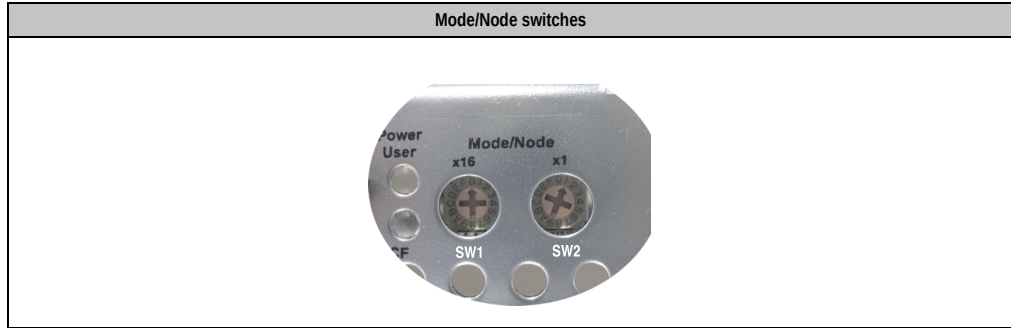


Table 10: Mode/Node switches

Switch position		Function	Description
SW1 (x16)	SW2 (x1)		
0	0	Service mode	Necessary for restoring the default BIOS settings - for more information, see section "Restoring the default BIOS values" on page 295.
x	x	None	No other switch positions have significance.

Table 11: Switch settings for the Mode/Node switch

2.1.6 Status LEDs

Power Panels are equipped with two status LEDs that are visible on the outside.

Status LEDs			
LED	Color	On	Meaning
Power	Green	On	Supply voltage OK
	Red	On	The system is in standby mode (S5: soft-off mode or S4: hibernate mode - suspend-to-disk)
User	Yellow	On	Freely available for use in an application (e.g. can be switched on/off directly via the ADI Library - only possible in the S0 state).
	Green	Off	
CF	Yellow	On	Indicates access to CompactFlash drive (read or write)



Figure 5: Status LEDs

2.1.7 Ethernet connection

Ethernet connection		
Controller	Intel 82551ER	
Cabling	S/STP (category 5)	
Transfer rate	10/100 MBit/s ¹⁾	
LED	On	Off
Green	100 MBit/s	10 MBit/s
Orange	Link (Ethernet network connection available)	Activity (blinking) (Data transfer in progress)

RJ45 twisted pair (10BaseT/100BaseT), female

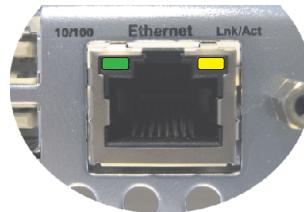


Table 12: Ethernet connection

1) Both operating modes possible. Change-over takes place automatically.

2.1.8 Power button

Due to the complete ATX power supply support, the power button serves a number of functions, which can be configured in BIOS setup.

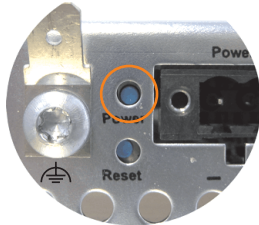
Power button	
The power button can be pressed with a pointed object (i.e. paper clip or tip of a pen). The power button acts like the on/off switch on a normal desktop PC with ATX power supply: press and release ... turn on or shut down operating system. press and hold ... ATX power supply switches off without shutting down the Power Panel (data could be lost!). Pressing the power button does not reset the MTCX processor.	

Table 13: Power button

2.1.9 Reset button

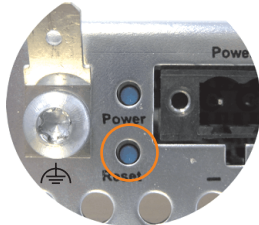
Reset button	
The reset button can be pressed with a pointed object (i.e. paper clip or tip of a pen). Pushing the reset button results in a hardware-reset. The Power Panel restarts. The MTCX processor is not reset when the reset button is pressed.	

Table 14: Reset button

Warning!

A system reset can cause data to be lost!

2.1.10 CompactFlash slot

Power Panel devices are equipped with a CompactFlash slot that is accessible from the side. Type I CompactFlash cards are supported.

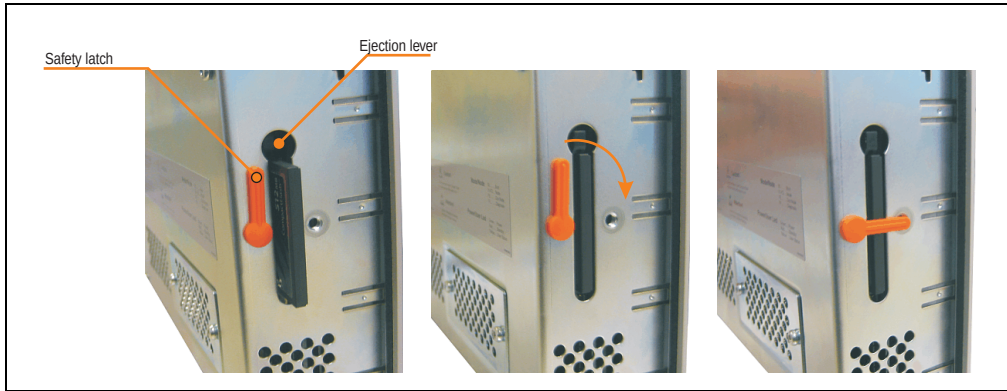


Figure 6: CompactFlash slot

It is possible to secure the CompactFlash slot using the latch provided. By pressing the ejector (using a pointed object is the best way to do this) the CompactFlash card can be changed quickly and safely.

Caution!

The power must be turned off before inserting or removing the CompactFlash card!
As a safety measure, a sticker is also attached to Power Panel devices stating this.

2.2 Stickers

2.2.1 Device label

The following sticker can be found in a suitable location on the Power Panel device:

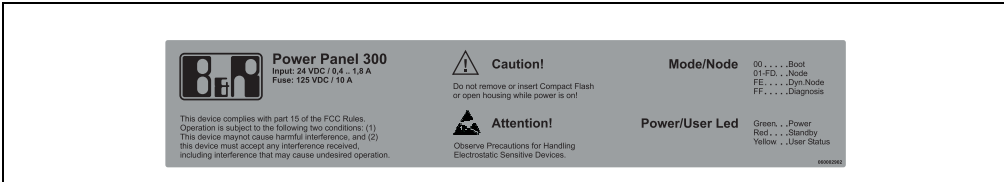


Figure 7: Device label

2.2.2 Serial number sticker

General

Each B&R device is given a unique serial number sticker with a barcode that allows the device to be clearly identified.

Design/Dimensions

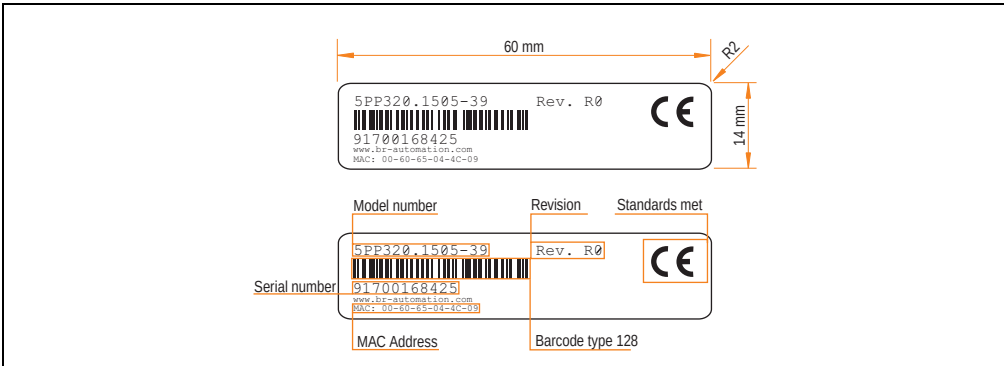


Figure 8: Design/dimensions - Serial number sticker

Information on the Internet

Information about each device can also be found on the B&R homepage. Enter the device's serial number in the serial number search field on the start page www.br-automation.com. The search also works if you enter the model number or the material number in the material number search field.

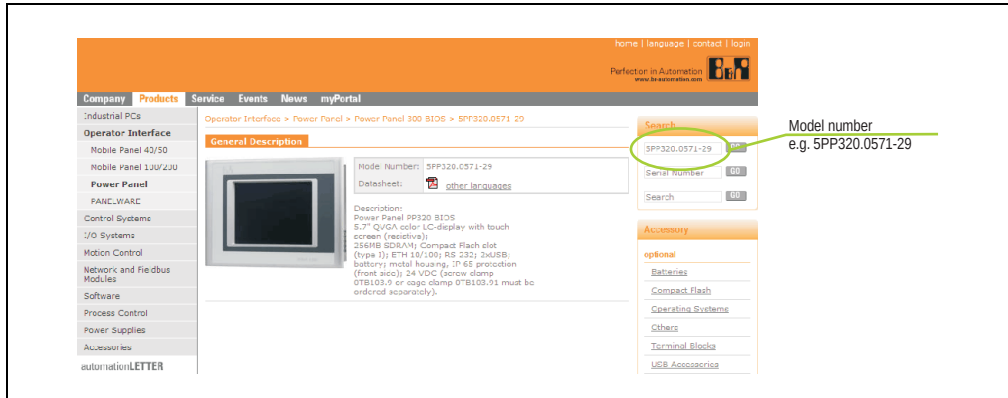


Figure 9: Example - material number search: 5PP320.0571-29

2.3 Device 5PP320.0571-29

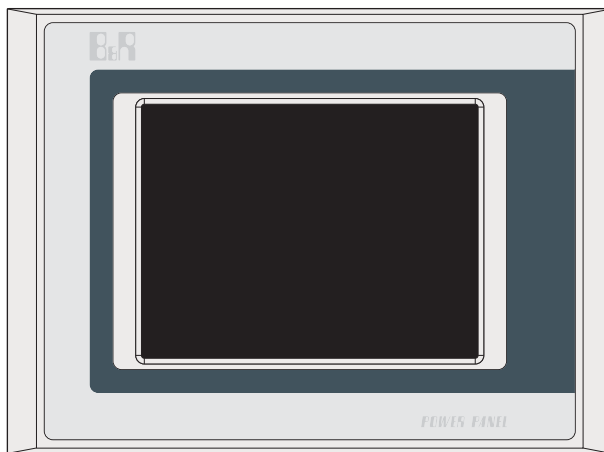


Figure 10: Front view - 5PP320.0571-29

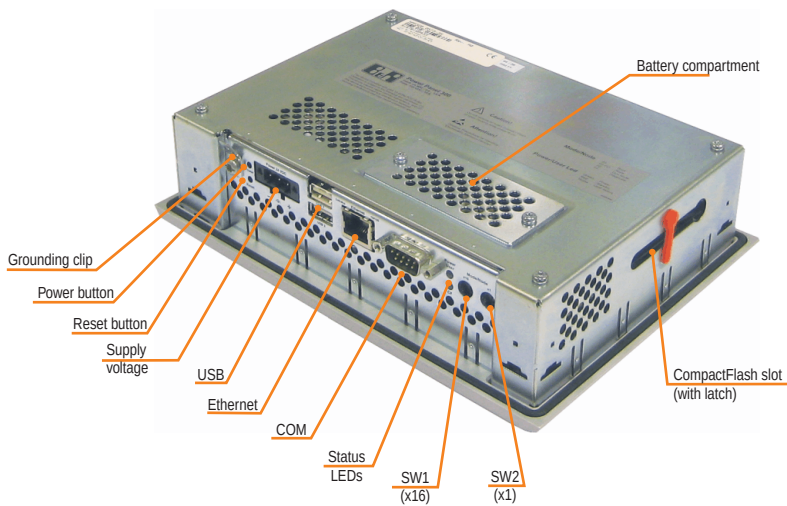


Figure 11: Rear view - 5PP320.0571-29

2.3.1 Technical data

Features	5PP320.0571-29
Boot loader / Operating system	BIOS
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 256 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 4 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 15: Technical data - 5PP320.0571-29

Features	5PP320.0571-29
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	Color LCD 5.7 in (144 mm) 512 colors ⁴⁾ QVGA, 320 x 240 pixels 40:1 Direction R / direction L = 40° Direction U = 40° / direction D = 50° 200 cd/m ² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.45 A Maximum 1.2 A typically 10 W Yes
Ground resistance	0 Ohm

Table 15: Technical data - 5PP320.0571-29 (cont.)

Mechanical characteristics	5PP320.0571-29
Outer dimensions	
Width	212 mm
Height	156 mm
Depth	55.5 mm
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.4 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 15: Technical data - 5PP320.0571-29 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 8.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

2.3.2 Dimensions

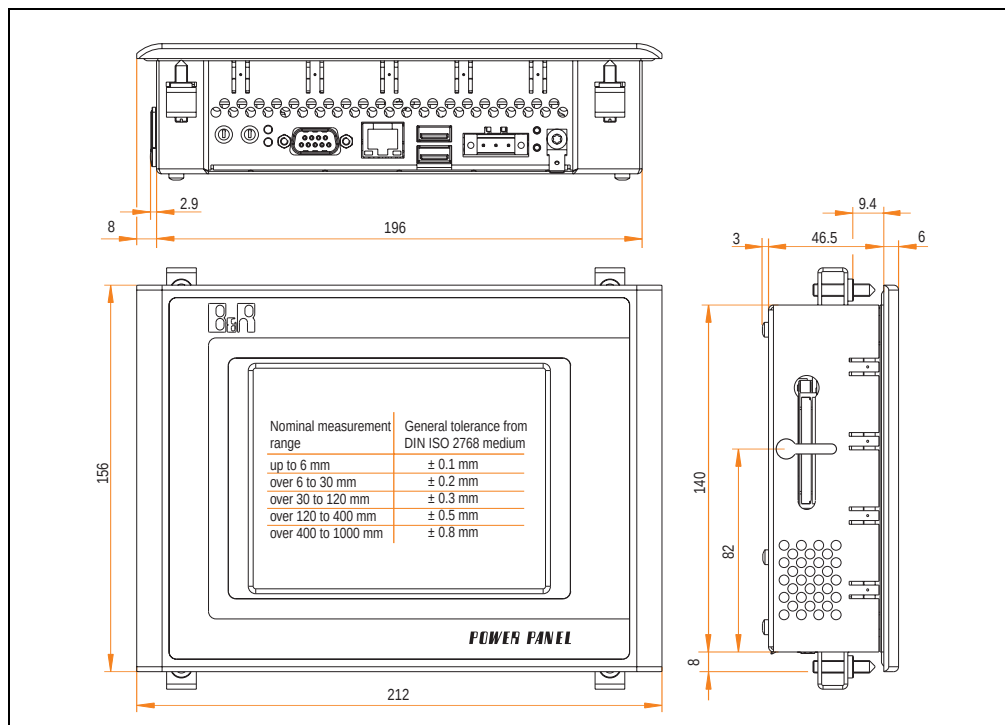


Figure 12: Dimensions - 5PP320.0571-29

2.3.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

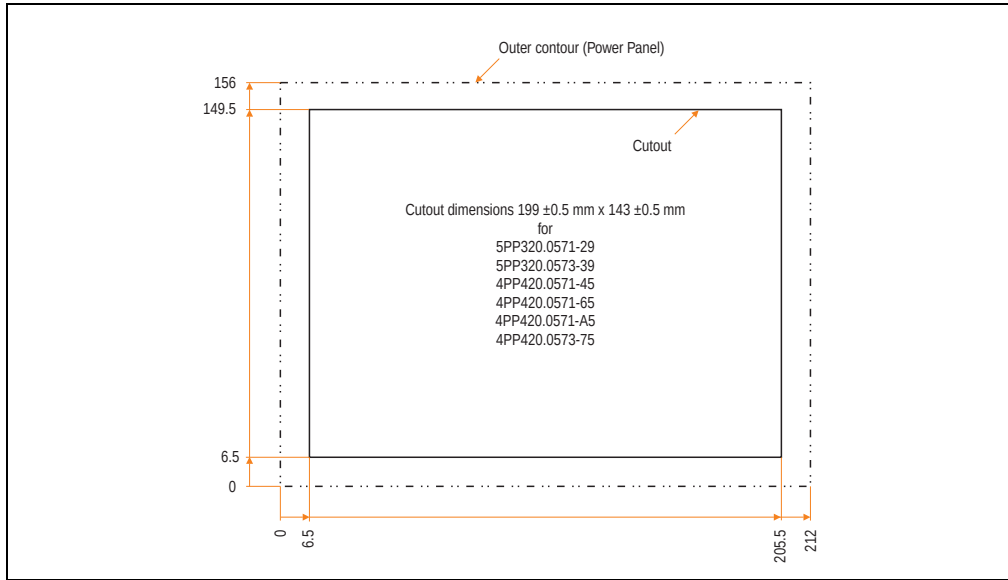


Figure 13: Cutout installation - 5PP320.0571-29

2.3.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 5.7" QVGA, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 16: Contents of delivery - 5PP320.0571-29

2.4 Device 5PP320.0571-39

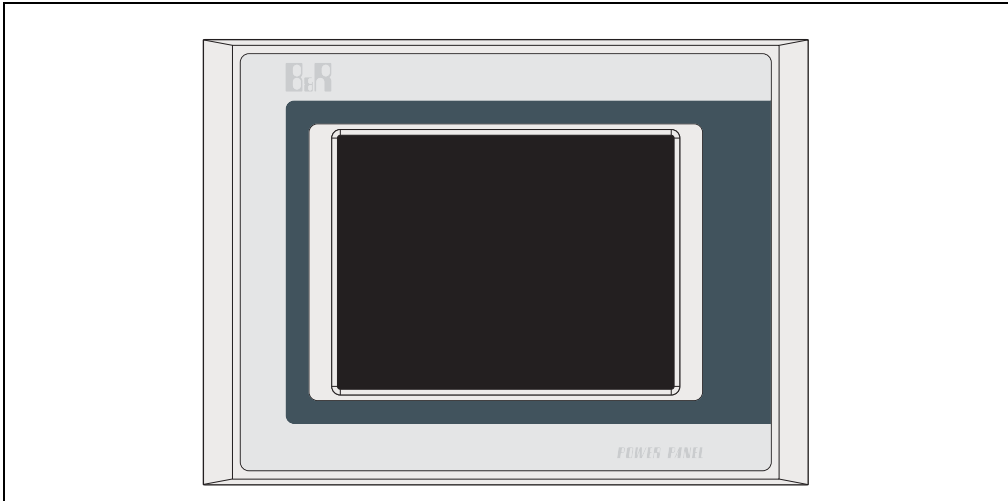


Figure 14: Front view - 5PP320.0571-39

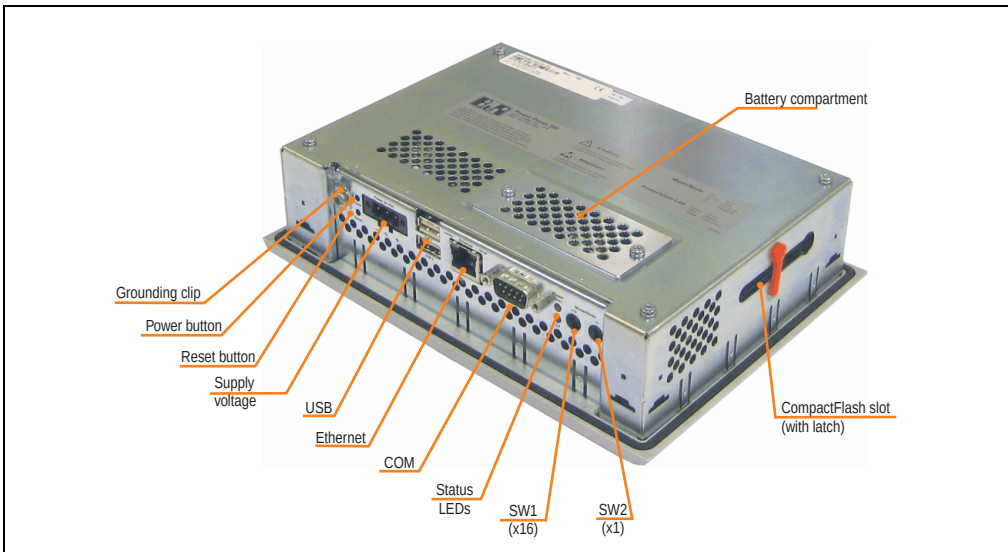


Figure 15: Rear view - 5PP320.0571-39

2.4.1 Technical data

Features	5PP320.0571-39
Boot loader / Operating system	BIOS
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 256 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 4 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 17: Technical data - 5PP320.0571-39

Technical data • Power Panel 300 with BIOS

Features	5PP320.0571-39
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 5.7 in (144 mm) 262144 colors ⁴⁾ QVGA, 320 x 240 pixels 400:1 Direction R / direction L = 60° Direction U = 40° / direction D = 50° 500 cd/m ² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.45 A Maximum 1.2 A typically 10 W Yes
Ground resistance	0 Ohm

Table 17: Technical data - 5PP320.0571-39 (cont.)

Mechanical characteristics	5PP320.0571-39
Outer dimensions	
Width	212 mm
Height	156 mm
Depth	55.5 mm
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.4 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 17: Technical data - 5PP320.0571-39 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 8.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

2.4.2 Dimensions

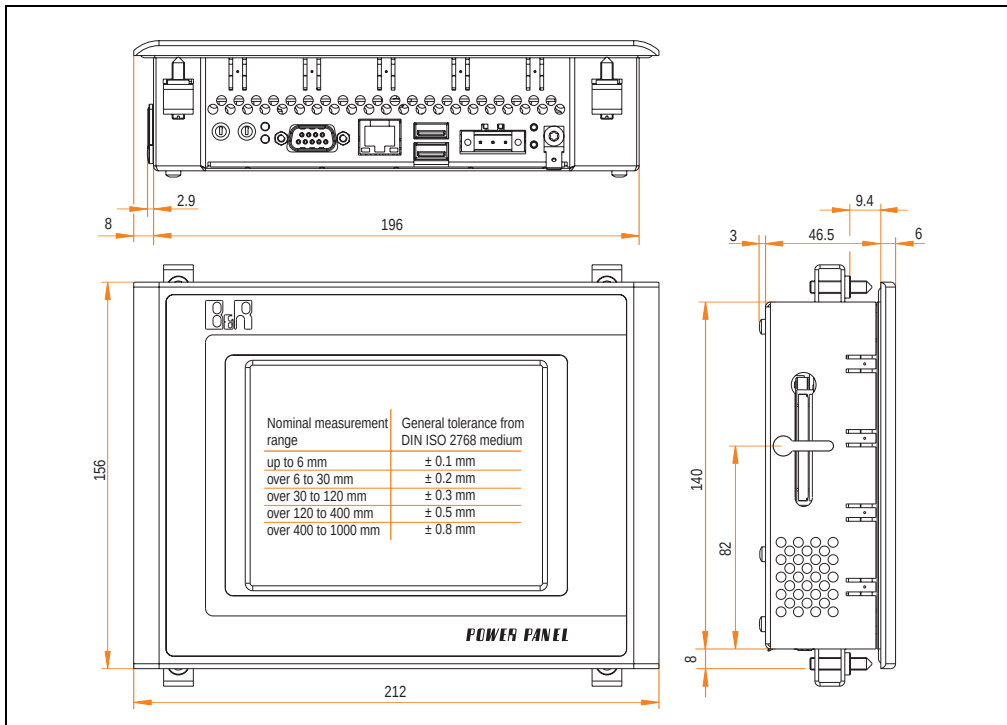


Figure 16: Dimensions - 5PP320.0571-39

2.4.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

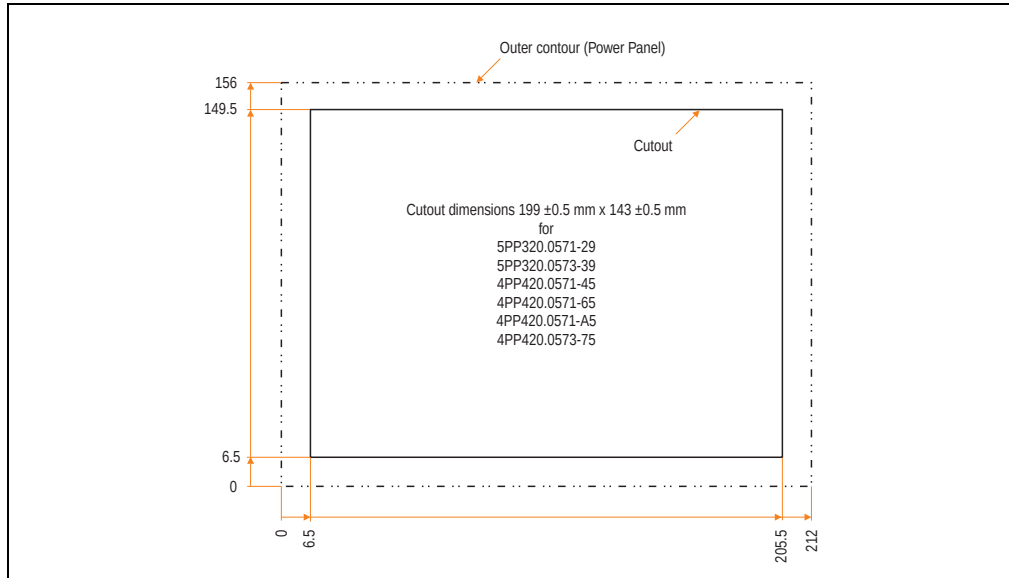


Figure 17: Cutout installation - 5PP320.0571-39

2.4.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 5.7" QVGA, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 18: Contents of delivery - 5PP320.0571-39

2.5 Device 5PP320.0573-39

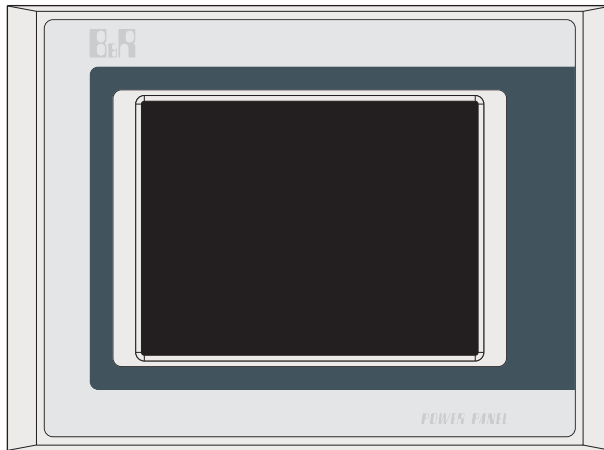


Figure 18: Front view - 5PP320.0573-39

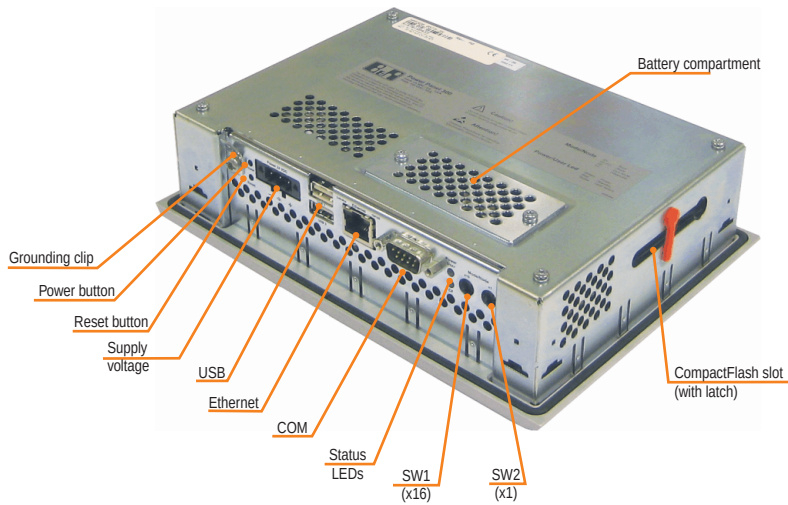


Figure 19: Rear view - 5PP320.0573-39

2.5.1 Technical data

Features	5PP320.0573-39
Boot loader / Operating system	BIOS
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 256 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 4 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 19: Technical data - 5PP320.0573-39

Features	5PP320.0573-39
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 5.7 in (144 mm) 262144 colors ⁴⁾ VGA, 640 x 480 pixels 400:1 Direction R / direction L = 80° Direction U = 80° / direction D = 70° 350 cd/m² 75000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.54 A Max. 1.2 A 13 W typical Yes
Ground resistance	0 Ohm

Table 19: Technical data - 5PP320.0573-39 (cont.)

Mechanical characteristics	5PP320.0573-39
Outer dimensions	
Width	212 mm
Height	156 mm
Depth	55.5 mm
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.4 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 19: Technical data - 5PP320.0573-39 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 8.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

2.5.2 Dimensions

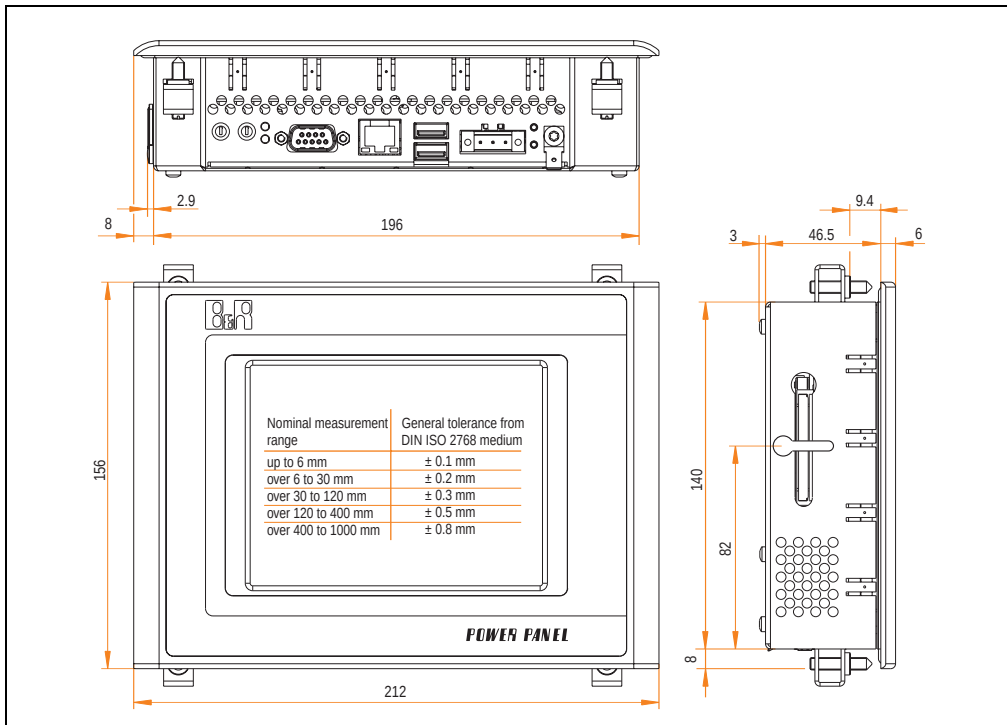


Figure 20: Dimensions - 5PP320.0573-39

2.5.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

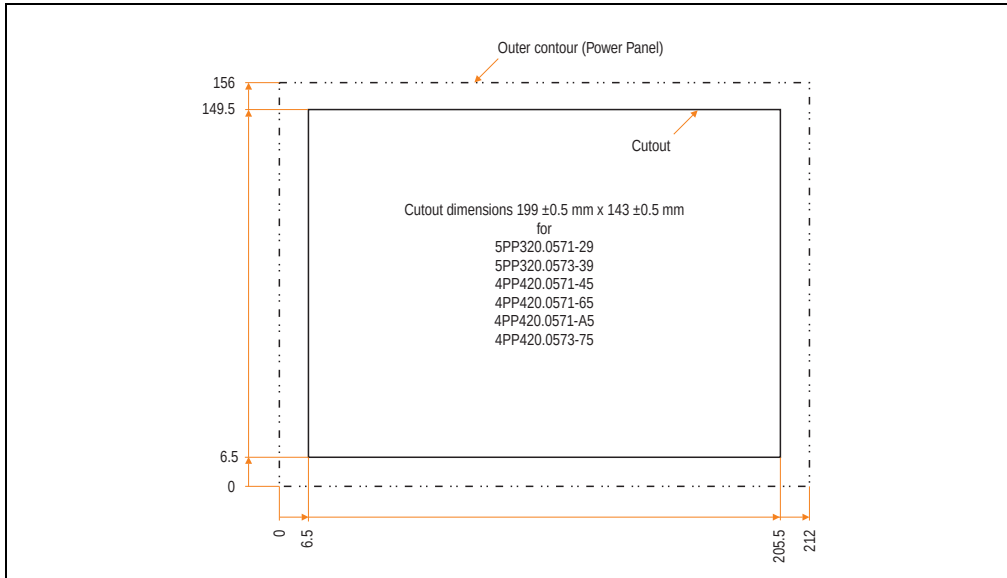


Figure 21: Cutout installation - 5PP320.0573-39

2.5.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 5.7" VGA, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 20: Contents of delivery - 5PP320.0573-39

2.6 Device 5PP320.1043-39

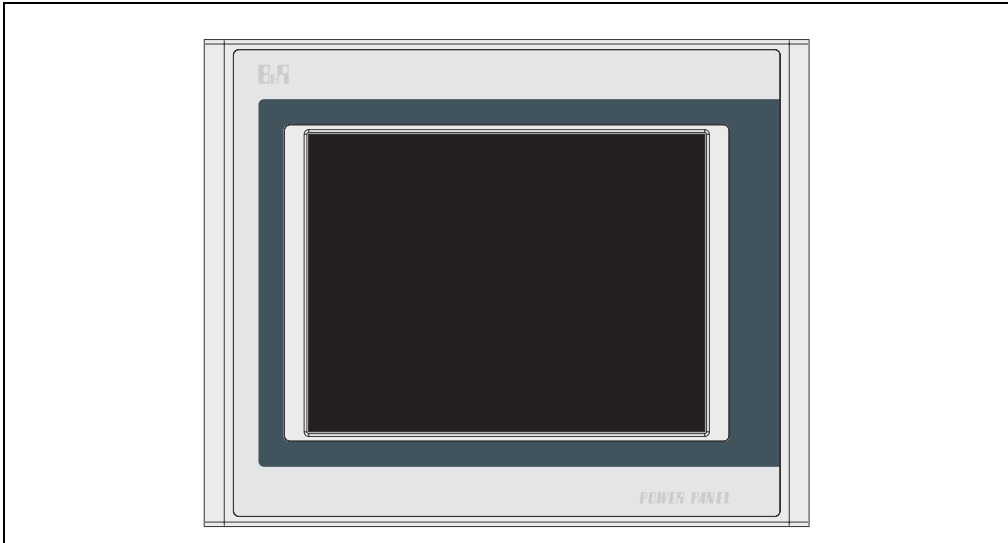


Figure 22: Front view - 5PP320.1043-39

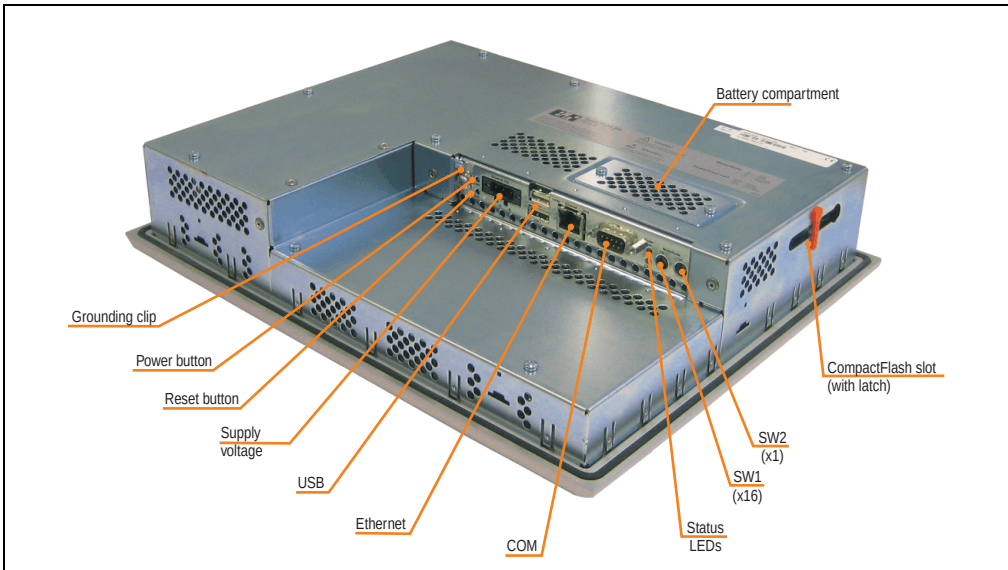


Figure 23: Rear view - 5PP320.1043-39

2.6.1 Technical data

Features	5PP320.1043-39
Boot loader / Operating system	BIOS
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 256 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 4 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 21: Technical data - 5PP320.1043-39

Features	5PP320.1043-39
USB interface	
Type	USB 1.1, USB 2.0 ⁴⁾
Amount	2
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾
Connection	Type A
Current load	Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display	
Type	TFT colors
Diagonal	10.4 in (264 mm)
Colors	262144 colors ⁴⁾
Resolution	VGA, 640 x 480 pixels
Contrast	600:1
Perspective (see page 370)	
Horizontal	Direction R / direction L = 70°
Vertical	Direction U = 45° / direction D = 35°
Background lighting	
Brightness	450 cd/m ²
Half-brightness time	55000 hours
Touch screen	
Technology	Analog, resistive
Controller	Elo, serial, 12- bit
Degree of transmission	Up to 80% ± 5%
Filter glass	-
Degree of transmission	
Coating	
Keys/LED	-
Function keys	
Soft keys	
Cursor keys	
Number block	
Other keys	
Key lifespan	
LED brightness	
Electrical characteristics	
Power supply	
Rated voltage	18 - 30 VDC
Rated current	0.63 A
Starting current	Maximum 2.8 A
Power consumption	typically 15 W
Electrical isolation	Yes
Ground resistance	0 Ohm

Table 21: Technical data - 5PP320.1043-39 (cont.)

Mechanical characteristics	5PP320.1043-39
Outer dimensions	
Width	323 mm
Height	260 mm
Depth	65,5 mm
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 3.7 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 21: Technical data - 5PP320.1043-39 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 8.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

2.6.2 Dimensions

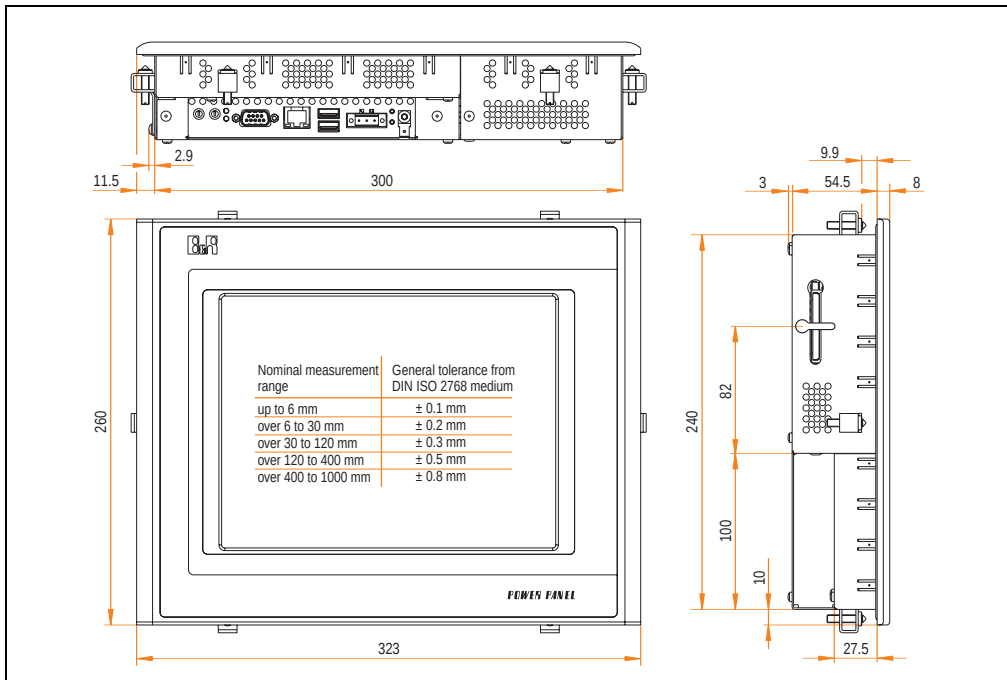


Figure 24: Dimensions - 5PP320.1043-39

2.6.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

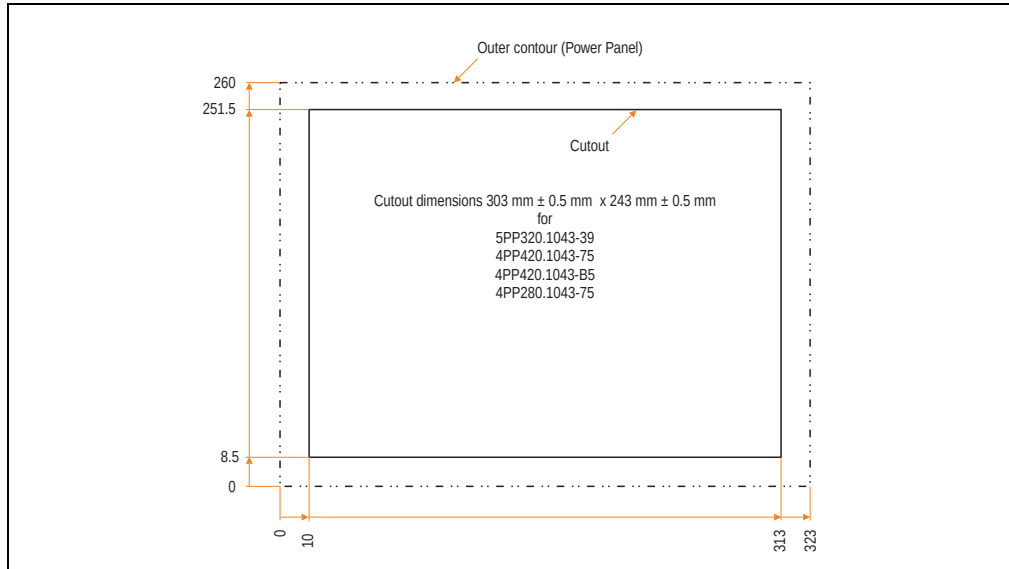


Figure 25: Cutout installation - 5PP320.1043-39

2.6.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 10.4" VGA, touch screen
6	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 22: Contents of delivery - 5PP320.1043-39

2.7 Device 5PP320.1214-39

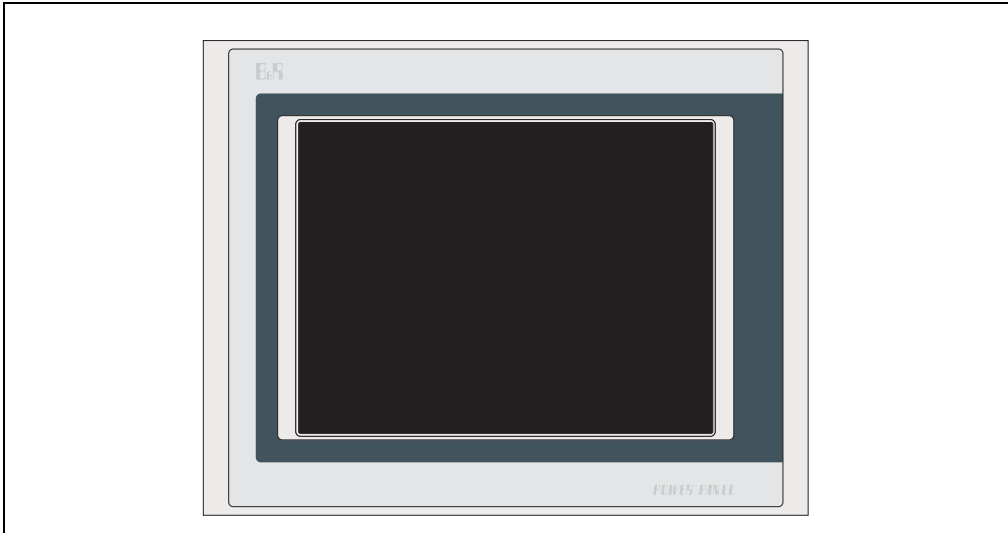


Figure 26: Front view - 5PP320.1214-39

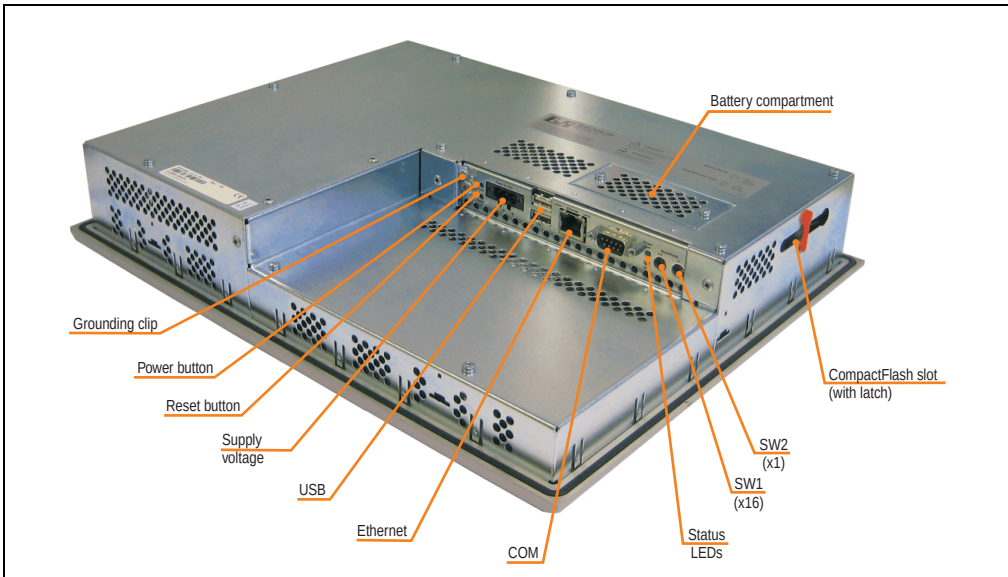


Figure 27: Rear view - 5PP320.1214-39

2.7.1 Technical data

Features	5PP320.1214-39
Boot loader / Operating system	BIOS
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 256 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 4 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 23: Technical data - 5PP320.1214-39

Features	5PP320.1214-39
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 12.1 in (307 mm) 262144 colors ⁴⁾ SVGA, 800 x 600 pixels 300:1 Direction R / direction L = 70° Direction U = 50° / direction D = 60° 350 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.63 A Maximum 2.8 A typically 15 W Yes
Ground resistance	0 Ohm

Table 23: Technical data - 5PP320.1214-39 (cont.)

Mechanical characteristics	5PP320.1214-39
Outer dimensions	
Width	362 mm
Height	284 mm
Depth	65,5 mm
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 4.1 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +45°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 23: Technical data - 5PP320.1214-39 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 8.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

2.7.2 Dimensions

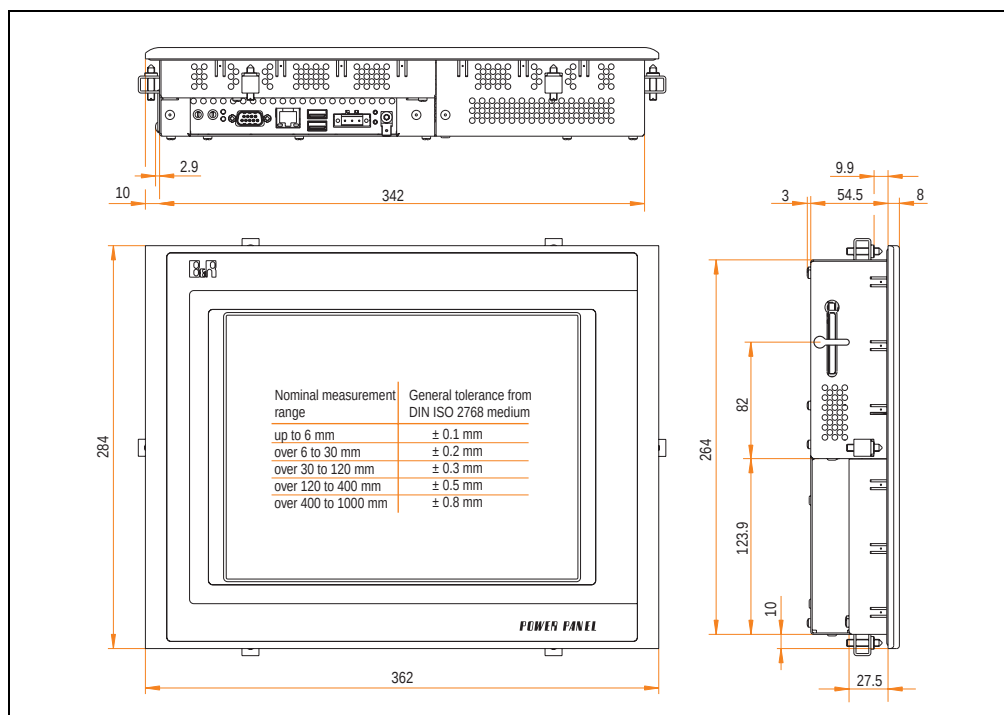


Figure 28: Dimensions - 5PP320.1214-39

2.7.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

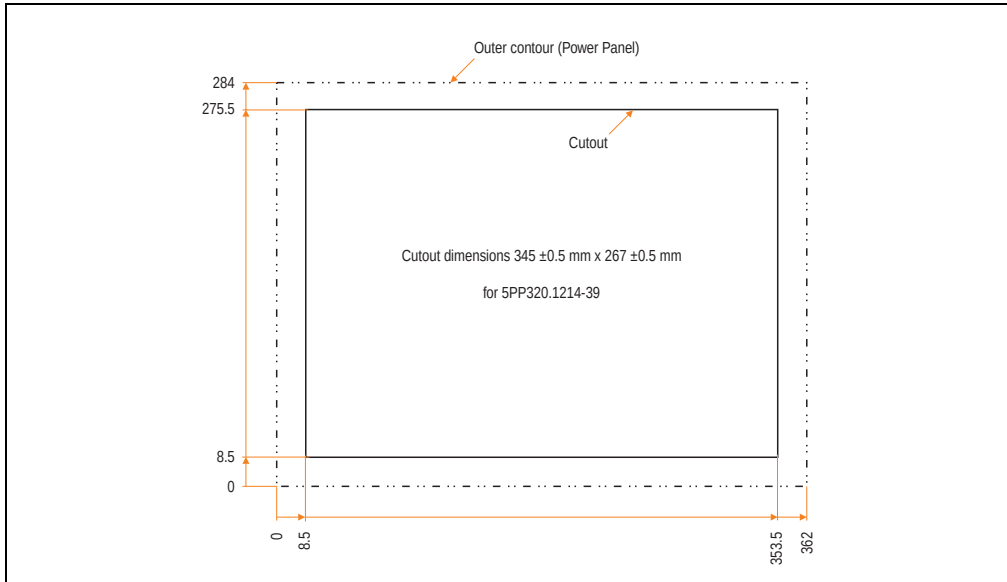


Figure 29: Cutout installation - 5PP320.1214-39

2.7.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 12.1" SVGA, touch screen
6	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 24: Contents of delivery - 5PP320.1214-39

2.8 Device 5PP320.1505-39

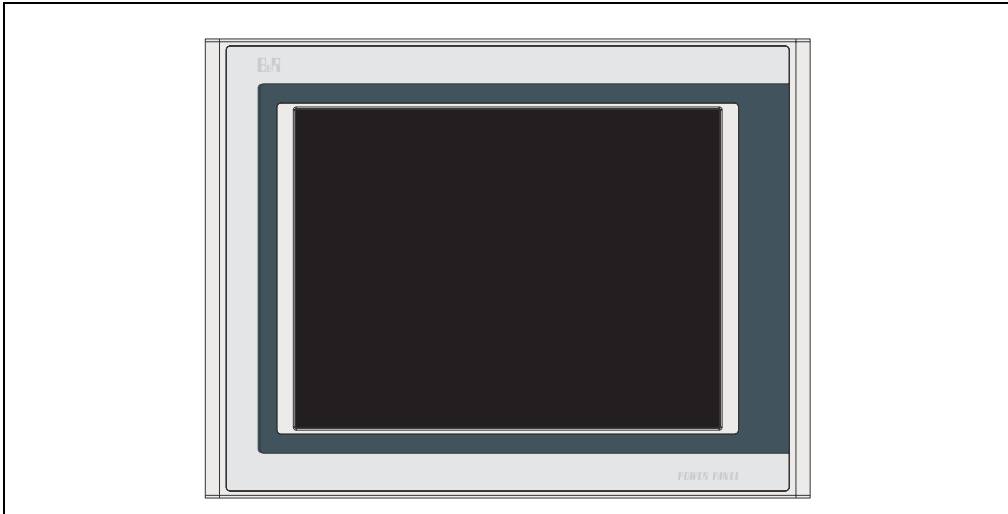


Figure 30: Front view - 5PP320.1505-39

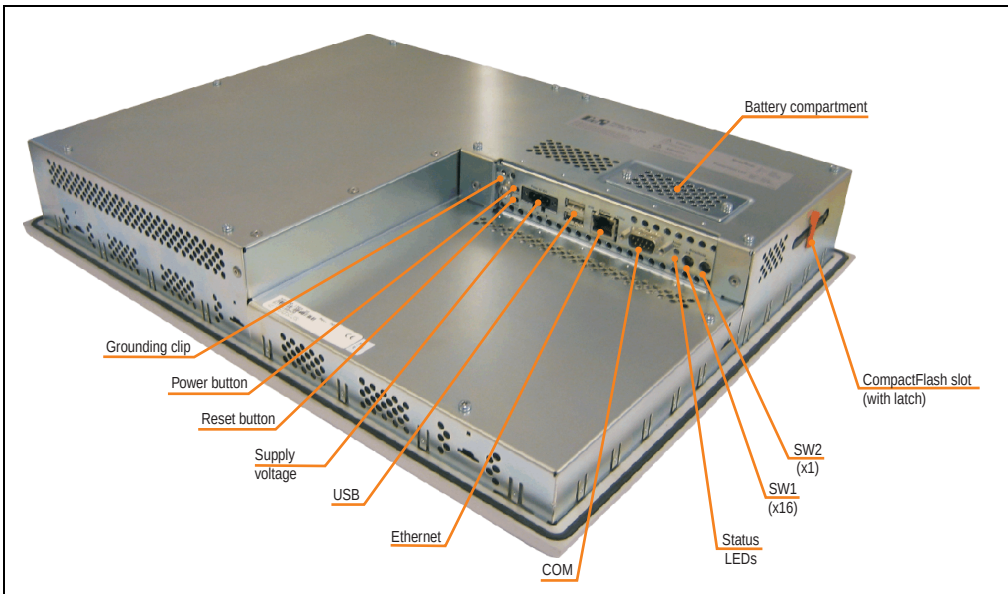


Figure 31: Rear view - 5PP320.1505-39

2.8.1 Technical data

Features	5PP320.1505-39
Boot loader / Operating system	BIOS
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 256 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 4 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 25: Technical data - 5PP320.1505-39

Features	5PP320.1505-39
USB interface	
Type	USB 1.1, USB 2.0 ⁴⁾
Amount	2
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾
Connection	Type A
Current load	Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display	
Type	TFT colors
Diagonal	15 in (381 mm)
Colors	262144 colors ⁴⁾
Resolution	XGA, 1024 x 768 pixels
Contrast	400:1
Perspective (see page 370)	
Horizontal	Direction R / direction L = 85°
Vertical	Direction U / direction D = 85°
Background lighting	
Brightness	250 cd/m ²
Half-brightness time	50000 hours
Touch screen	
Technology	Analog, resistive
Controller	Elo, serial, 12- bit
Degree of transmission	Up to 80% ± 5%
Filter glass	-
Degree of transmission	
Coating	
Keys/LED	-
Function keys	
Soft keys	
Cursor keys	
Number block	
Other keys	
Key lifespan	
LED brightness	
Electrical characteristics	
Power supply	
Rated voltage	18 - 30 VDC
Rated current	1.25 A
Starting current	Maximum 2 A
Power consumption	typically 30 W
Electrical isolation	Yes
Ground resistance	0 Ohm

Table 25: Technical data - 5PP320.1505-39 (cont.)

Mechanical characteristics	5PP320.1505-39
Outer dimensions	
Width	435 mm
Height	330 mm
Depth	71.5 mm
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 6.3 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 25: Technical data - 5PP320.1505-39 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 8.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

2.8.2 Dimensions

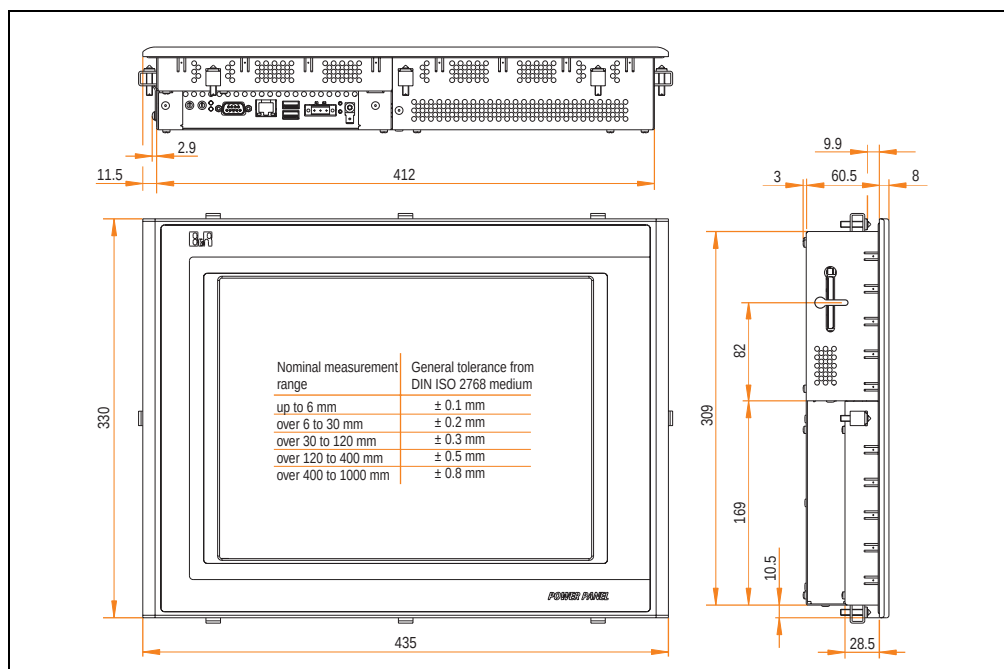


Figure 32: Dimensions - 5PP320.1505-39

2.8.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

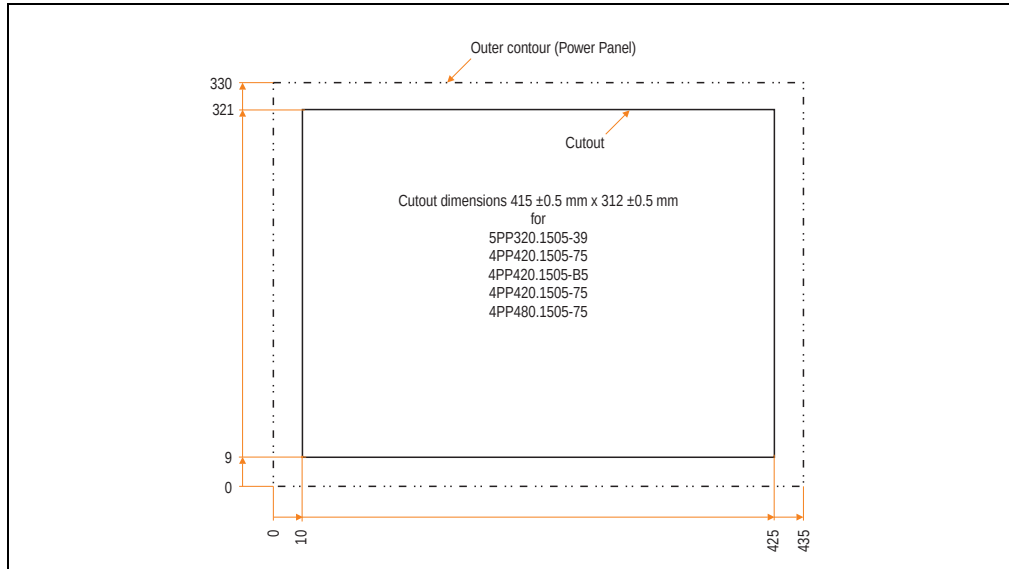


Figure 33: Cutout installation - 5PP320.1505-39

2.8.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 15" XGA, touch screen
8	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 26: Contents of delivery - 5PP320.1505-39

3. Power Panel 300 with Automation Runtime

3.1 Device interfaces

The following section provides a description of all interfaces and plugs possible with a Power Panel 300 device with Automation Runtime.

3.1.1 Supply voltage

Input voltage: 18 - 30 VDC

The 3-pin socket required for the supply voltage connection is not included in delivery. This can be ordered from B&R using the model number OTB103.9 (screw clamps) or OTB103.91 (cage clamps).

The pin assignments can be found either in the following table or printed onto the Power Panel plate. The supply voltage is internally protected so that the device cannot be damaged if there is an overload (fuse replacement necessary) or if the voltage supply is connected incorrectly (reverse polarity protection - fuse replacement not necessary).

Supply voltage	
Protected against reverse polarity	
Pin	Description
1	-
2	Functional grounding
3	+
Accessories	
OTB103.9	Plug 24 V 5.08 3p screw clamps
OTB103.91	Plug 24 V 5.08 3p cage clamps



Figure 34: Supply voltage connection

Ground

Important!

The pin's connection to the functional ground (pin 2, e.g. switching cabinet) should be as short as possible. We recommend using the largest possible conductor cross section on the supply plug.

3.1.2 Functional grounding clip

Next to the supply voltage plug there is a functional grounding clip. The grounding clip (functional ground) must be connected with a central grounding point on the switching cabinet using a 6.3 mm blade connector via the shortest distance and with as little resistance as possible (e.g. copper strip, but must be at least 2.5 mm²).

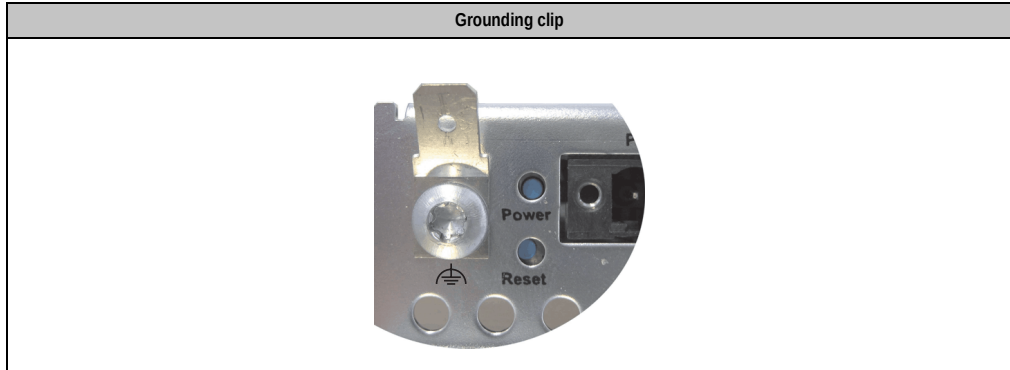


Figure 35: Functional grounding clip

3.1.3 Serial interface COM

The Power Panel is equipped with a PC-compatible serial interface with a 16-byte FIFO buffer. This non-electrically isolated interface is primarily intended for programming Power Panel devices using Automation Studio.

The RS232 can also be used as a general interface (e.g. third-party connections, barcode reader, etc.).

Serial interface (COM)		
Type	RS232, modem-capable, not electrically isolated	9-pin DSUB connector 
UART	16C550 compatible, 16-byte FIFO	
Transfer rate	Up to 115 kBaud	
Pin	Assignment	
1	DCD	
2	RxD	
3	TxD	
4	DTR	
5	GND	
6	DSR	
7	RTS	
8	CTS	
9	RI	

Table 27: Pin assignments - COM

3.1.4 USB port

The Power Panel 300/400 devices have a USB 2.0 (Universal Serial Bus) host controller with multiple USB ports, two of which are on the outside for easy user access.

Universal serial bus		
Transfer rate ¹⁾	Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s)	2x USB Type A, female 
Power supply	Max. 500 mA per port ²⁾	
Maximum cable length	5 m (not including hub)	

Table 28: USB port

1) The actual value depends on the operating system or diver being used.

2) For safety, every USB port is equipped with a maintenance free "USB current-limiting circuit breaker" (max. 500 mA)

Warning!

Peripheral USB devices can be connected to the USB interfaces. Due to the vast number of USB devices available on the market, B&R cannot guarantee their performance. B&R does assure the performance of all USB devices that they provide.

Important!

Because of general PC specifications, this interface should be handled with extreme care with regard to EMC, location of cables, etc.

3.1.5 Mode/Node switches

Power Panel devices are equipped with 2 hex switches that serve as operating mode switches. Switch positions 01 to FD are available for any purpose in an application and can be evaluated by the application program.

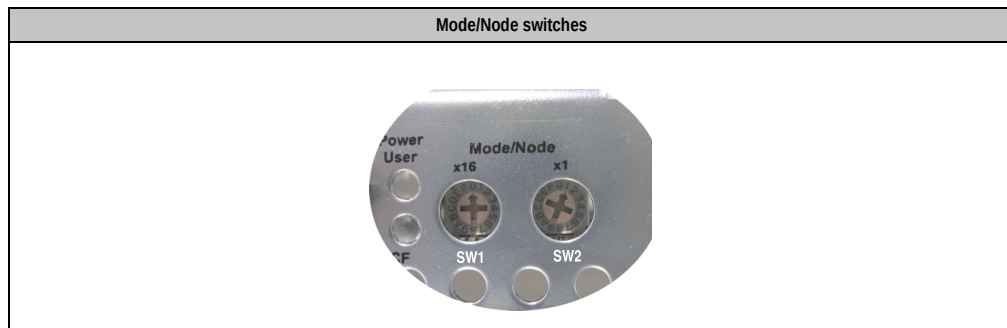


Table 29: Mode/Node switches

Switch position		Function	Description
SW1 (x16)	SW2 (x1)		
0	0	Boot	Automation Runtime boot mode for operating system (firmware) upgrade (default: Automation Runtime). In this position, a new or missing operating system can be downloaded.
0 ... F	0 ... D	Node	Automation Runtime run mode with node 01-FD (CompactFlash Automation Runtime or terminal operation). Freely available for use in an application, e.g. setting the INA2000 node number for the Ethernet interface.
F	E	Dyn. mode	Automation Runtime run mode with node 01-FD (CompactFlash Automation Runtime or terminal operation). Device addresses can be assigned through the software.
F	F	Diagnostics	Automation Runtime diagnostics mode (CompactFlash Automation Runtime or terminal operation).

Table 30: Switch settings for the Mode/Node switch

3.1.6 Status LEDs

Power Panels are equipped with two status LEDs that are visible on the outside.

Status LEDs			
LED	Color	On	Meaning
Power	Green	On	Supply voltage OK
	Red	On	The system is in standby mode (S5: soft-off mode or S4: hibernate mode - suspend-to-disk)
User	Yellow	On	Freely available for use in an application (e.g. can be switched on/off directly via the ADI Library - only possible in the S0 state). S0 Zustand möglich).
	Green	Off	
CF	Yellow	On	Indicates access to CompactFlash drive (read or write)

1x three-color, 1x one-color



Figure 36: Status LEDs

3.1.7 Ethernet connection

Ethernet connection		
Controller	Intel 82551ER	
Cabling	S/STP (category 5)	
Transfer rate	10/100 MBit/s ¹⁾	
LED	On	Off
Green	100 MBit/s	10 MBit/s
Orange	Link (Ethernet network connection available)	Activity (blinking) (Data transfer in progress)

RJ45 twisted pair (10BaseT/100BaseT), female

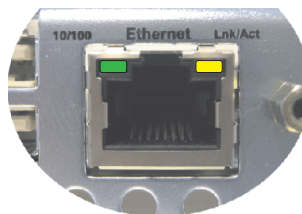


Table 31: Ethernet connection

1) Both operating modes possible. Change-over takes place automatically.

3.1.8 Power button

Due to the complete ATX power supply support, the power button serves a number of functions, which can be configured in BIOS setup.

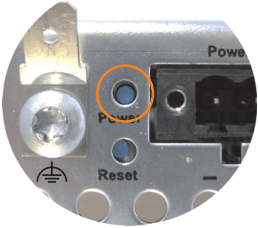
Power button	
The power button can be pressed with a pointed object (i.e. paper clip or tip of a pen). If the button is pressed for longer than 4 seconds, the ATX power supply switches the Power Panel off (loss of data possible!)	 A circular inset image showing a close-up of the Power Panel 300. The panel is silver with a black power button labeled 'Power' circled in orange. Below it is a smaller blue button labeled 'Reset'. To the left is a gold-colored metal bracket and a silver screw. The background is white.

Table 32: Power button

3.1.9 Reset button

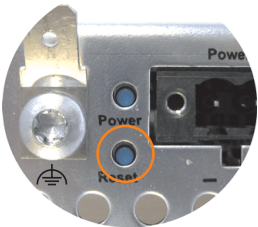
Reset button	
The reset button can be pressed with a pointed object (i.e. paper clip or tip of a pen). Pushing the reset button results in a hardware-reset. The Power Panel restarts. The MTCX processor is not reset when the reset button is pressed.	 A circular inset image showing a close-up of the Power Panel 300. The panel is silver with a black power button labeled 'Power' and a smaller blue button labeled 'Reset' circled in orange. To the left is a gold-colored metal bracket and a silver screw. The background is white.

Table 33: Reset button

Warning!

A system reset can cause data to be lost!

3.1.10 CompactFlash slot

Power Panel devices are equipped with a CompactFlash slot that is accessible from the side. Type I CompactFlash cards are supported.

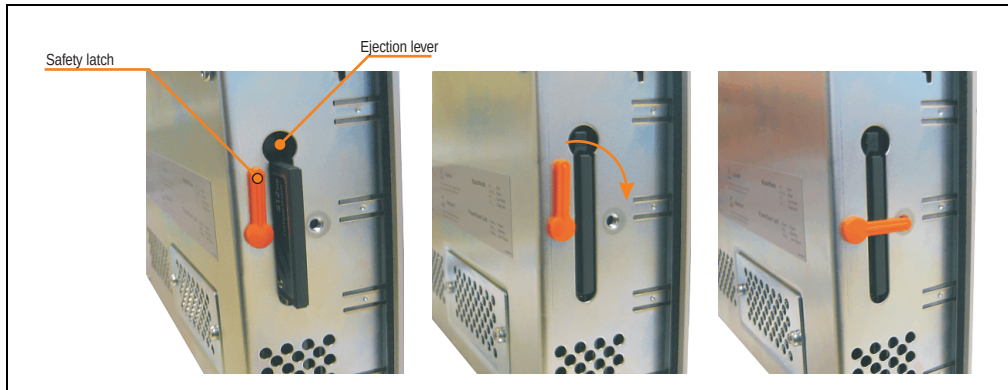


Figure 37: CompactFlash slot

It is possible to secure the CompactFlash slot using the latch provided. By pressing the ejector (using a pointed object is the best way to do this) the CompactFlash card can be changed quickly and safely.

Caution!

The power must be turned off before inserting or removing the CompactFlash card!
As a safety measure, a sticker is also attached to Power Panel devices stating this.

3.2 Stickers

3.2.1 Device label

The following sticker can be found in a suitable location on the Power Panel device:

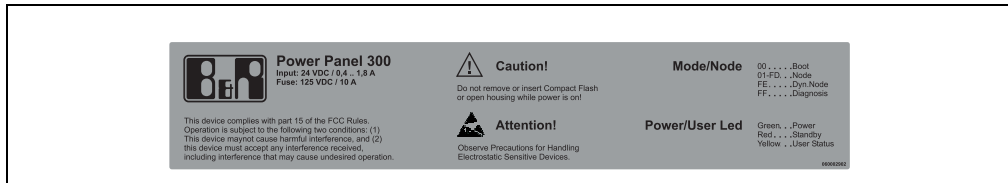


Figure 38: Device label

3.2.2 Serial number sticker

General

Each B&R device is given a unique serial number sticker with a barcode that allows the device to be clearly identified.

Design/Dimensions

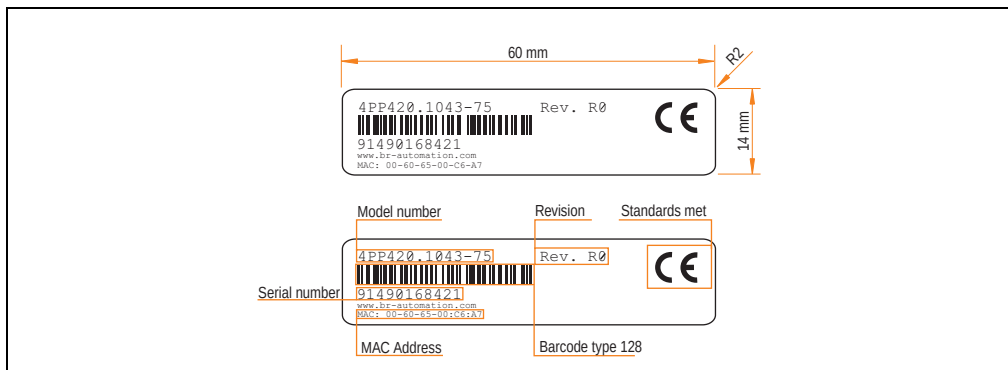


Figure 39: Design/dimensions - Serial number sticker

Information on the Internet

Information about each device can also be found on the B&R homepage. Enter the device's serial number in the serial number search field on the start page www.br-automation.com. The search also works if you enter the model number or the material number in the material number search field.

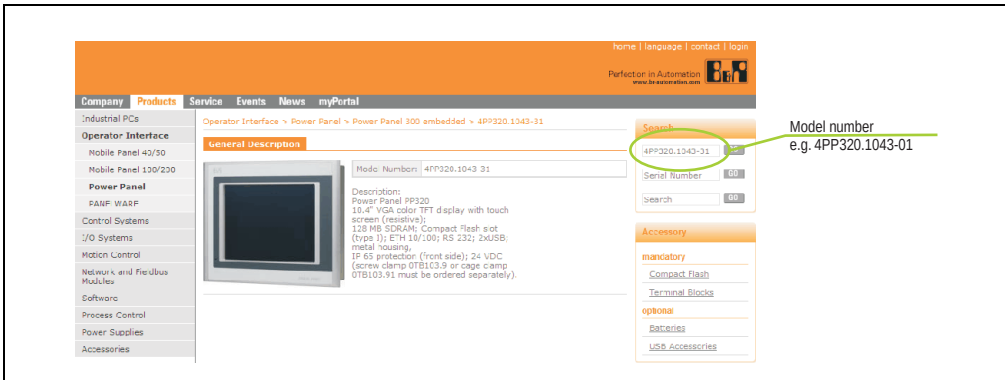


Figure 40: Example - material number search: 4PP320.1043-31

3.3 Device 4PP320.0571-01

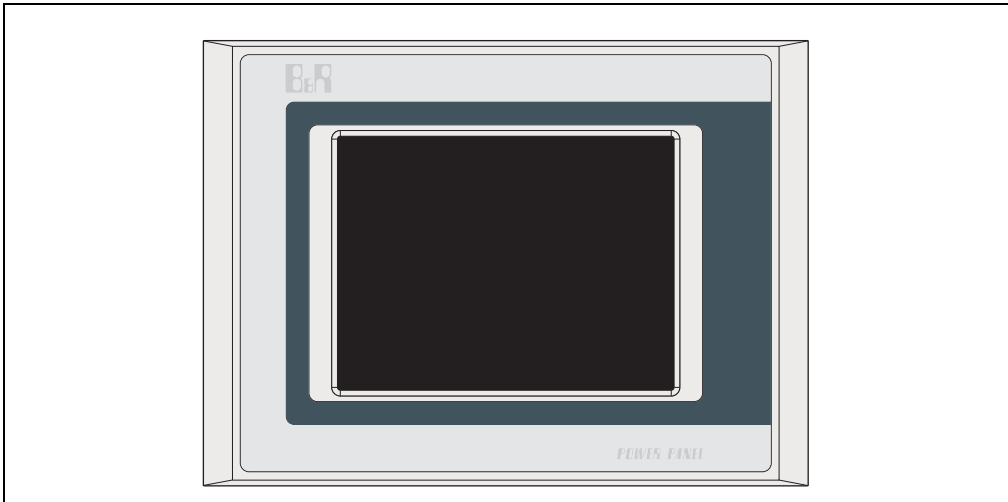


Figure 41: Front view - 4PP320.0571-01

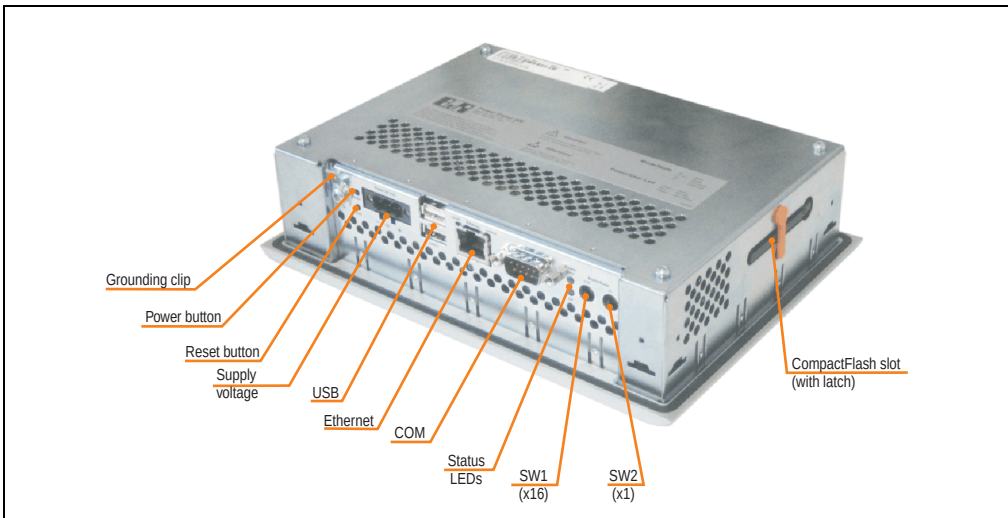


Figure 42: Rear view - 4PP320.0571-01

3.3.1 Technical data

Features	4PP320.0571-01
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	-
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 34: Technical data - 4PP320.0571-01

Technical data • Power Panel 300 with Automation Runtime

Features	4PP320.0571-01
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ³⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ³⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	LCD BW 5.7 in (144 mm) 8 shades of gray ³⁾ QVGA, 320 x 240 pixels 25:1 Direction R / direction L = 40° Direction U = 40° / direction D = 50° 220 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.45 A Maximum 1.2 A typically 10 W Yes
Ground resistance	0 Ohm
Outer dimensions Width Height Depth	212 mm 156 mm 55.5 mm

Table 34: Technical data - 4PP320.0571-01 (cont.)

Mechanical characteristics	4PP320.0571-01
Front	
Frame	Aluminum, naturally anodized ⁴⁾
Design	Gray ⁴⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁴⁾
Light background	Similar to Pantone 427CV ⁴⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.4 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 34: Technical data - 4PP320.0571-01 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) The actual value depends on the operating system or diver being used.
- 4) Depending on the process or batch, there may be visible deviations in the color and surface structure.

3.3.2 Dimensions

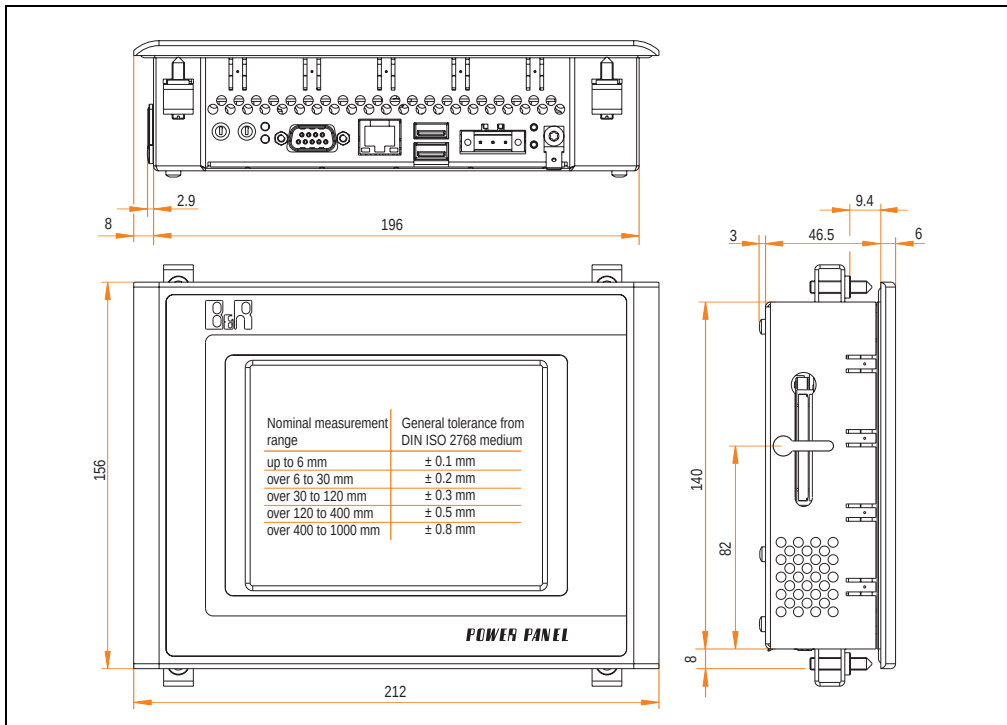


Figure 43: Dimensions 4PP320.0571-01

3.3.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

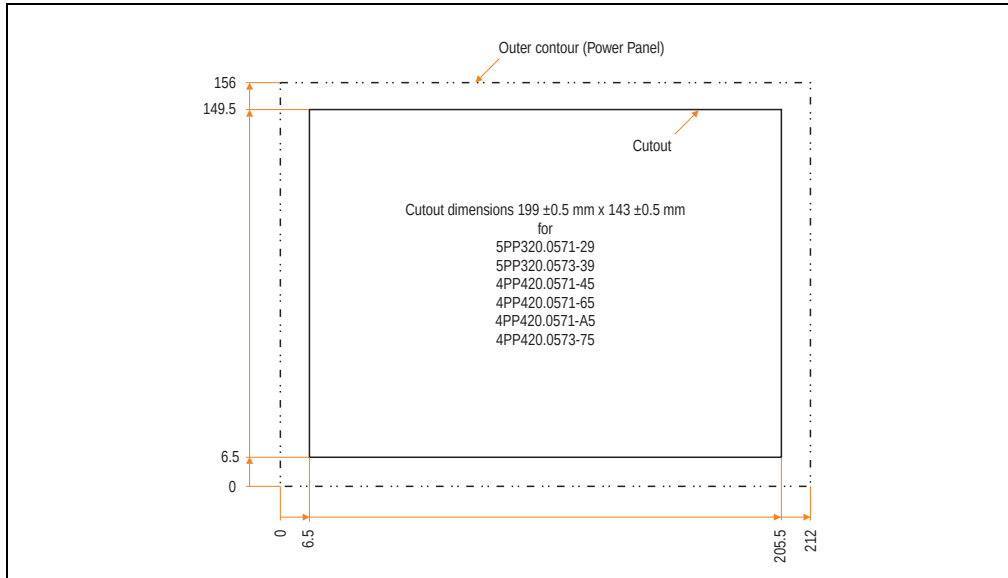


Figure 44: Cutout installation - 4PP320.0571-01

3.3.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 5.7" QVGA, touch screen
4	Retaining clips included

Table 35: Contents of delivery - 4PP320.0571-01

3.4 Device 4PP320.0571-35

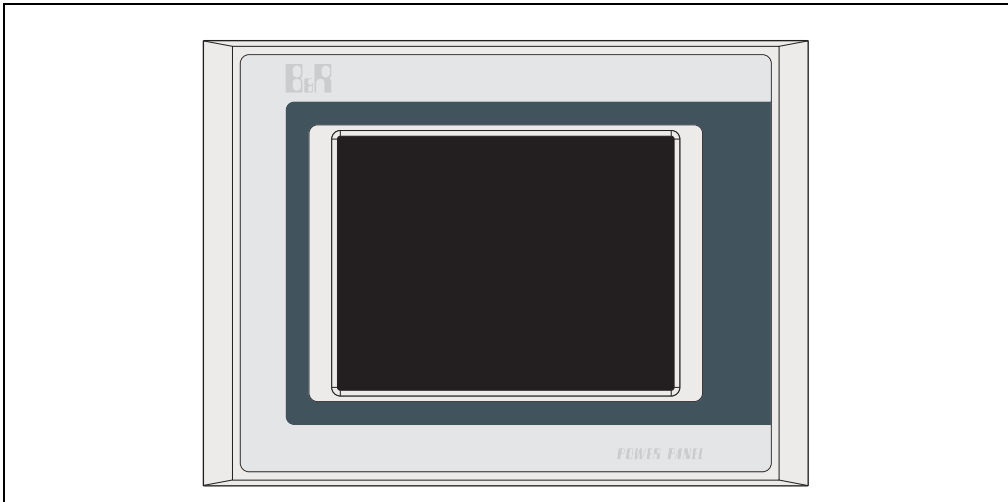


Figure 45: Front view - 4PP320.0571-35

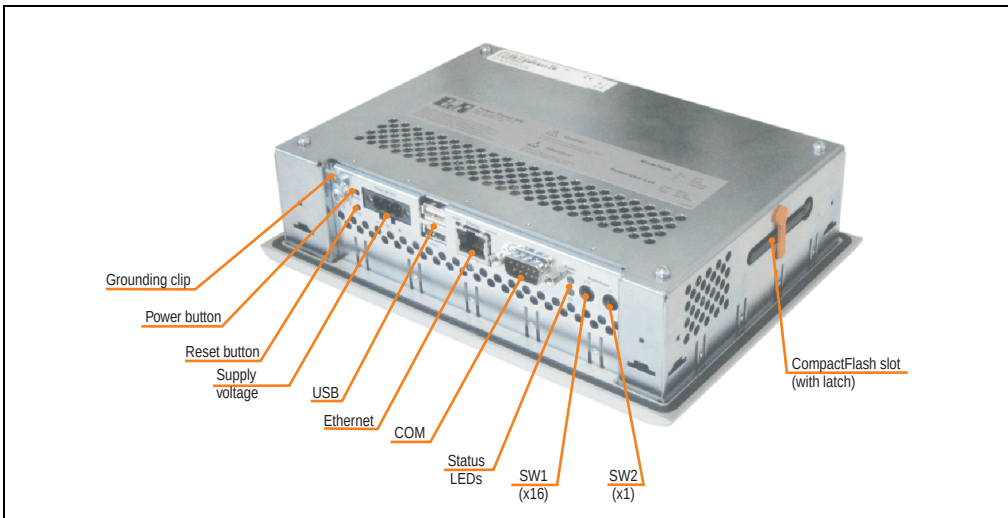


Figure 46: Rear view - 4PP320.0571-35

3.4.1 Technical data

Features	4PP320.0571-35
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	-
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 36: Technical data - 4PP320.0571-35

Technical data • Power Panel 300 with Automation Runtime

Features	4PP320.0571-35
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ³⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ³⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 5.7 in (144 mm) 262144 colors ³⁾ QVGA, 320 x 240 pixels 400:1 Direction R / direction L = 60° Direction U = 40° / direction D = 50° 500 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.45 A Maximum 1.2 A typically 10 W Yes
Ground resistance	0 Ohm
Outer dimensions Width Height Depth	212 mm 156 mm 55.5 mm

Table 36: Technical data - 4PP320.0571-35 (cont.)

Mechanical characteristics	4PP320.0571-35
Front	
Frame	Aluminum, naturally anodized ⁴⁾
Design	Gray ⁴⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁴⁾
Light background	Similar to Pantone 427CV ⁴⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.4 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 36: Technical data - 4PP320.0571-35 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) The actual value depends on the operating system or diver being used.
- 4) Depending on the process or batch, there may be visible deviations in the color and surface structure.

3.4.2 Dimensions

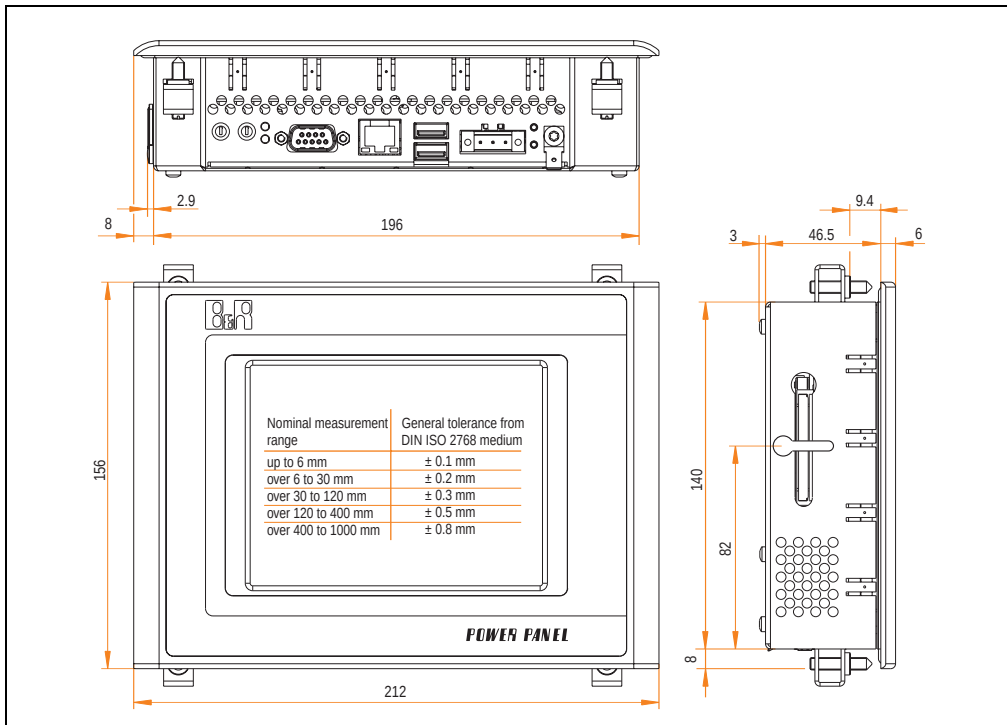


Figure 47: Dimensions 4PP320.0571-35

3.4.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

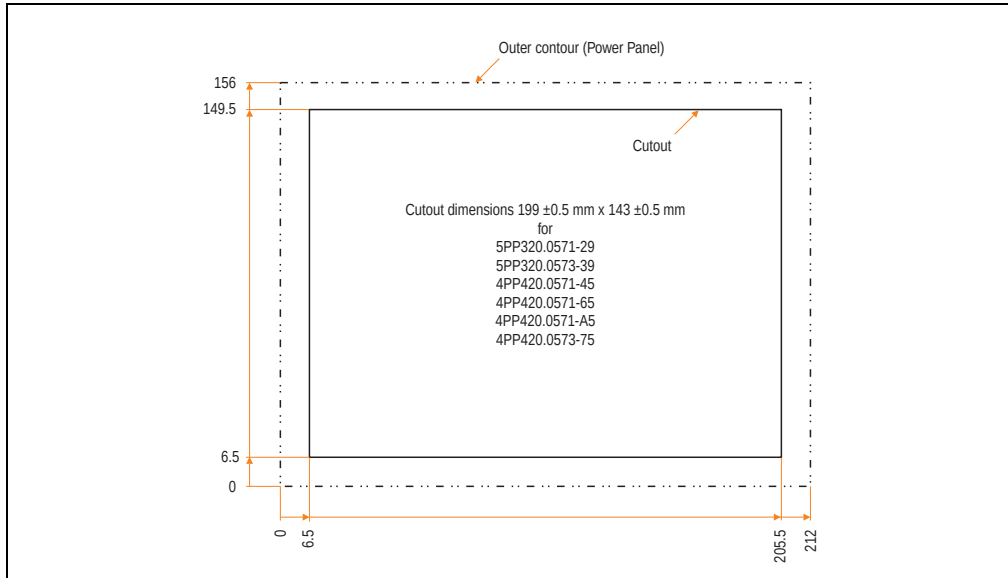


Figure 48: Cutout installation - 5PP320.0571-35

3.4.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 5.7" QVGA, touch screen
4	Retaining clips included

Table 37: Contents of delivery - 4PP320.0571-35

3.5 Device 4PP320.1043-31

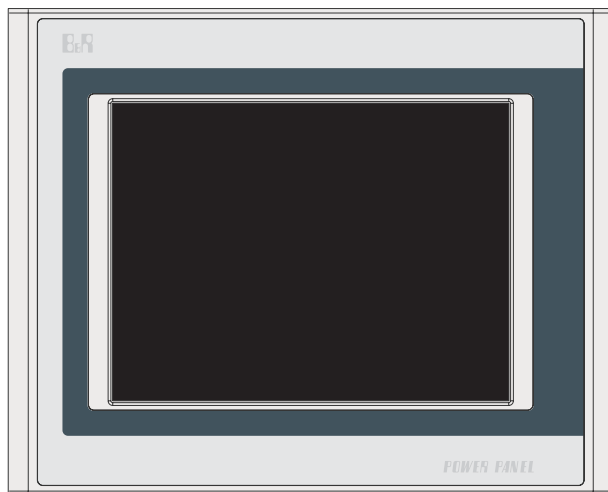


Figure 49: Front view - 4PP320.1043-31

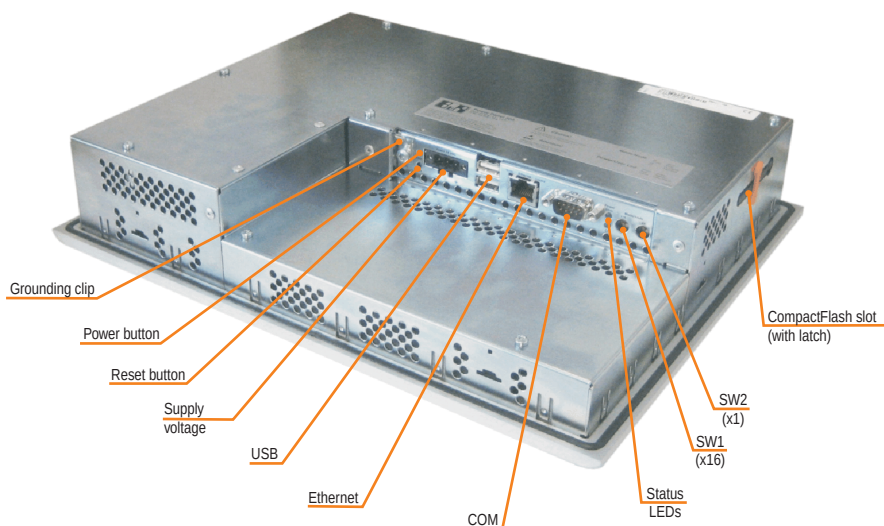


Figure 50: Rear view - 4PP320.1043-31

3.5.1 Technical data

Features	4PP320.1043-31
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	-
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 38: Technical data - 4PP320.1043-31

Technical data • Power Panel 300 with Automation Runtime

Features	4PP320.1043-31
USB interface	
Type	USB 1.1, USB 2.0 ³⁾
Amount	2
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ³⁾
Connection	Type A
Current load	Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display	
Type	TFT colors
Diagonal	10.4 in (264 mm)
Colors	262144 colors ³⁾
Resolution	VGA, 640 x 480 pixels
Contrast	600:1
Perspective (see page 370)	
Horizontal	Direction R / direction L = 70°
Vertical	Direction U = 45° / direction D = 35°
Background lighting	
Brightness	450 cd/m²
Half-brightness time	55000 hours
Touch screen	
Technology	Analog, resistive
Controller	Elo, serial, 12- bit
Degree of transmission	Up to 80% ± 5%
Filter glass	-
Degree of transmission	
Coating	
Keys/LED	-
Function keys	
Soft keys	
Cursor keys	
Number block	
Other keys	
Key lifespan	
LED brightness	
Electrical characteristics	
Power supply	
Rated voltage	18 - 30 VDC
Rated current	0.63 A
Starting current	Maximum 2.8 A
Power consumption	typically 15 W
Electrical isolation	Yes
Ground resistance	0 Ohm
Outer dimensions	
Width	323 mm
Height	260 mm
Depth	65,5 mm

Table 38: Technical data - 4PP320.1043-31 (cont.)

Mechanical characteristics	4PP320.1043-31
Front	
Frame	Aluminum, naturally anodized ⁴⁾
Design	Gray ⁴⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁴⁾
Light background	Similar to Pantone 427CV ⁴⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 3.7 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 38: Technical data - 4PP320.1043-31 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) The actual value depends on the operating system or diver being used.
- 4) Depending on the process or batch, there may be visible deviations in the color and surface structure.

3.5.2 Dimensions

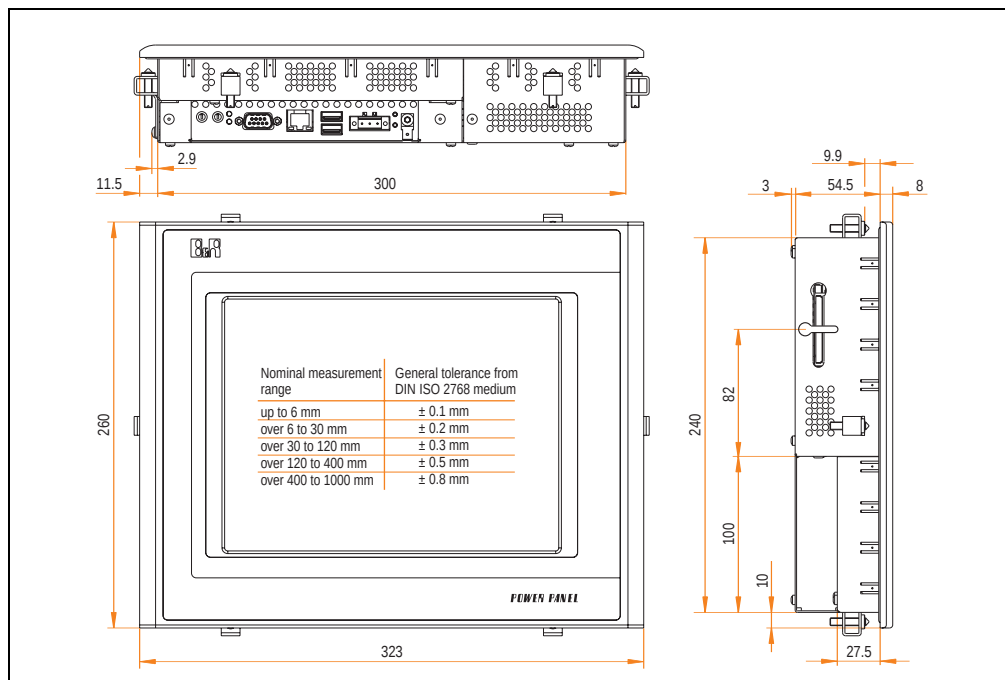


Figure 51: Dimensions 4PP320.1043-31

3.5.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

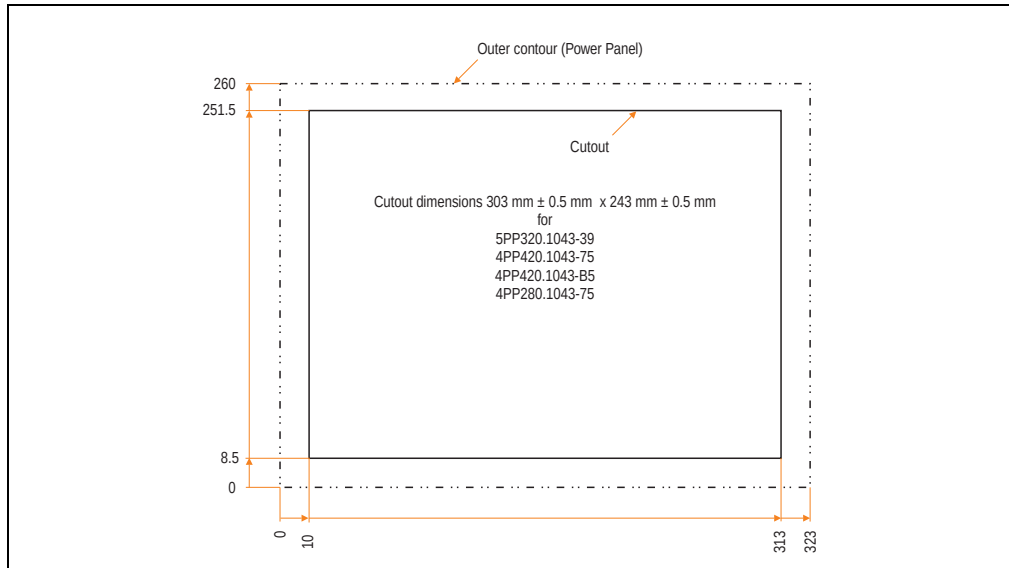


Figure 52: Cutout installation - 4PP320.1043-31

3.5.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 10.4" VGA, touch screen
6	Retaining clips included

Table 39: Contents of delivery - 4PP320.1043-31

3.6 Device 4PP320.1505-31



Figure 53: Front view - 4PP320.1505-31

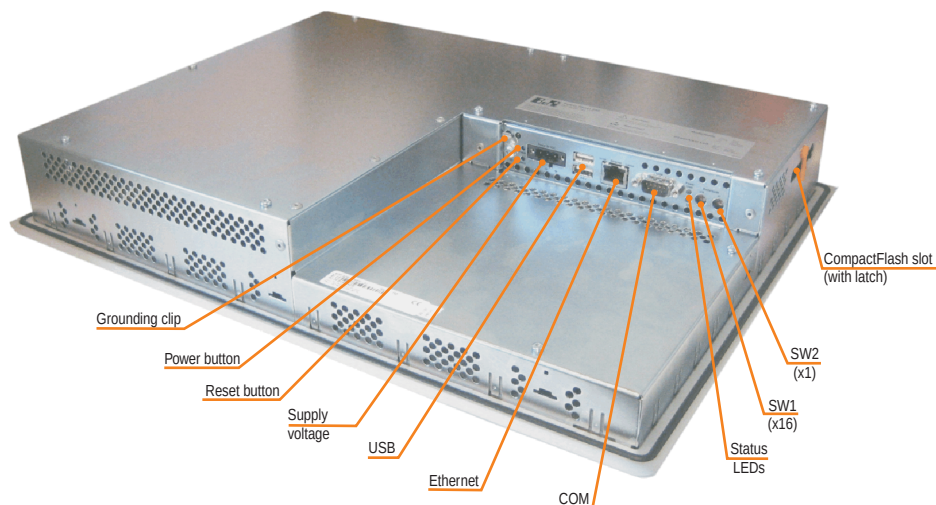


Figure 54: Rear view - 4PP320.1505-31

3.6.1 Technical data

Features	4PP320.1505-31
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	-
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ -
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	-
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 40: Technical data - 4PP320.1505-31

Technical data • Power Panel 300 with Automation Runtime

Features	4PP320.1505-31
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ³⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ³⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	-
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 15 in (381 mm) 262144 colors ³⁾ XGA, 1024 x 768 pixels 400:1 Direction R / direction L = 85° Direction U / direction D = 85° 250 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 1.25 A Maximum 2 A typically 30 W Yes
Ground resistance	0 Ohm
Outer dimensions Width Height Depth	435 mm 330 mm 71.5 mm

Table 40: Technical data - 4PP320.1505-31 (cont.)

Mechanical characteristics	4PP320.1505-31
Front	
Frame	Aluminum, naturally anodized ⁴⁾
Design	Gray ⁴⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁴⁾
Light background	Similar to Pantone 427CV ⁴⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 6.3 kg
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 40: Technical data - 4PP320.1505-31 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) The actual value depends on the operating system or diver being used.
- 4) Depending on the process or batch, there may be visible deviations in the color and surface structure.

3.6.2 Dimensions

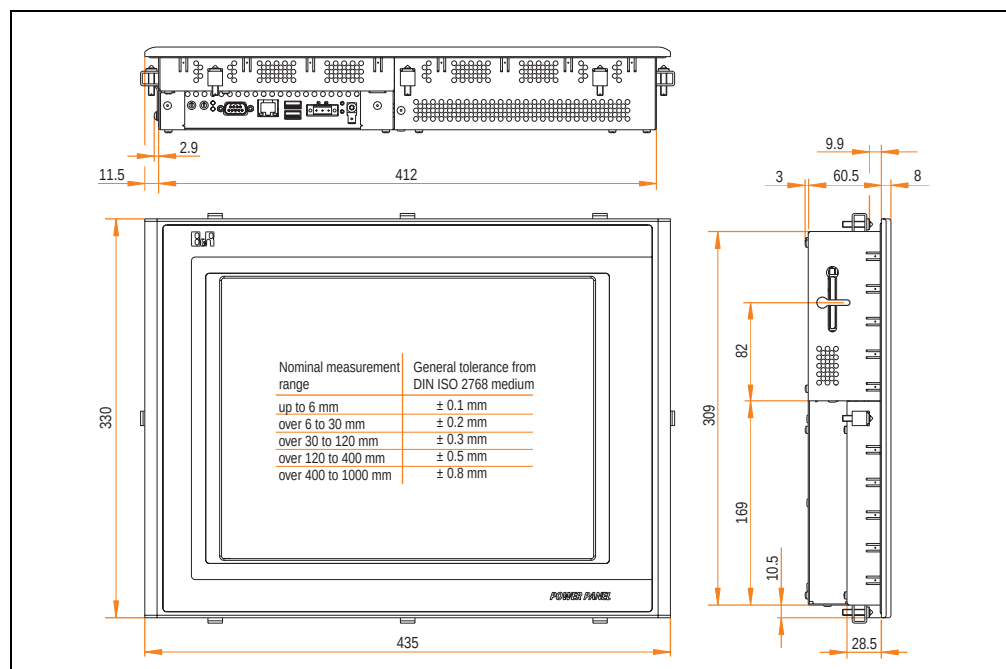


Figure 55: Dimensions 4PP320.1505-31

3.6.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

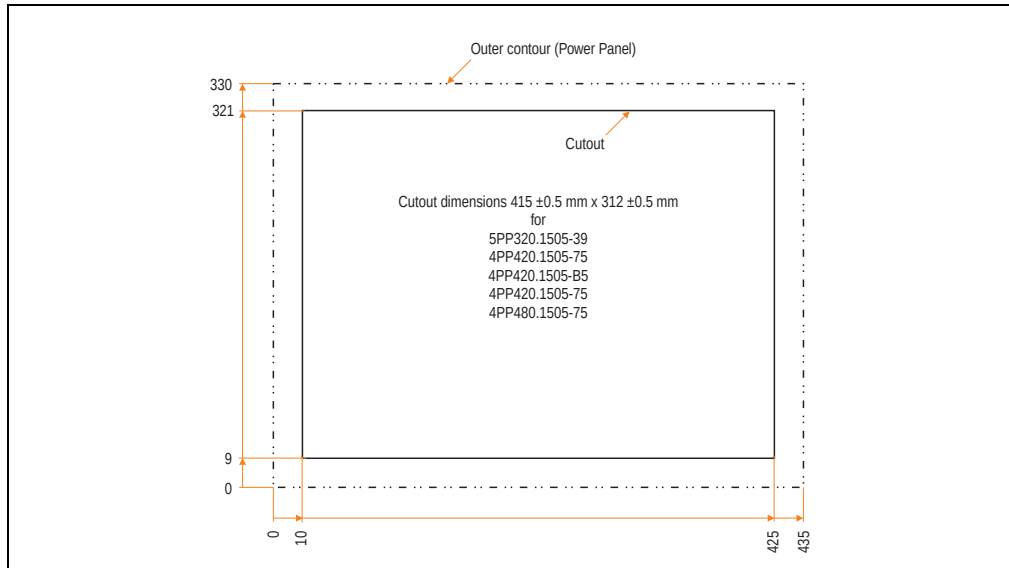


Figure 56: Cutout installation - 4PP320.1505-31

3.6.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP320 BIOS 15" XGA, touch screen
8	Retaining clips included

Table 41: Contents of delivery - 4PP320.1505-31

4. Power Panel 400 with Automation Runtime

4.1 Device interfaces

The following section provides a description of all interfaces and plugs possible with a Power Panel 400 device with Automation Runtime.

4.1.1 Supply voltage

Input voltage: 18 - 30 VDC

The 3-pin socket required for the supply voltage connection is not included in delivery. This can be ordered from B&R using the model number OTB103.9 (screw clamps) or OTB103.91 (cage clamps).

The pin assignments can be found either in the following table or printed onto the Power Panel plate. The supply voltage is internally protected so that the device cannot be damaged if there is an overload (fuse replacement necessary) or if the voltage supply is connected incorrectly (reverse polarity protection - fuse replacement not necessary).

Supply voltage	
Protected against reverse polarity	
Pin	Description
1	-
2	Functional grounding
3	+
Accessories	
OTB103.9	Plug 24 V 5.08 3p screw clamps
OTB103.91	Plug 24 V 5.08 3p cage clamps



Figure 57: Supply voltage connection

Ground

Important!

The pin's connection to the functional ground (pin 2, e.g. switching cabinet) should be as short as possible. We recommend using the largest possible conductor cross section on the supply plug.

4.1.2 Functional grounding clip

Next to the supply voltage plug there is a functional grounding clip. The grounding clip (functional ground) must be connected with a central grounding point on the switching cabinet using a 6.3 mm blade connector via the shortest distance and with as little resistance as possible (e.g. copper strip, but must be at least 2.5 mm²).

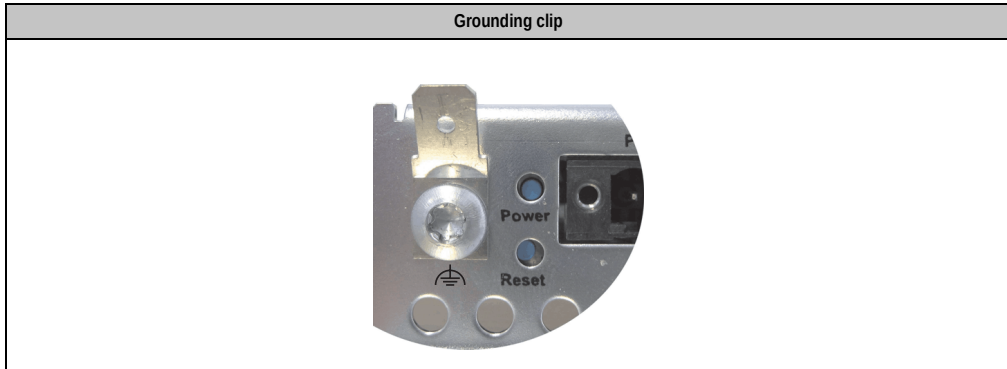


Figure 58: Functional grounding clip

4.1.3 Serial interface COM

The Power Panel is equipped with a PC-compatible serial interface with a 16-byte FIFO buffer. This non-electrically isolated interface is primarily intended for programming Power Panel devices using Automation Studio.

The RS232 can also be used as a general interface (e.g. third-party connections, barcode reader, etc.).

Serial interface (COM)		9-pin DSUB connector 
Type	RS232, modem-capable, not electrically isolated	
UART	16C550 compatible, 16-byte FIFO	
Transfer rate	Up to 115 kBaud	
Pin	Assignment	
1	DCD	
2	RxD	
3	TxD	
4	DTR	
5	GND	
6	DSR	
7	RTS	
8	CTS	
9	RI	

Table 42: Pin assignments - COM

4.1.4 USB port

The Power Panel 300/400 devices have a USB 2.0 (Universal Serial Bus) host controller with multiple USB ports, two of which are on the outside for easy user access.

Universal serial bus		
Transfer rate ¹⁾	Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s)	2x USB Type A, female 
Power supply	Max. 500 mA per port ²⁾	
Maximum cable length	5 m (not including hub)	

Table 43: USB port

1) The actual value depends on the operating system or diver being used.

2) For safety, every USB port is equipped with a maintenance free "USB current-limiting circuit breaker" (max. 500 mA)

Warning!

Peripheral USB devices can be connected to the USB interfaces. Due to the vast number of USB devices available on the market, B&R cannot guarantee their performance. B&R does assure the performance of all USB devices that they provide.

Important!

Because of general PC specifications, this interface should be handled with extreme care with regard to EMC, location of cables, etc.

4.1.5 Mode/Node switches

Power Panel devices are equipped with 2 hex switches that serve as operating mode switches. Switch positions 01 to FD are available for any purpose in an application and can be evaluated by the application program.

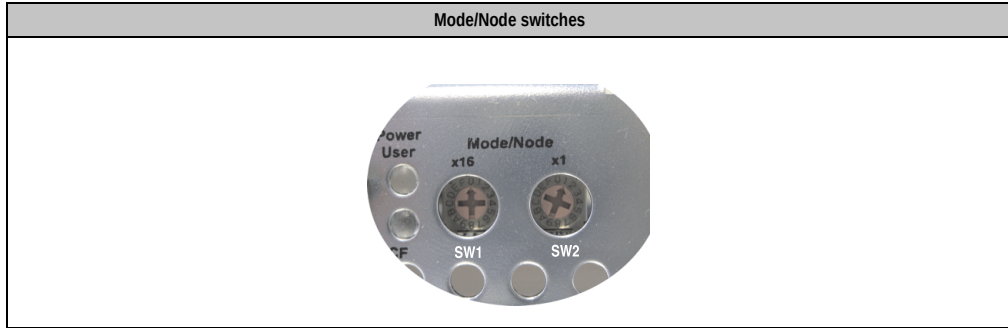


Table 44: Mode/Node switches

Switch position		Function	Description
SW1 (x16)	SW2 (x1)		
0	0	Boot	Automation Runtime boot mode for operating system (firmware) upgrade (default: Automation Runtime). In this position, a new or missing operating system can be downloaded.
0 ... F	0 ... D	Node	Automation Runtime run mode with node 01-FD (CompactFlash Automation Runtime or terminal operation). Freely available for use in an application, e.g. setting the INA2000 node number for the Ethernet interface.
F	E	Dyn. mode	Automation Runtime run mode with node 01-FD (CompactFlash Automation Runtime or terminal operation). Device addresses can be assigned through the software.
F	F	Diagnostics	Automation Runtime diagnostics mode (CompactFlash Automation Runtime or terminal operation).

Table 45: Switch settings for the Mode/Node switch

4.1.6 Status LEDs

Power Panels are equipped with two status LEDs that are visible on the outside.

Status LEDs			
LED	Color	On	Meaning
Power	Green	On	Supply voltage OK
	Red	On	The system is in standby mode (S5: soft-off mode or S4: hibernate mode - suspend-to-disk)
User	Yellow	On	Freely available for use in an application (e.g. can be switched on/off directly via the ADI Library - only possible in the S0 state). S0 Zustand möglich).
	Green	Off	
CF	Yellow	On	Indicates access to CompactFlash drive (read or write)

1x three-color, 1x one-color



Figure 59: Status LEDs

4.1.7 Ethernet connection

Ethernet connection		
Controller	Intel 82551ER	
Cabling	S/STP (category 5)	
Transfer rate	10/100 MBit/s ¹⁾	
LED	On	Off
Green	100 MBit/s	10 MBit/s
Orange	Link (Ethernet network connection available)	Activity (blinking) (Data transfer in progress)

RJ45 twisted pair (10BaseT/100BaseT), female



Table 46: Ethernet connection

1) Both operating modes possible. Change-over takes place automatically.

4.1.8 Power button

Due to the complete ATX power supply support, the power button serves a number of functions, which can be configured in BIOS setup.

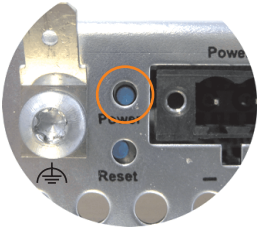
Power button	
The power button can be pressed with a pointed object (i.e. paper clip or tip of a pen). If the button is pressed for longer than 4 seconds, the ATX power supply switches the Power Panel off (loss of data possible!)	 A circular inset image showing a close-up of the front panel of the Power Panel 400. The panel is silver-colored metal. On the left, there is a large circular power button with a power symbol. To its right, there is a smaller circular button labeled 'Power' and another labeled 'Reset'. The 'Power' button is circled in orange. To the right of the buttons is a rectangular power jack labeled 'Power'.

Table 47: Power button

4.1.9 Reset button

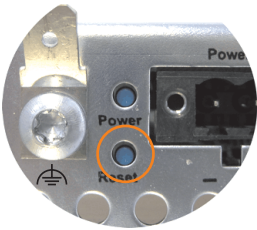
Reset button	
The reset button can be pressed with a pointed object (i.e. paper clip or tip of a pen). Pushing the reset button results in a hardware-reset. The Power Panel restarts. The MTCX processor is not reset when the reset button is pressed.	 A circular inset image showing a close-up of the front panel of the Power Panel 400. The panel is silver-colored metal. On the left, there is a large circular power button with a power symbol. To its right, there is a smaller circular button labeled 'Power' and another labeled 'Reset'. The 'Reset' button is circled in orange. To the right of the buttons is a rectangular power jack labeled 'Power'.

Table 48: Reset button

Warning!

A system reset can cause data to be lost!

4.1.10 CompactFlash slot

Power Panel devices are equipped with a CompactFlash slot that is accessible from the side. Type I CompactFlash cards are supported.

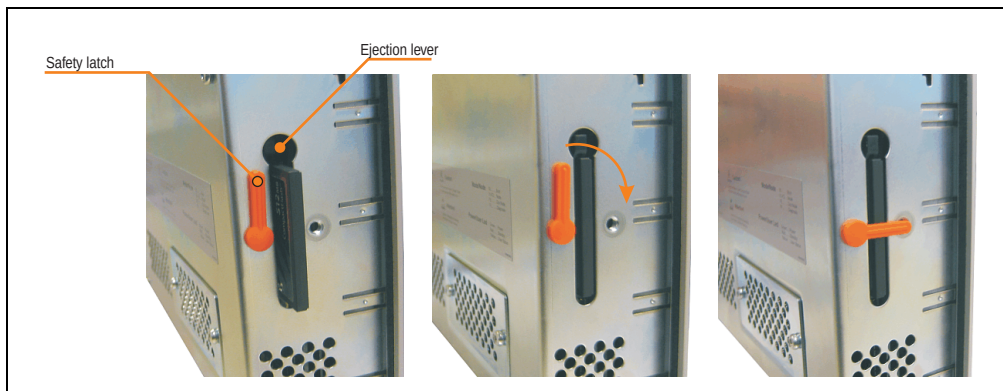


Figure 60: CompactFlash slot

It is possible to secure the CompactFlash slot using the latch provided. By pressing the ejector (using a pointed object is the best way to do this) the CompactFlash card can be changed quickly and safely.

Caution!

The power must be turned off before inserting or removing the CompactFlash card!
As a safety measure, a sticker is also attached to Power Panel devices stating this.

4.1.11 aPCI Slot(s)

Either 1 or 2 aPCI slots are available depending on the Power Panel variant. B&R System 2005 aPCI interface modules can be inserted (available aPCI interface modules - see B&R homepage - Products - Control systems - System 2005 - Communication modules).



Figure 61: aPCI Slot(s)

4.2 Stickers

4.2.1 Device label

The following sticker can be found in a suitable location on the Power Panel device:

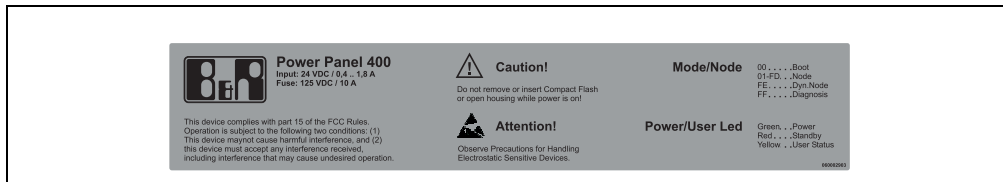


Figure 62: Device label

4.2.2 Serial number sticker

General

Each B&R device is given a unique serial number sticker with a barcode that allows the device to be clearly identified.

Design/Dimensions

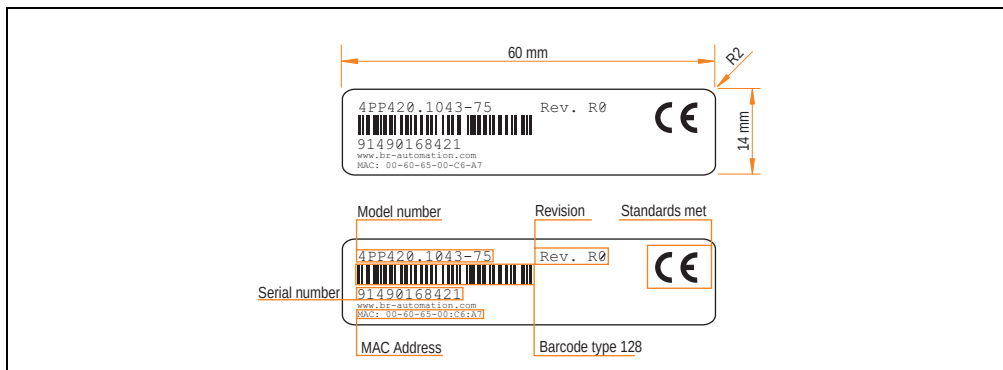


Figure 63: Design/dimensions - Serial number sticker

Information on the Internet

Information about each device can also be found on the B&R homepage. Enter the device's serial number in the serial number search field on the start page www.br-automation.com. The search also works if you enter the model number or the material number in the material number search field.

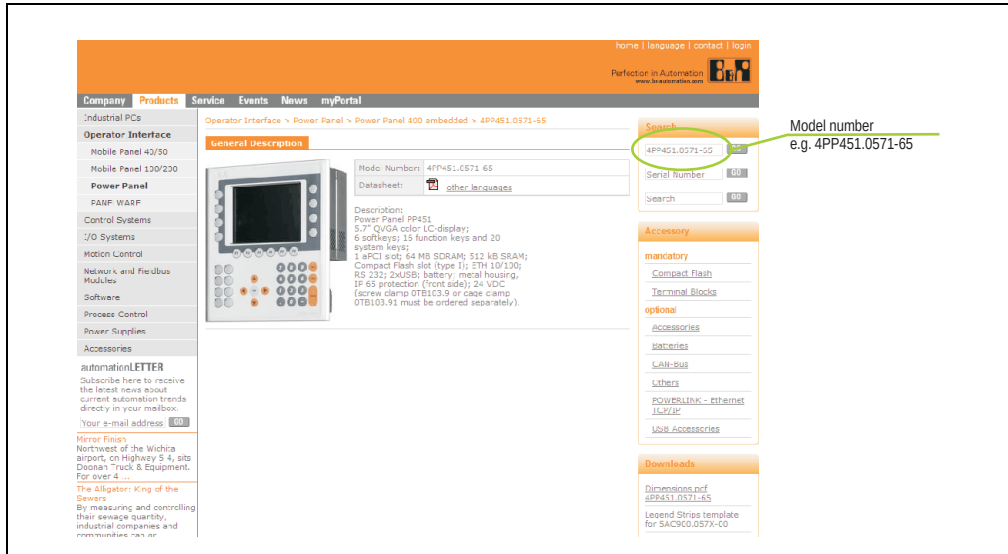


Figure 64: Example - material number search: 4PP420.0571-45

4.3 Device 4PP420.0571-45

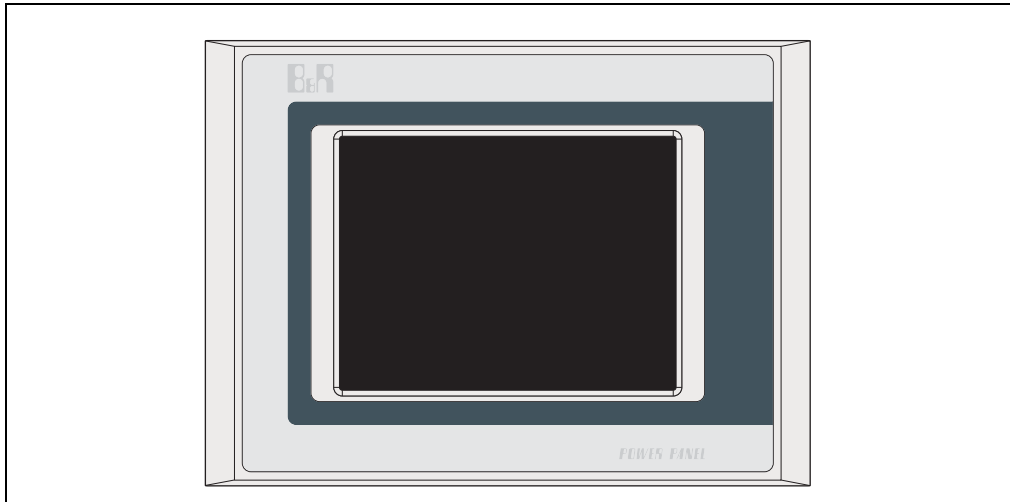


Figure 65: Front view - 4PP420.0571-45

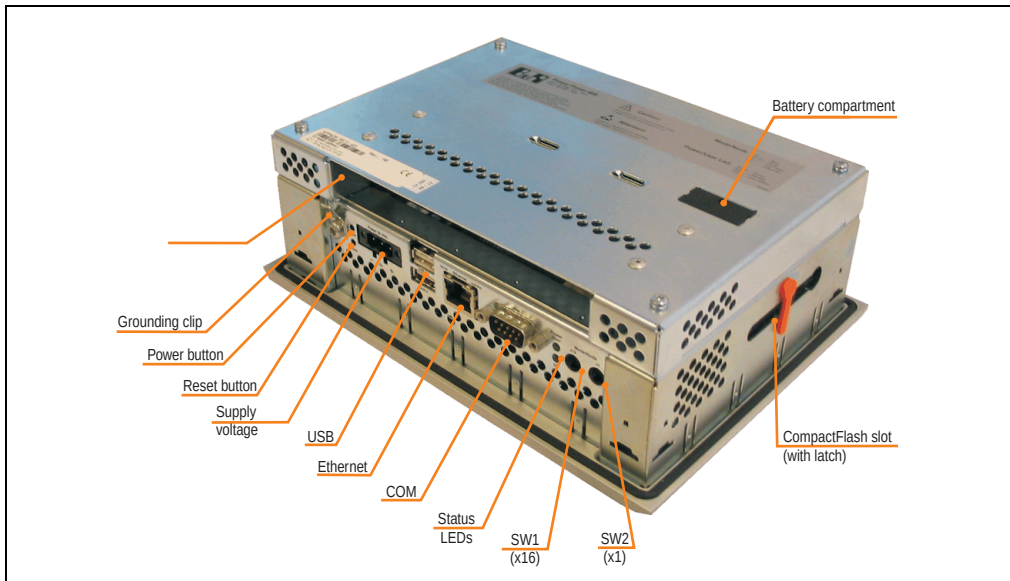


Figure 66: Rear view - 4PP420.0571-45

4.3.1 Technical data

Features	4PP420.0571-45
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 49: Technical data - 4PP420.0571-45

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.0571-45
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	LCD BW 5.7 in (144 mm) 8 shades of gray ⁴⁾ QVGA, 320 x 240 pixels 25:1 Direction R / direction L = 40° Direction U = 40° / direction D = 50° 220 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.5 A Maximum 1.2 A typically 12 W Yes
Ground resistance	0 Ohm

Table 49: Technical data - 4PP420.0571-45 (cont.)

Mechanical characteristics	4PP420.0571-45
Outer dimensions	
Width	212 mm
Height	156 mm
Depth	76 mm
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.7 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 49: Technical data - 4PP420.0571-45 (cont.)

1) Maintenance Controller Extended.

2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).

3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.

4) The actual value depends on the operating system or diver being used.

5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.3.2 Dimensions

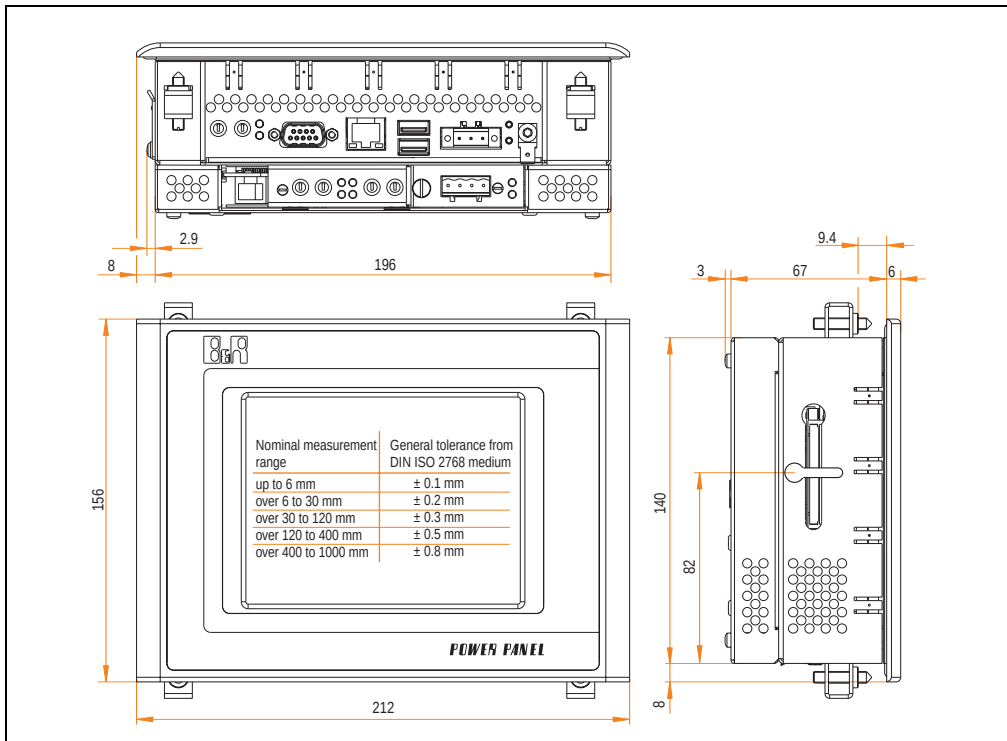


Figure 67: Dimensions - 4PP420.0571-45

4.3.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

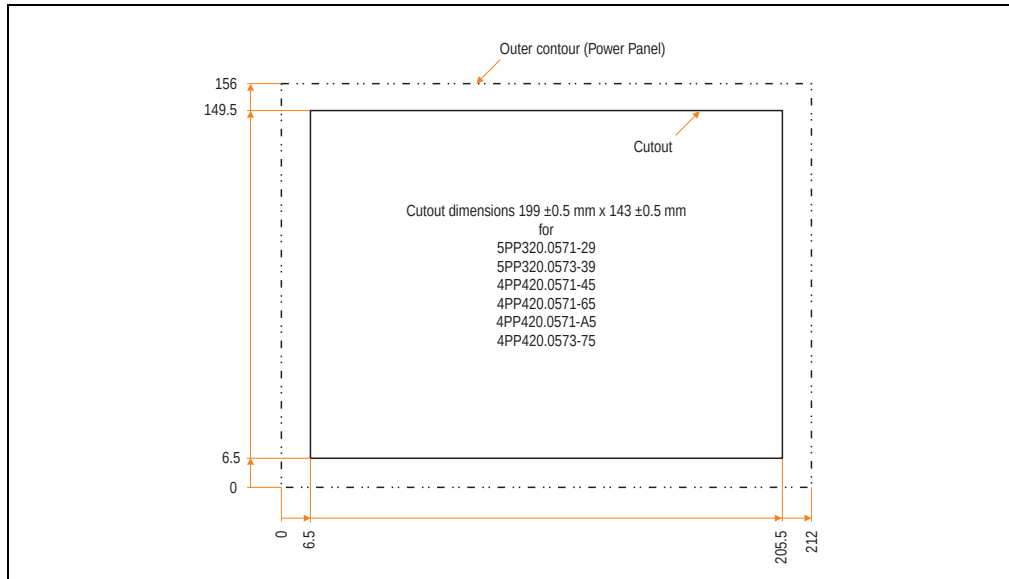


Figure 68: Cutout installation - 4PP420.0571-45

4.3.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420 5.7" QVGA, 1 aPCI, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 50: Contents of delivery - 4PP420.0571-45

4.4 Device 4PP420.0571-65

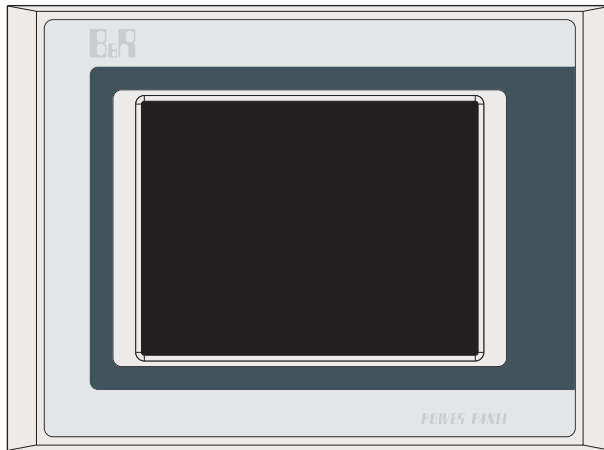


Figure 69: Front view - 4PP420.0571-65

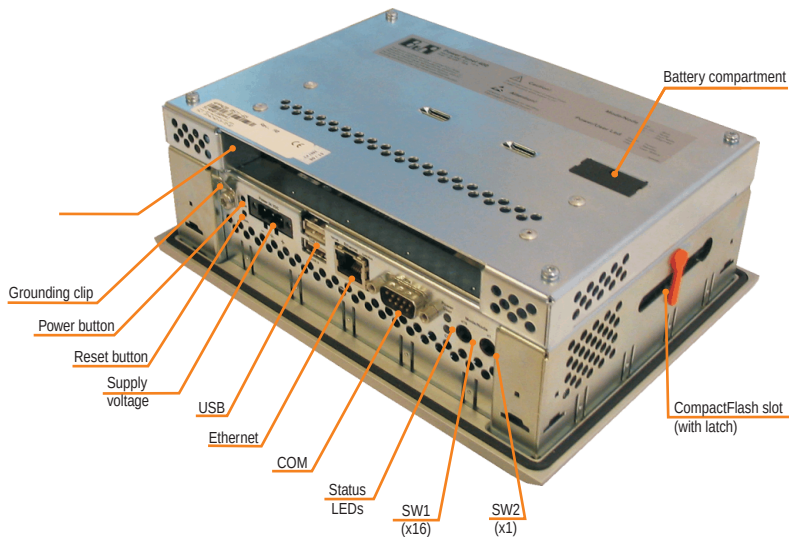


Figure 70: Rear view - 4PP420.0571-65

4.4.1 Technical data

Features	4PP420.0571-65
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 51: Technical data - 4PP420.0571-65

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.0571-65
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	Color LCD 5.7 in (144 mm) 512 colors ⁴⁾ QVGA, 320 x 240 pixels 40:1 Direction R / direction L = 40° Direction U = 40° / direction D = 50° 200 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.5 A Maximum 1.2 A typically 12 W Yes
Ground resistance	0 Ohm

Table 51: Technical data - 4PP420.0571-65 (cont.)

Mechanical characteristics	4PP420.0571-65
Outer dimensions	
Width	212 mm
Height	156 mm
Depth	76 mm
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.7 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 51: Technical data - 4PP420.0571-65 (cont.)

1) Maintenance Controller Extended.

2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).

3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.

4) The actual value depends on the operating system or diver being used.

5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.4.2 Dimensions

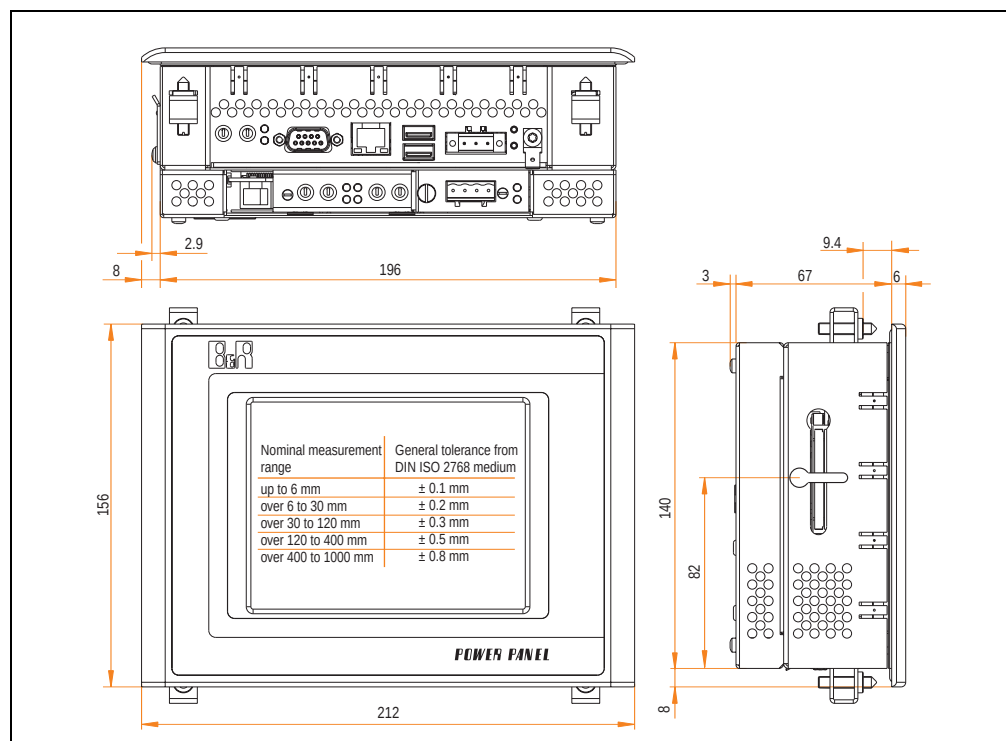


Figure 71: Dimensions - 4PP420.0571-65

4.4.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

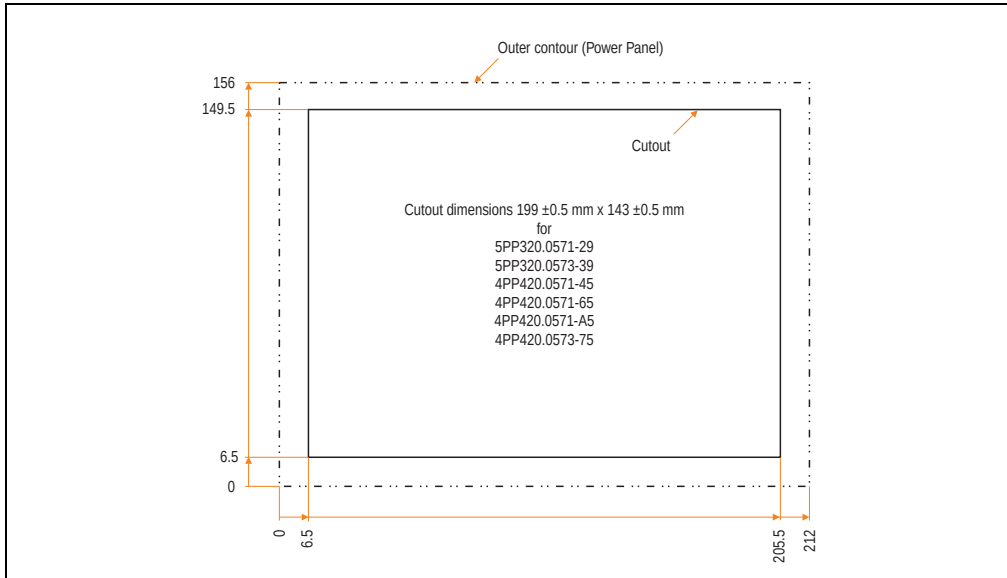


Figure 72: Cutout installation - 4PP420.0571-65

4.4.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420, 5.7" QVGA, 1 aPCI, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 52: Contents of delivery - 4PP420.0571-65

4.5 Device 4PP420.0571-75

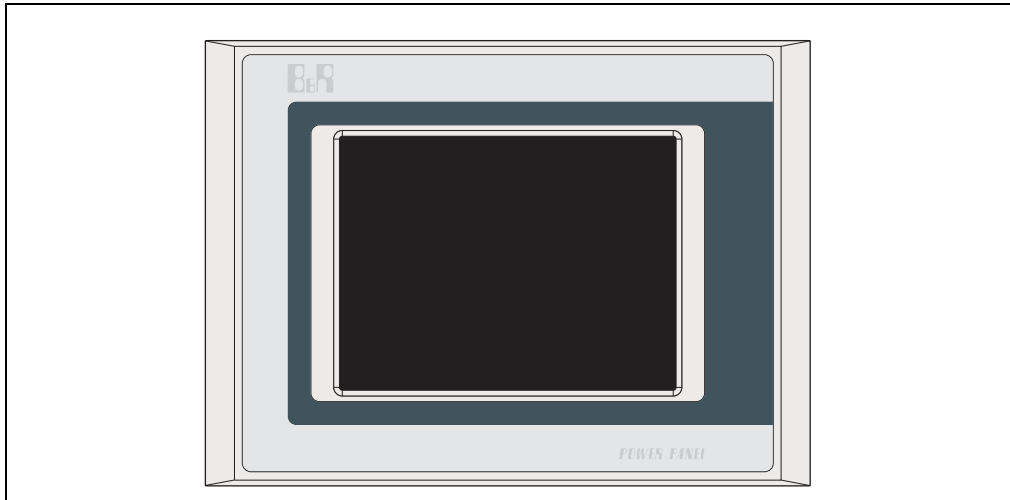


Figure 73: Front view - 4PP420.0571-75

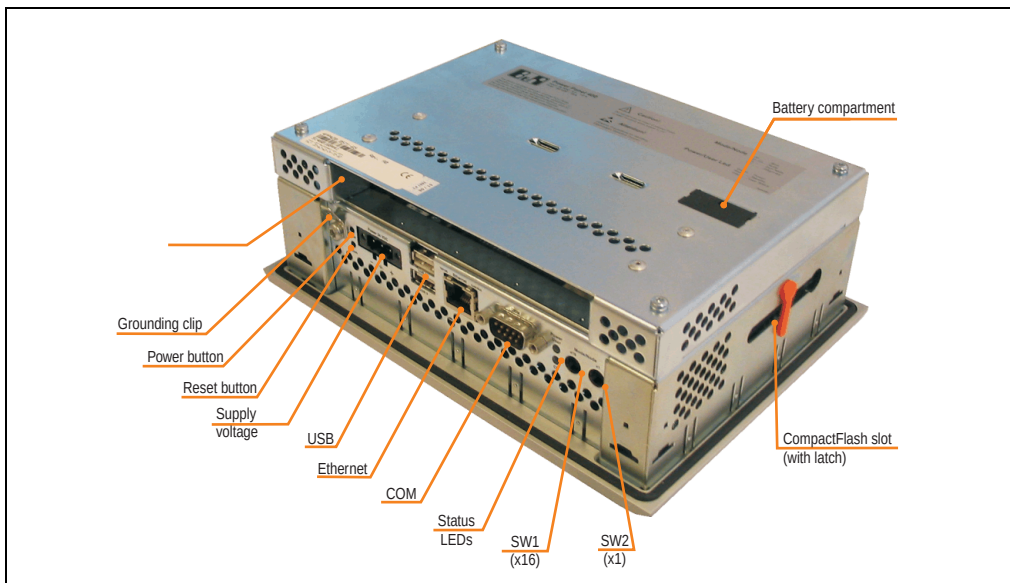


Figure 74: Rear view - 4PP420.0571-75

4.5.1 Technical data

Features	4PP420.0571-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 53: Technical data - 4PP420.0571-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.0571-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 5.7 in (144 mm) 262144 colors ⁴⁾ QVGA, 320 x 240 pixels 400:1 Direction R / direction L = 60° Direction U = 40° / direction D = 50° 500 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.5 A Maximum 1.2 A typically 12 W Yes
Ground resistance	0 Ohm
Outer dimensions Width Height Depth	212 mm 156 mm 76 mm

Table 53: Technical data - 4PP420.0571-75 (cont.)

Mechanical characteristics	4PP420.0571-75
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.7 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T <= 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 53: Technical data - 4PP420.0571-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.5.2 Dimensions

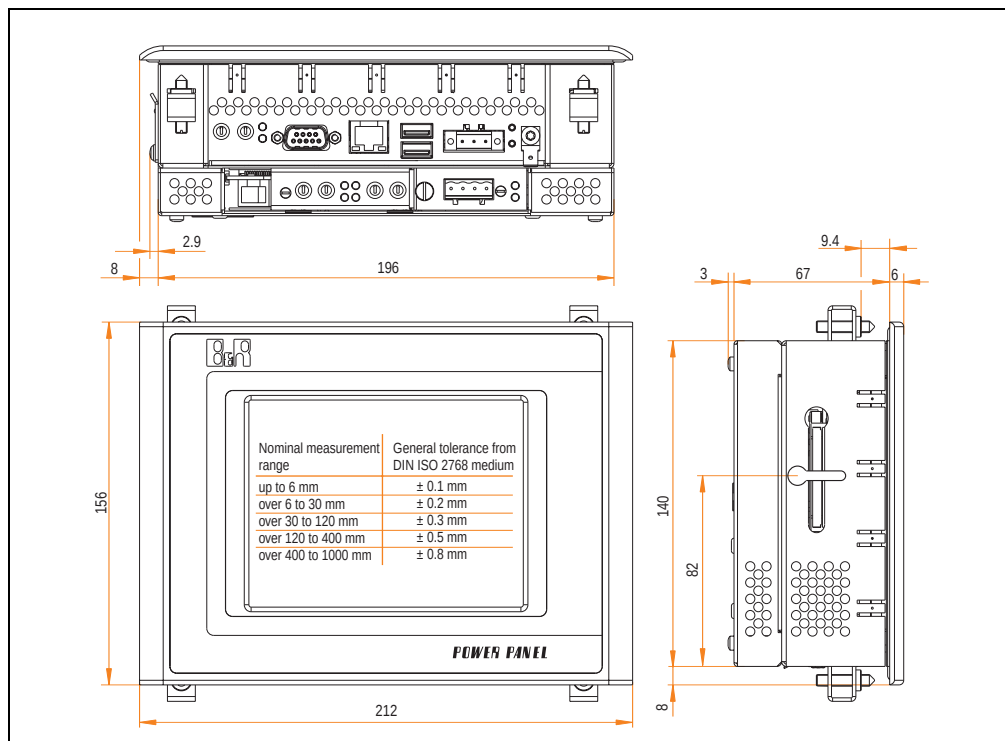


Figure 75: Dimensions - 4PP420.0571-75

4.5.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

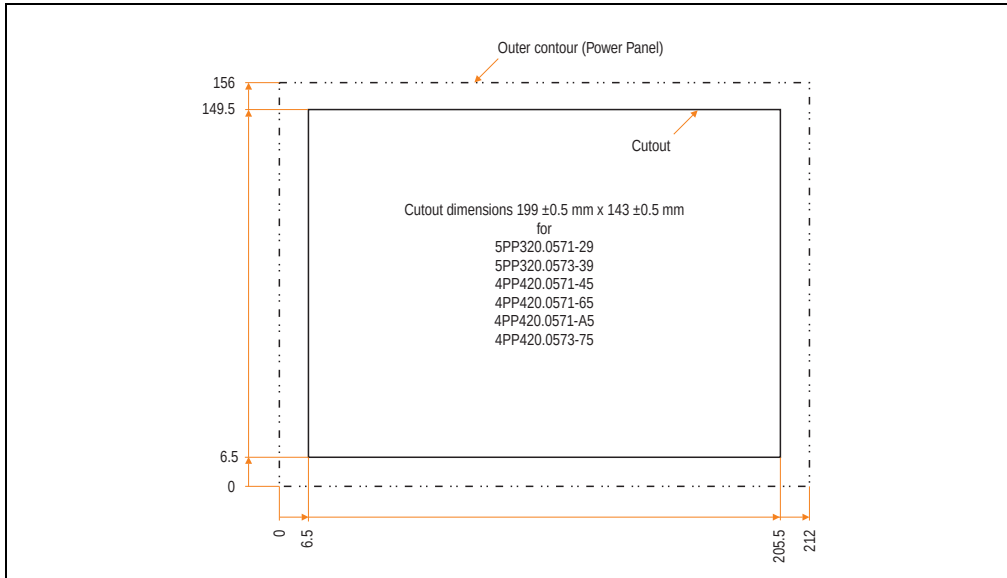


Figure 76: Cutout installation - 4PP420.0571-75

4.5.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420, 5.7" QVGA, 1 aPCI, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 54: Contents of delivery - 4PP420.0571-75

4.6 Device 4PP420.0571-A5

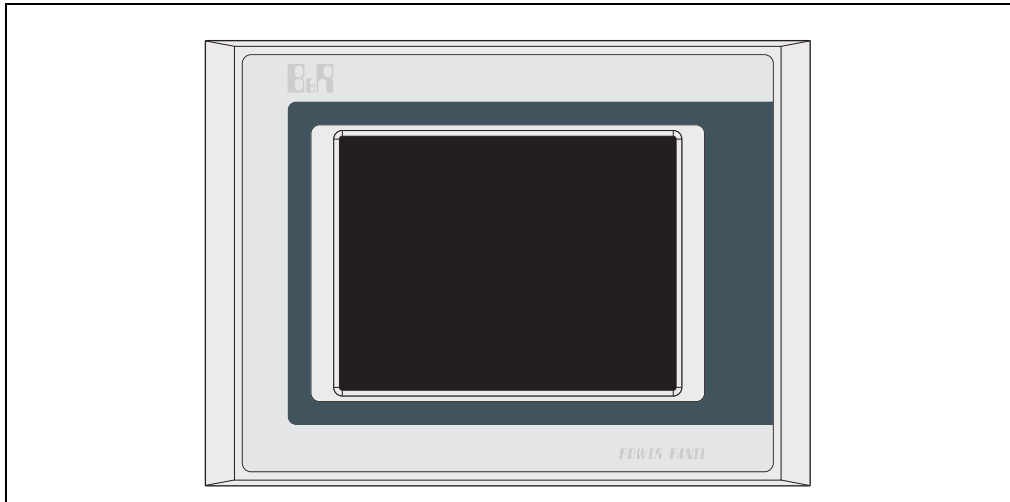


Figure 77: Front view - 4PP420.0571-A5

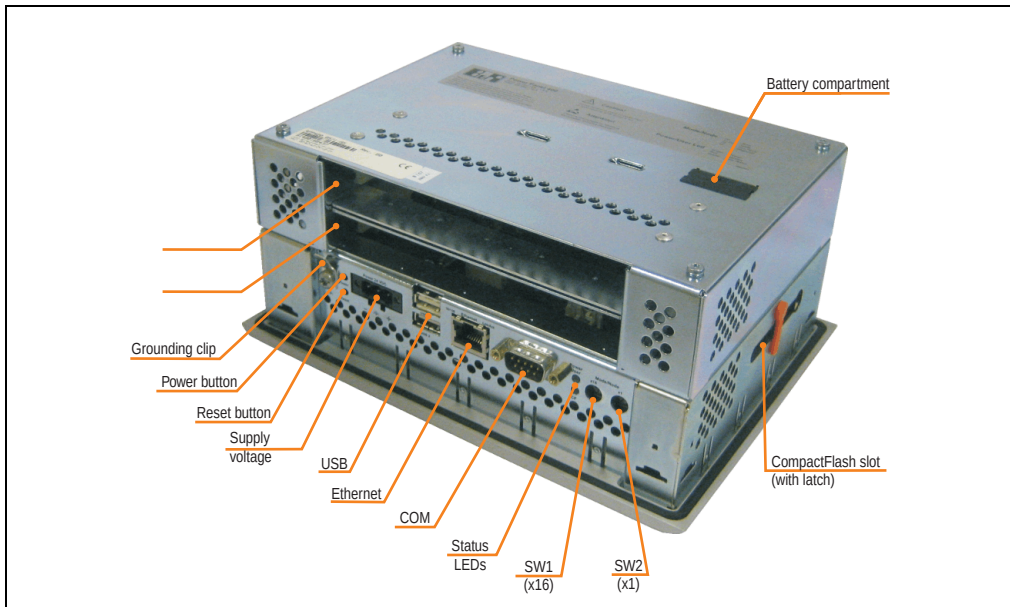


Figure 78: Rear view - 4PP420.0571-A5

4.6.1 Technical data

Features	4PP420.0571-A5
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 55: Technical data - 4PP420.0571-A5

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.0571-A5
USB interface	
Type	USB 1.1, USB 2.0 ⁴⁾
Amount	2
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾
Connection	Type A
Current load	Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	2 (see B&R System 2005 manual for available aPCI interface modules)
Display	
Type	Color LCD
Diagonal	5.7 in (144 mm)
Colors	512 colors ⁴⁾
Resolution	QVGA, 320 x 240 pixels
Contrast	40:1
Perspective (see page 370)	
Horizontal	Direction R / direction L = 40°
Vertical	Direction U = 40° / direction D = 50°
Background lighting	
Brightness	200 cd/m ²
Half-brightness time	50000 hours
Touch screen	
Technology	Analog, resistive
Controller	Elo, serial, 12- bit
Degree of transmission	Up to 80% ± 5%
Filter glass	-
Degree of transmission	
Coating	
Keys/LED	-
Function keys	
Soft keys	
Cursor keys	
Number block	
Other keys	
Key lifespan	
LED brightness	
Electrical characteristics	
Power supply	
Rated voltage	18 - 30 VDC
Rated current	0.5 A
Starting current	Maximum 1.2 A
Power consumption	typically 12 W
Electrical isolation	Yes
Ground resistance	0 Ohm
Outer dimensions	
Width	212 mm
Height	156 mm
Depth	98 mm

Table 55: Technical data - 4PP420.0571-A5 (cont.)

Mechanical characteristics	4PP420.0571-A5
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 2 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T <= 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 55: Technical data - 4PP420.0571-A5 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.6.2 Dimensions

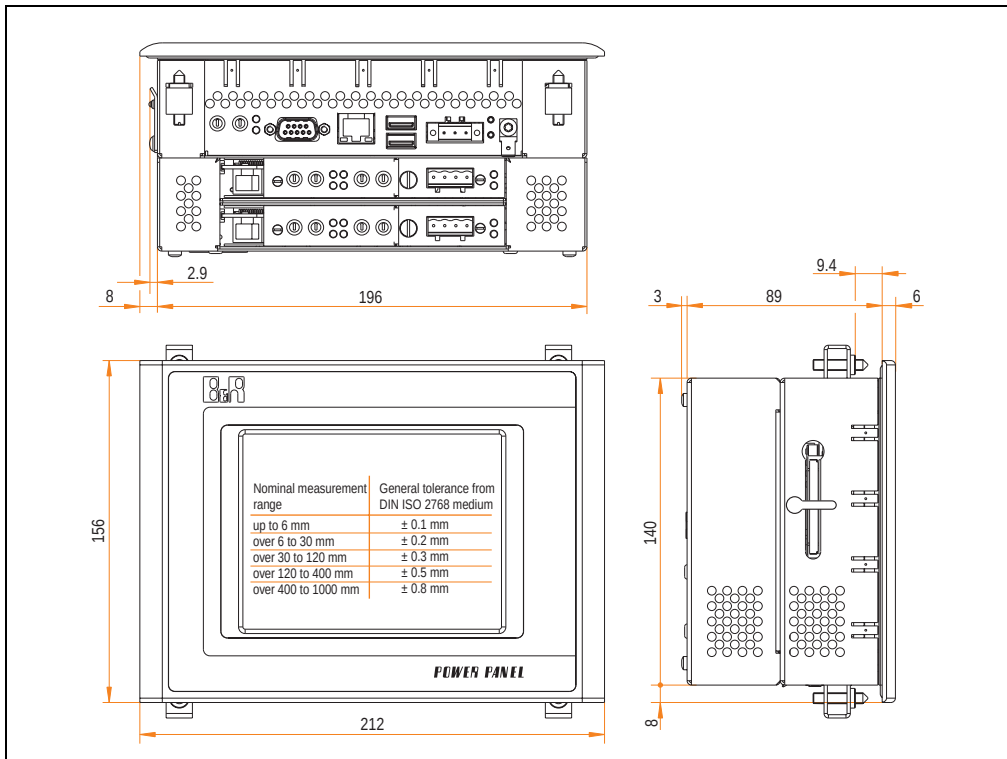


Figure 79: Dimensions - 4PP420.0571-A5

4.6.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

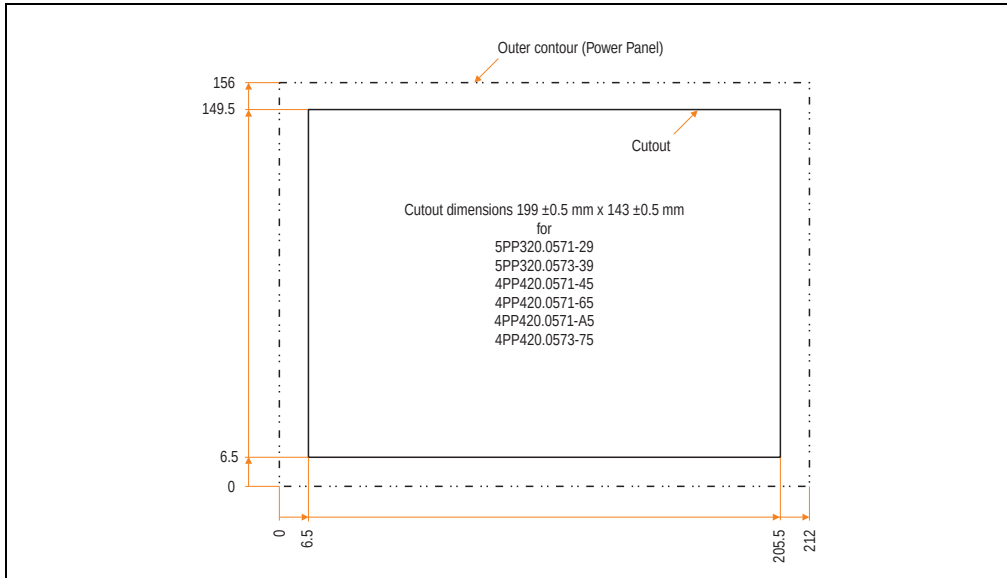


Figure 80: Cutout installation - 4PP420.0571-A5

4.6.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420, 5.7" QVGA, 2 aPCI, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 56: Contents of delivery - 4PP420.0571-A5

4.7 Device 4PP420.0571-B5

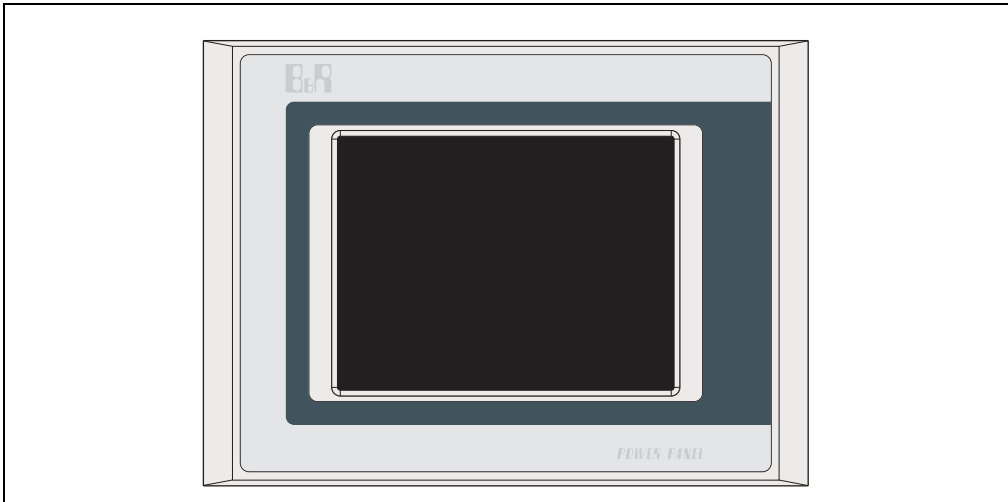


Figure 81: Front view - 4PP420.0571-B5

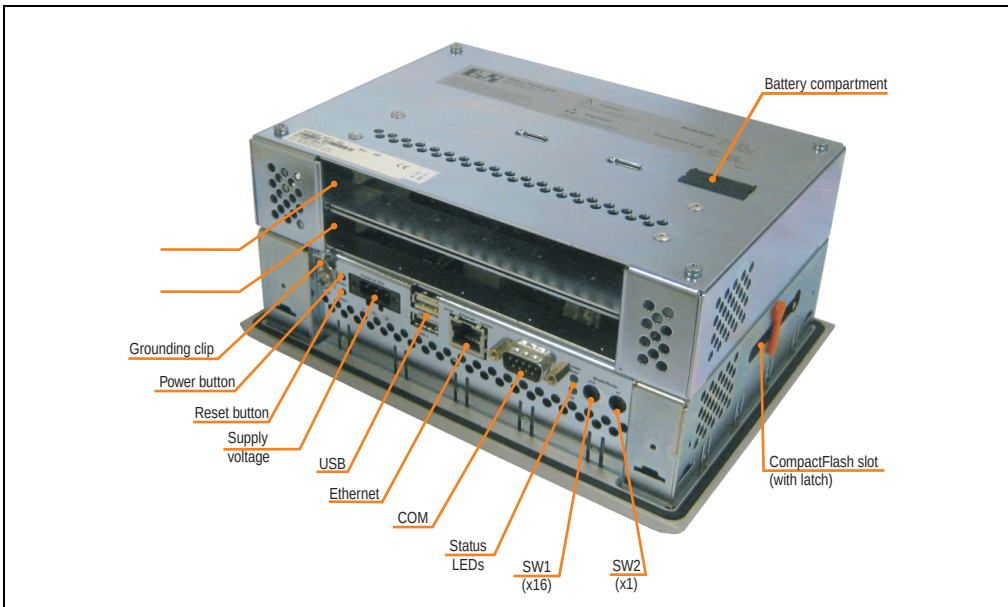


Figure 82: Rear view - 4PP420.0571-B5

4.7.1 Technical data

Features	4PP420.0571-B5
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ - -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 57: Technical data - 4PP420.0571-B5

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.0571-B5
USB interface	
Type	USB 1.1, USB 2.0 ⁴⁾
Amount	2
Transfer rate	Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾
Connection	Type A
Current load	Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	2 (see B&R System 2005 manual for available aPCI interface modules)
Display	
Type	TFT colors
Diagonal	5.7 in (144 mm)
Colors	262144 colors ⁴⁾
Resolution	QVGA, 320 x 240 pixels
Contrast	400:1
Perspective (see page 370)	
Horizontal	Direction R / direction L = 60°
Vertical	Direction U = 40° / direction D = 50°
Background lighting	
Brightness	500 cd/m ²
Half-brightness time	50000 hours
Touch screen	
Technology	Analog, resistive
Controller	Elo, serial, 12- bit
Degree of transmission	Up to 80% ± 5%
Filter glass	-
Degree of transmission	
Coating	
Keys/LED	-
Function keys	
Soft keys	
Cursor keys	
Number block	
Other keys	
Key lifespan	
LED brightness	
Electrical characteristics	
Power supply	
Rated voltage	18 - 30 VDC
Rated current	0.5 A
Starting current	Maximum 1.2 A
Power consumption	typically 12 W
Electrical isolation	Yes
Ground resistance	0 Ohm
Outer dimensions	
Width	212 mm
Height	156 mm
Depth	98 mm

Table 57: Technical data - 4PP420.0571-B5 (cont.)

Mechanical characteristics	4PP420.0571-B5
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 2 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 57: Technical data - 4PP420.0571-B5 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.7.2 Dimensions

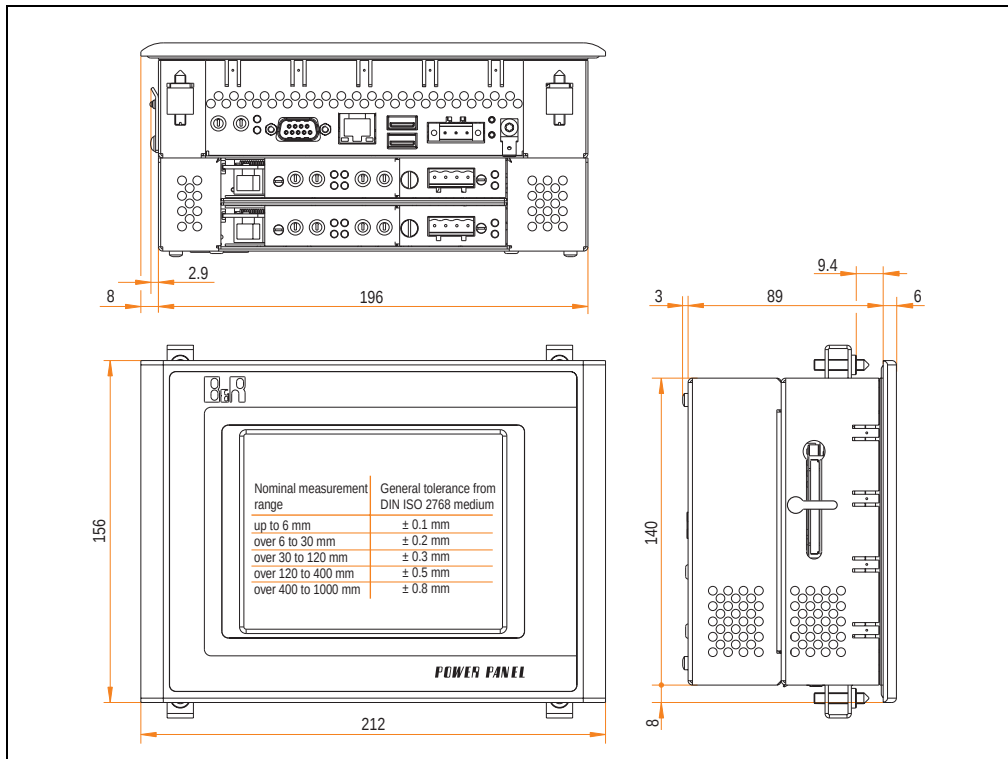


Figure 83: Dimensions - 4PP420.0571-B5

4.7.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

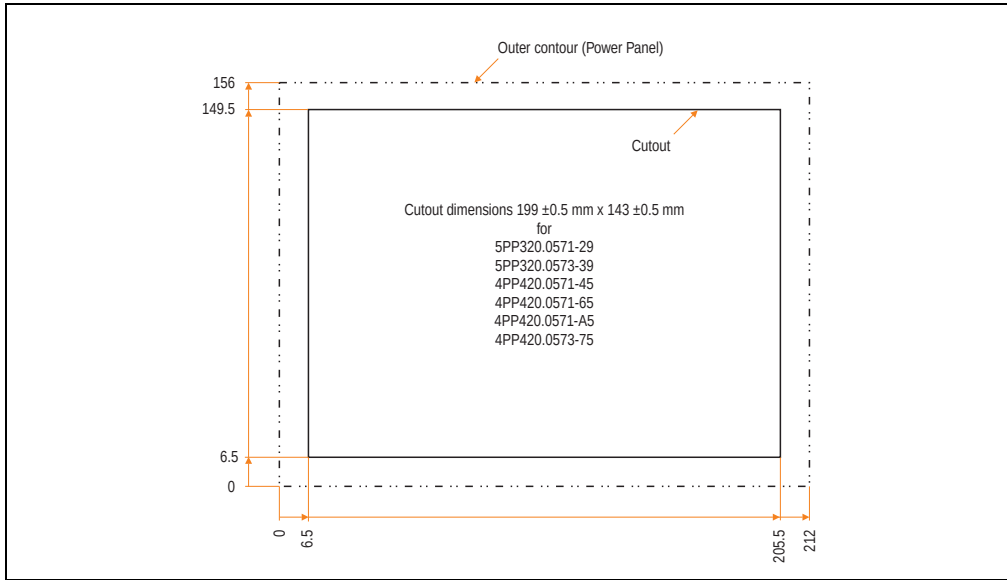


Figure 84: Cutout installation - 4PP420.0571-B5

4.7.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420, 5.7" QVGA, 2 aPCI, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 58: Contents of delivery - 4PP420.0571-B5

4.8 Device 4PP420.0573-75

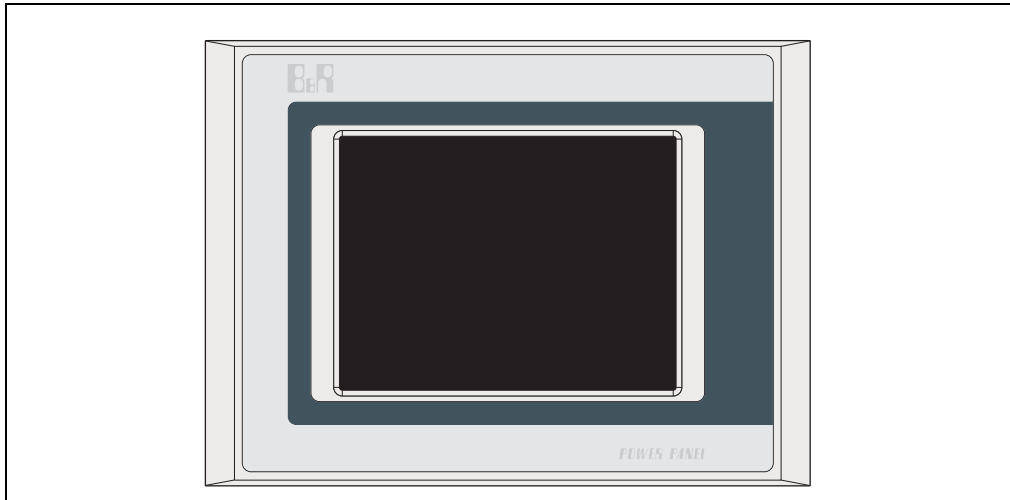


Figure 85: Front view - 4PP420.0573-75

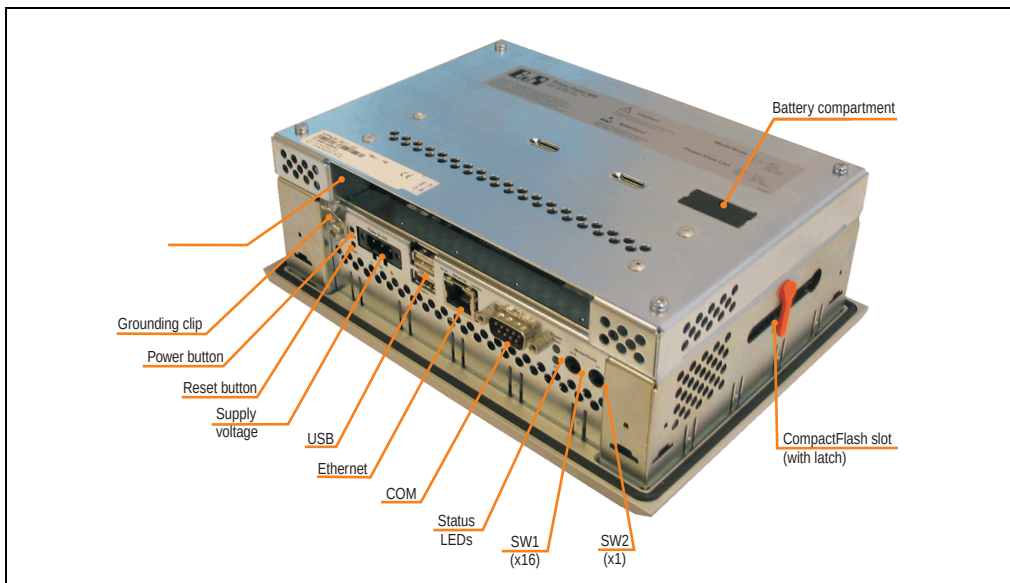


Figure 86: Rear view - 4PP420.0573-75

4.8.1 Technical data

Features	4PP420.0573-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 59: Technical data - 4PP420.0573-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.0573-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 5.7 in (144 mm) 262144 colors ⁴⁾ VGA, 640 x 480 pixels 400:1 Direction R / direction L = 80° Direction U = 80° / direction D = 70° 350 cd/m² 75000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.5 A Maximum 1.2 A typically 12 W Yes
Ground resistance	0 Ohm
Outer dimensions Width Height Depth	212 mm 156 mm 76 mm

Table 59: Technical data - 4PP420.0573-75 (cont.)

Mechanical characteristics	4PP420.0573-75
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 1.7 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 59: Technical data - 4PP420.0573-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.8.2 Dimensions

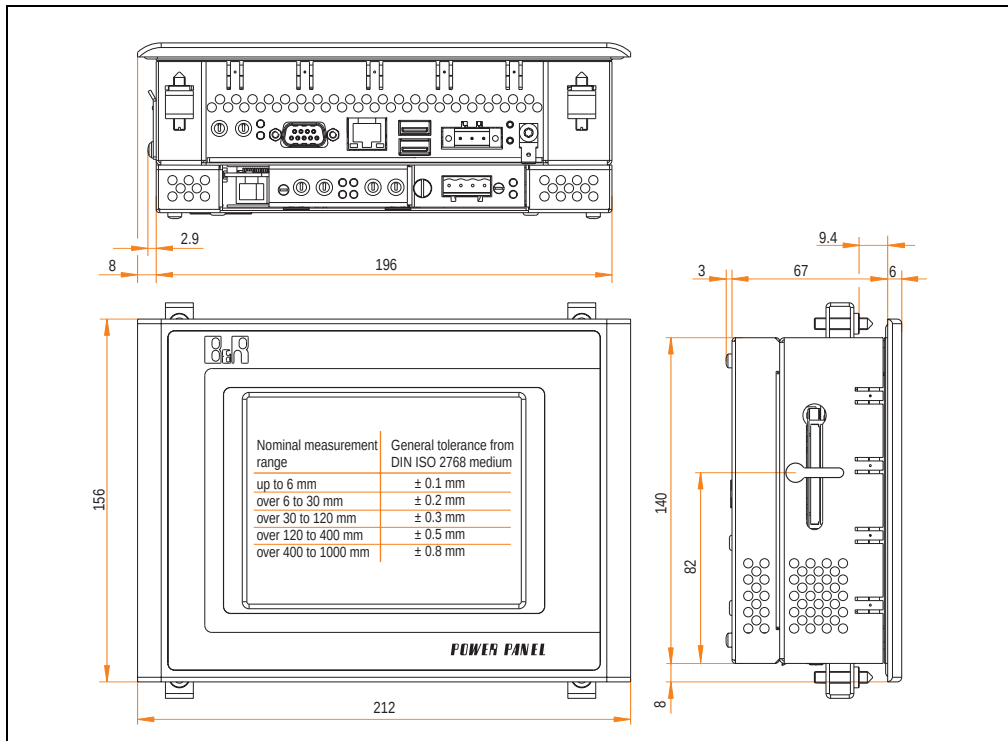


Figure 87: Dimensions - 4PP420.0573-75

4.8.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

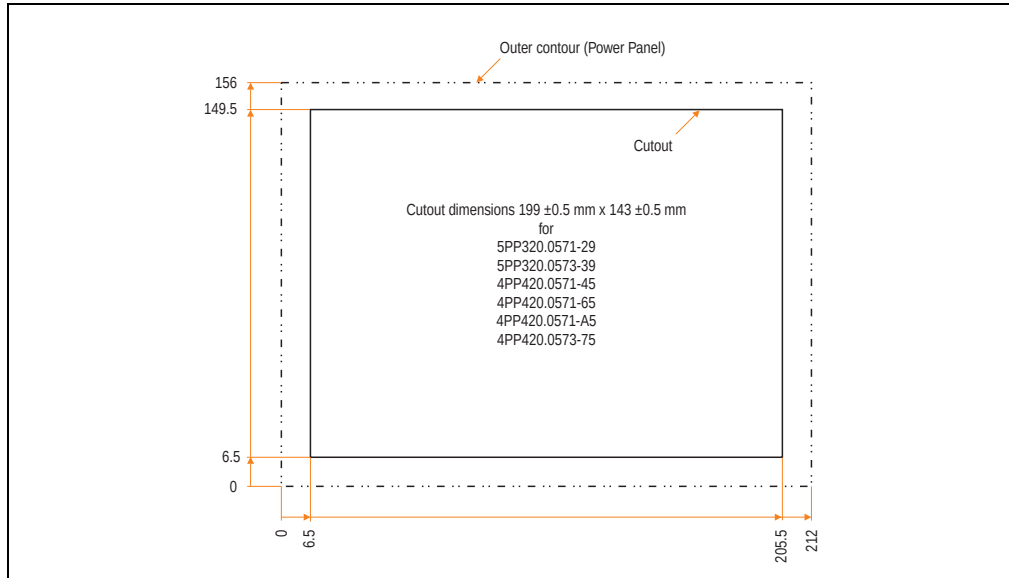


Figure 88: Cutout installation - 4PP420.0573-75

4.8.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420 5.7" VGA, 1 aPCI, touch screen
4	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 60: Contents of delivery - 4PP420.0573-75

4.9 Device 4PP420.1043-75

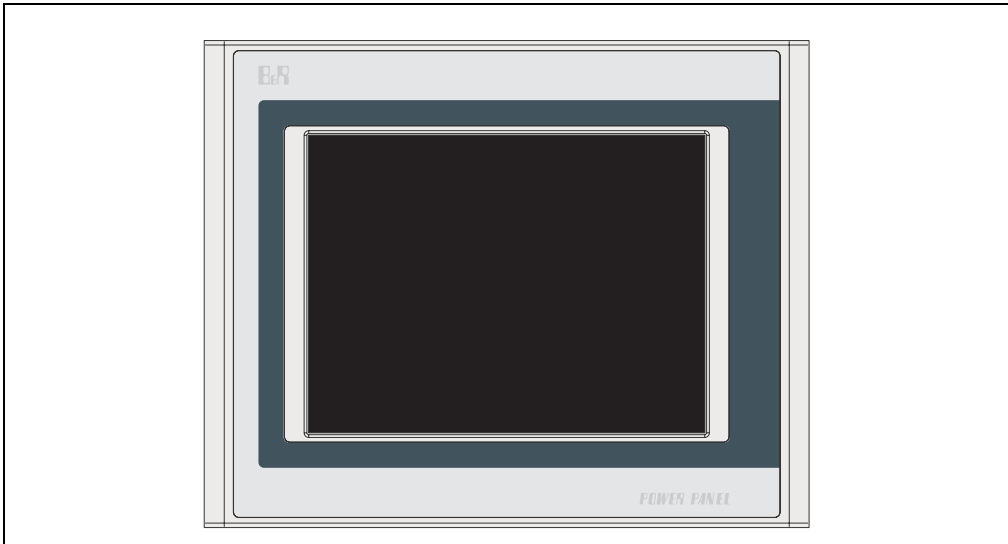


Figure 89: Front view - 4PP420.1043-75

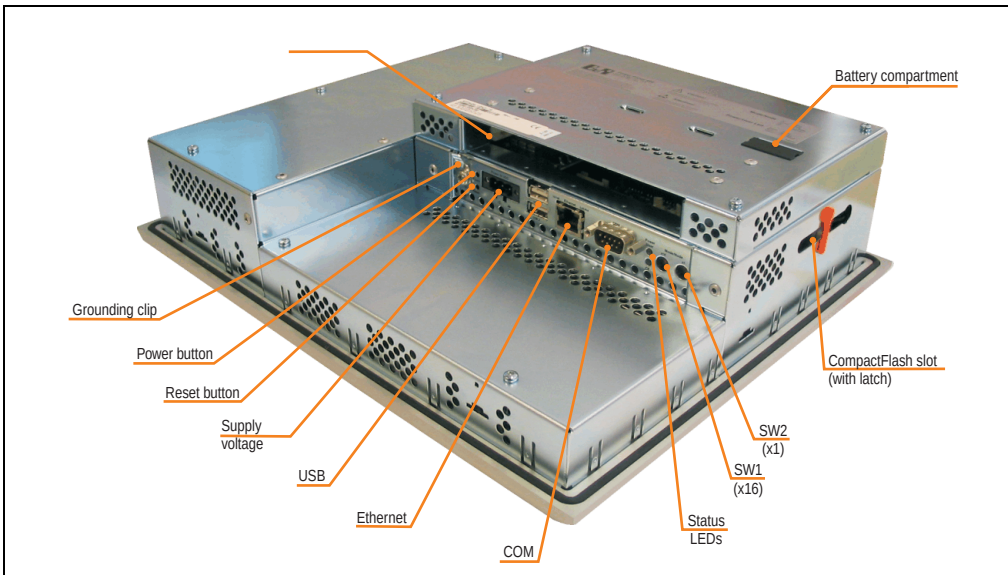


Figure 90: Rear view - 4PP420.1043-75

4.9.1 Technical data

Features	4PP420.1043-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. D0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 61: Technical data - 4PP420.1043-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.1043-75
USB interface	
Type	USB 1.1, USB 2.0 ⁴⁾
Amount	2
Transfer rate	Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s) ⁴⁾
Connection	Type A
Current load	Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display	
Type	TFT colors
Diagonal	10.4 in (264 mm)
Colors	262144 colors
Resolution	VGA, 640 x 480 pixels
Contrast	600:1
Perspective (see page 370)	
Horizontal	Direction R / direction L = 70°
Vertical	Direction U = 45° / direction D = 35°
Background lighting	
Brightness	450 cd/m ²
Half-brightness time	55000 hours
Touch screen	
Technology	Analog, resistive
Controller	Elo, serial, 12- bit
Degree of transmission	Up to 80% ± 5%
Filter glass	-
Degree of transmission	
Coating	
Keys/LED	-
Function keys	
Soft keys	
Cursor keys	
Number block	
Other keys	
Key lifespan	
LED brightness	
Electrical characteristics	
Power supply	
Rated voltage	18 - 30 VDC
Rated current	0.71 A
Starting current	Maximum 2.8 A
Power consumption	typically 17 W
Electrical isolation	Yes
Ground resistance	0 Ohm
Outer dimensions	
Width	323 mm
Height	260 mm
Depth	86 mm

Table 61: Technical data - 4PP420.1043-75 (cont.)

Mechanical characteristics	4PP420.1043-75
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 3.9 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 61: Technical data - 4PP420.1043-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.9.2 Dimensions

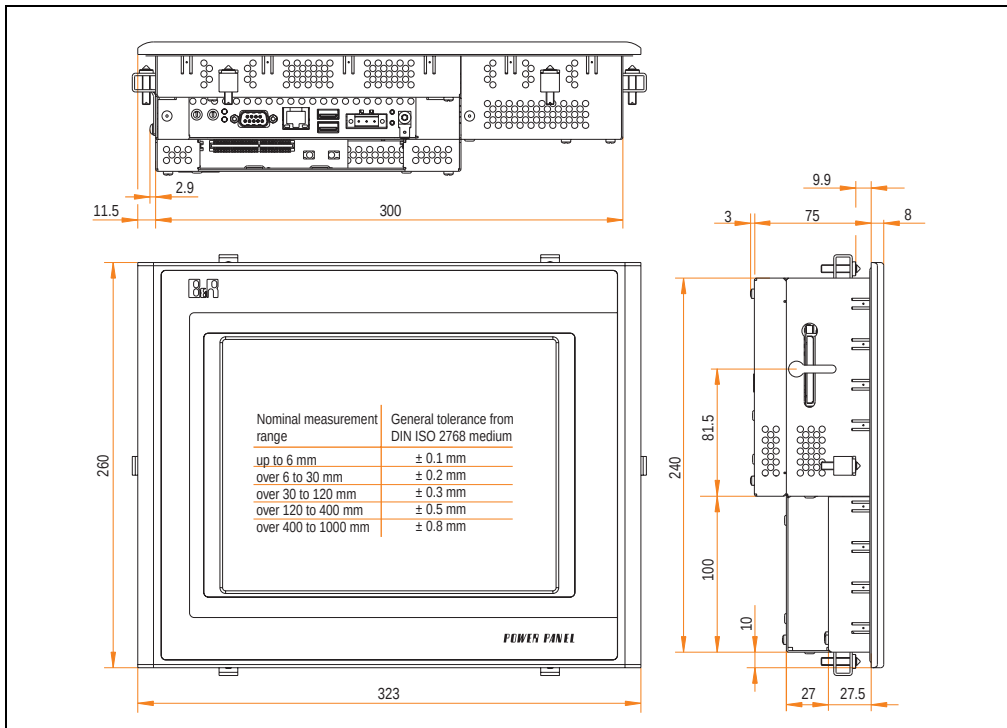


Figure 91: Dimensions - 4PP420.1043-75

4.9.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

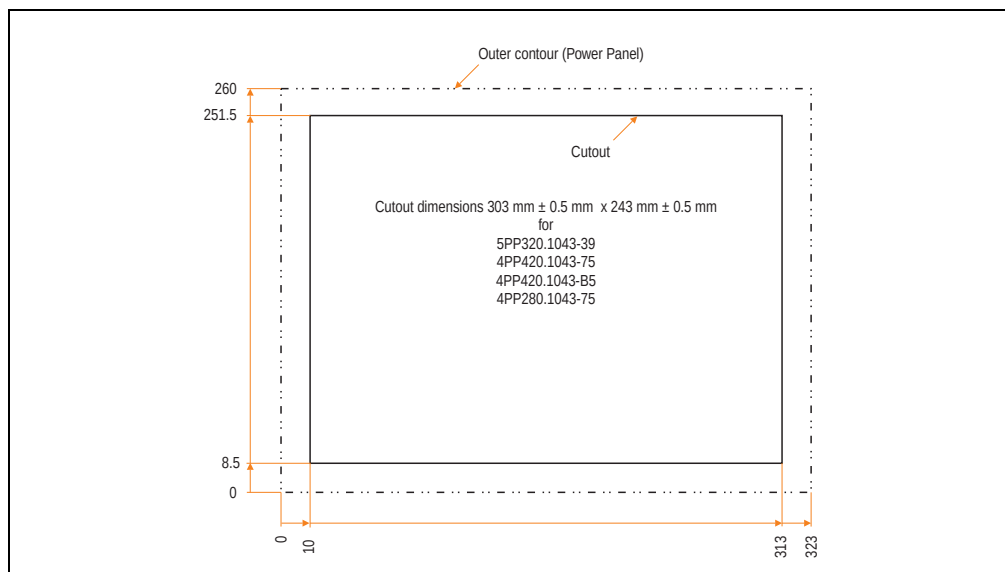


Figure 92: Cutout installation - 4PP420.1043-75

4.9.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420 10.4" VGA, 1 aPCI, touch screen
6	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 62: Contents of delivery - 4PP420.1043-75

4.10 Device 4PP420.1043-B5

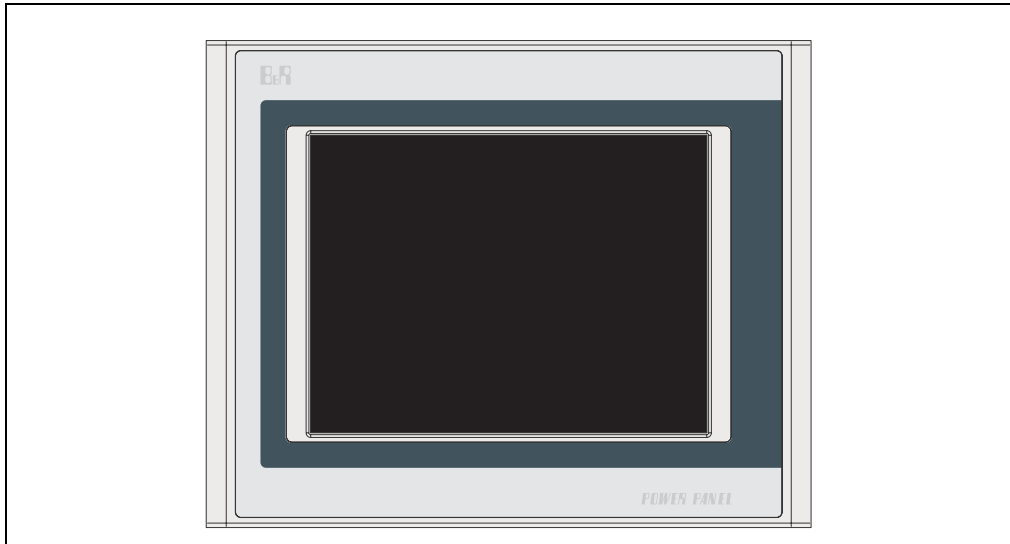


Figure 93: Front view - 4PP420.1043-B5

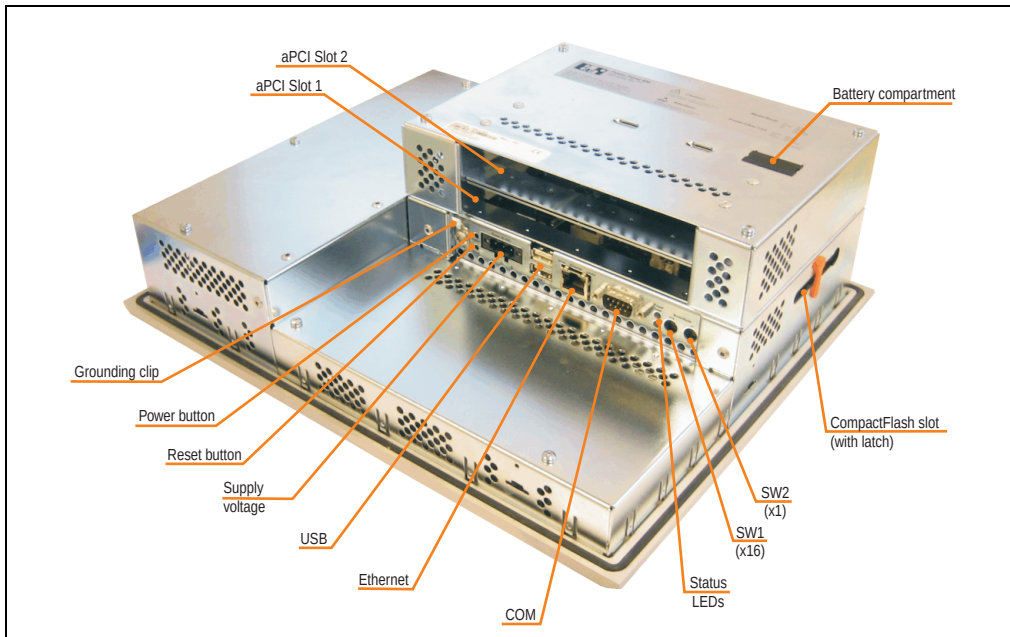


Figure 94: Rear view - 4PP420.1043-B5

4.10.1 Technical data

Features	4PP420.1043-B5
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. D0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 63: Technical data - 4PP420.1043-B5

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.1043-B5
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	2 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 10.4 in (264 mm) 262144 colors ⁴⁾ VGA, 640 x 480 pixels 600:1 Direction R / direction L = 70° Direction U = 45° / direction D = 35° 450 cd/m ² 55000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.71 A Maximum 2.8 A typically 17 W Yes
Ground resistance	0 Ohm
Outer dimensions Width Height Depth	323 mm 260 mm 108 mm

Table 63: Technical data - 4PP420.1043-B5 (cont.)

Mechanical characteristics	4PP420.1043-B5
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 4.2 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 63: Technical data - 4PP420.1043-B5 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.10.2 Dimensions

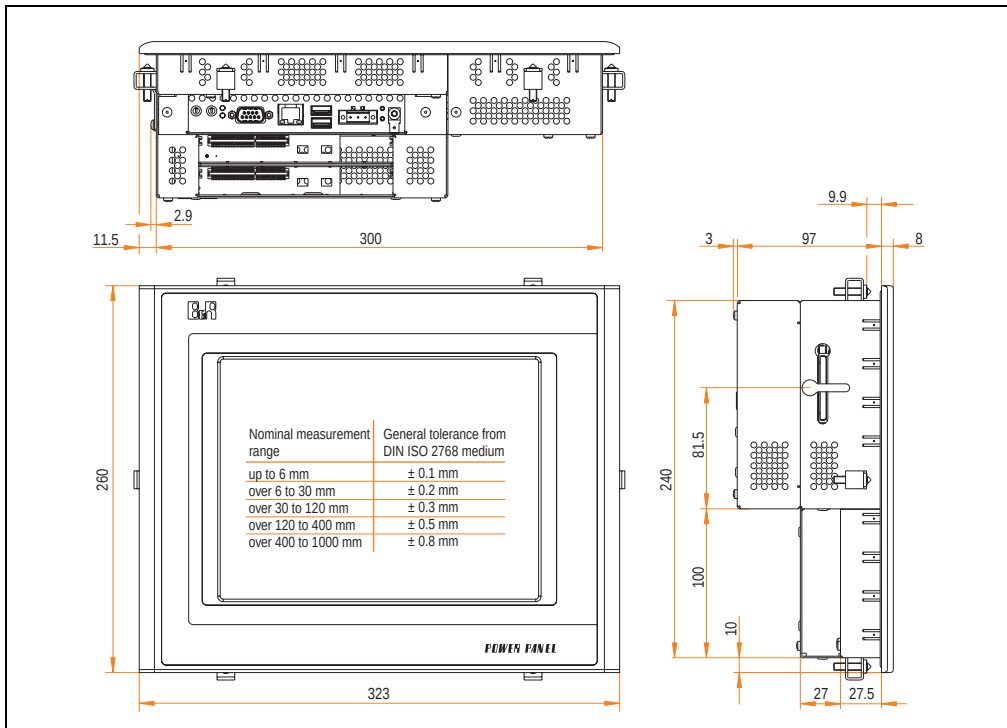


Figure 95: Dimensions - 4PP420.1043-B5

4.10.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

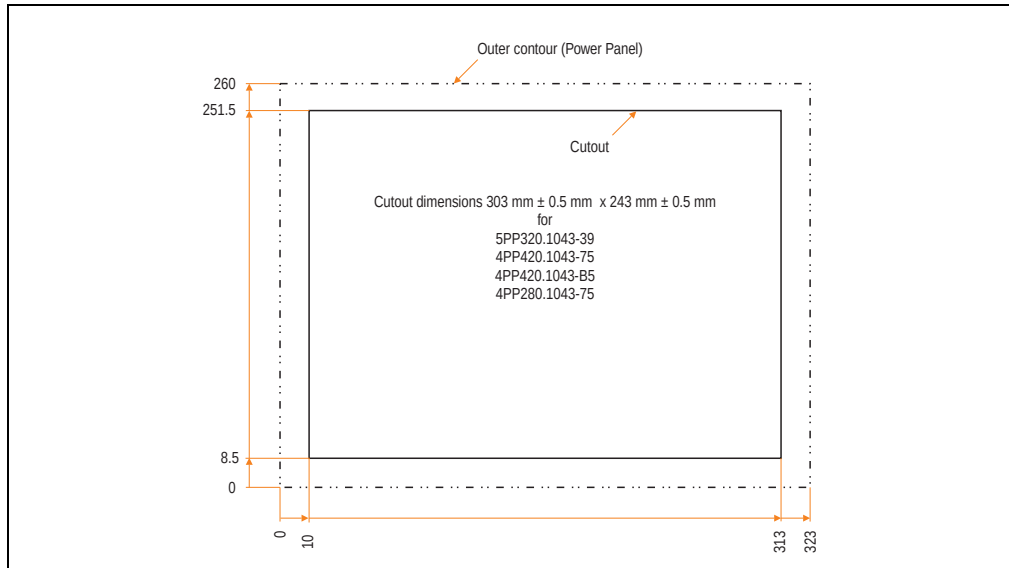


Figure 96: Cutout installation - 4PP420.1043-B5

4.10.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420 10.4" VGA, 2 aPCI, touch screen
6	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 64: Contents of delivery - 4PP420.1043-B5

4.11 Device 4PP420.1505-75

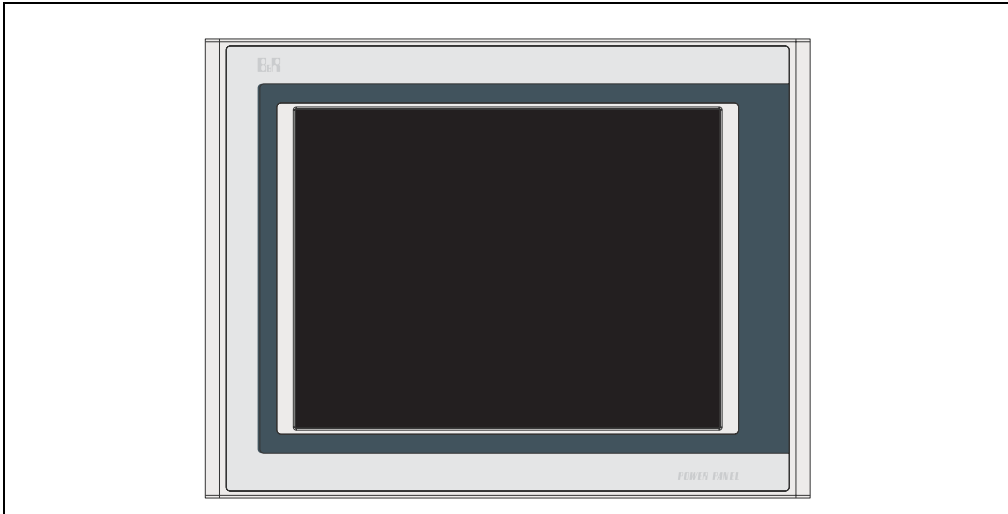


Figure 97: Front view - 4PP420.1505-75

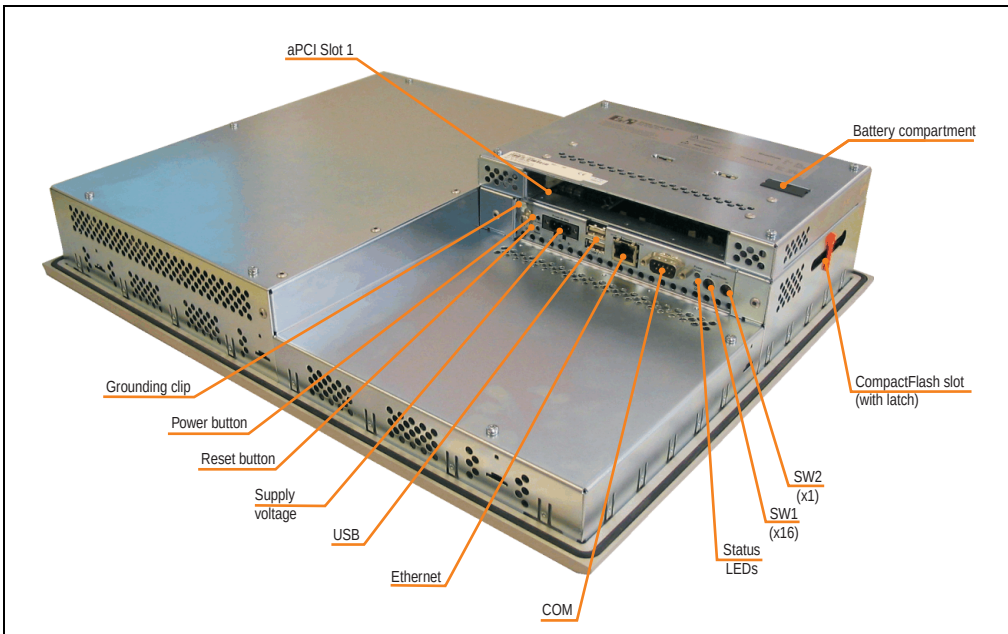


Figure 98: Rear view - 4PP420.1505-75

4.11.1 Technical data

Features	4PP420.1505-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 65: Technical data - 4PP420.1505-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.1505-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 15 in (381 mm) 512 colors ⁴⁾ XGA, 1024 x 768 pixels 400:1 Direction R / direction L = 85° Direction U / direction D = 85° 250 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 1.25 A Maximum 2 A typically 30 W Yes
Ground resistance	0 Ohm
Outer dimensions Width Height Depth	435 mm 330 mm 86 mm

Table 65: Technical data - 4PP420.1505-75 (cont.)

Mechanical characteristics	4PP420.1505-75
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 6.7 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T <= 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 65: Technical data - 4PP420.1505-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.11.2 Dimensions

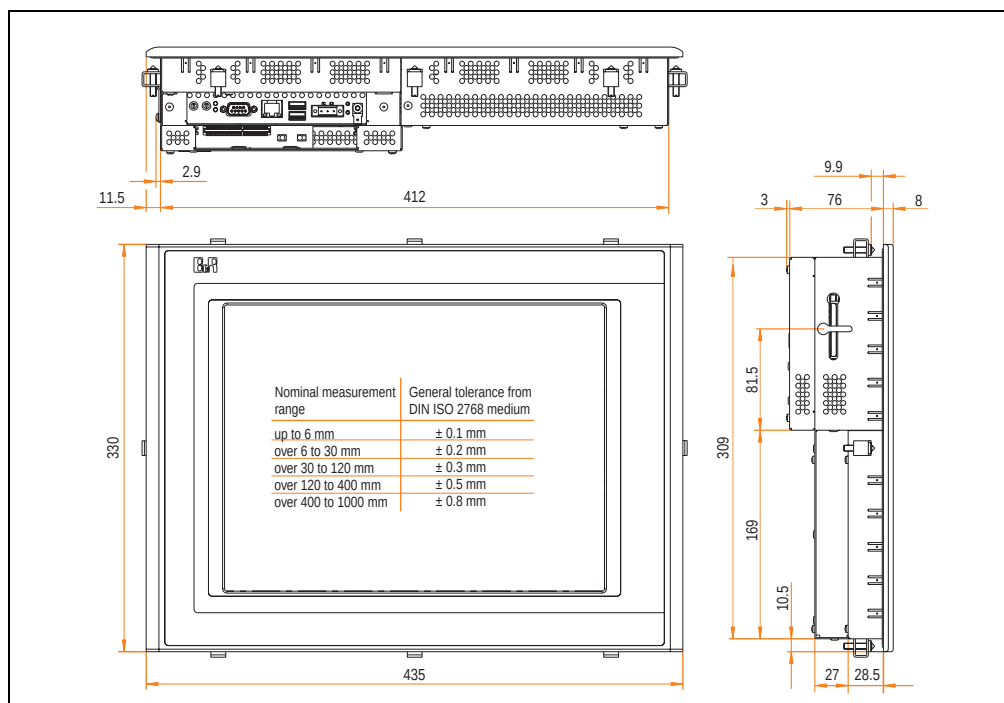


Figure 99: Dimensions - 4PP420.1505-75

4.11.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

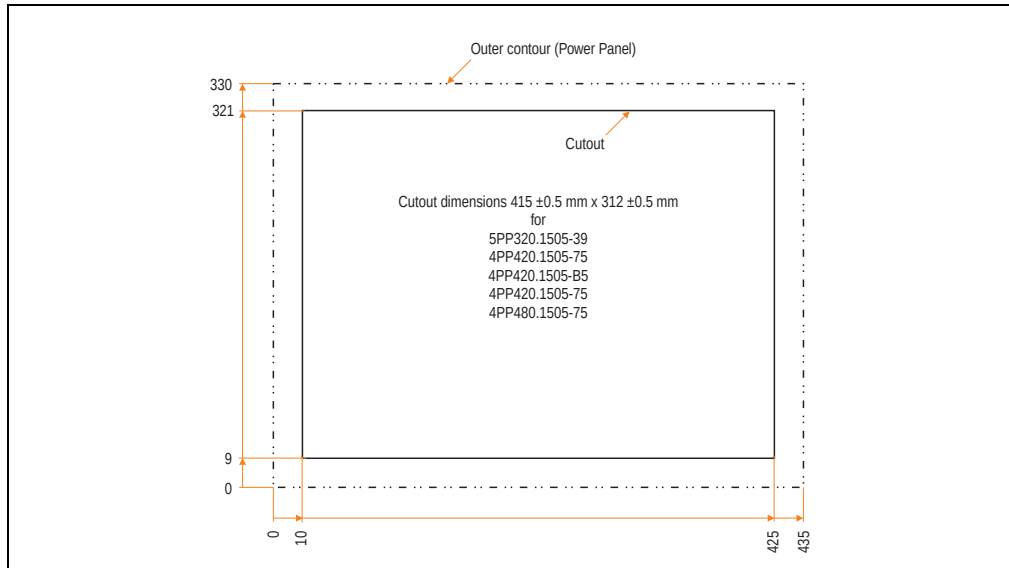


Figure 100: Cutout installation - 4PP420.1505-75

4.11.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420 15" XGA, 1 aPCI, touch screen
8	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 66: Contents of delivery - 4PP420.1505-75

4.12 Device 4PP420.1505-B5

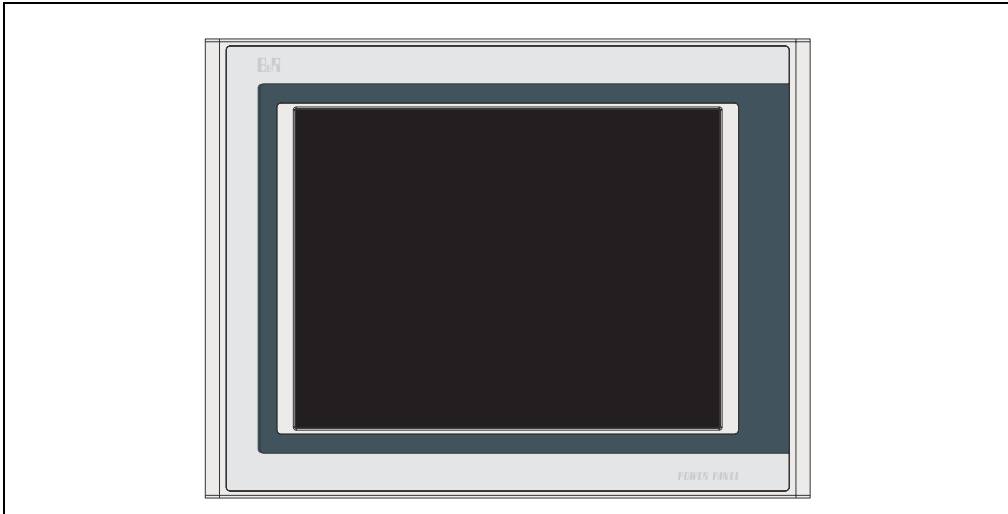


Figure 101: Front view - 4PP420.1505-B5

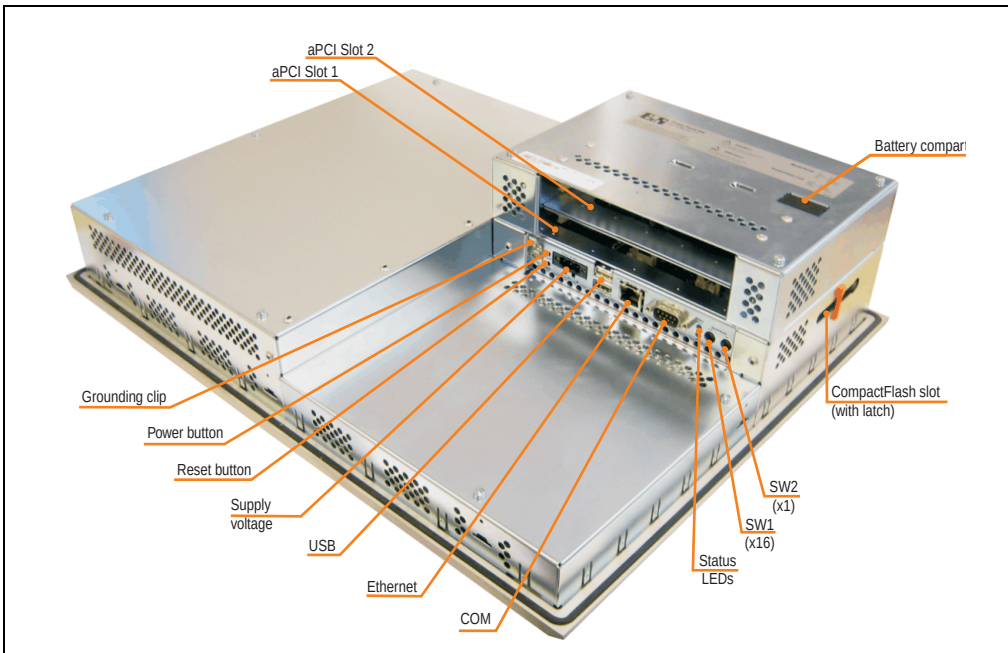


Figure 102: Rear view - 4PP420.1505-B5

4.12.1 Technical data

Features	4PP420.1505-B5
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 67: Technical data - 4PP420.1505-B5

Technical data • Power Panel 400 with Automation Runtime

Features	4PP420.1505-B5
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	2 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 15 in (381 mm) 262144 colors ⁴⁾ XGA, 1024 x 768 pixels 400:1 Direction R / direction L = 85° Direction U / direction D = 85° 250 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	-
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 1.25 A Maximum 2 A typically 30 W Yes
Ground resistance	0 Ohm
Outer dimensions Width Height Depth	435 mm 330 mm 109 mm

Table 67: Technical data - 4PP420.1505-B5 (cont.)

Mechanical characteristics	4PP420.1505-B5
Front	
Frame	Aluminum, naturally anodized ⁵⁾
Design	Gray ⁵⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁵⁾
Light background	Similar to Pantone 427CV ⁵⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 6.8 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T <= 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 67: Technical data - 4PP420.1505-B5 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.12.2 Dimensions

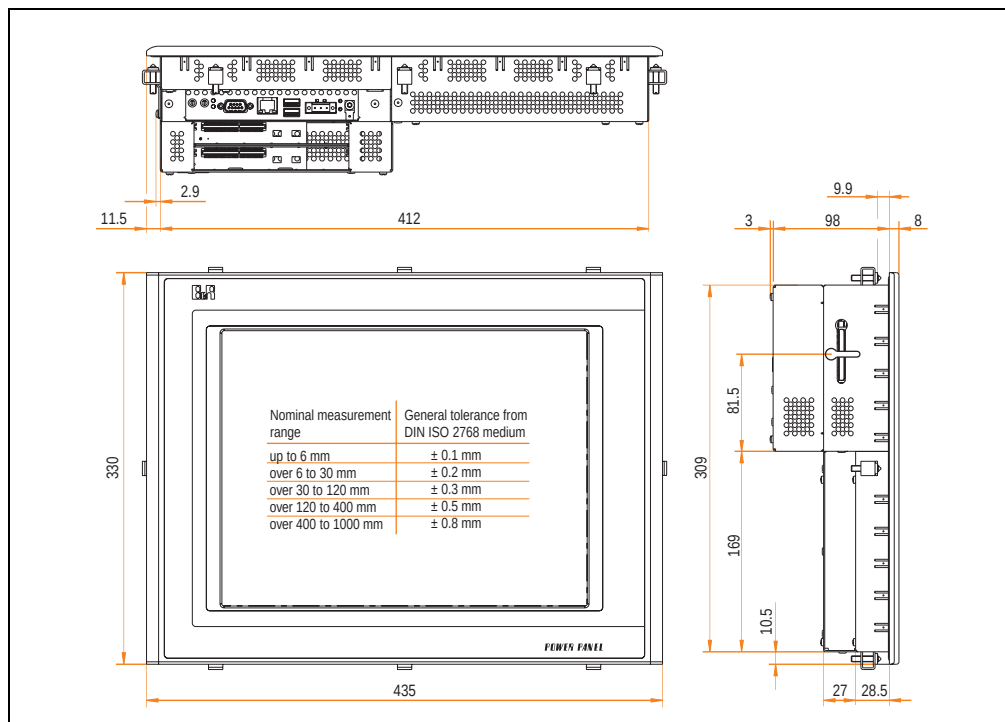


Figure 103: Dimensions - 4PP420.1505-B5

4.12.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

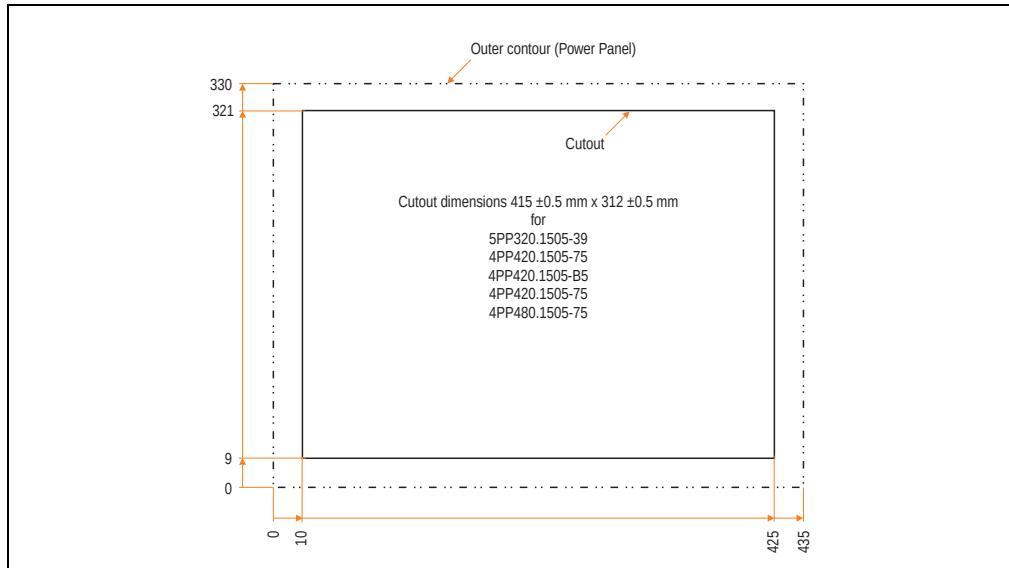


Figure 104: Cutout installation - 4PP420.1505-B5

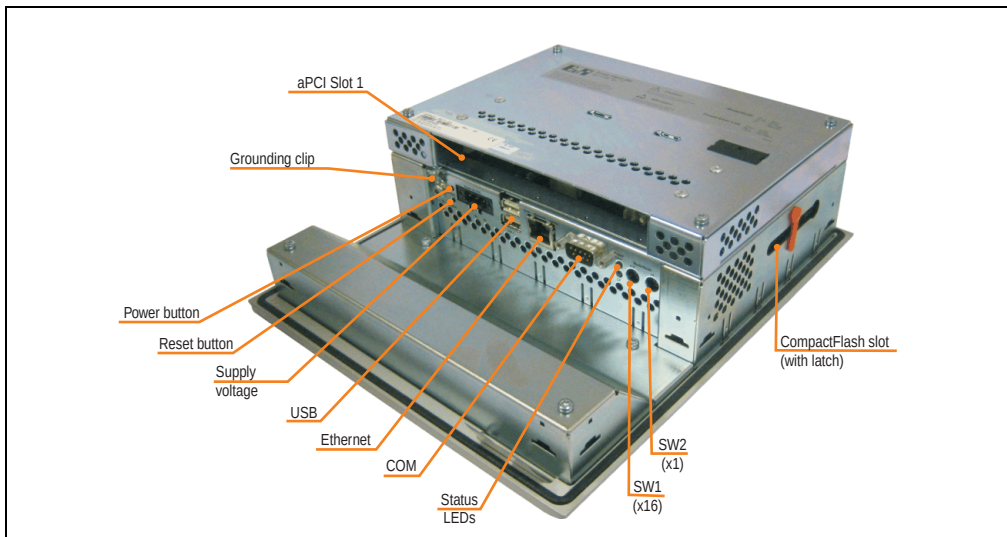
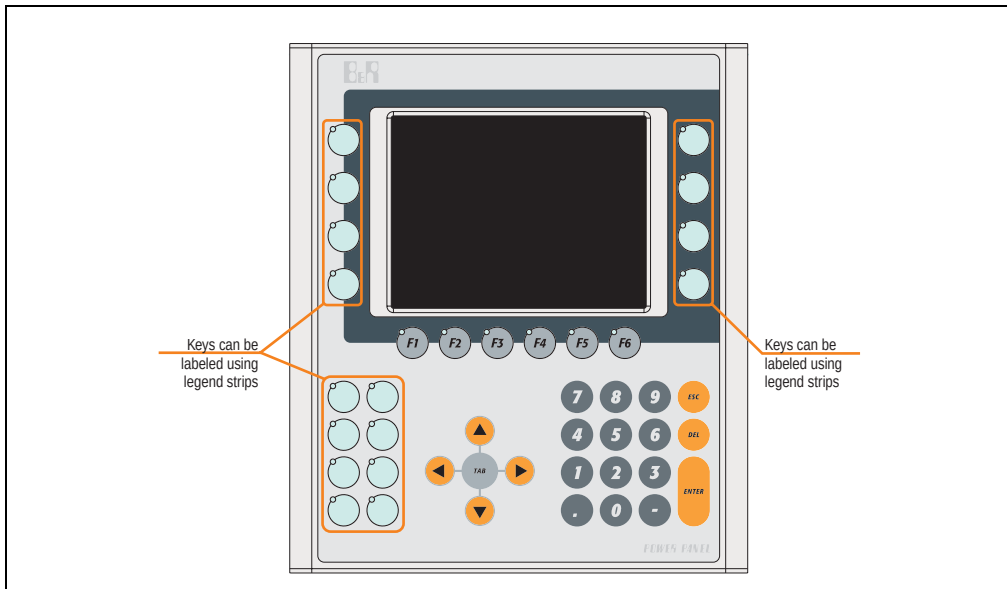
4.12.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP420 15" XGA, 2 aPCI, touch screen
8	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 68: Contents of delivery - 4PP420.1505-B5

4.13 Device 4PP451.0571-65



4.13.1 Technical data

Features	4PP451.0571-65
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ - -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 69: Technical data - 4PP451.0571-65

Technical data • Power Panel 400 with Automation Runtime

Features	4PP451.0571-65
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	Color LCD 5.7 in (144 mm) 512 colors ⁴⁾ QVGA, 320 x 240 pixels 40:1 Direction R / direction L = 40° Direction U = 40° / direction D = 50° 200 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	16 with LED (yellow) 6 with LED (yellow) 5 without LED 15 without LED - > 10 ⁶ actuations with 1 ± 0.3 to 3 ± 0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.63 A Maximum 1.2 A typically 15 W Yes
Ground resistance	0 Ohm

Table 69: Technical data - 4PP451.0571-65 (cont.)

Mechanical characteristics	4PP451.0571-65
Outer dimensions	
Width	212 mm
Height	245 mm
Depth	76 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Orange keys	Similar to Pantone 151CV ⁶⁾
Dark gray keys	Similar to Pantone 431CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 2.4 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 69: Technical data - 4PP451.0571-65 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.13.2 Dimensions

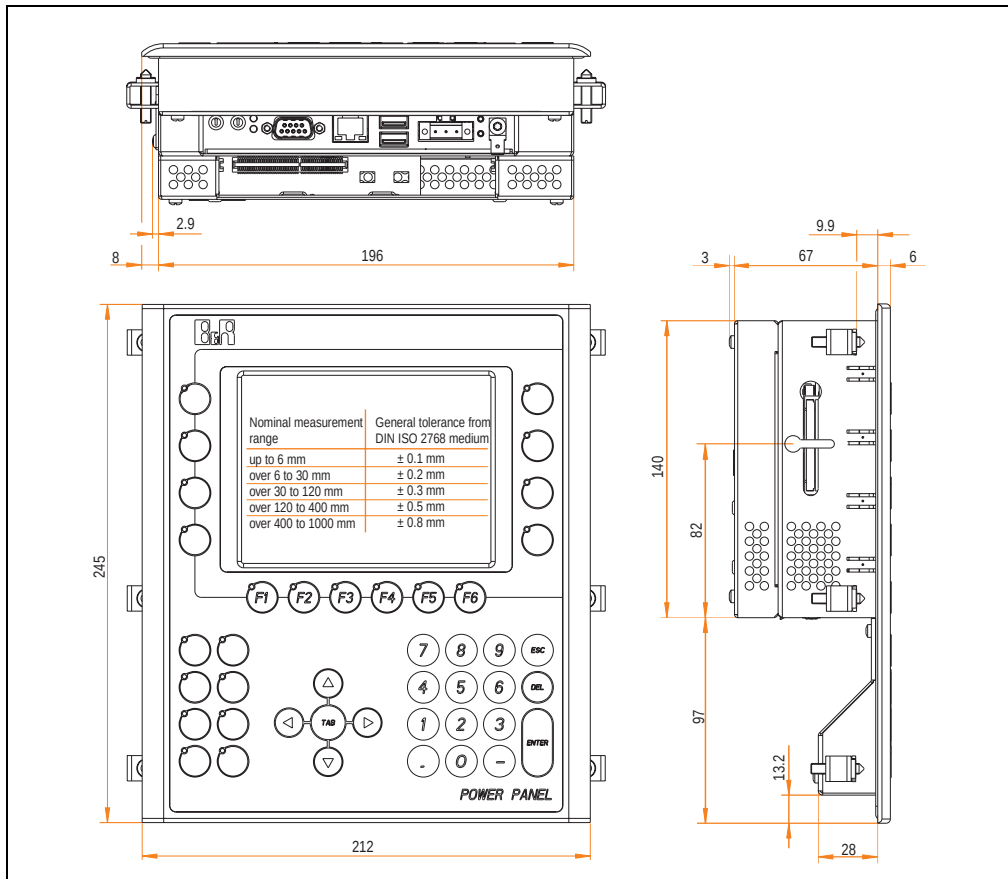


Figure 107: Dimensions - 4PP451.0571-65

4.13.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

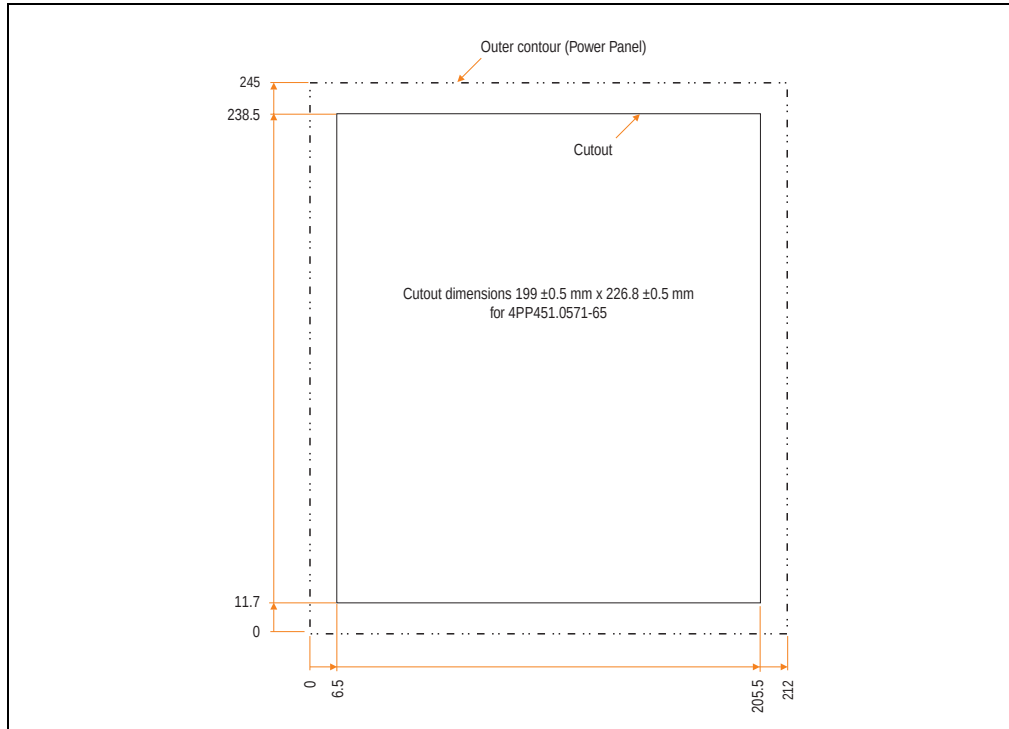


Figure 108: Cutout installation - 4PP451.0571-65

4.13.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP451 5.7" QVGA, 1 aPCI, touch screen, keys
6	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 70: Contents of delivery - 4PP451.0571-65

4.14 Device 4PP451.0571-75

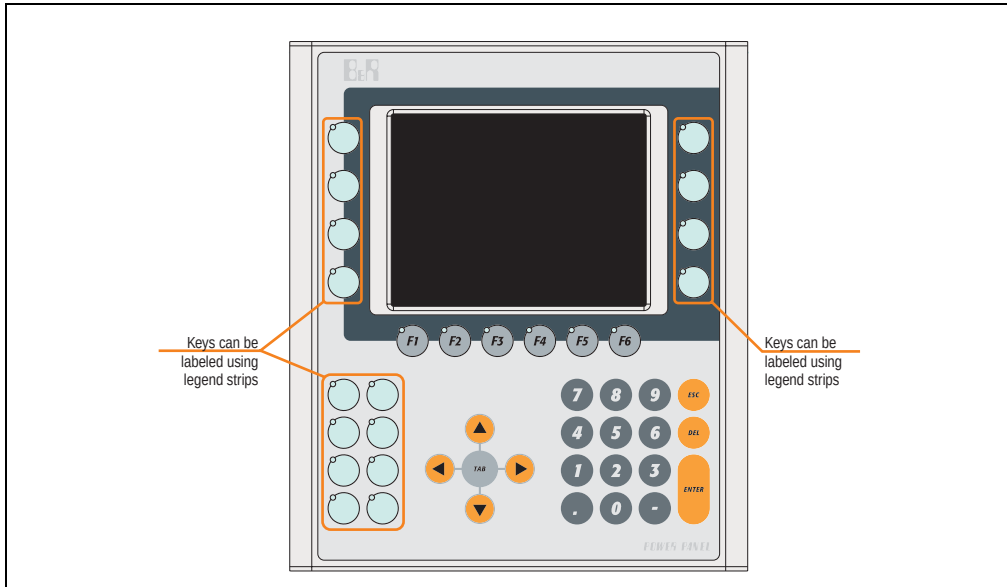


Figure 109: Front view - 4PP451.0571-75

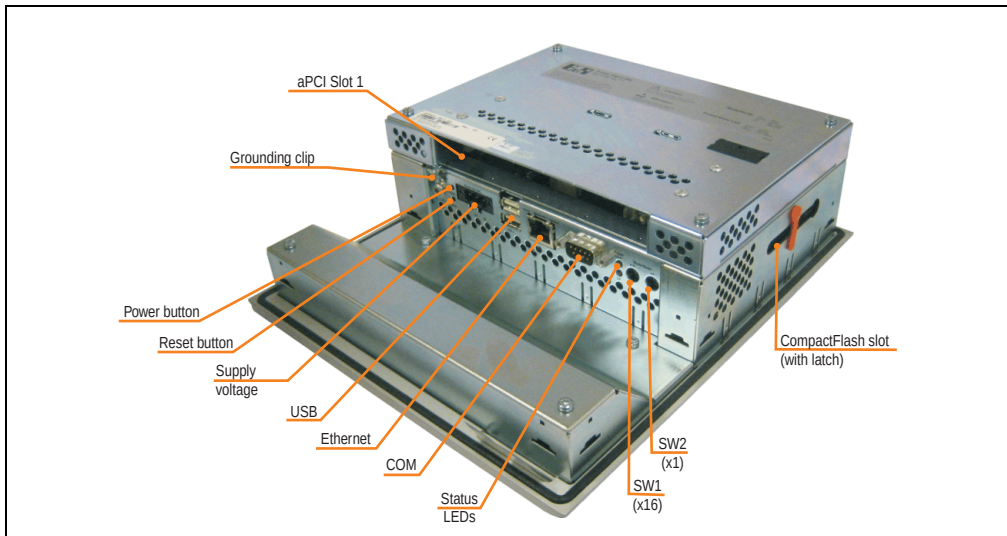


Figure 110: Rear view - 4PP451.0571-75

4.14.1 Technical data

Features	4PP451.0571-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ - -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 71: Technical data - 4PP451.0571-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP451.0571-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 5.7 in (144 mm) 262144 colors ⁴⁾ QVGA, 320 x 240 pixels 400:1 Direction R / direction L = 60° Direction U = 40° / direction D = 50° 500 cd/m ² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	16 with LED (yellow) 6 with LED (yellow) 5 without LED 15 without LED - > 10 ⁶ actuations with 1 ± 0.3 to 3 ± 0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.63 A Maximum 1.2 A typically 15 W Yes
Ground resistance	0 Ohm

Table 71: Technical data - 4PP451.0571-75 (cont.)

Mechanical characteristics	4PP451.0571-75
Outer dimensions	
Width	212 mm
Height	245 mm
Depth	76 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Orange keys	Similar to Pantone 151CV ⁶⁾
Dark gray keys	Similar to Pantone 431CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 2.4 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 71: Technical data - 4PP451.0571-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.14.2 Dimensions

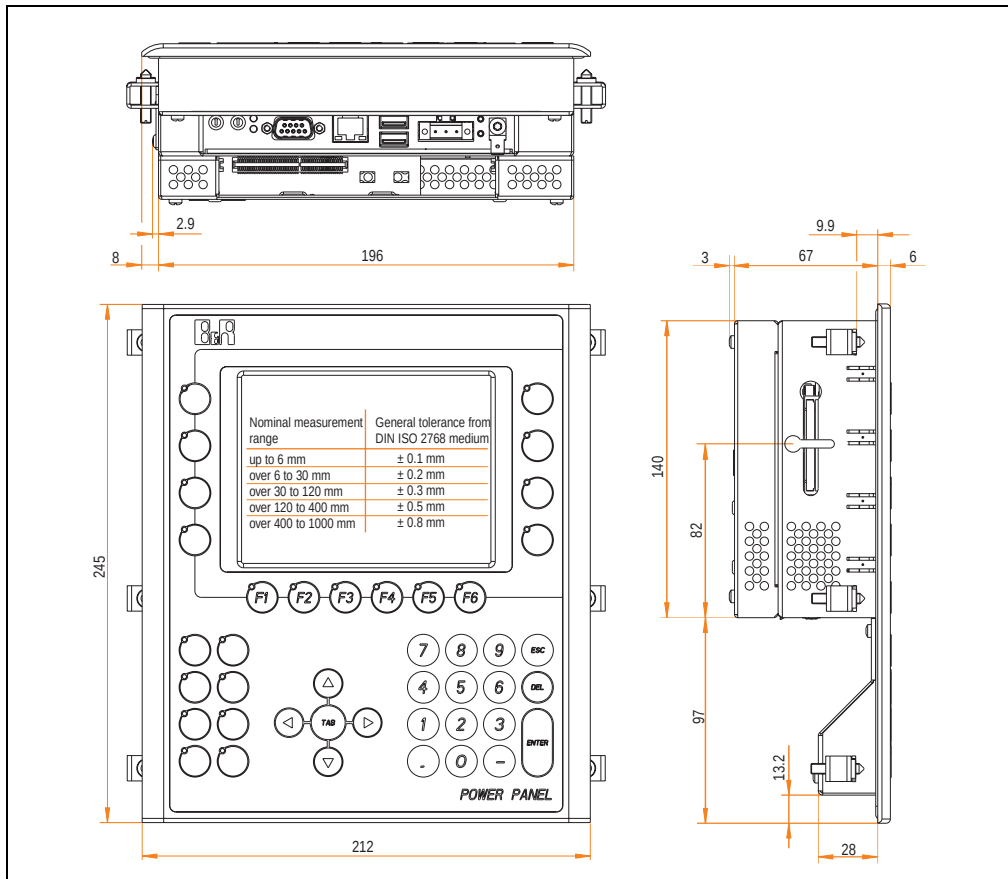


Figure 111: Dimensions - 4PP451.0571-75

4.14.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

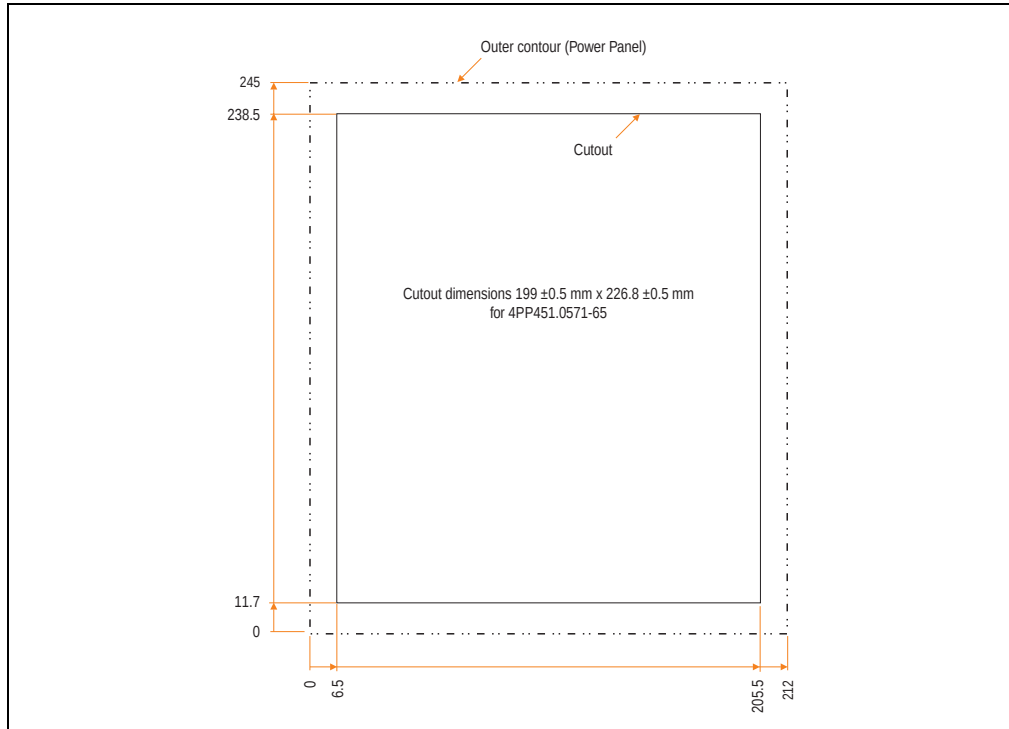


Figure 112: Cutout installation - 4PP451.0571-75

4.14.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP451 5.7" QVGA, 1 aPCI, touch screen, keys
6	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 72: Contents of delivery - 4PP451.0571-75

4.15 Device 4PP452.0571-65

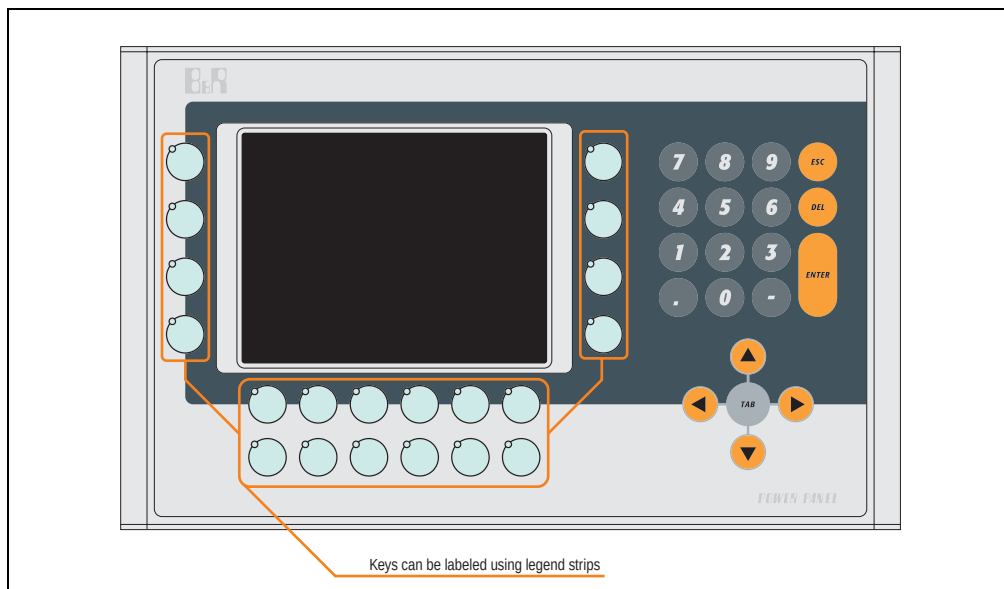


Figure 113: Front view - 4PP452.0571-65

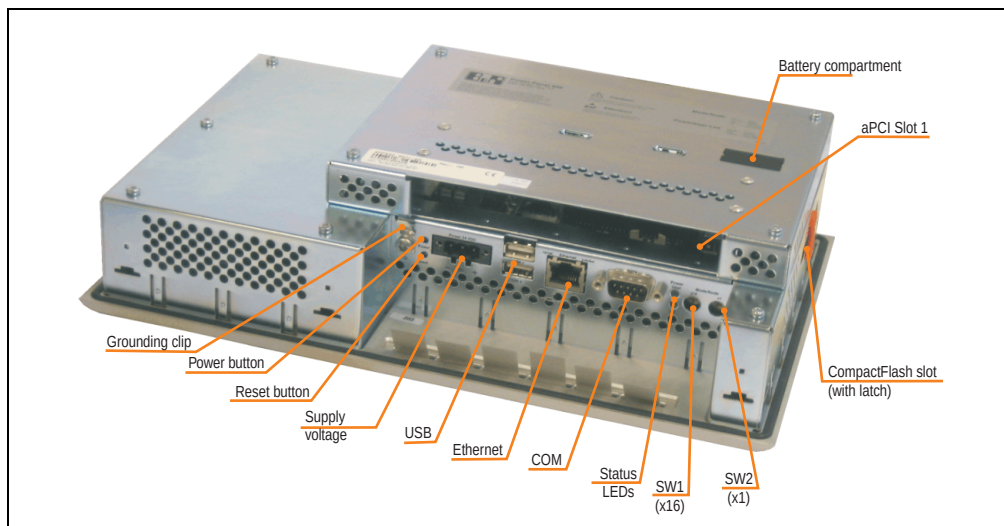


Figure 114: Rear view - 4PP452.0571-65

4.15.1 Technical data

Features	4PP452.0571-65
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ - -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 73: Technical data - 4PP452.0571-65

Technical data • Power Panel 400 with Automation Runtime

Features	4PP452.0571-65
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	Color LCD 5.7 in (144 mm) 512 colors ⁴⁾ QVGA, 320 x 240 pixels 40:1 Direction R / direction L = 40° Direction U = 40° / direction D = 50° 200 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	20 with LED (yellow) - 5 without LED 15 without LED - > 10 ⁶ actuations with 1 ± 0.3 to 3 ± 0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.63 A Maximum 1.2 A typically 15 W Yes
Ground resistance	0 Ohm

Table 73: Technical data - 4PP452.0571-65 (cont.)

Mechanical characteristics	4PP452.0571-65
Outer dimensions	
Width	302 mm
Height	187 mm
Depth	76 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Orange keys	Similar to Pantone 151CV ⁶⁾
Dark gray keys	Similar to Pantone 431CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 2.6 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 73: Technical data - 4PP452.0571-65 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.15.2 Dimensions

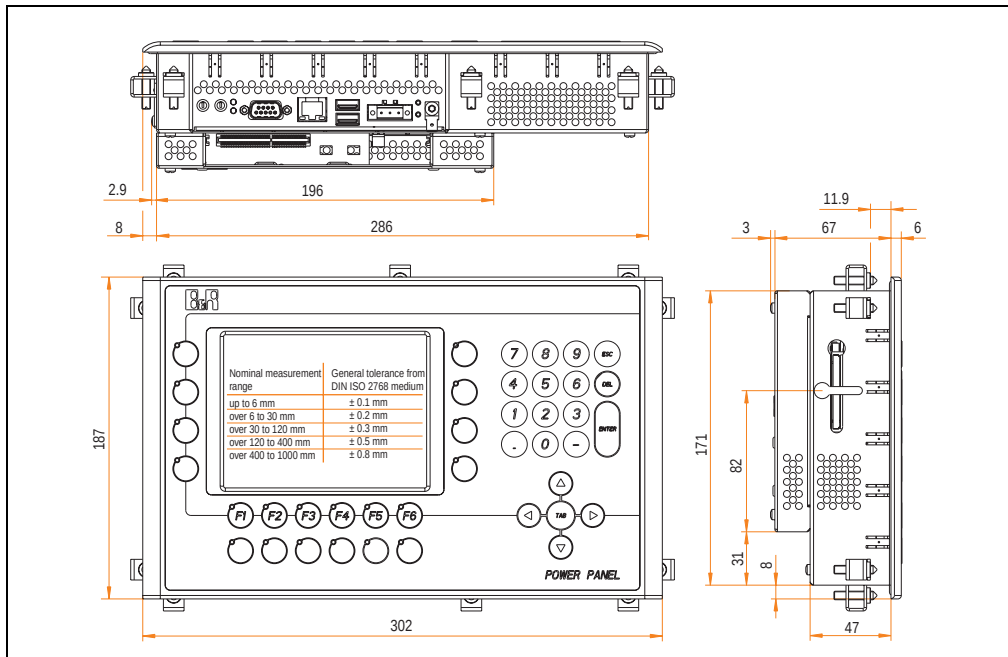


Figure 115: Dimensions - 4PP452.0571-65

4.15.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

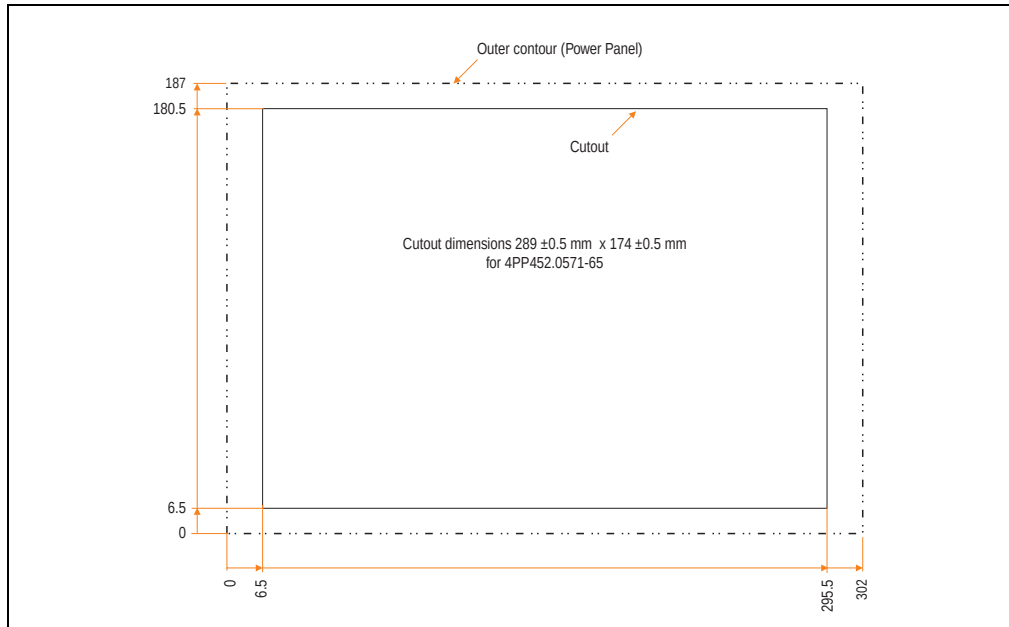


Figure 116: Cutout installation - 4PP452.0571-65

4.15.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP452 5.7" QVGA, 1 aPCI, touch screen, keys
10	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 74: Contents of delivery - 4PP452.0571-65

4.16 Device 4PP452.0571-75

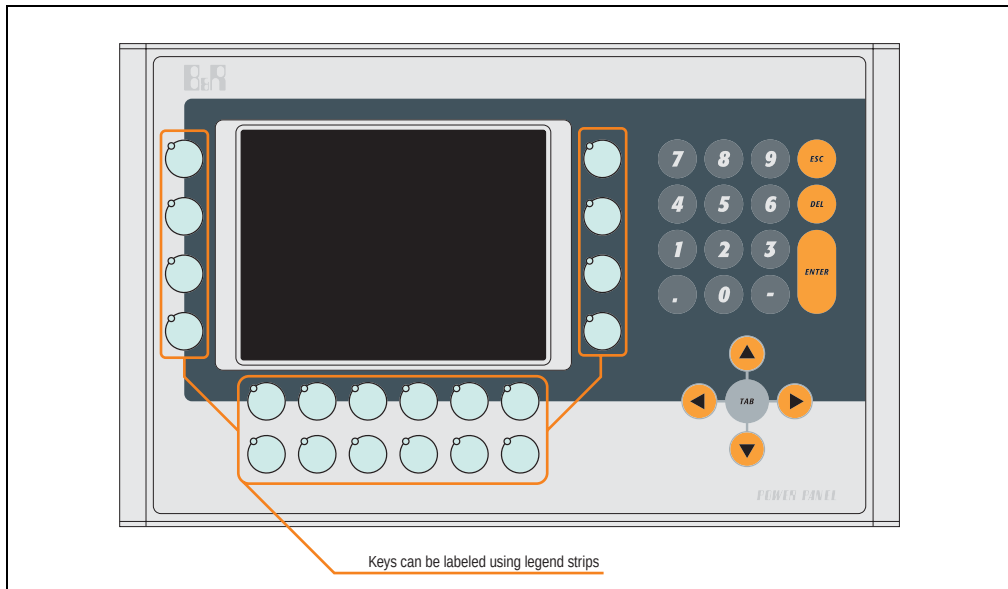


Figure 117: Front view - 4PP452.0571-75

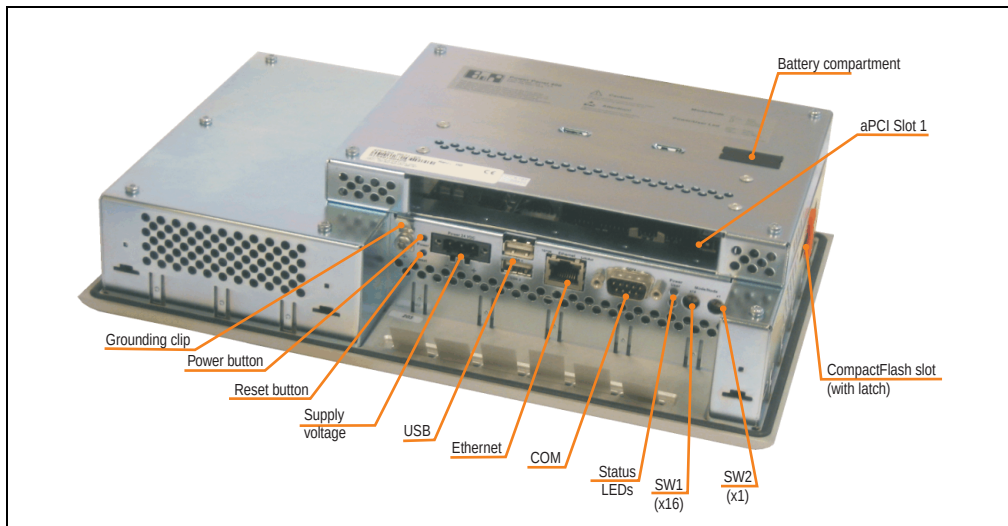


Figure 118: Rear view - 4PP452.0571-75

4.16.1 Technical data

Features	4PP452.0571-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ - -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 75: Technical data - 4PP452.0571-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP452.0571-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 5.7 in (144 mm) 262144 colors ⁴⁾ QVGA, 320 x 240 pixels 400:1 Direction R / direction L = 60° Direction U = 40° / direction D = 50° 500 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12-bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	20 with LED (yellow) - 5 without LED 15 without LED - > 10 ⁶ actuations with 1 ± 0.3 to 3 ± 0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.63 A Maximum 1.2 A typically 15 W Yes
Ground resistance	0 Ohm

Table 75: Technical data - 4PP452.0571-75 (cont.)

Mechanical characteristics	4PP452.0571-75
Outer dimensions	
Width	302 mm
Height	187 mm
Depth	76 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Orange keys	Similar to Pantone 151CV ⁶⁾
Dark gray keys	Similar to Pantone 431CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 2.6 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 75: Technical data - 4PP452.0571-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.16.2 Dimensions

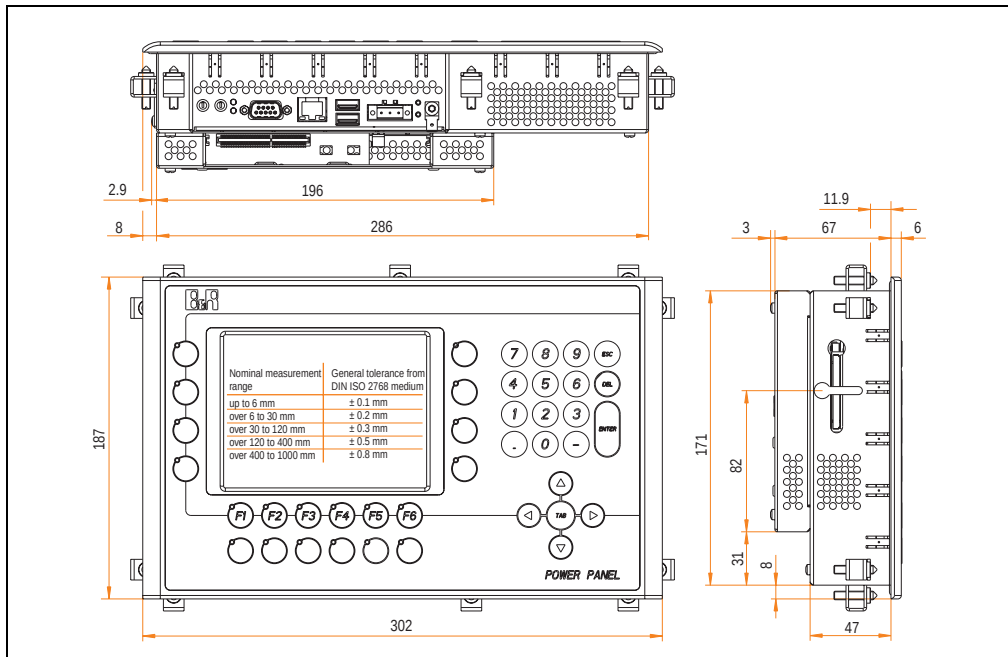


Figure 119: Dimensions - 4PP452.0571-75

4.16.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

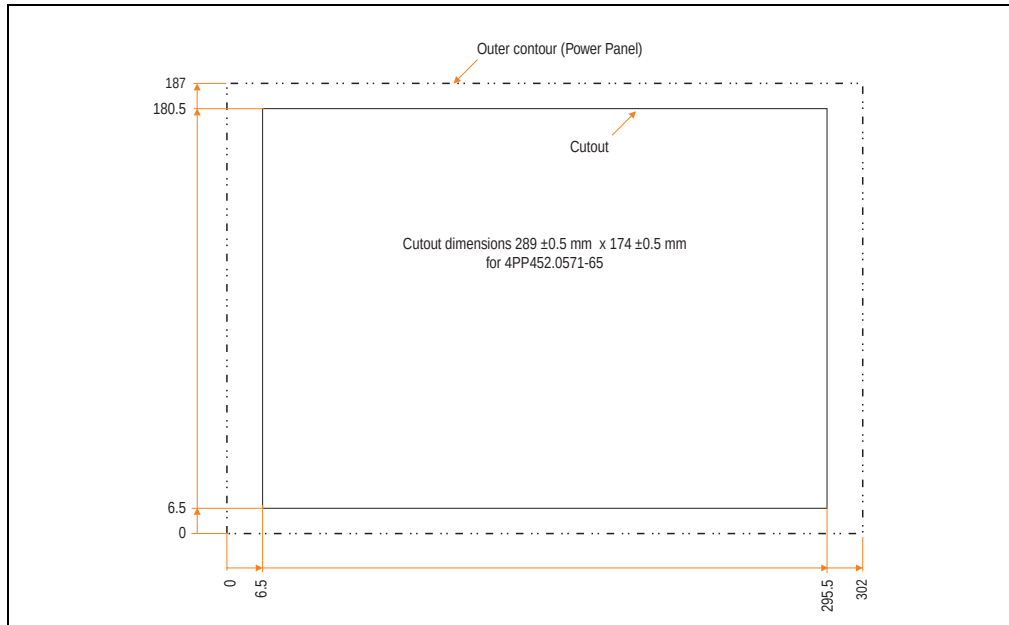


Figure 120: Cutout installation - 4PP452.0571-75

4.16.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP452 5.7" QVGA, 1 aPCI, touch screen, keys
10	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 76: Contents of delivery - 4PP452.0571-75

4.17 Device 4PP480.1043-75

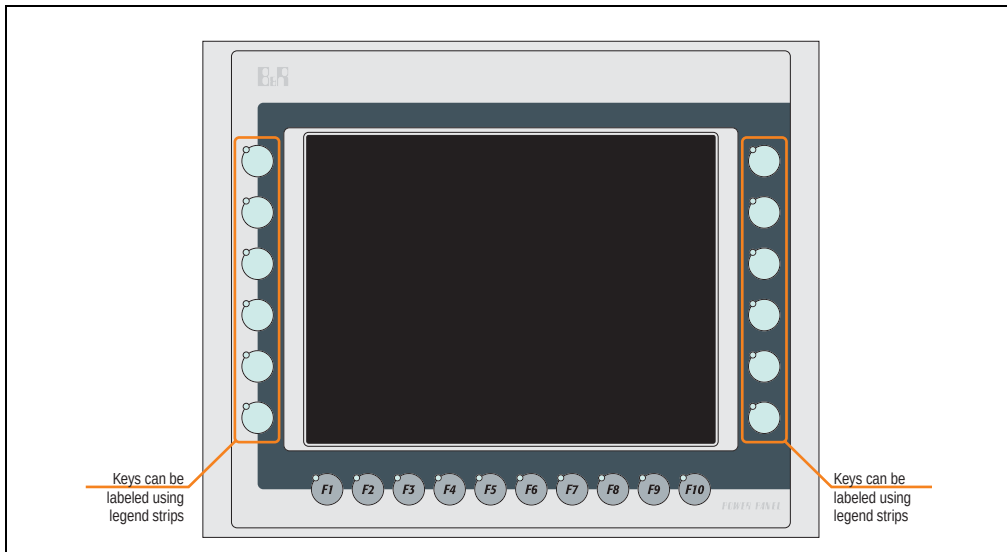


Figure 121: Front view - 4PP480.1043-75

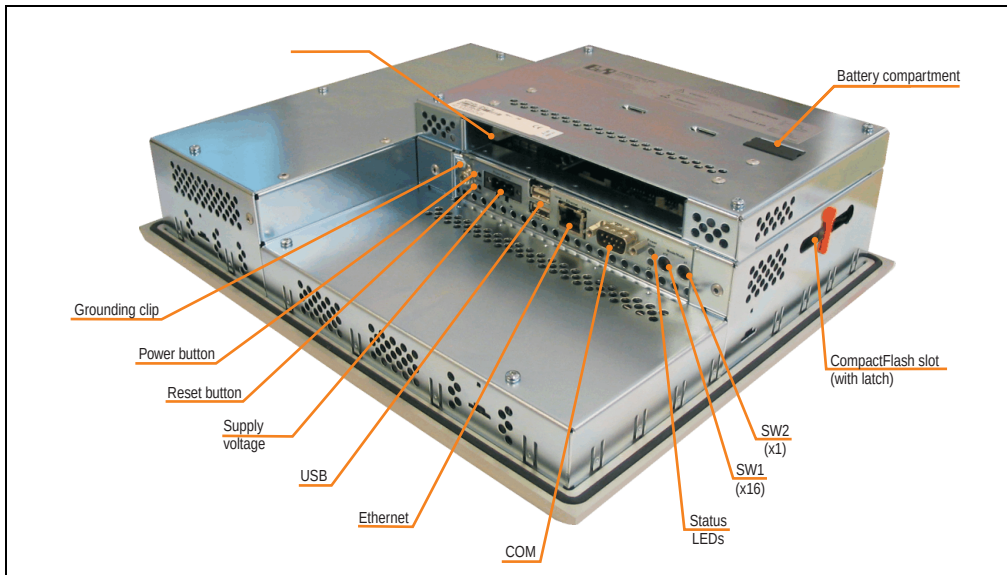


Figure 122: Rear view - 4PP480.1043-75

4.17.1 Technical data

Features	4PP480.1043-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 77: Technical data - 4PP480.1043-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP480.1043-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 26.42 cm (264 mm) 262144 colors ⁴⁾ VGA, 640 x 480 pixels 600:1 Direction R / direction L = 70° Direction U = 45° / direction D = 35° 450 cd/m² 55000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	12 with LED (yellow) 10 with LED (yellow) - - - > 10 ⁶ actuations with 1 ±0.3 to 3 ±0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.84 A Maximum 2.8 A typically 20 W Yes
Ground resistance	0 Ohm

Table 77: Technical data - 4PP480.1043-75 (cont.)

Mechanical characteristics	4PP480.1043-75
Outer dimensions	
Width	323 mm
Height	260 mm
Depth	86 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 3.9 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 77: Technical data - 4PP480.1043-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.17.2 Dimensions

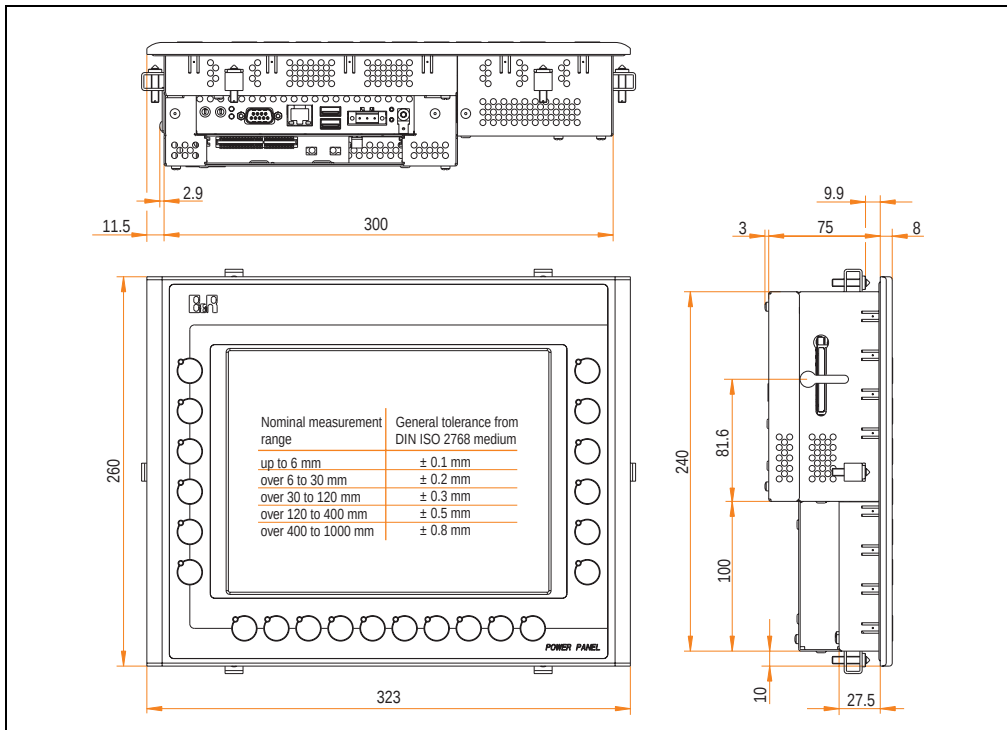


Figure 123: Dimensions - 4PP480.1043-75

4.17.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

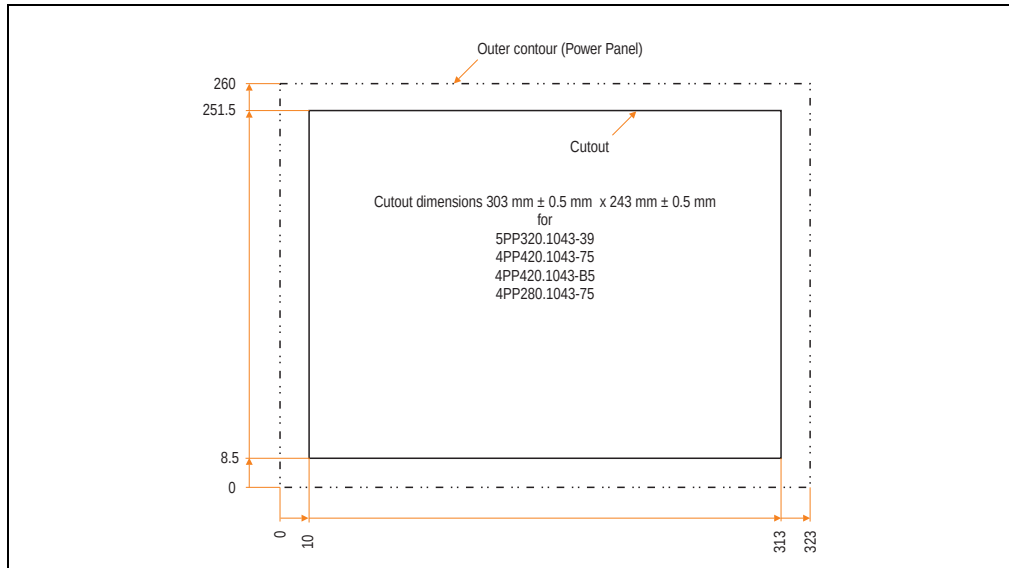


Figure 124: Cutout installation - 4PP480.1043-75

4.17.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP480 10.4" VGA, 1 aPCI, touch screen, keys
6	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 78: Contents of delivery - 4PP480.1043-75

4.18 Device 4PP480.1505-75

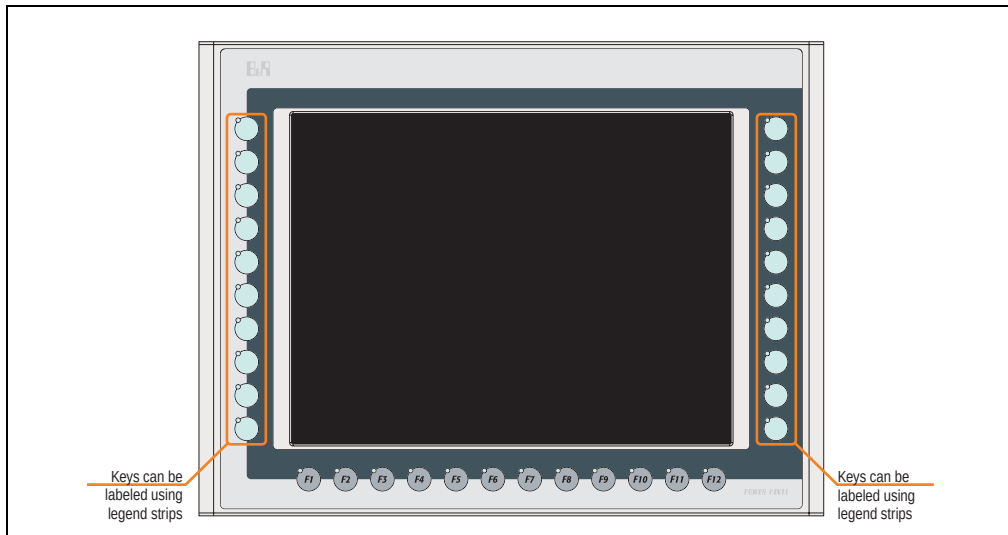


Figure 125: Front view - 4PP480.1505-75

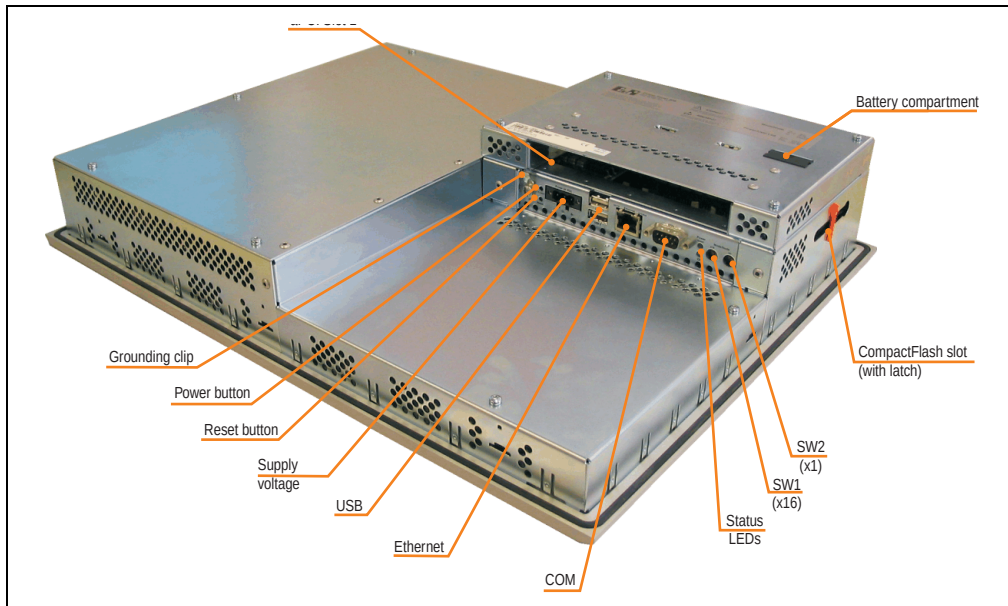


Figure 126: Rear view - 4PP480.1505-75

4.18.1 Technical data

Features	4PP480.1505-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 79: Technical data - 4PP480.1505-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP480.1505-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 38.10 cm (380 mm) 262144 colors ⁴⁾ XGA, 1024 x 768 pixels 400:1 Direction R / direction L = 85° Direction U / direction D = 85° 250 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	20 with LED (yellow) 12 with LED (yellow) - - - - > 10 ⁶ actuations with 1 ±0.3 to 3 ±0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.84 A Maximum 2.8 A typically 20 W Yes
Ground resistance	0 Ohm

Table 79: Technical data - 4PP480.1505-75 (cont.)

Mechanical characteristics	4PP480.1505-75
Outer dimensions	
Width	435 mm
Height	330 mm
Depth	87 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 6.5 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 79: Technical data - 4PP480.1505-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.18.2 Dimensions

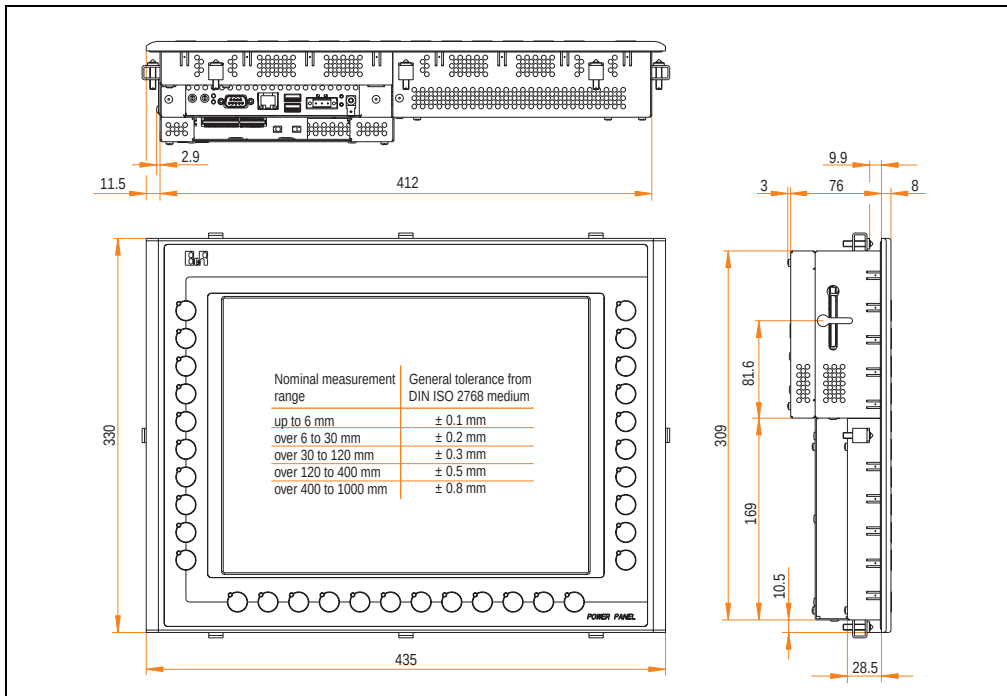


Figure 127: Dimensions - 4PP480.1505-75

4.18.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

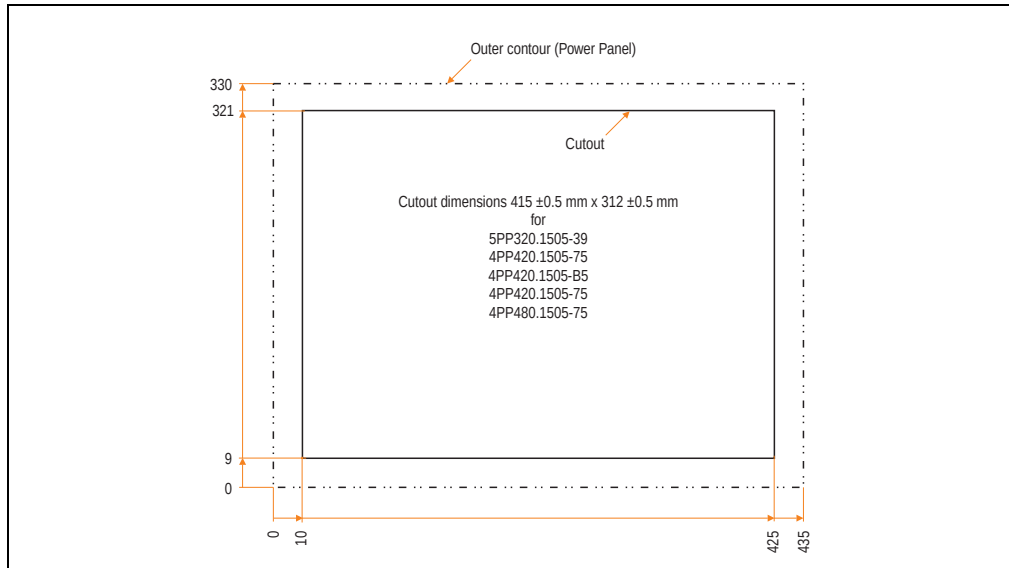


Figure 128: Cutout installation - 4PP480.1505-75

4.18.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP480 15" XGA, 1 aPCI, touch screen, keys
8	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 80: Contents of delivery - 4PP480.1505-75

4.19 Device 4PP481.1043-75

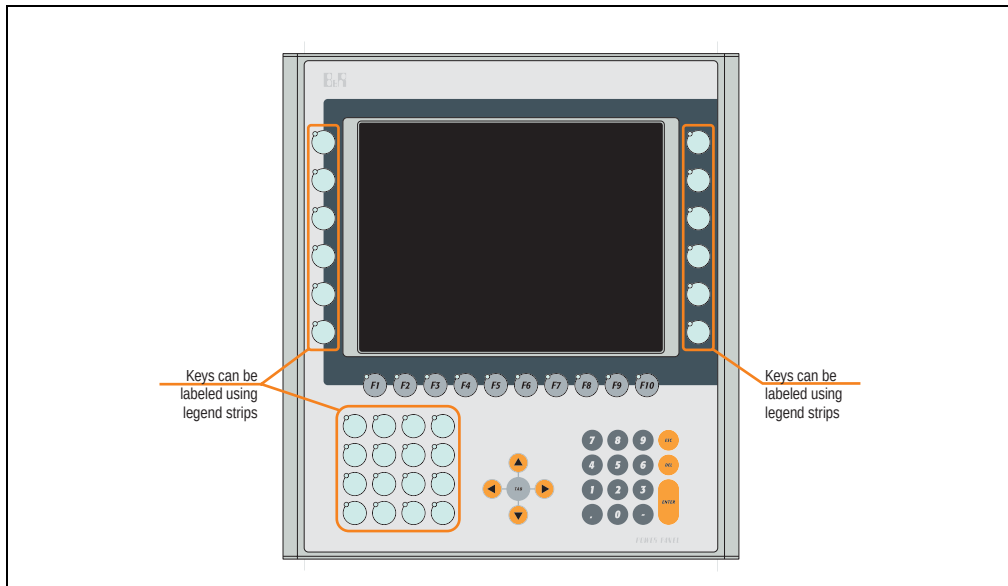


Figure 129: Front view - 4PP481.1043-75

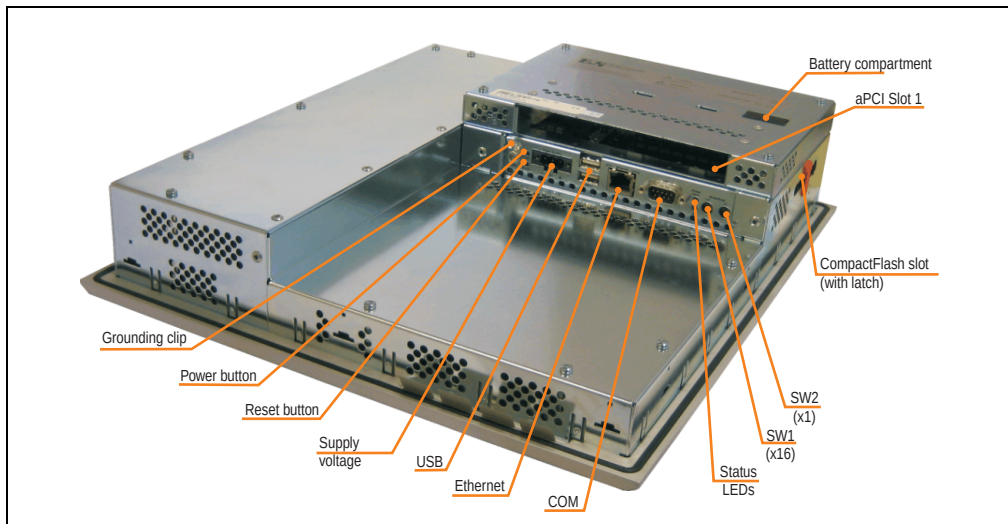


Figure 130: Rear view - 4PP481.1043-75

4.19.1 Technical data

Features	4PP481.1043-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 81: Technical data - 4PP481.1043-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP481.1043-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 26.42 cm (264 mm) 262144 colors ⁴⁾ VGA, 640 x 480 pixels 600:1 Direction R / direction L = 70° Direction U = 45° / direction D = 35° 450 cd/m² 55000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	28 with LED (yellow) 10 with LED (yellow) 5 without LED 15 without LED - > 10 ⁶ actuations with 1 ± 0.3 to 3 ± 0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.84 A Maximum 2.8 A typically 20 W Yes
Ground resistance	0 Ohm

Table 81: Technical data - 4PP481.1043-75 (cont.)

Mechanical characteristics	4PP481.1043-75
Outer dimensions	
Width	323 mm
Height	358 mm
Depth	86 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Orange keys	Similar to Pantone 151CV ⁶⁾
Dark gray keys	Similar to Pantone 431CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 5 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 81: Technical data - 4PP481.1043-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.19.2 Dimensions

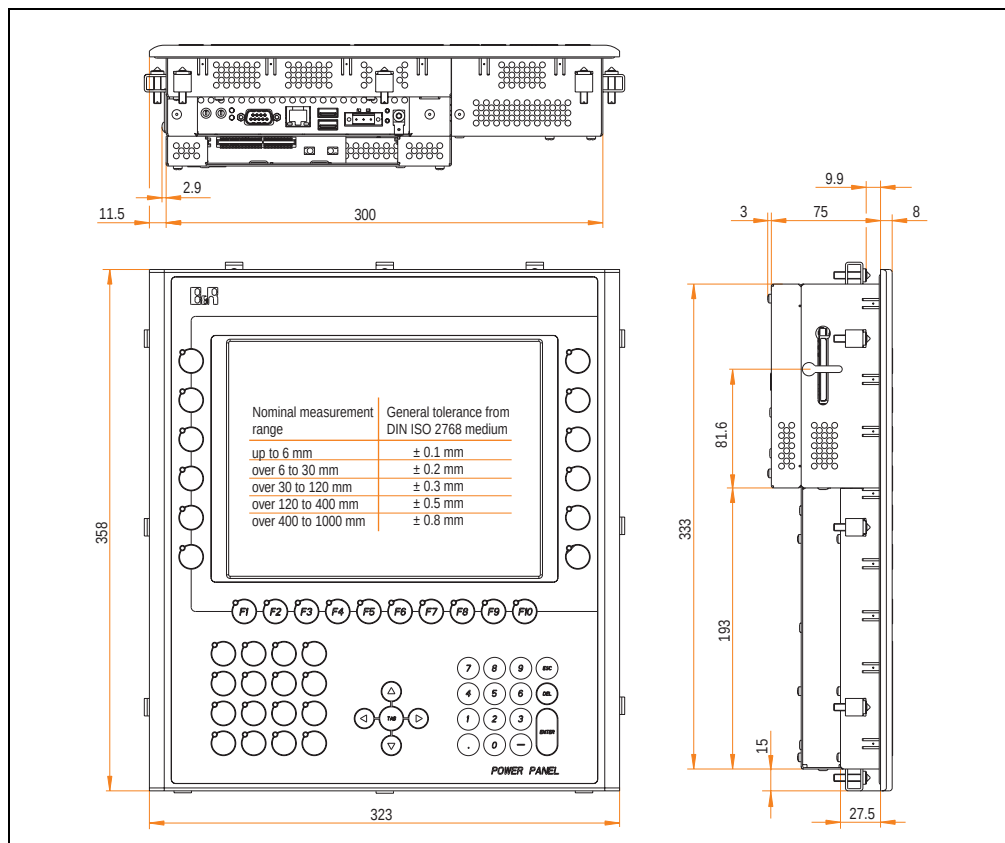


Figure 131: Dimensions - 4PP481.1043-75

4.19.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

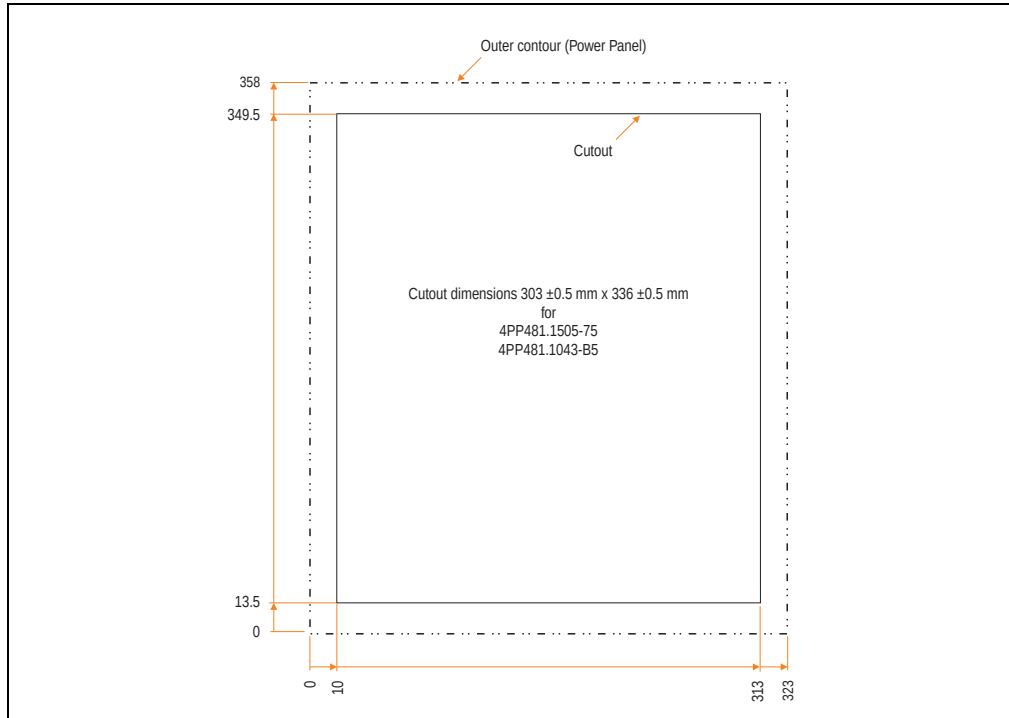


Figure 132: Cutout installation - 4PP481.1043-75

4.19.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP481 10.4" VGA, 1 aPCI, touch screen, keys
12	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 82: Contents of delivery - 4PP481.1043-75

4.20 Device 4PP481.1043-B5

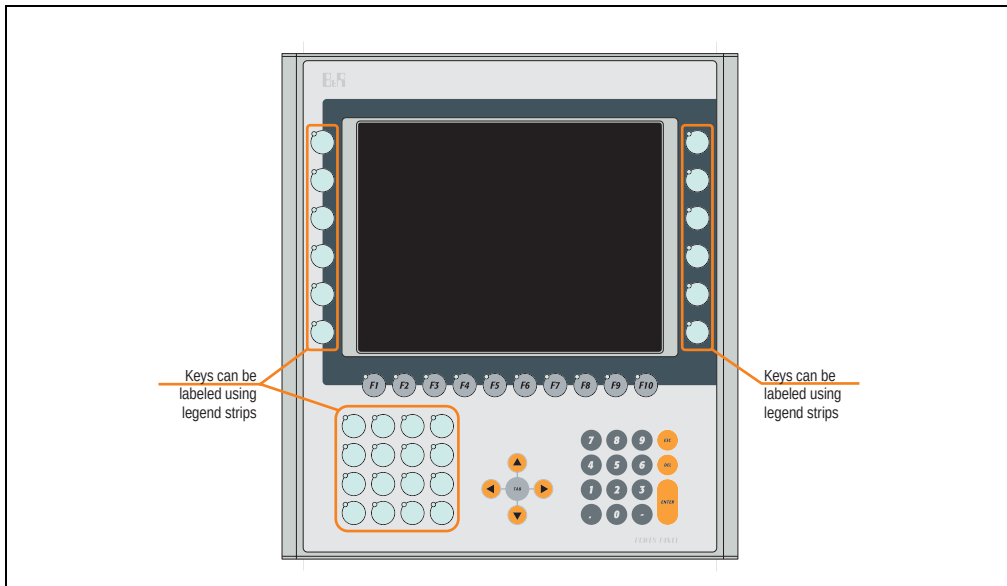


Figure 133: Front view - 4PP481.1043-B5

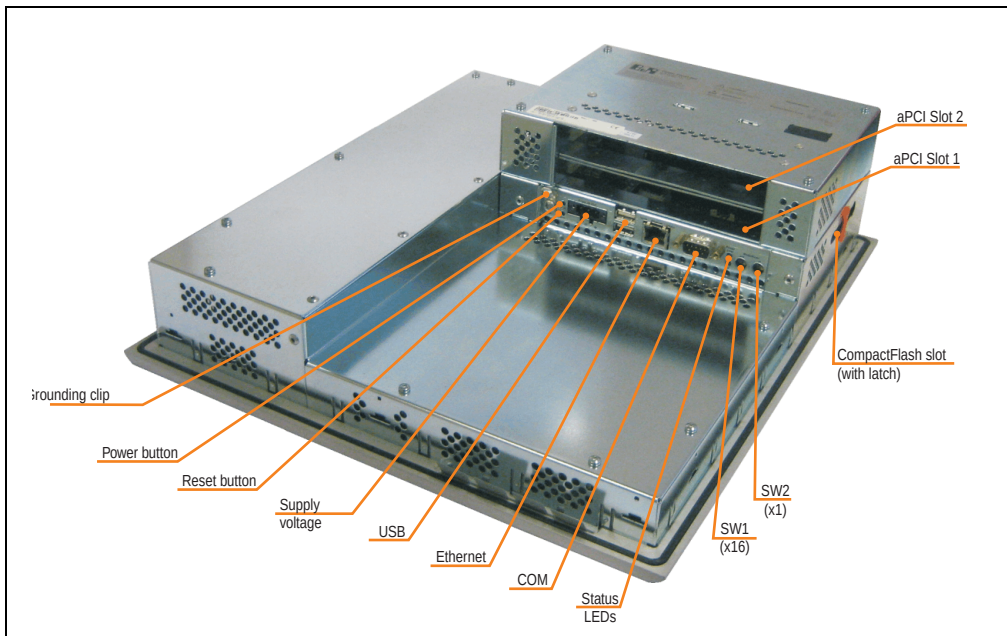


Figure 134: Rear view - 4PP481.1043-B5

4.20.1 Technical data

Features	4PP481.1043-B5
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MD (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 83: Technical data - 4PP481.1043-B5

Technical data • Power Panel 400 with Automation Runtime

Features	4PP481.1043-B5
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	2 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 26.42 cm (264 mm) 262144 colors ⁴⁾ VGA, 640 x 480 pixels 600:1 Direction R / direction L = 70° Direction U = 45° / direction D = 35° 450 cd/m ² 55000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	28 with LED (yellow) 10 with LED (yellow) 5 without LED 15 without LED - > 10 ⁶ actuations with 1 ±0.3 to 3 ±0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 0.84 A Maximum 2.8 A typically 20 W Yes
Ground resistance	0 Ohm

Table 83: Technical data - 4PP481.1043-B5 (cont.)

Mechanical characteristics	4PP481.1043-B5
Outer dimensions	
Width	323 mm
Height	358 mm
Depth	108 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Orange keys	Similar to Pantone 151CV ⁶⁾
Dark gray keys	Similar to Pantone 431CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 5.3 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 83: Technical data - 4PP481.1043-B5 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.20.2 Dimensions

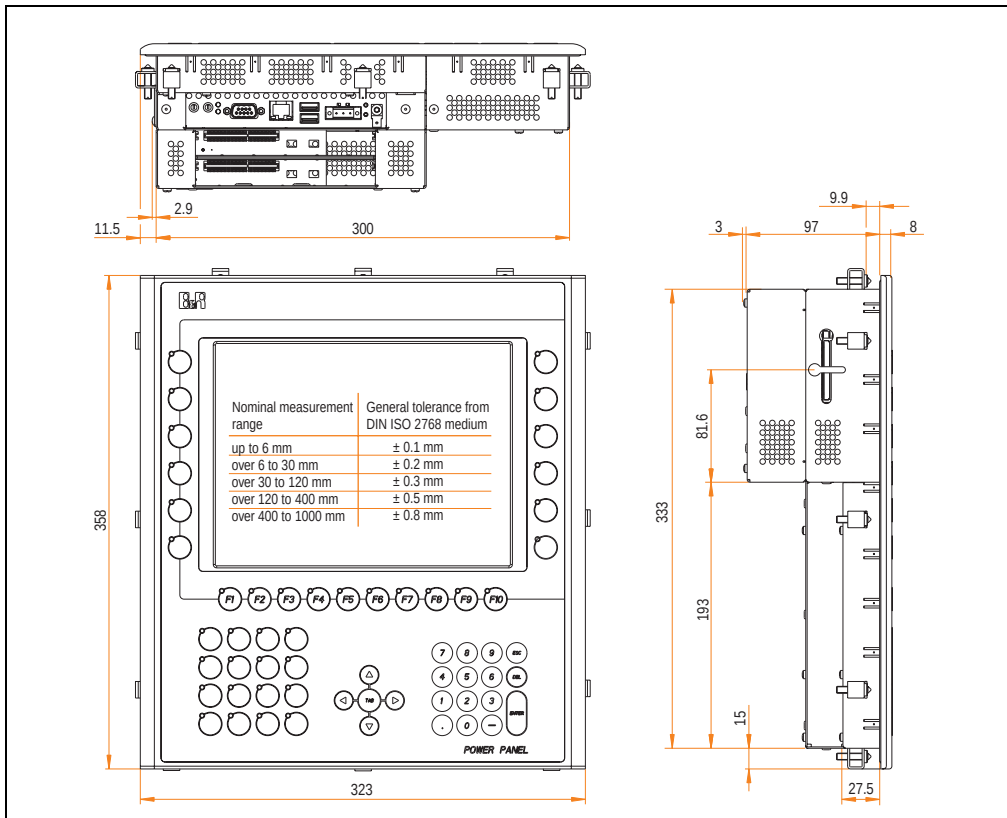


Figure 135: Dimensions - 4PP481.1043-B5

4.20.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

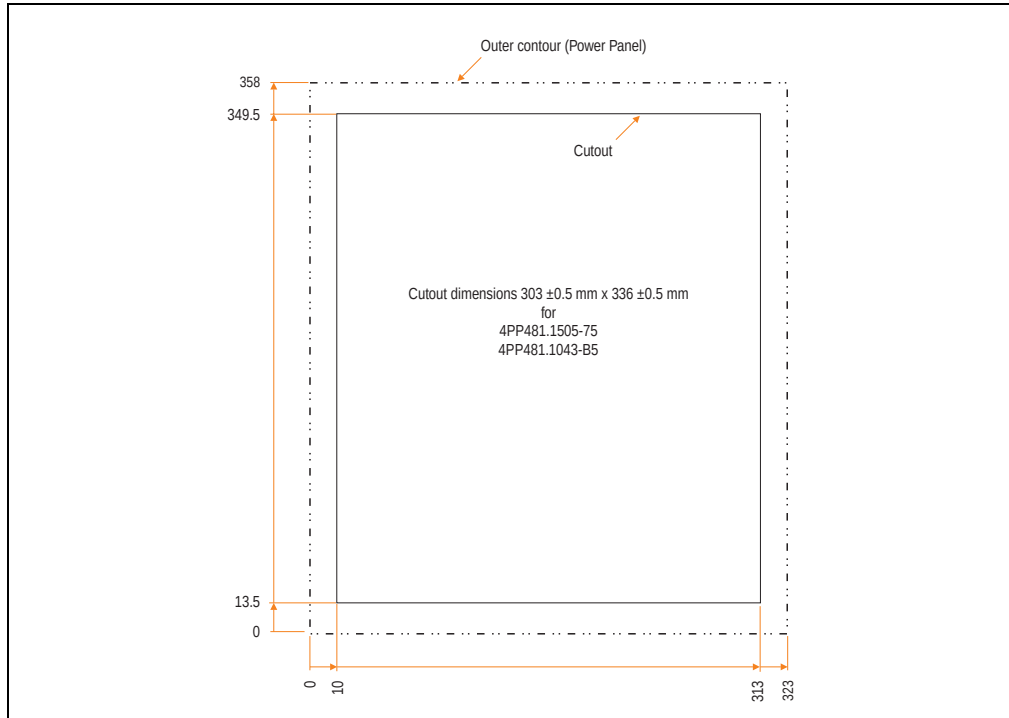


Figure 136: Cutout installation - 4PP481.1043-B5

4.20.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP481 10.4" VGA, 2 aPCI, touch screen, keys
12	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 84: Contents of delivery - 4PP481.1043-B5

4.21 Device 4PP481.1505-75

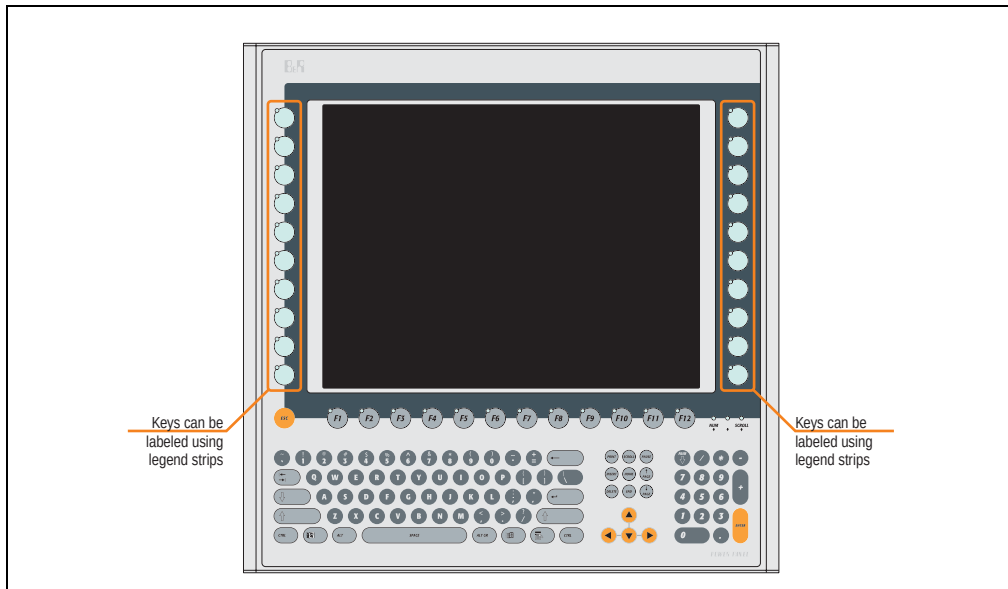


Figure 137: Front view - 4PP481.1505-75

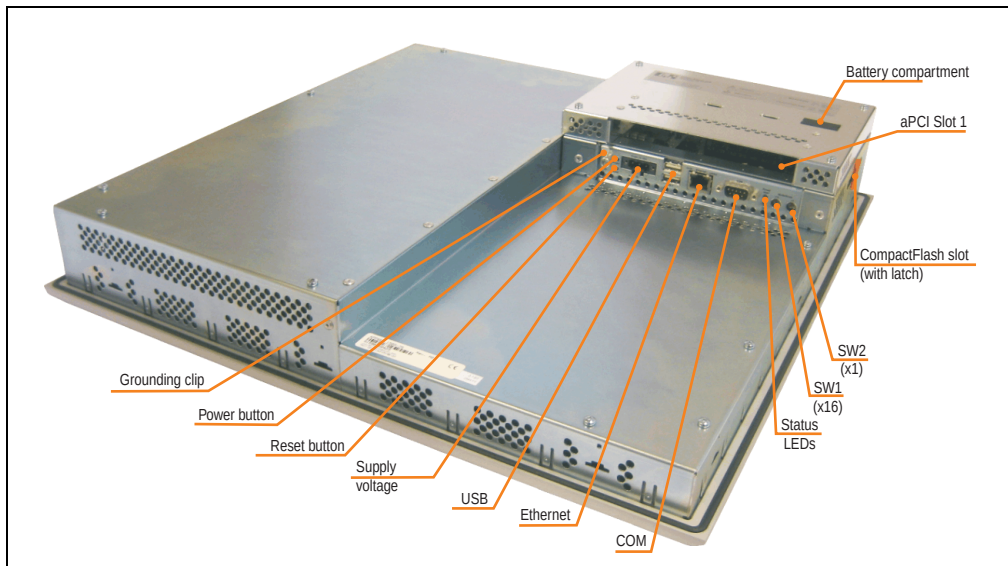


Figure 138: Rear view - 4PP481.1505-75

4.21.1 Technical data

Features	4PP481.1505-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB Rev. < C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 85: Technical data - 4PP481.1505-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP481.1505-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 Mbit/s), full speed (12 Mbit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 38.10 cm (380 mm) 262144 colors ⁴⁾ XGA, 1024 x 768 pixels 400:1 Direction R / direction L = 85° Direction U / direction D = 85° 250 cd/m² 50000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	20 with LED (yellow) 12 with LED (yellow) 4 without LED 15 without LED 73 without LED > 10 ⁶ actuations with 1 ±0.3 to 3 ±0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 1.38 A Maximum 2 A typically 23 W Yes
Ground resistance	0 Ohm

Table 85: Technical data - 4PP481.1505-75 (cont.)

Mechanical characteristics	4PP481.1505-75
Outer dimensions	
Width	435 mm
Height	430 mm
Depth	87 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Orange keys	Similar to Pantone 151CV ⁶⁾
Dark gray keys	Similar to Pantone 431CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 8 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +60°C
Transport	-20 .. +60°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 85: Technical data - 4PP481.1505-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.21.2 Dimensions

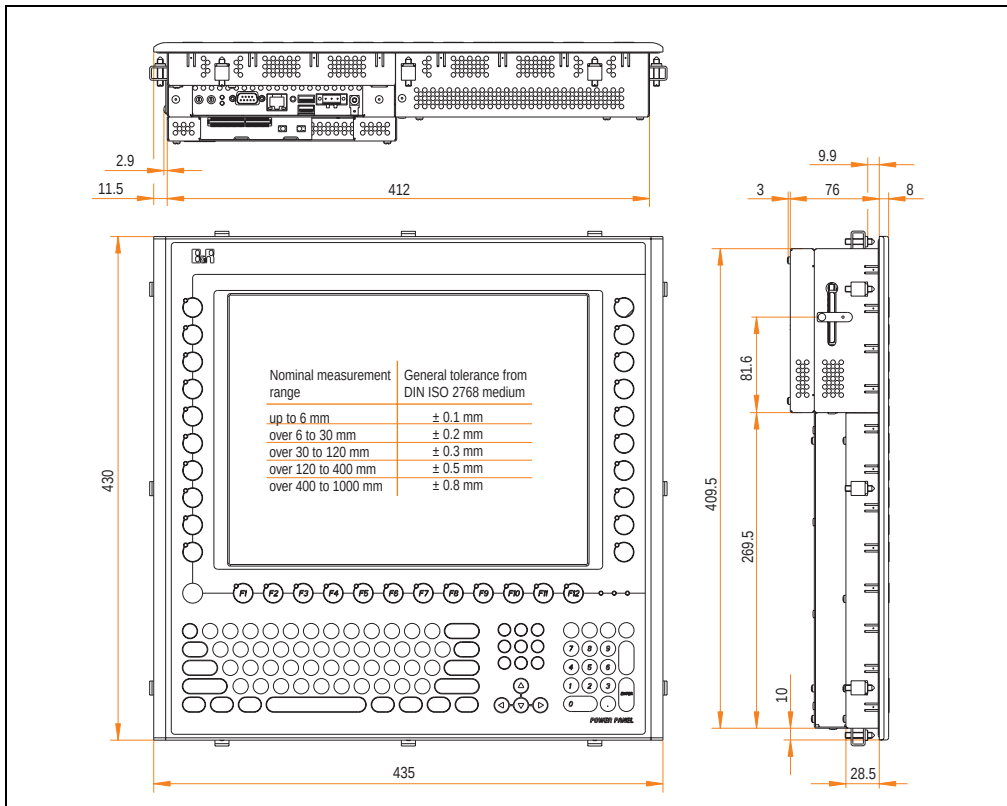


Figure 139: Dimensions - 4PP481.1505-75

4.21.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

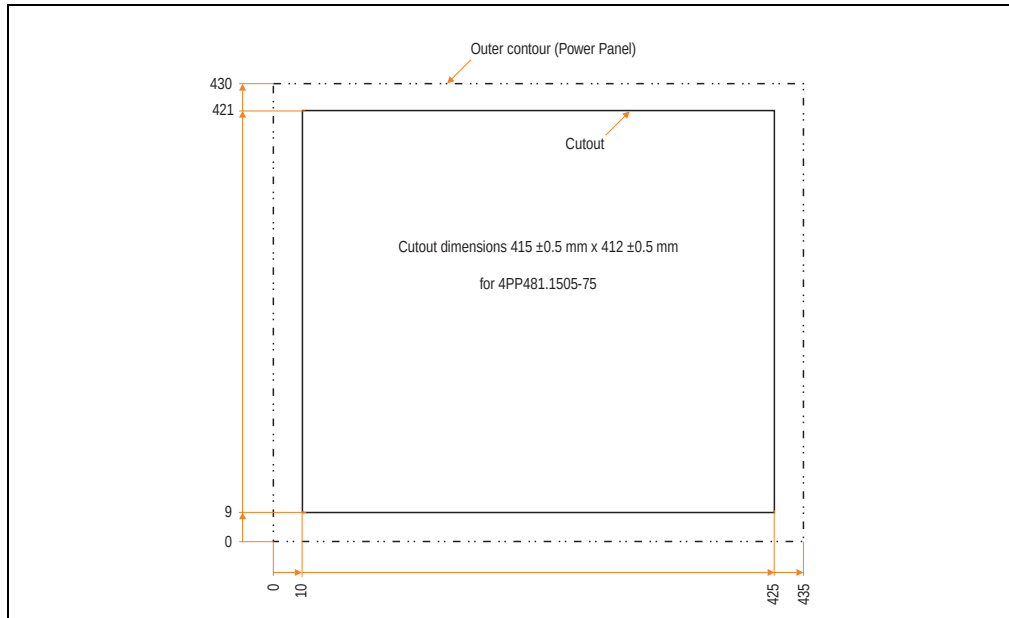


Figure 140: Cutout installation - 4PP481.1505-75

4.21.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP481 15" XGA, 1 aPCI, touch screen, keys
12	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 86: Contents of delivery - 4PP481.1505-75

4.22 Device 4PP482.1043-75

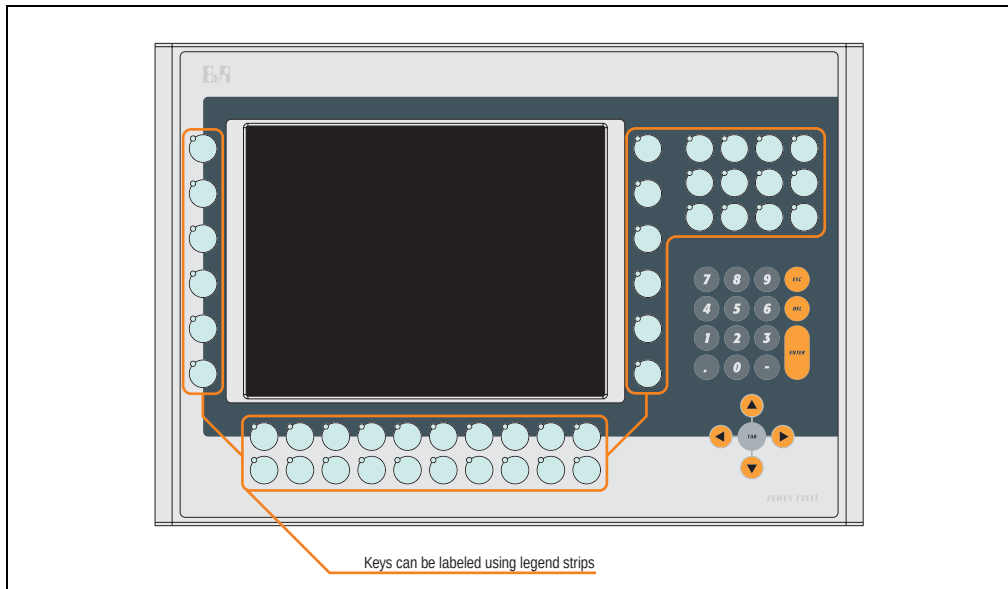


Figure 141: Front view - 4PP482.1043-75

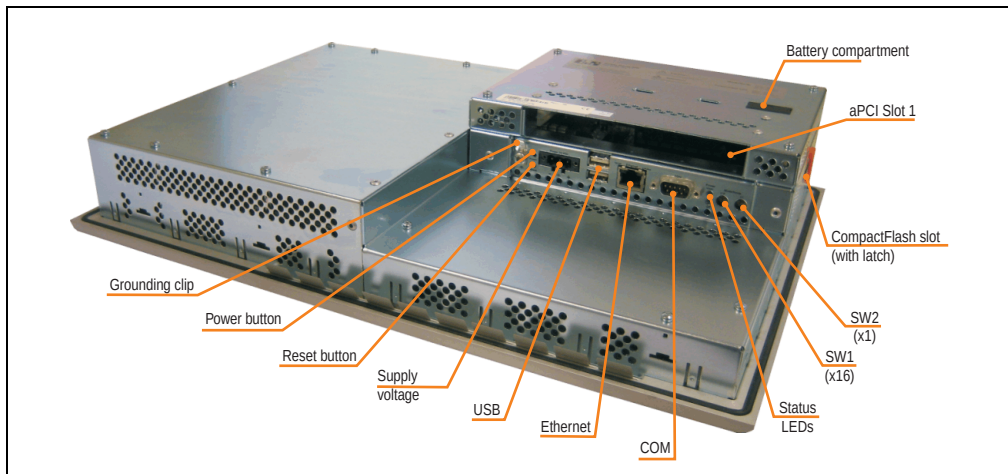


Figure 142: Rear view - 4PP482.1043-75

4.22.1 Technical data

Features	4PP482.1043-75
Boot loader / Operating system	Automation Runtime
Processor Type Expanded command set L1 cache L2 cache Floating point unit (FPU) Cooling Type	Geode LX800 500 MHz, 32-bit x86 MMX technology, 3D Now 128 KB (64 KB L cache / 64 KB D cache) 128 KB Yes Passive (heat sink)
Flash	2 MB (for firmware)
Memory Type Size	DDR SDRAM 128 MB (64 MB < Rev. C0)
Graphics Controller Memory	Geode LX800 8 MB shared memory (reserved by main memory)
SRAM Size Battery-buffered	512 KB Yes
Watchdog Controller	MTCX ¹⁾
Power failure logic Controller Buffer time	MTCX ¹⁾ 10 ms
Real-time clock Battery-buffered Accuracy	Yes At 25°C: typically 30 ppm (2.5 seconds) ²⁾ per day
Battery Type Removable Lifespan Backup capacitor (for changing battery) Buffer time	Renata 950 mAh Yes, accessible from the outside 3 years ³⁾ -
Ethernet Controller Transfer rate Connection Cables NE2000-compatible	Intel 82551ER 10/100 Mbps RJ45 twisted pair (10 Base T / 100 Base T) S/STP (category 5) -
CompactFlash Type Amount Connection	Type I 1 slot Primary IDE device
Serial interface Type UART Transfer rate Connection	RS232, modem-capable, not electrically isolated 16C550 compatible, 16-byte FIFO Max. 115 kBaud 9-pin DSUB

Table 87: Technical data - 4PP482.1043-75

Technical data • Power Panel 400 with Automation Runtime

Features	4PP482.1043-75
USB interface Type Amount Transfer rate Connection Current load	USB 1.1, USB 2.0 ⁴⁾ 2 Low speed (1.5 MBit/s), full speed (12 MBit/s), to high speed (480 Mbit/s) ⁴⁾ Type A Max. 500 mA per connection
Reset button	Yes, accessible from the outside
Power button	Yes, accessible from the outside
LEDs	1x CF (yellow) 1x combined power (red/green) and user (yellow)
Mode/Node switches	2, 16 digits each
aPCI slots	1 (see B&R System 2005 manual for available aPCI interface modules)
Display Type Diagonal Colors Resolution Contrast Perspective (see page 370) Horizontal Vertical Background lighting Brightness Half-brightness time	TFT colors 26.42 cm (264 mm) 262144 colors ⁴⁾ VGA, 640 x 480 pixels 600:1 Direction R / direction L = 70° Direction U = 45° / direction D = 35° 450 cd/m² 55000 hours
Touch screen Technology Controller Degree of transmission	Analog, resistive Elo, serial, 12- bit Up to 80% ± 5%
Filter glass Degree of transmission Coating	-
Keys/LED ⁵⁾ Function keys Soft keys Cursor keys Number block Other keys Key lifespan LED brightness	44 with LED (yellow) - 5 without LED 15 without LED - > 1,000,000 actuations with 1 ± 0.3 to 3 ± 0.3 N operating force Typ. 12 mcd (yellow) and 20 mcd (green)
Caution! Pressing several keys at the same time may trigger unintended actions.	
Electrical characteristics	
Power supply Rated voltage Rated current Starting current Power consumption Electrical isolation	18 - 30 VDC 1.38 A Maximum 2 A typically 23 W Yes
Ground resistance	0 Ohm

Table 87: Technical data - 4PP482.1043-75 (cont.)

Mechanical characteristics	4PP482.1043-75
Outer dimensions	
Width	423 mm
Height	288 mm
Depth	86 mm
Front	
Frame	Aluminum, naturally anodized ⁶⁾
Design	Gray ⁶⁾
Membrane	Polyester
Dark gray border around display	Similar to Pantone 432CV ⁶⁾
Light background	Similar to Pantone 427CV ⁶⁾
Orange keys	Similar to Pantone 151CV ⁶⁾
Dark gray keys	Similar to Pantone 431CV ⁶⁾
Legend strips (gray)	Similar to Pantone 429CV ⁶⁾
Gasket	Flat gasket around display front
Housing	Metal
Weight	Approx. 5.2 kg (without aPCI interface modules)
Environmental characteristics	
Ambient temperature	
Operation	0 .. +50°C
Storage	-20 .. +70°C
Transport	-20 .. +70°C
Relative humidity	
Operation	5% to 85%, non-condensing
Storage / Transport	T ≤ 40°C: 5% to 90%, non-condensing T > 40°C: < 90%, non-condensing
Vibration	
Operation (continuous)	2 - 9 Hz: 1.75 mm amplitude / 9 - 200 Hz: 0.5 g (4.9 m/s ² 0-peak)
Operation (occasional)	2 - 9 Hz: 3 mm amplitude / 9 - 200 Hz: 1 g (9.8 m/s ² 0-peak)
Storage	2 .. 9 Hz: 7.5 mm, 9 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Transport	2 .. 9 Hz: 7.5 mm, 8 .. 200 Hz: 2 g, 200 .. 500 Hz: 4 g
Shock	
Operation	15 g, 11 ms
Storage	30 g, 15 ms
Transport	30 g, 15 ms
Protection type	IP20 back side (only with installed CompactFlash card, inserted aPCI module or with an optional aPCI cover) IP65 / NEMA 250 type 4X, dust and sprayed water protection (front side)
Altitude	Max. 3000 m

Table 87: Technical data - 4PP482.1043-75 (cont.)

- 1) Maintenance Controller Extended.
- 2) At max. specified ambient temperature: typ. 50 ppm (4 seconds) - worst-case 100 ppm (8 seconds).
- 3) At 50°C, 18.5 µA of the supplied components and a self discharge of 40%.
- 4) The actual value depends on the operating system or diver being used.
- 5) The functions of the keys and the LEDs can be configured using B&R Automation Studio - Visual Components.
- 6) Depending on the process or batch, there may be visible deviations in the color and surface structure.

4.22.2 Dimensions

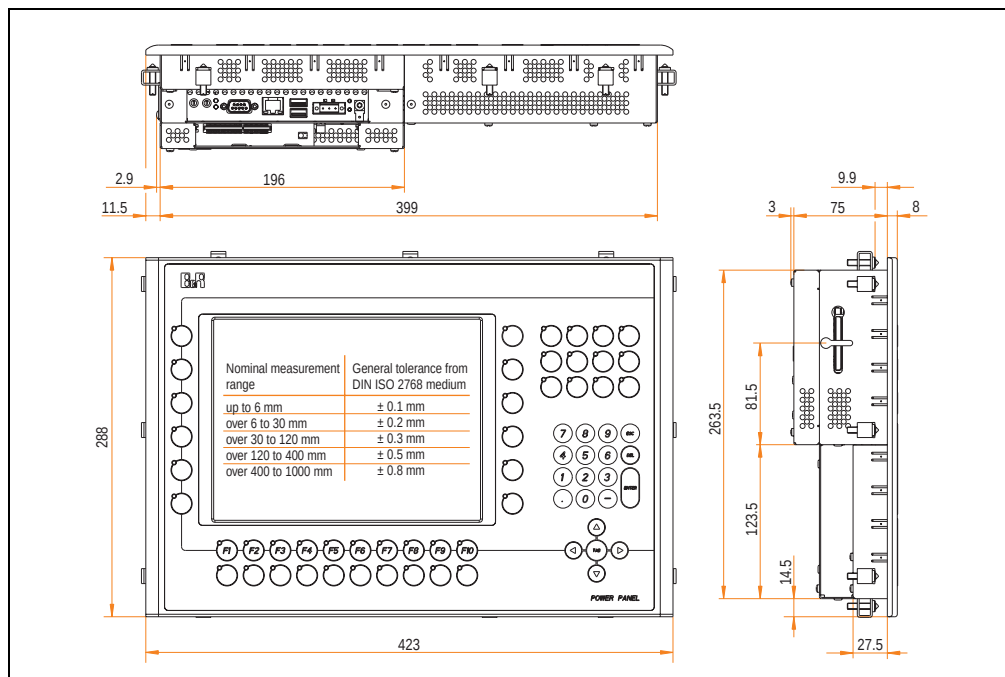


Figure 143: Dimensions - 4PP482.1043-75

4.22.3 Cutout installation

The cutout hole is to be made according to the following dimensions for cutout installation. The device must be mounted using the retaining clips included in delivery.

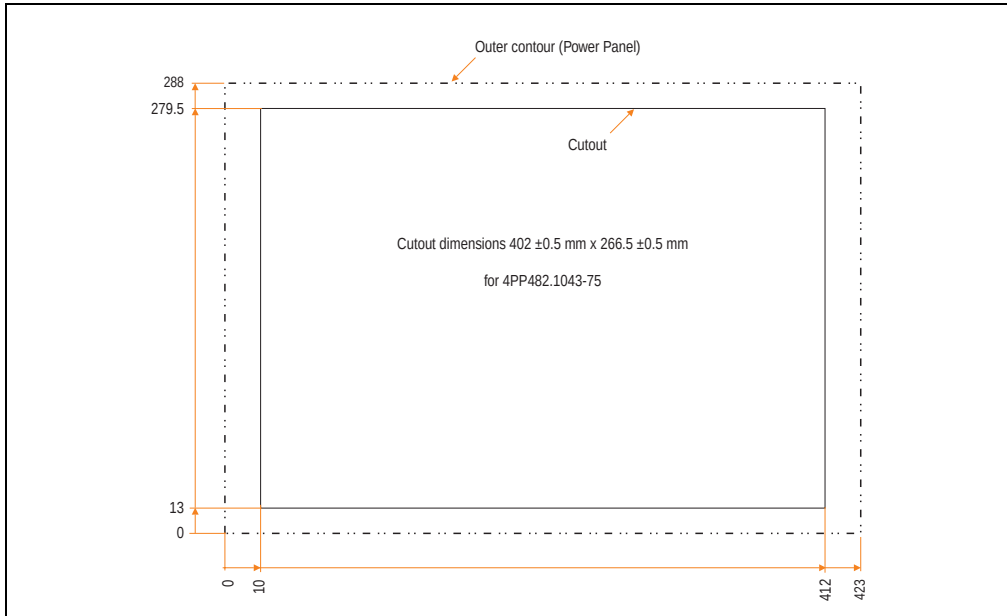


Figure 144: Cutout installation - 4PP482.1043-75

4.22.4 Contents of delivery

The following components are included in the delivery of the Power Panel device:

Amount	Component
1	Power Panel PP482 10.4" VGA, 1 aPCI, touch screen, keys
12	Retaining clips included
1	Lithium battery 3 V / 950 mAh included

Table 88: Contents of delivery - 4PP482.1043-75

Chapter 3 • Start-up

1. Mounting instructions

- The Power Panel must be mounted using the retaining clips included in delivery. Depending on the Power Panel version a corresponding number of retaining clips are included.



Figure 145: Retaining clip

- In order to guarantee proper air circulation, allow a sufficient amount of space above, below, to the side and behind the Power Panel device. The minimum specified free space can be found in the diagram below. Free space specifications apply to all Power Panel versions (with/without aPCI slots and keys).

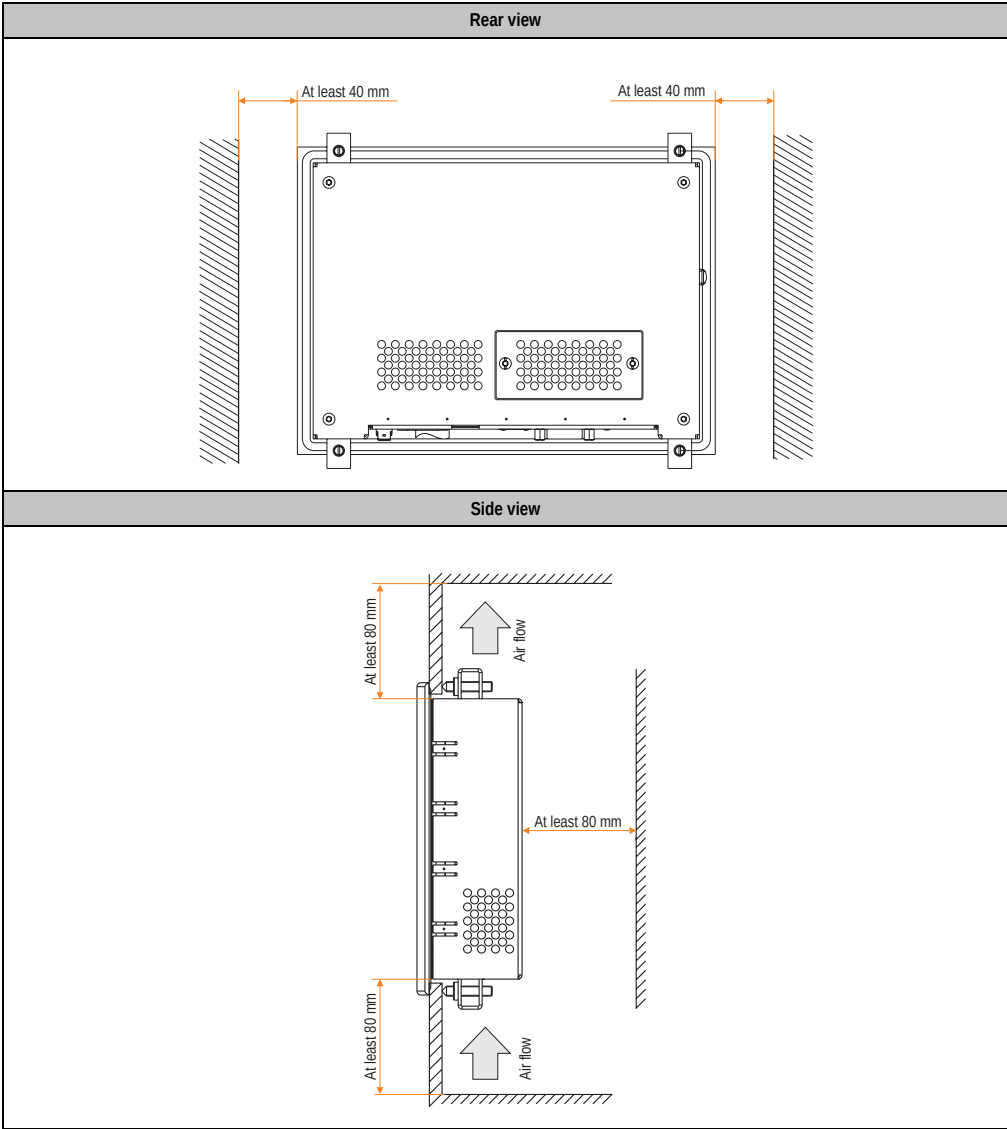


Table 89: Space for air circulation

2. Mounting orientation

The following diagram displays the specified mounting orientation for the Power Panel device. The mounting orientation applies to all Power Panel versions (with/without aPCI slots and keys).

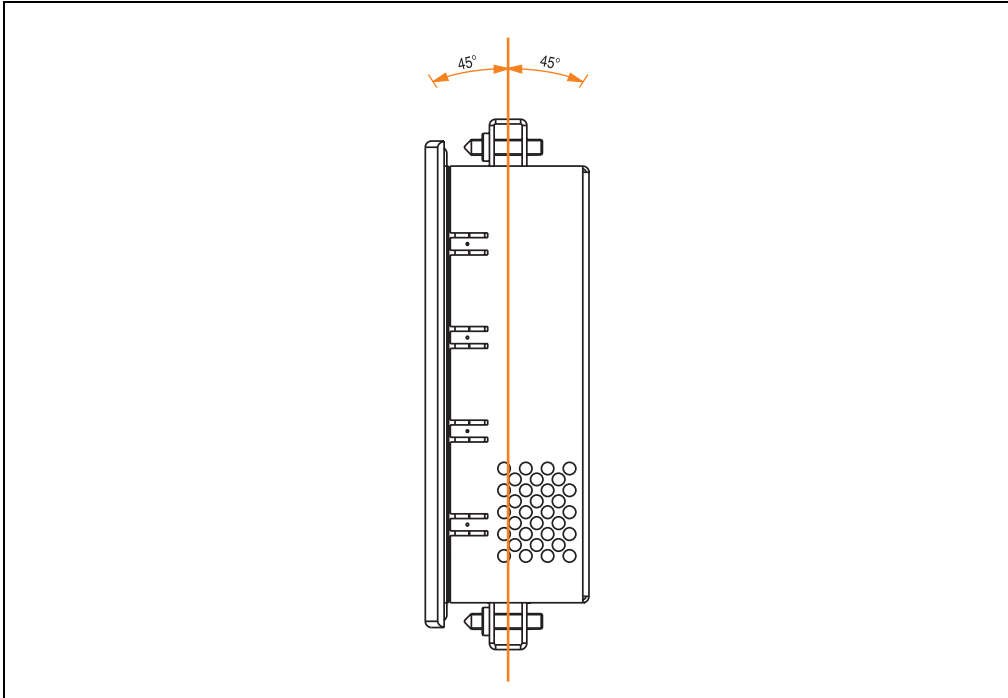


Figure 146: Mounting orientation for the Power Panel

Caution!

The maximum permitted ambient temperature can be found in the technical data for the respective Power Panel device.

3. Touch screen calibration:

B&R touch screen devices are equipped with a touch screen controller, which supports hardware calibration. This means that the devices are pre-calibrated from stock (pre-calibration). This feature proves advantageous in the case of a replacement part because a new calibration is no longer required when exchanging devices (identical model / type). Nevertheless, we recommend calibrating the device in order to achieve the best results and to better readjust the touch screen to the user's preferences.

Regardless of this, the touch screen driver requires calibration following installation.

3.1 Windows CE

Windows CE starts the touch screen calibration sequence during its first boot in the default configuration / delivered state.

3.2 Windows XP embedded

After first starting Windows XP embedded (First Boot Agent), the touch screen driver must be installed in the device in order to operate the touch screen. The corresponding drivers can be downloaded from the download area on the B&R homepage (www.br-automation.com). The touch screen should be calibrated while installing the driver.

3.3 Automation Runtime / Visual Components

The first time the touch screen is used, it must be calibrated once in the customer application for the existing device and project.

Chapter 4 • Software

1. Power Panel 300 with BIOS

Information:

The following diagrams and BIOS menu items including descriptions refer to BIOS Version 1.14. It is therefore possible that these diagrams and BIOS descriptions do not correspond with the installed BIOS version.

1.1 General

BIOS stands for "Basic Input Output System." It is the most basic standardized communication between the user and the system (hardware). A B&R-modified BIOS from Insyde is used in the Power Panel devices.

BIOS setup lets you modify basic system configuration settings. These settings are saved in CMOS RAM.

The CMOS RAM is a nonvolatile, battery-backed memory that retains information when power is not applied to the Power Panel.

BIOS is immediately activated when switching on the power supply of the Power Panel.

BIOS reads the system configuration information in CMOS RAM, checks the system, and configures it using the power-on self-test (POST).

1.2 Summary screen

```

Power Panel
Rev: V01.14 (1.02.15)      Built: 07/18/2007 07:38:15
Geode LX Rev: C0 @ 500MHz   5536 Rev: B1
Memory: 57024k @ 333MHz/DDR  CAS: 2.5
Floppy A: 1.44M             COM1: 03F8      GeodeROM: 4.52.36
                               COM2: 02F8      VSA: 03B0
                               VideoBIOS: 060C
USB: Legacy
PM: Disabled
(c) 2002-2007 Copyright Bernecker + Rainer
(c) 1999-2005 Copyright Advanced Micro Devices

```

Figure 147: BIOS summary screen for VGA, SVGA and XGA Power Panel devices

To deactivate this summary screen for VGA, SVGA and XGA variants, see "Miscellaneous configuration" on page 265.

```

Power Panel
Rev: V01.14 (1.02.15)      Built: 07/18/2007
Geode LX Rev: C0 @ 500MHz   5536 Rev: B1
Memory: 57024k @ 333MHz/DDR  CAS: 2.5
FPD A: 1.44M                COM1: 03F8
                               COM2: 02F8
USB: Legacy
PM: Disabled                GeodeROM: 4.52.36
                               VideoBIOS: 060C
                               USA: 03B0
(c) 1999-2007 B&R
(c) 1999-2005 AMD

```

Figure 148: BIOS summary screen for QVGA Power Panel devices

To deactivate this summary screen for QVGA variants, see "Miscellaneous configuration" on page 287.

To make changes in the BIOS setup, the DEL key must be pressed when booting the Power Panel device as soon as the following message appears in the upper margin of the display (during the POST):



Figure 149: Press DEL for setup

If the message disappears before DEL has been pressed¹⁾, then the Power Panel must be booted again in order to enter BIOS setup.

Important!

The following general rule applies: Only modify those settings that you completely understand. On no account should settings be changed without a good reason. The BIOS settings have been carefully chosen by B&R to guarantee ideal performance and reliability. Even a seemingly minor change to the settings may cause the system to become unstable.

Information:

The settings recommended by B&R can be loaded with "Load defaults". For a list of the default values, see Section 1.5 "BIOS default values" on page 293.

The following keys¹⁾ help you navigate in BIOS setup:

Key	Function
Cursor ↑	Moves to the previous item.
Cursor ↓	Go to the next item.
Cursor ←	Moves to the previous item.
Cursor →	Go to the next item.
ESC	Exits the submenu.
Enter or press highlighted character shortcut	Changes to the selected menu.
F1 and ALT+H	Opens up a help window that describes the possible values for the highlighted item. Press ESC to exit the help window. In a help window, the cursor ↑, Cursor ↓, Home, End, Page Up, and Page Down keys can be used to navigate when help texts are longer than the displayable area.
Home	Jumps to the first BIOS menu item or object.
End	Jumps to the last BIOS menu item or object.
ALT+Q and ALT+X	Enters the BIOS main menu.

Table 90: BIOS-relevant keys

1) A USB keyboard is required to enter characters and operate BIOS setup pages.

Key	Function
- (Minus)	Decreases the numerical value or selects the previous parameter value.
+ (Plus)	Increases the numerical value or selects the next parameter value.

Table 90: BIOS-relevant keys (cont.)

1.3 BIOS settings for VGA, SVGA and XGA Power Panel devices

Information:

The BIOS default values can be found in the section 1.5 "BIOS default values" on page 293.

1.3.1 Main menu

The BIOS setup main menu appears immediately after pressing the DEL button while the system is booting:

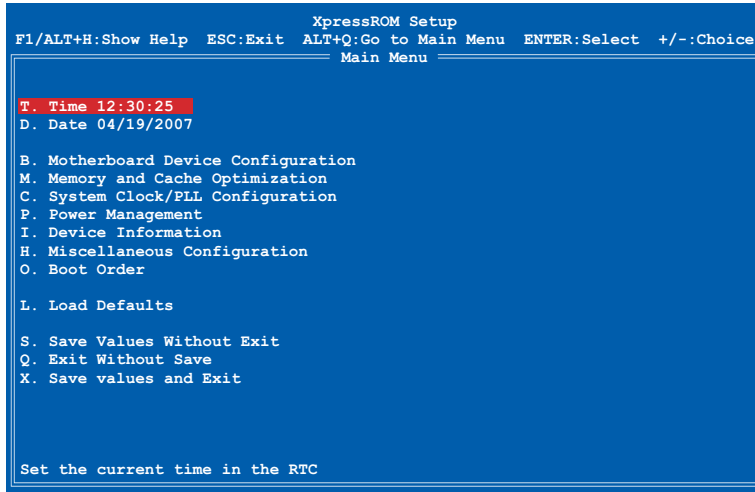


Figure 150: Main menu

The individual menu items are explained in detail in the following sections.

Shortcut	BIOS setup menu	Function
T	Time 21:56:12	The system time can be configured here.
D	Date 04/19/2007	The system date can be configured here.
B	Motherboard device configuration	Motherboard resources can be configured here.
M	Memory and cache optimization	The settings for memory management can be made here.
C	System clock/PLL configuration	The timing settings can be made here.
P	Power management	Setup of various APM (Advanced Power Management) options.

Table 91: Overview of BIOS main menu functions

Shortcut	BIOS setup menu	Function
I	Device information	Important parameters (e.g. temperature, Mode/Node position, etc.) for a Power Panel device are displayed here.
H	Miscellaneous configuration	The various BIOS settings can be configured here (Summary screen, Halt on errors, etc.)
O	Boot order	The boot order can be set here.
L	Load defaults	Load the optimal BIOS settings for best performance.
S	Save values without exit	Saves BIOS values without exiting BIOS setup.
Q	Exit without save	Exits BIOS setup without saving any changes.
X	Save values and exit	Saves settings and exits BIOS setup.

Table 91: Overview of BIOS main menu functions (cont.)

1.3.2 Time

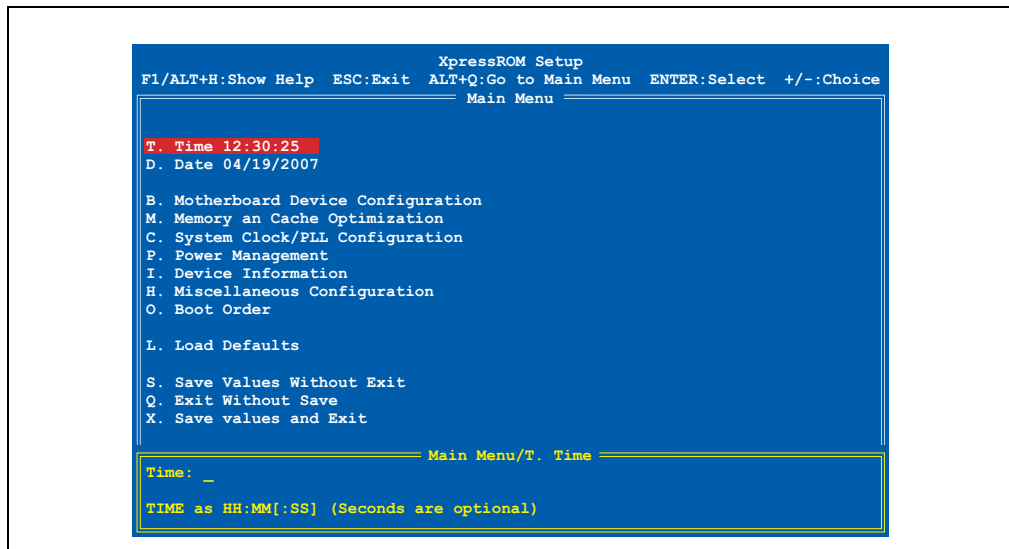


Figure 151: Time

The currently configured system time is displayed here. The time is buffered by a battery (CMOS battery) after the Power Panel device has been switched off.

A new system time can be entered with the shortcut "A" or by selecting "Time" and then confirming with Enter. The format HH:MM[:SS] must be entered as follows:

Example: Set time to 13:00:00.

The entry can be made in three different ways using the keyboard:

- 01:00:00 PM - Confirm with Enter
- 13:00 - Confirm with Enter

- 13: - Confirm with Enter

Information:

If using a German keyboard, press Shift + ö to enter ":".

1.3.3 Date

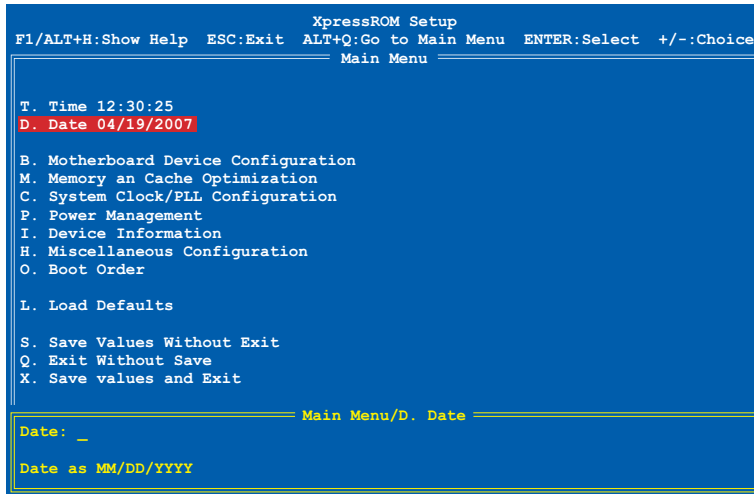


Figure 152: Date

The current system date is displayed here. The date is buffered by a battery (CMOS battery) after the Power Panel device has been switched off.

A new system date can be entered with the shortcut "B" or by selecting "Date" and then confirming with Enter. The format MM:DD:YYYY must be entered as shown in the following example:

Example: Set date to 2/12/2003.

Entry using keyboard:

- 02/12/2003 - Confirm with Enter

Information:

If using a German keyboard, press the "-" key (next to the Shift key) to enter "/".

1.3.4 Motherboard device configuration

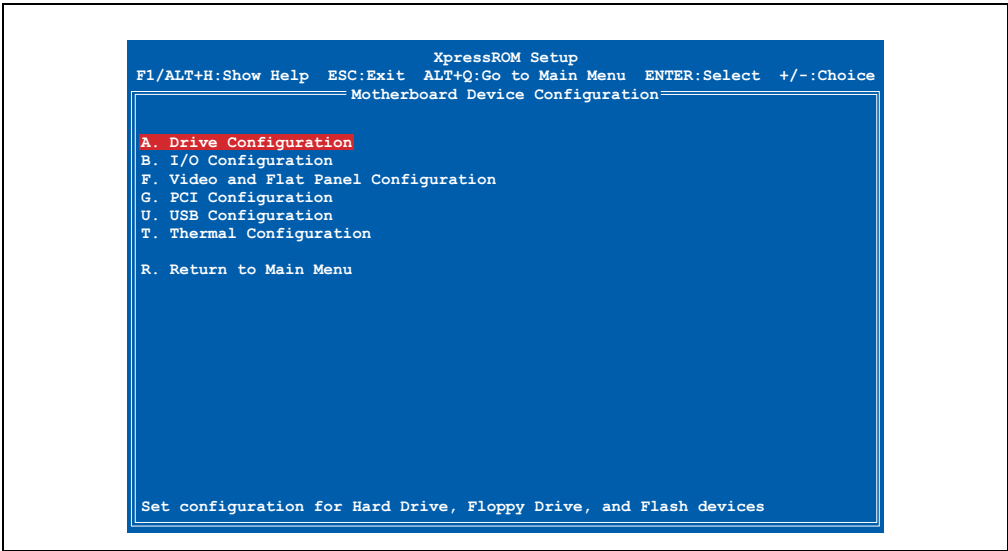


Figure 153: Motherboard device configuration

Shortcut	BIOS setup menu	Function
A	Drive configuration	Settings for the floppy drive and CompactFlash card.
B	I/O configuration	Configuration of the I/O devices.
F	Video and flat panel configuration	Displays the video settings and configuration for resolution, brightness, and contrast display parameters.
G	PCI configuration	Configures PCI bus settings.
U	USB configuration	Configures USB settings.
T	Thermal configuration	Display of temperatures.
R	Return to main menu	Exits the current page and returns to the BIOS main menu.

Table 92: BIOS motherboard device configuration menu

Motherboard device configuration - Drive configuration

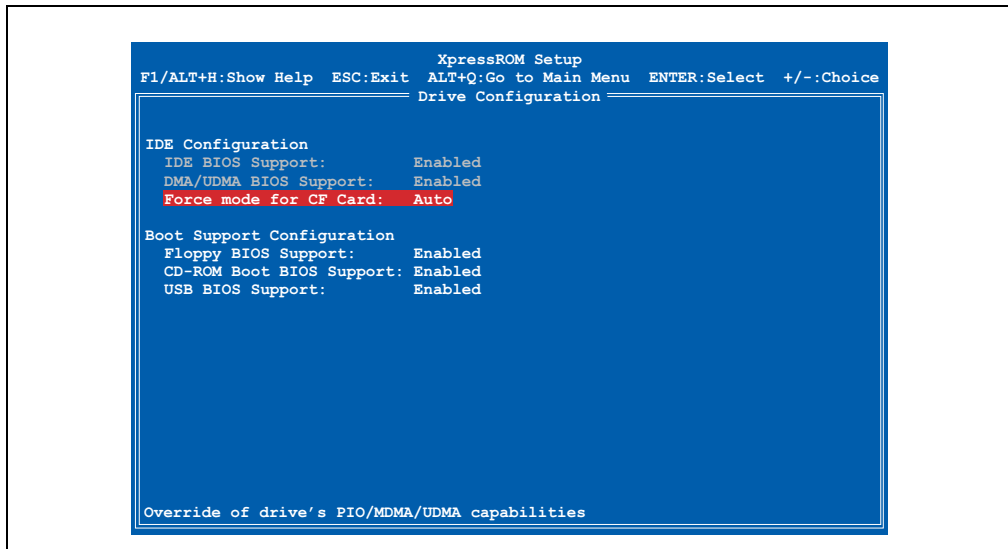


Figure 154: Motherboard device configuration - Drive configuration

BIOS setting	Meaning	Setting options	Effect
IDE BIOS support	Displays the IDE configuration of the inserted CompactFlash card.	None	-
DMA/UDMA BIOS support	Display of the DMA/UDMA BIOS support for the inserted CompactFlash card.	None	-
Force mode for CF card	The maximum data transfer mode to and from a CompactFlash card can be configured here. Information: If a mode is configured that is not supported by the CompactFlash card, then the fastest supported mode is configured.	Auto	Configures the fastest mode supported by the inserted CompactFlash card.
		PIO 0 to PIO 4	Manual configuration option for PIO mode.
		MDMA 0 to MDMA 2	Manual configuration option for MDMA mode.
		UDMA 0 to UDMA 5	Manual configuration option for UDMA mode.
Floppy BIOS support	Floppy support (USB) can be activated/deactivated here.	Enabled	Floppy support activated.
		Disabled	Floppy support deactivated.
CD-ROM boot BIOS support	The CD-ROM boot BIOS support can be activated/deactivated here.	Enabled	CD-ROM boot support activated. Booting a connected USB CD-ROM drive is possible.
		Disabled	CD-ROM boot support deactivated.
USB BIOS support	USB BIOS support can be activated/deactivated here.	Enabled	USB BIOS support activated.
		Disabled	USB BIOS support deactivated.

Table 93: BIOS drive configuration menu

Motherboard device configuration - I/O configuration

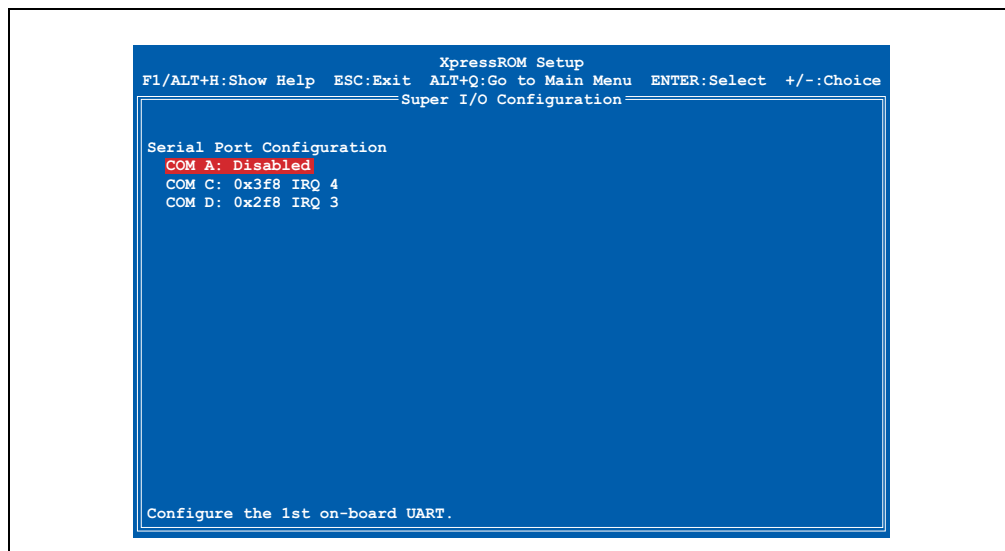


Figure 155: Motherboard device configuration - I/O configuration

BIOS setting	Meaning	Setting options	Effect
COM A	Configures the UART address range and the corresponding interrupt for the optional internal interface. Information: Two ports cannot use the same address range and interrupt.	Disabled	No assignment. The interface is disabled.
		0x3f8 IRQ 4	Use this address range and interrupt.
		0x2f8 IRQ 3	
		0x3e8 IRQ 4	
		0x2e8 IRQ 3	
COM C	Configures the UART address range and the corresponding interrupt for the external serial interface. Information: Two ports cannot use the same address range and interrupt.	Disabled	No assignment. The serial interface is disabled.
		0x3f8 IRQ 4	Use this address range and interrupt.
		0x2f8 IRQ 3	
		0x3e8 IRQ 4	
		0x2e8 IRQ 3	
		0x3f8 IRQ 12	
		0x2f8 IRQ 11	
		0x3e8 IRQ 12	
		0x2e8 IRQ 11	

Table 94: BIOS super I/O configuration menu

BIOS setting	Meaning	Setting options	Effect
COM D	Configures the UART address range and the corresponding interrupt for the touch controller. Information: Two ports cannot use the same address range and interrupt.	Disabled	No assignment. The touch screen is disabled and does not function.
		0x3f8 IRQ 4	Use this address range and interrupt.
		0x2f8 IRQ 3	
		0x3e8 IRQ 4	
		0x2e8 IRQ 3	
		0x3f8 IRQ 12	
		0x2f8 IRQ 11	
		0x3e8 IRQ 12	
		0x2e8 IRQ 11	

Table 94: BIOS super I/O configuration menu (cont.)

Motherboard device configuration - Video and flat panel

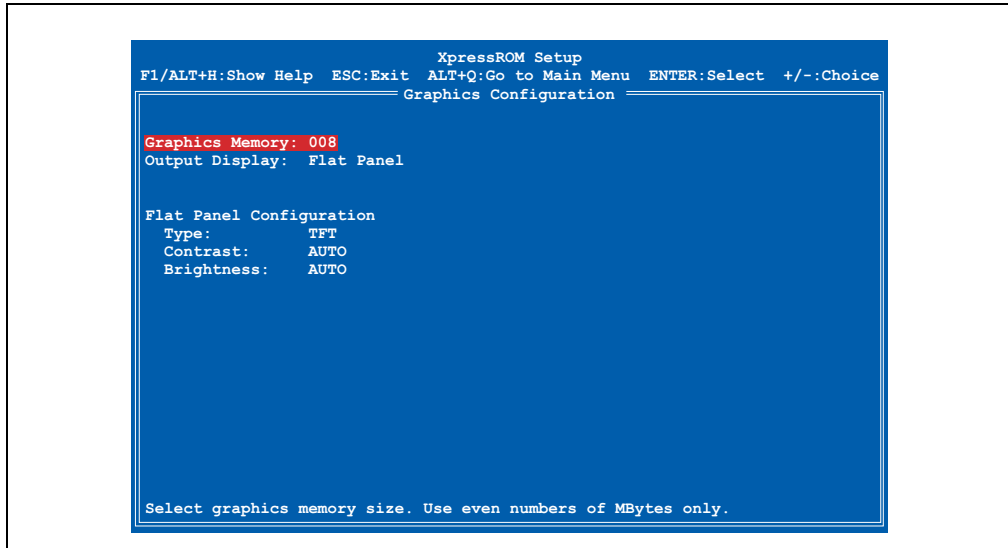


Figure 156: Motherboard device configuration - Video and flat panel configuration

BIOS setting	Meaning	Setting options	Effect
Graphics memory	Setting for the amount of graphics memory reserved by the main memory.	2-254	Manually set the value.
Output display	Selection of display mode	Flat panel	Displays on a Power Panel display.
		Panel and CRT	Displays on an external monitor and Power Panel display.
Type	Displays the Power Panel display type.	None	-

Table 95: BIOS video configuration menu

BIOS setting	Meaning	Setting options	Effect
Contrast	Setting for the contrast of the display.	Auto	The optimal contrast is automatically configured using the factory settings. A contrast value between 100% and 0% is set.
		0% to 100%	Manual setting of the desired contrast within factory settings limits.
Brightness	Setting for the background lighting of the display.	Auto	The optimal brightness is automatically configured using the factory settings. A brightness value between 100% and 0% is set.
		0% to 100%	Manual setting of the desired brightness within factory settings limits.

Table 95: BIOS video configuration menu (cont.)

Motherboard device configuration - PCI configuration

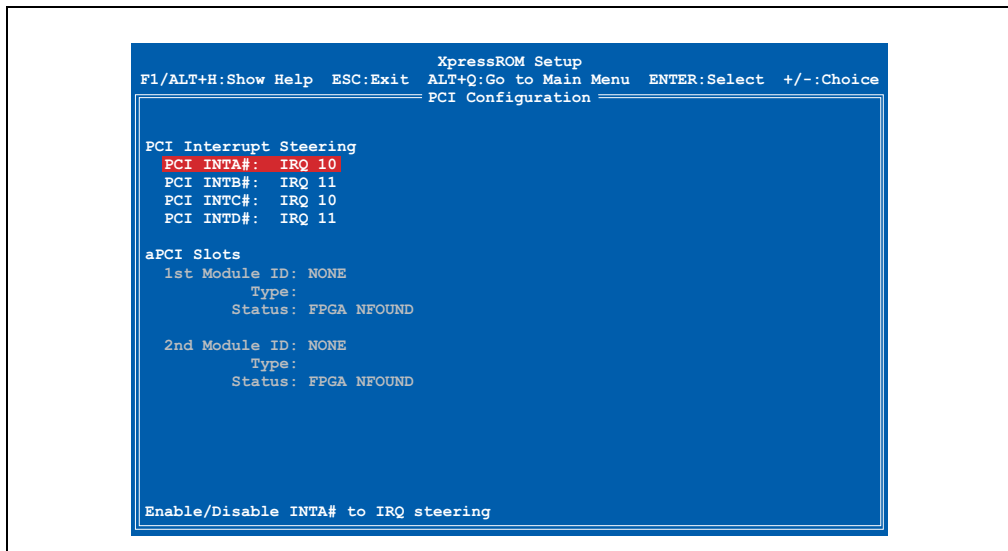


Figure 157: Motherboard device configuration - PCI configuration

BIOS setting	Meaning	Setting options	Effect
PCI INTA#	IRQ setting for the VGA controller.	Disabled	No IRQ is reserved.
		3, 4, 5, 6, 7, 9, 10, 11, 12, 14 or 15	Manual configuration of the IRQ.
PCI INTB#	IRQ setting for the audio controller.	Disabled	No IRQ is reserved.
		3, 4, 5, 6, 7, 9, 10, 11, 12, 14 or 15	Manual configuration of the IRQ.
PCI INTC#	Activates IRQ for aPCI slot 2. First IRQ for aPCI slot 2 and IRQ for IRQ for aPCI slot 1.	Disabled	No IRQ is reserved.
		3, 4, 5, 6, 7, 9, 10, 11, 12, 14 or 15	Manual configuration of the IRQ.

Table 96: BIOS PCI configuration menu

BIOS setting	Meaning	Setting options	Effect
PCI INTD#	IRQ setting for the USB interface.	Disabled	No IRQ is reserved.
		3, 4, 5, 6, 7, 9, 10, 11, 12, 14 or 15	Manual configuration of the IRQ.
aPCI slots	Information about aPCI modules located in the aPCI slots of the Power Panel device are displayed here.	None	-

Table 96: BIOS PCI configuration menu (cont.)

Motherboard device configuration - USB configuration

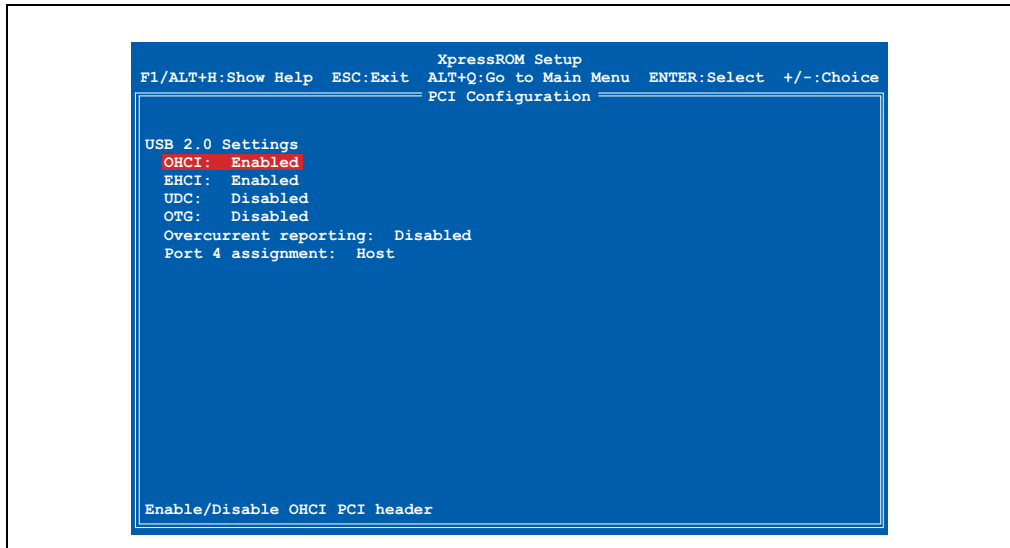


Figure 158: Motherboard device configuration - USB configuration

BIOS setting	Meaning	Setting options	Effect
OHCI	Turns USB 1.0/1.1 support on/off (OHCI - Open Host Controller Interface).	Enabled	Activates the USB port.
		Disabled	Deactivates the USB port.
EHCI	Turns USB 2.0 support on/off (EHCI - Enhanced Host Controller Interface).	Enabled	Enables this function.
		Disabled	Disables this function.
UDC	Turns the USB device controller on/off. When on, only the PCI config space is activated in BIOS.	Enabled	Enables this function.
		Disabled	Disables this function.
OTG	Turns the On-to-go device on/off. Only the PCI config space is activated in BIOS.	Enabled	Enables this function.
		Disabled	Disables this function.

Table 97: BIOS USB configuration menu

BIOS setting	Meaning	Setting options	Effect
Overcurrent reporting	This function enables an automatic error message to be sent to the system when the USB hub is overloaded (e.g. in Windows XP embedded).	Enabled	Enables this function.
		Disabled	Disables this function.
Port 4 assignment	With this option, USB port 4 can be configured.	Host	Functions as host.
		Device	Functions as device (two computers can be connected via port 4 - Master -> Slave).
		Not used	In BIOS, the default value (=Host) is assigned.

Table 97: BIOS USB configuration menu (cont.)

Motherboard device configuration - Thermal configuration

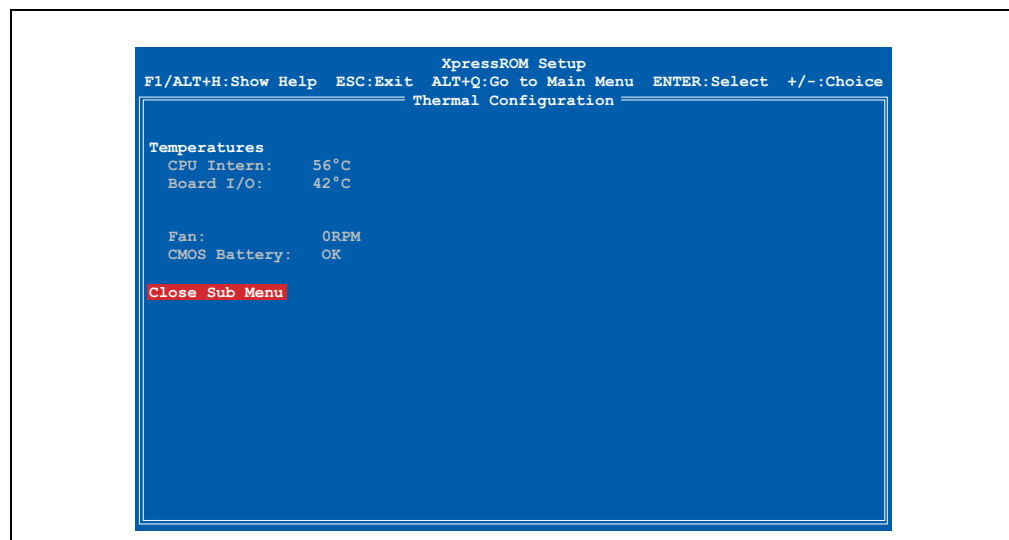


Figure 159: Motherboard device configuration - Thermal configuration

BIOS setting	Meaning	Setting options	Effect
CPU intern	Displays the current internal processor temperature.	None	-
Board I/O	Indicates the current board I/O temperature.	None	-
Fan	Displays fan speed for the selected panel (depending on features).	None	-
Close submenu	Close submenu	Enter	Closes the submenu.
CMOS battery	The status of the built-in CMOS battery is displayed here. Possible displays: OK - Battery is ok, Bad - Battery must be replaced.	None	-

Table 98: BIOS thermal configuration menu

1.3.5 Memory and cache optimization

Warning!

The parameters in this screen are for system designers, service personnel, and technically competent users only. Only modify those settings that you completely understand.

Incorrectly setting "Memory optimization" values can cause instability and even cause the entire system not to boot. If the PPC300 can no longer be booted, then the Mode/Node switch must be set to 0-0 and the default BIOS values can be restored by pushing the reset button three times (see section 1.5.8 "Restoring the default BIOS values" on page 295).

Information:

More detailed information about the meaning and effects of the settings can also be found in the corresponding User's Manual for the processor.

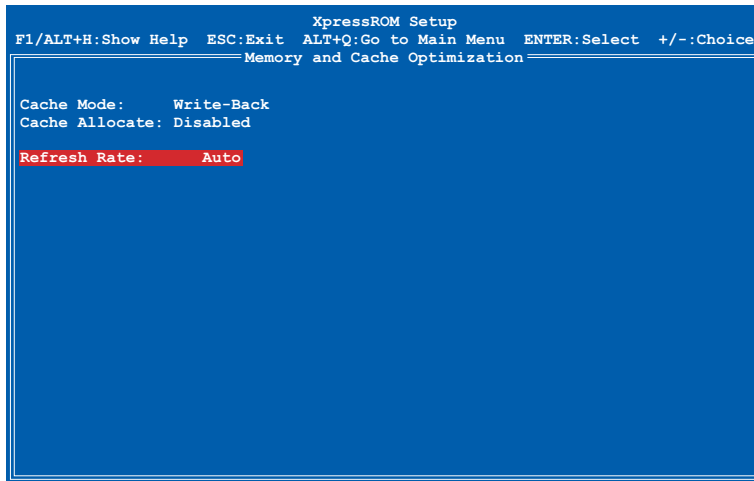


Figure 160: Memory and cache optimization

BIOS setting	Meaning	Setting options	Effect
Cache mode	Using cache mode, write accesses are determined on the cache.	Write back	The data is only written in the main memory if necessary (main memory and cache do not have the same information content).
		Write through	Data is written to the cache and to the main memory.
Cache allocate	The cache is divided into memory levels.	Disabled	Disables this function.
		Enabled	Enables this function.
Refresh rate	The refresh cycle can be set here. Note: Enter the clock frequency, the chipset does the rest.	Auto	Value selected automatically.
		15μs, 3μs, 7μs, 31μs, 62μs or 125μs	Manually set the value.

Table 99: BIOS memory and cache optimization menu

1.3.6 System clock/PLL configuration

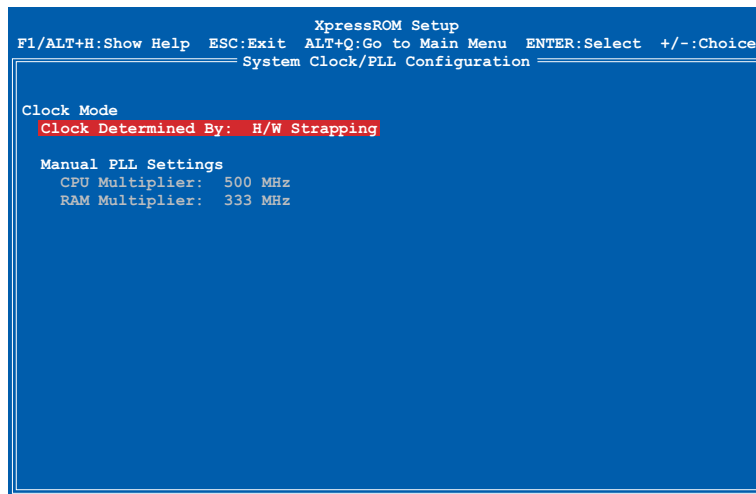


Figure 161: System clock/PLL configuration

BIOS setting	Meaning	Setting options	Effect
Clock determined by	The processor clock can be set with this option.	H/W strapping	Value is set automatically.
		Manual settings	Value must be set manually (CPU multiplier, RAM multiplier).

Table 100: System clock/PLL configuration

BIOS setting	Meaning	Setting options	Effect
CPU multiplier	The CPU multiplier can be selected with this option. (This value can only be set if the BIOS setting "Clock determined by" is set to Manual .)	None	-
		233 MHz, 266 MHz, 300 MHz, 333 MHz, 366 MHz, 400 MHz, 433 MHz, 466 MHz, 500 MHz	Manually set the value.
RAM multiplier	The RAM multiplier can be selected with this option. (This value can only be set if the BIOS setting "Clock determined by" is set to Manual .)	None	-
		233 MHz, 266 MHz, 300 MHz, 333 MHz, 366 MHz, 400 MHz, 433 MHz, 466 MHz, 500 MHz	Manually set the value.

Table 100: System clock/PLL configuration

1.3.7 Power management

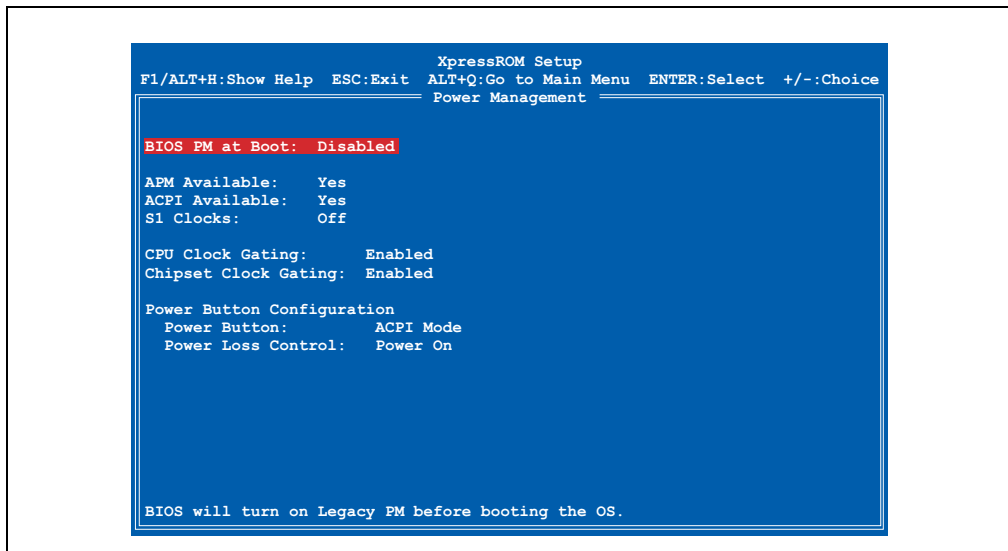


Figure 162: Power management

BIOS setting	Meaning	Setting options	Effect
BIOS PM at boot	Power Management is already enabled in the boot phase.	Enabled	Enables this function.
		Disabled	Disables this function.
APM available	Under this option you can set whether the operating system is allowed to change the BIOS power management settings.	Yes	Enables this function.
		No	Disables this function.
ACPI available	The ACPI (Advanced Configuration and Power Interface) option is an extended PnP and power management function.	Yes	Enables this function.
		No	Disables this function.

Table 101: BIOS power management menu

BIOS setting	Meaning	Setting options	Effect
S1 clocks	The processor can be "stopped" with this option.	Off	Disables this function.
		On	Enables this function.
CPU clock gating	During power management, the clock lines are turned off for devices connected to the CPU.	Enabled	Enables this function.
		Disabled	Disables this function.
Chipset clock gating	During power management, the clock lines are turned off for devices connected to the chipset.	Enabled	Enables this function.
		Disabled	Disables this function.
Power button	This option determines how the Power button will function.	ACPI mode	When the power button is pressed and held for 4 seconds, the Power Panel is switched off without shutting down the operating system.
		Instant off	Turns off immediately.
Power loss control	This option determines what should occur after a power failure.	Power-on	The device turns back on.
		Stay off	Device remains off.

Table 101: BIOS power management menu (cont.)

1.3.8 Device information

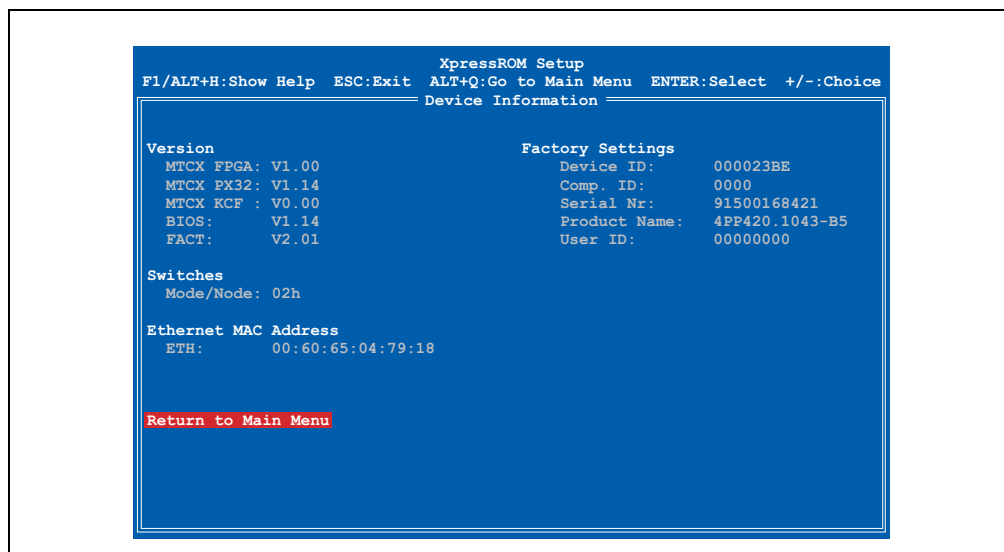


Figure 163: Device information

BIOS setting	Meaning	Setting options	Effect
MTXC FPGA	The FPGA firmware version is displayed here.	None	-
MTCX PX32	The MTCX firmware version is displayed here.	None	-

Table 102: BIOS device information menu

BIOS setting	Meaning	Setting options	Effect
MTCX KCF	The KCF (Key Configuration File) version is displayed here.	None	-
BIOS	The BIOS version is displayed here.	None	-
FACT	The version of the factory settings is displayed here.	None	-
ETH	The MAC address of the Ethernet interface is displayed here.	None	-
Mode/Node	Displays the current Mode/Node switch position.	None	-
Device ID	Hex value for the device code of the Power Panel device.	None	-
Comp. ID	The compatibility code of the Power Panel device is displayed here.	None	-
Serial no.	The serial number of the Power Panel device is displayed here.	None	-
Product name	The product name of the Power Panel device is displayed here.	None	-
User ID	The User ID of the Power Panel device is displayed here.	None	-

Table 102: BIOS device information menu (cont.)

1.3.9 Miscellaneous configuration

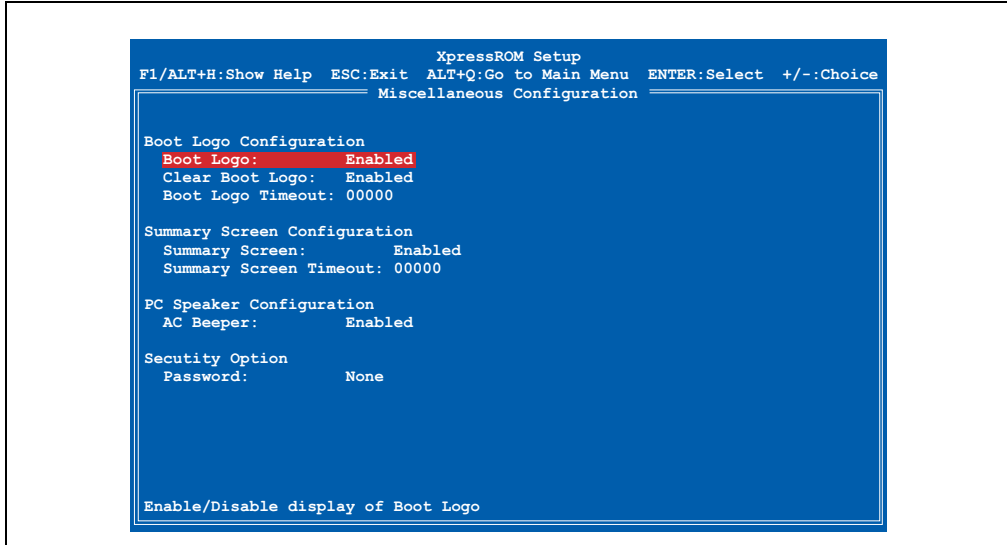


Figure 164: Miscellaneous configuration

BIOS setting	Meaning	Setting options	Effect
Boot logo ¹⁾	Displays a boot logo while the Power Panel is starting.	Disabled	No boot logo displayed during booting.
		Enabled	A B&R boot logo is displayed during booting as long as no customized bitmap is shown.
Clear boot logo	BIOS automatically clears the boot logo after starting in order to reduce the boot time.	Disabled	The boot logo is removed.
		Enabled	Disables this function.
Boot logo timeout	Defines the length of time the message "Press DEL for setup" is shown on the display, and how long the user has to switch to BIOS configuration. By pressing any key the boot can be continued before the timeout has expired.	0	No waiting.
		1-65535 [milliseconds]	The manually set value in milliseconds that must pass before the boot process continues. wird.
Summary screen	Displays information about the BIOS, VGA, VSA versions, devices found, etc.	Disabled	Shows the summary screen.
		Enabled	Hides the summary screen.
Summary screen timeout	Defines the length of time the summary screen is shown. By pressing any key the boot can be continued before the timeout has expired.	0	No waiting.
		1-65535 [milliseconds]	The manually set value in milliseconds that must pass before the boot process continues. wird.
AC beeper	The tone that sounds after startup can be turned on/off here.	Disabled	Disables this function.
		Enabled	Enables this function.
Password	A password for BIOS setup can be specified here. No changes can be made without entering the password.	None	No password.
		Enter password	Enter a password manually (max. 8 characters).

Table 103: BIOS miscellaneous configuration menu

1) The standard B&R boot logo is pre-configured upon delivery.

1.3.10 Boot order

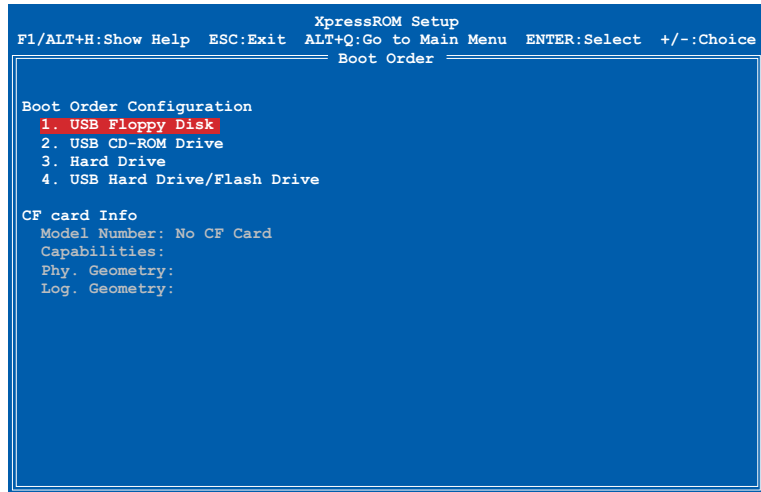


Figure 165: Boot order

BIOS setting	Meaning	Setting options		Effect
Boot order configuration	Configures the order in which memory media is booted. If two identical devices are selected a conflict warning is displayed.	1	USB floppy disk	The device attempts to boot from this drive first.
			USB CD-ROM drive	
			Hard drive	
			USB hard drive / flash drive	
			None	
		2	USB floppy disk	The device attempts to boot from this drive second.
			USB CD-ROM drive	
			Hard drive	
			USB hard drive / flash drive	
			None	
		3	USB floppy disk	The device attempts to boot from this drive third.
			USB CD-ROM drive	
			Hard drive	
			USB hard drive / flash drive	
			None	
		4	USB floppy disk	The device attempts to boot from this drive fourth.
			USB CD-ROM drive	
			Hard drive	
			USB hard drive / flash drive	
			None	
Model number	Displays the CompactFlash model ID.	None		-
Capabilities	Displays the possible data transfer speeds to or from the inserted CompactFlash card.	None		-
Phy. geometry	Displays the physical geometry of the inserted CompactFlash card in cylinders, heads, and number of sectors.	None		-
Log. geometry	Displays the logical geometry of the inserted CompactFlash card in cylinders, heads, and number of sectors.	None		-

Table 104: BIOS drive configuration menu

1.3.11 Load defaults

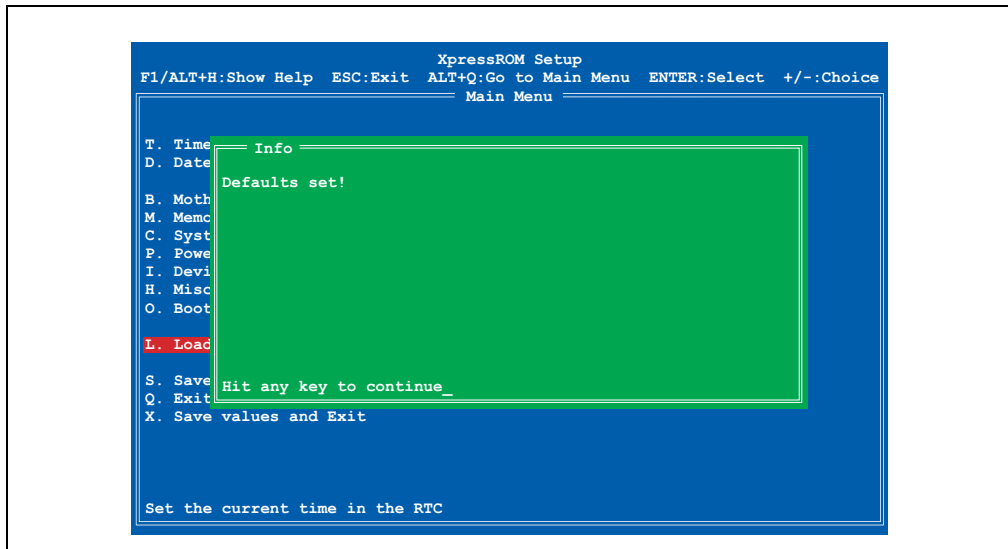


Figure 166: Load defaults

Under this BIOS menu item (shortcut "L"), by pressing any key you can load the values that were set at the time BIOS setup was opened. All changes made up to that point are lost as a result.

Restoring the default BIOS values

The BIOS default values can also be restored without entering the BIOS setup. For procedure, see Section 1.5.8 "Restoring the default BIOS values" on page 295.

1.3.12 Save values without exit

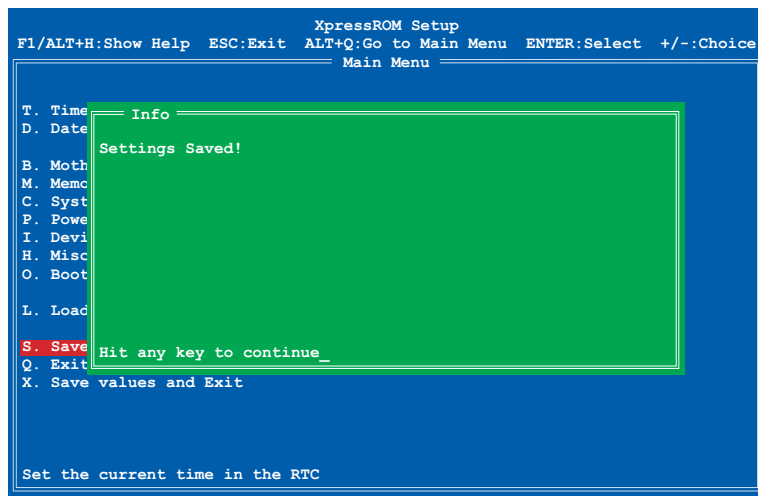


Figure 167: Save values without exit

The BIOS values are saved using this menu item (shortcut "S") by pressing any key. The user can then make additional settings or exit BIOS setup.

1.3.13 Exit without save

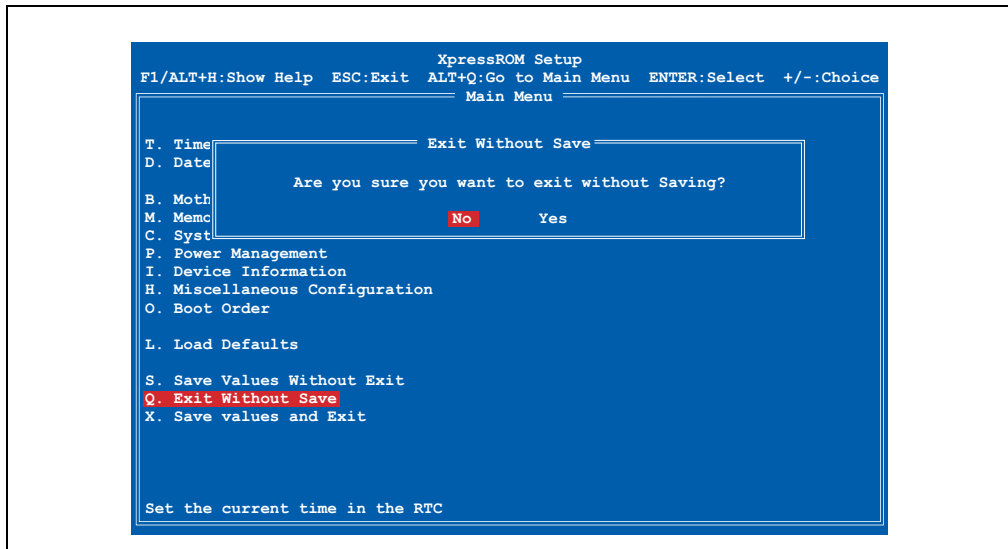


Figure 168: Exit without save

BIOS setup can be exited by selecting "Yes" under this menu item (shortcut "Q") without saving any changes that might have been made. The system is then automatically restarted.

Information:

If using a German keyboard, press the "z" key to enter "y".

1.3.14 Save values and exit

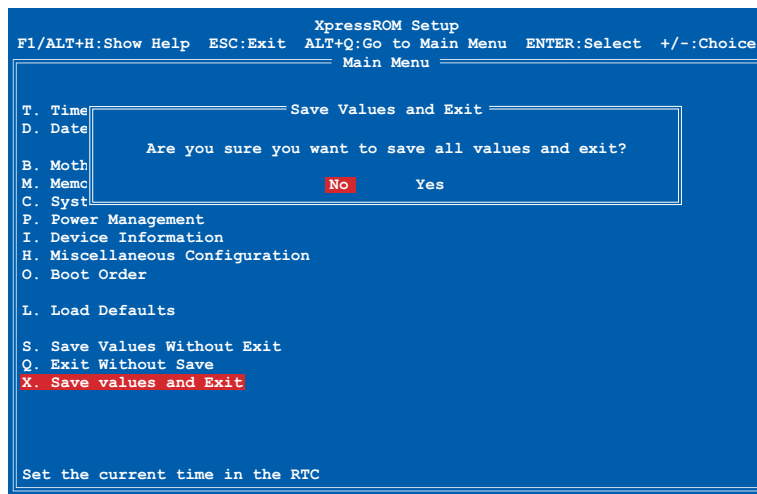


Figure 169: Save values and exit

If "Yes" is selected under this menu item (X shortcut), the system saves the settings, automatically exits BIOS setup, and reboots the system.

Information:

If using a German keyboard, press the "z" key to enter "y".

1.4 BIOS settings for QVGA Power Panel devices

Information:

The BIOS default values can be found in the section 1.5 "BIOS default values" on page 293.

1.4.1 Main menu

The BIOS setup main menu appears immediately after pressing the DEL button while the system is booting:

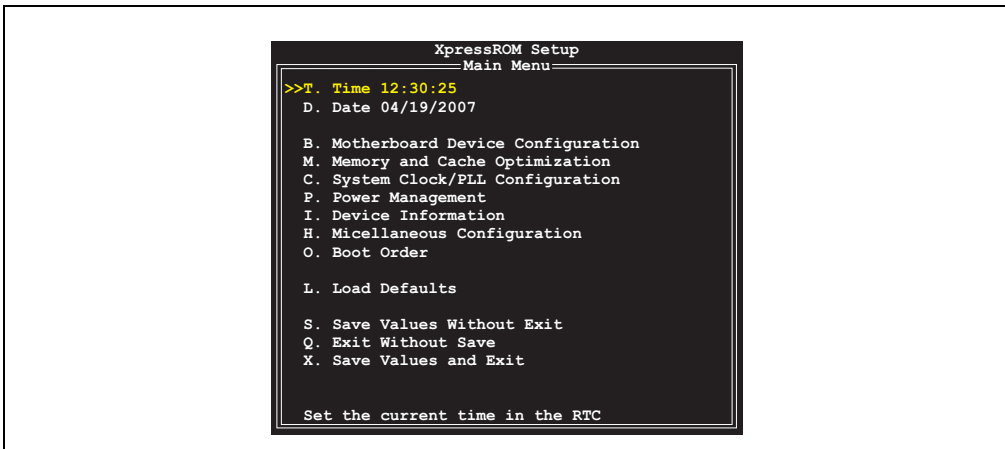


Figure 170: Main menu

The individual menu items are explained in detail in the following sections.

Shortcut	BIOS setup menu	Function
T	Time 00:02:56	The system time can be configured here.
D	Date 03/12/2007	The system date can be configured here.
B	Motherboard device configuration	Motherboard resources can be configured here.
M	Memory and cache optimization	The settings for memory management can be made here.
C	System clock/PLL configuration	The timing settings can be made here.
P	Power management	Setup of various APM (Advanced Power Management) options.
I	Device information	Important parameters (e.g. temperature, Mode/NodeMode/Node position, etc.) for a Power Panel device are displayed here.
H	Miscellaneous configuration	The various BIOS settings can be configured here (Summary screen, Halt on errors, etc.)

Table 105: Overview of BIOS main menu functions

Shortcut	BIOS setup menu	Function
O	Boot order	The boot order can be set here.
L	Load defaults	Load the optimal BIOS settings for best performance.
S	Save values without exit	Saves BIOS values without exiting BIOS setup.
Q	Exit without save	Exits BIOS setup without saving any changes.
X	Save values and exit	Saves settings and exits BIOS setup.

Table 105: Overview of BIOS main menu functions (cont.)

1.4.2 Time

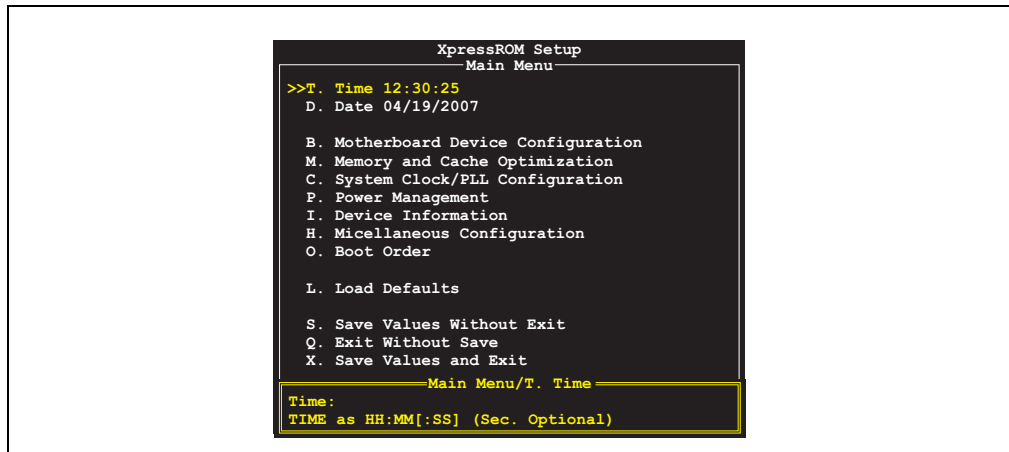


Figure 171: Time

The currently configured system time is displayed here. The time is buffered by a battery (CMOS battery) after the Power Panel device has been switched off.

A new system time can be entered with the shortcut "A" or by selecting "Time" and then confirming with Enter. The format HH:MM[:SS] must be entered as follows:

Example: Set time to 13:00:00.

The entry can be made in three different ways using the keyboard:

- 01:00:00 PM - Confirm with Enter
- 13:00 - Confirm with Enter
- 13: - Confirm with Enter

Information:

If using a German keyboard, press Shift + ö to enter ":".

1.4.3 Date

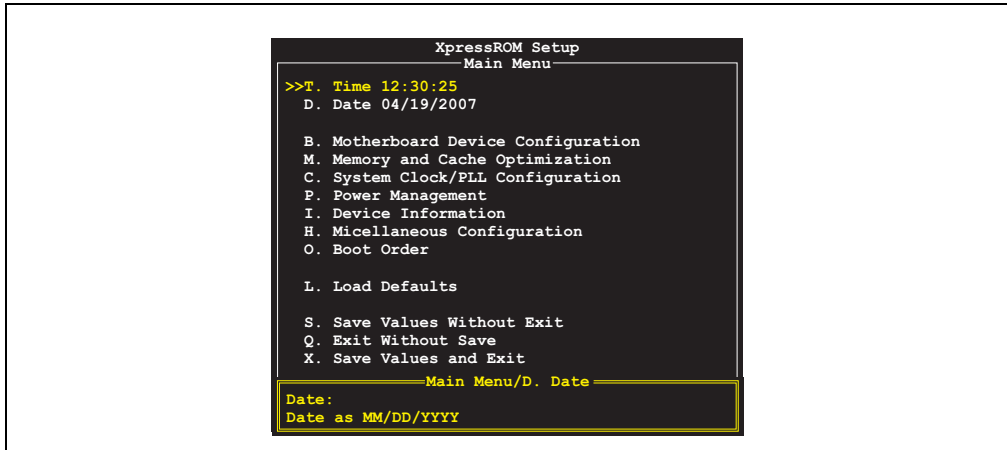


Figure 172: Date

The current system date is displayed here. The date is buffered by a battery (CMOS battery) after the Power Panel device has been switched off.

A new system date can be entered with the shortcut "B" or by selecting "Date" and then confirming with Enter. The format MM:DD:YYYY must be entered as shown in the following example:

Example: Set date to 2/12/2003.

Entry using keyboard:

- 02/12/2003 - Confirm with Enter

Information:

If using a German keyboard, press the "-" key (next to the Shift key) to enter "/".

1.4.4 Motherboard device configuration

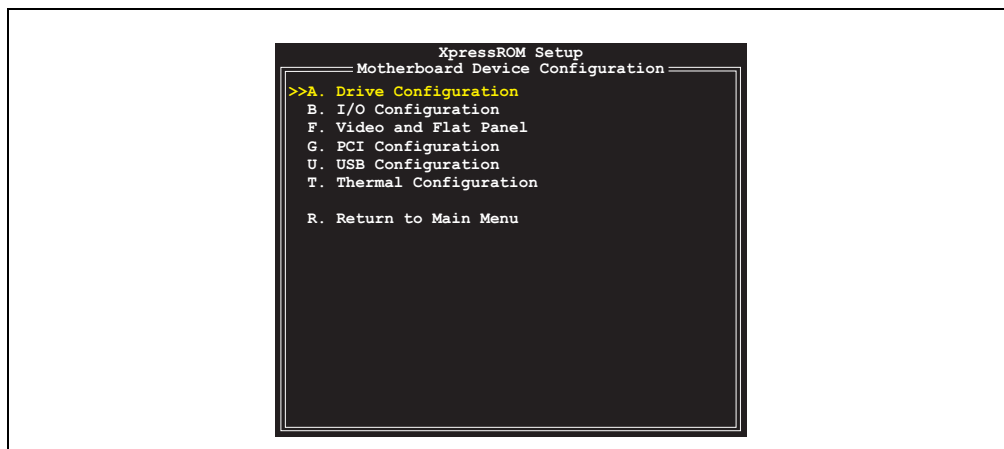


Figure 173: Motherboard device configuration

Shortcut	BIOS setup menu	Function
A	Drive configuration	Settings for the floppy drive and CompactFlash card.
B	I/O configuration	Configuration of the I/O devices.
F	Video and flat panel	Displays the video settings and configuration for resolution, brightness, and contrast display parameters.
G	PCI configuration	Configures PCI bus settings.
U	USB configuration	Configures USB settings.
T	Thermal configuration	Display of temperatures.
R	Return to main menu	Exits the current page and returns to the BIOS main menu.

Table 106: BIOS motherboard device configuration menu

Motherboard device configuration - drive configuration

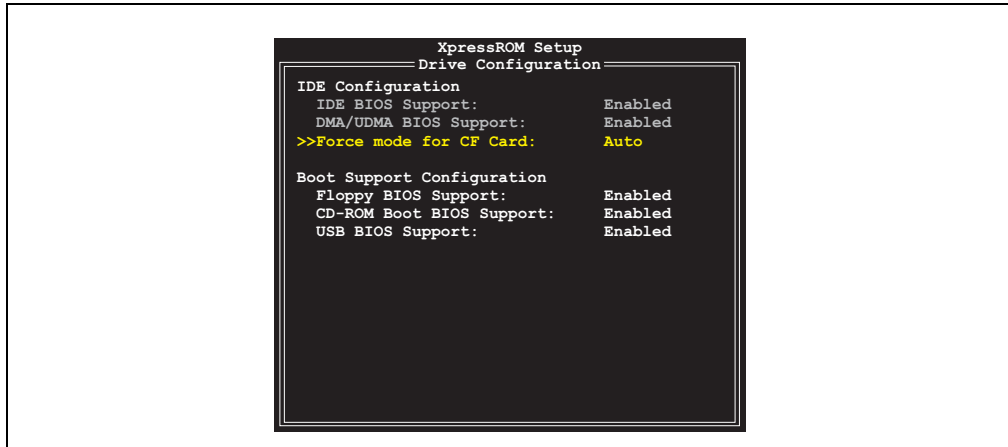


Figure 174: Motherboard device configuration - drive configuration

BIOS setting	Meaning	Setting options	Effect
IDE BIOS support	Displays the IDE configuration of the inserted CompactFlash card.	None	-
DMA/UDMA BIOS support	Display of the DMA/UDMA BIOS support for the inserted CompactFlash card.	None	-
Force mode for CF card	The maximum data transfer mode to and from a CompactFlash card can be configured here. Information: If a mode is configured that is not supported by the CompactFlash card, then the fastest supported mode is configured.	Auto	Configures the fastest mode supported by the inserted CompactFlash card.
		PIO 0 to PIO 4	Manual configuration option for PIO mode.
		MDMA 0 to MDMA 2	Manual configuration option for MDMA mode.
		UDMA 0 to UDMA 5	Manual configuration option for UDMA mode.
Floppy BIOS support	Floppy support (USB) can be activated/deactivated here.	Enabled	Floppy support activated.
		Disabled	Floppy support deactivated.
CD-ROM boot BIOS support	The CD-ROM boot BIOS support can be activated/deactivated here.	Enabled	CD-ROM boot support activated. Booting a connected USB CD-ROM drive is possible.
		Disabled	CD-ROM boot support deactivated.
USB BIOS support	USB BIOS support can be activated/deactivated here.	Enabled	USB BIOS support activated.
		Disabled	USB BIOS support deactivated.

Table 107: BIOS drive configuration menu

Motherboard device configuration - I/O configuration

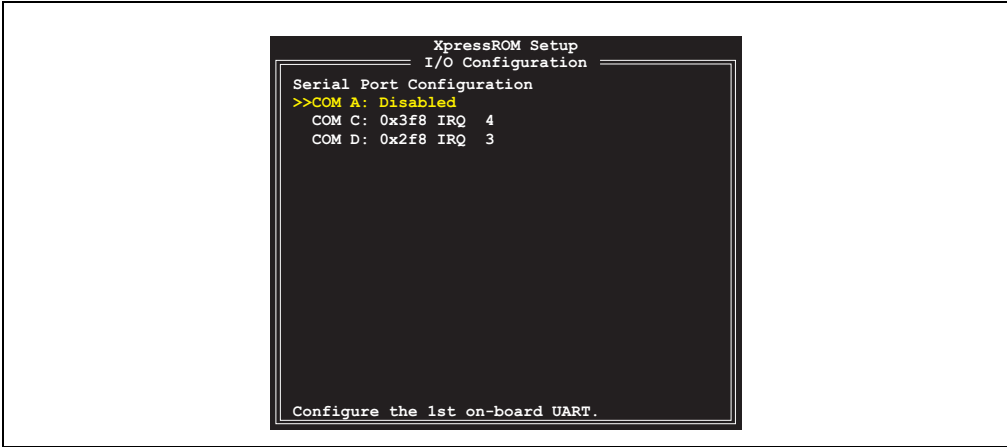


Figure 175: Motherboard device configuration - I/O configuration

BIOS setting	Meaning	Setting options	Effect
COM A	Configures the UART address range and the corresponding interrupt for the optional internal interface. Information: Two ports cannot use the same address range and interrupt.	Disabled	No assignment.
		0x3f8 IRQ 4	Use this address range and interrupt.
		0x2f8 IRQ 3	
		0x3e8 IRQ 4	
		0x2e8 IRQ 3	
COM C	Configures the UART address range and the corresponding interrupt for the external serial interface. Information: Two ports cannot use the same address range and interrupt.	Disabled	No assignment. The serial interface is disabled.
		0x3f8 IRQ 4	Use this address range and interrupt.
		0x2f8 IRQ 3	
		0x3e8 IRQ 4	
		0x2e8 IRQ 3	
		0x3f8 IRQ 12	
		0x2f8 IRQ 11	
		0x3e8 IRQ 12	
		0x2e8 IRO 11	

Table 108: BIOS super I/O configuration menu

BIOS setting	Meaning	Setting options	Effect
COM D	Configures the UART address range and the corresponding interrupt for the touch controller. Information: Two ports cannot use the same address range and interrupt.	Disabled	No assignment. The touch screen is disabled and does not function.
		0x3f8 IRQ 4	Use this address range and interrupt.
		0x2f8 IRQ 3	
		0x3e8 IRQ 4	
		0x2e8 IRQ 3	
		0x3f8 IRQ 12	
		0x2f8 IRQ 11	
		0x3e8 IRQ 12	
		0x2e8 IRQ 11	

Table 108: BIOS super I/O configuration menu (cont.)

Motherboard device configuration - Video and flat panel

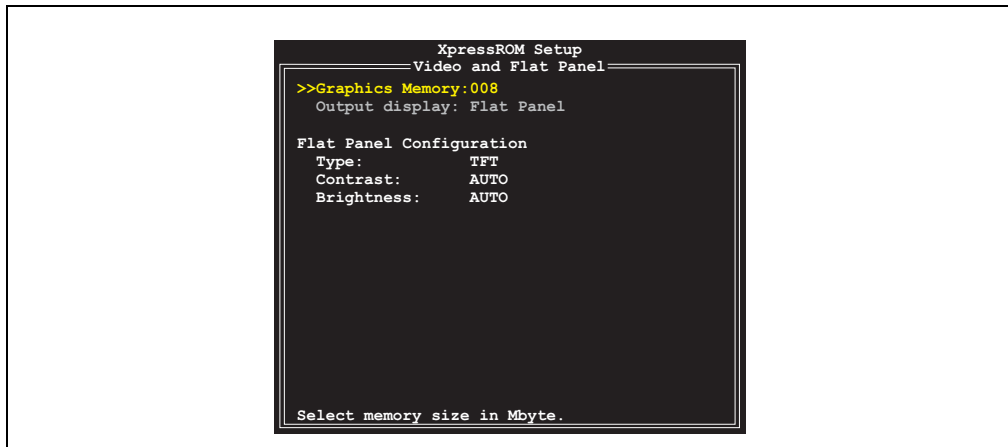


Figure 176: Motherboard device configuration - Video and flat panel configuration

BIOS setting	Meaning	Setting options	Effect
Graphics memory	Setting for the amount of graphics memory reserved by the main memory.	2-254	Manually set the value.
Output display	Selection of display mode	Flat panel	Displays on a Power Panel display.
		Panel and CRT	Displays on an external monitor and Power Panel display.
Type	Displays the Power Panel display type.	None	-

Table 109: BIOS video configuration menu

BIOS setting	Meaning	Setting options	Effect
Contrast	Setting for the contrast of the display. Note: Contrast settings can only be configured for passive displays. If the Mode/Node switch is set to 0/0, then contrast settings are automatically set to the default factory settings every time the Power Panel device is restarted.	Auto	The optimal contrast is automatically configured using the factory settings. A contrast value between 100% and 0% is set.
		0% to 100%	Manual setting of the desired contrast within factory settings limits.
Brightness	Setting for the background lighting of the display. Note: If the Mode/Node switch is set to 0/0, then brightness settings are automatically set to the default values from the factory settings every time the Power Panel device is restarted.	Auto	The optimal brightness is automatically configured using the factory settings. A brightness value between 100% and 0% is set.
		0% to 100%	Manual setting of the desired brightness within factory settings limits.

Table 109: BIOS video configuration menu (cont.)

Motherboard device configuration - PCI configuration

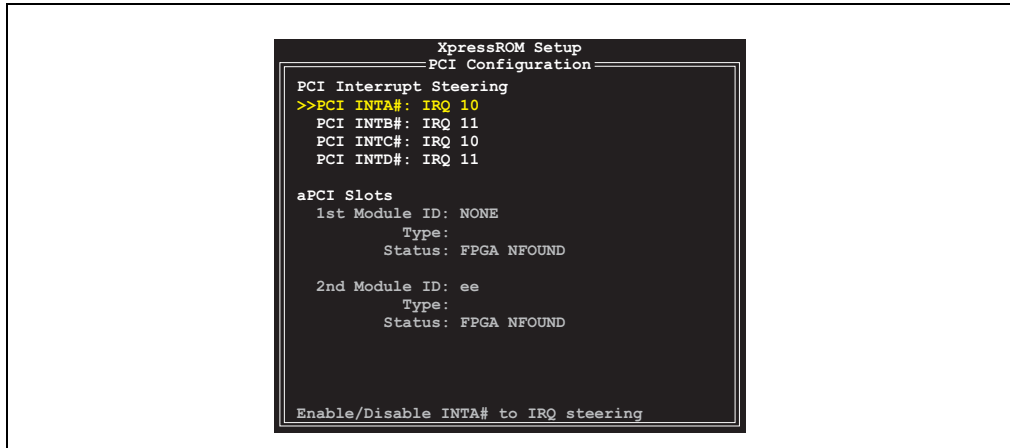


Figure 177: Motherboard device configuration - PCI configuration

BIOS setting	Meaning	Setting options	Effect
PCI INTA#	Activates the IRQ for the Ethernet controller.	Disabled	No IRQ is reserved.
		3, 4, 5, 6, 7, 9, 10, 11, 12, 14 or 15	Manual configuration of the IRQ.
PCI INTB#	Activates IRQ for aPCI slot 1. First IRQ for aPCI slot 1 and IRQ for USB controller.	Disabled	No IRQ is reserved.
		3, 4, 5, 6, 7, 9, 10, 11, 12, 14 or 15	Manual configuration of the IRQ.
PCI INTC#	Activates IRQ for aPCI slot 2. First IRQ for aPCI slot 2 and IRQ for IRQ for aPCI slot 1.	Disabled	No IRQ is reserved.
		3, 4, 5, 6, 7, 9, 10, 11, 12, 14 or 15	Manual configuration of the IRQ.

Table 110: BIOS PCI configuration menu

BIOS setting	Meaning	Setting options	Effect
PCI INTD#	Activates IRQ for the USB controller. Second IRQ for aPCI slot 2.	Disabled	No IRQ is reserved.
		3, 4, 5, 6, 7, 9, 10, 11, 12, 14 or 15	Manual configuration of the IRQ.
aPCI slots	Information about aPCI modules located in the aPCI slots of the Power Panel device are displayed here.	None	-

Table 110: BIOS PCI configuration menu (cont.)

Motherboard device configuration - USB configuration

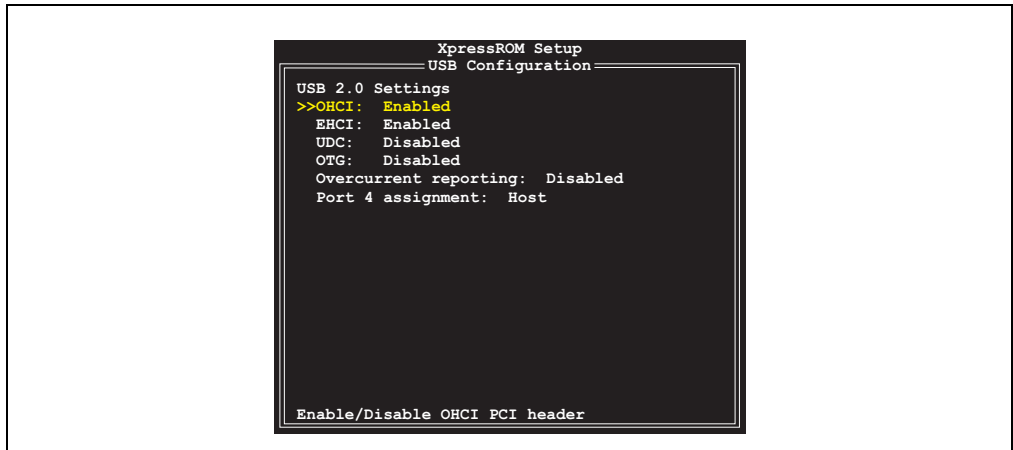


Figure 178: Motherboard device configuration - USB configuration

BIOS setting	Meaning	Setting options	Effect
OHCI	Turns USB 1.0/1.1 support on/off (OHCI - Open Host Controller Interface).	Enabled	Activates the USB port.
		Disabled	Deactivates the USB port.
EHCI	Turns USB 2.0 support on/off (EHCI - Enhanced Host Controller Interface).	Enabled	Enables this function.
		Disabled	Disables this function.
UDC	Turns the USB device controller on/off. When on, only the PCI config space is activated in BIOS.	Enabled	Enables this function.
		Disabled	Disables this function.
OTG	Turns the On-to-go device on/off. Only the PCI config space is activated in BIOS.	Enabled	Enables this function.
		Disabled	Disables this function.
Overcurrent reporting	This function enables an automatic error message to be sent to the system when the USB hub is overloaded (e.g. in Windows XP embedded).	Enabled	Enables this function.
		Disabled	Disables this function.

Table 111: BIOS USB configuration menu

BIOS setting	Meaning	Setting options	Effect
Port 4 assignment	With this option, USB port 4 can be configured.	Host	Functions as host.
		Device	Functions as device (two computers can be connected via port 4 - Master -> Slave).
		Not used	In BIOS, the default value (=Host) is assigned.

Table 111: BIOS USB configuration menu

Motherboard device configuration - Thermal configuration

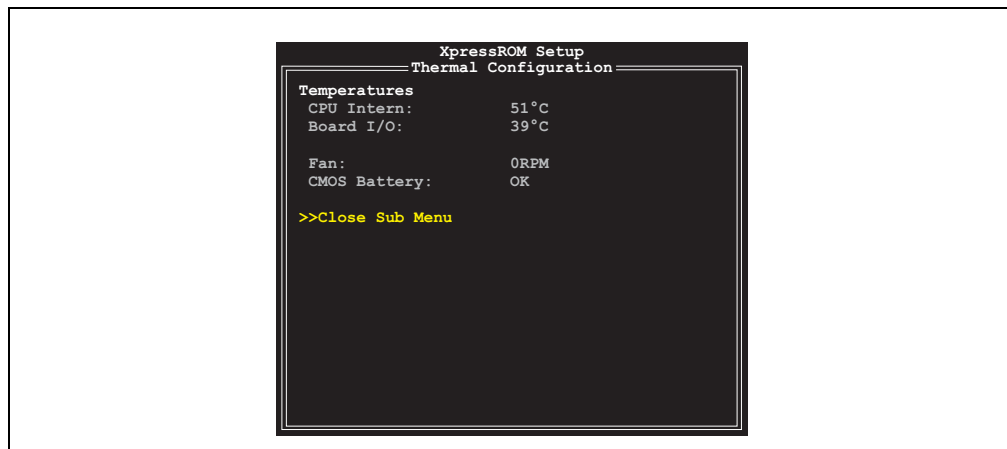


Figure 179: Motherboard device configuration - Thermal configuration

BIOS setting	Meaning	Setting options	Effect
CPU intern	Displays the current internal processor temperature.	None	-
Board I/O	Indicates the current board I/O temperature.	None	-
Fan	Displays fan speed for the selected panel (depending on features).	None	-
Close submenu	Close submenu	Enter	Closes the submenu.
CMOS battery	The status of the built-in CMOS battery is displayed here. Possible displays: OK - Battery is ok, Bad - Battery must be replaced.	None	-

Table 112: BIOS thermal configuration menu

1.4.5 Memory and cache optimization

Warning!

The parameters in this screen are for system designers, service personnel, and technically competent users only. Only modify those settings that you completely understand.

Incorrectly setting "Memory optimization" values can cause instability and even cause the entire system not to boot. If the Power Panel can no longer be booted, then the default BIOS values can be restored by pushing the reset button three times (see section 1.5.8 "Restoring the default BIOS values" on page 295).

Information:

More detailed information about the meaning and effects of the settings can also be found in the corresponding user's manual for the processor.

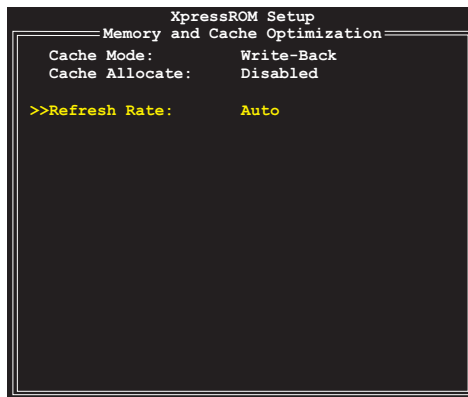


Figure 180: Memory and cache optimization

BIOS setting	Meaning	Setting options	Effect
Cache mode	Using cache mode, write accesses are determined on the cache.	Write back	The data is only written in the main memory if necessary (main memory and cache do not have the same information content).
		Write through	Data is written to the cache and to the main memory.
Cache allocate	The cache is divided into memory levels.	Disabled	Disables this function.
		Enabled	Enables this function.

Table 113: BIOS memory and cache optimization menu

BIOS setting	Meaning	Setting options	Effect
Refresh rate	The refresh cycle can be set here. Note: Enter the clock frequency, the chipset does the rest.	Auto	Value selected automatically.
		15 μ s, 3 μ s, 7 μ s, 31 μ s, 62 μ s or 125 μ s	Manually set the value.

Table 113: BIOS memory and cache optimization menu (cont.)

1.4.6 System clock/PLL configuration

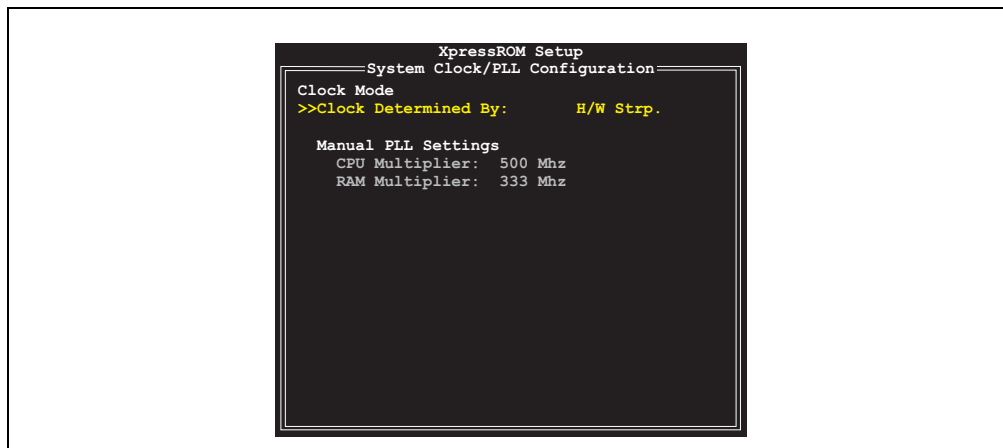


Figure 181: System clock/PLL configuration

BIOS setting	Meaning	Setting options	Effect
Clock determined by	The processor clock can be set with this option.	H/W strapping	Value is set automatically.
		Manual	Value must be set manually (CPU multiplier, RAM multiplier).
CPU multiplier	The CPU multiplier can be selected with this option. (This value can only be set if the BIOS setting "Clock determined by" is set to Manual .)	None	-
		233 MHz, 266 MHz, 300 MHz, 333 MHz, 366 MHz, 400 MHz, 433 MHz, 466 MHz, 500 MHz	Manually set the value.
RAM multiplier	The RAM multiplier can be selected with this option. (This value can only be set if the BIOS setting "Clock determined by" is set to Manual .)	None	-
		233 MHz, 266 MHz, 300 MHz, 333 MHz, 366 MHz, 400 MHz, 433 MHz, 466 MHz, 500 MHz	Manually set the value.

Table 114: System clock/PLL configuration

1.4.7 Power management

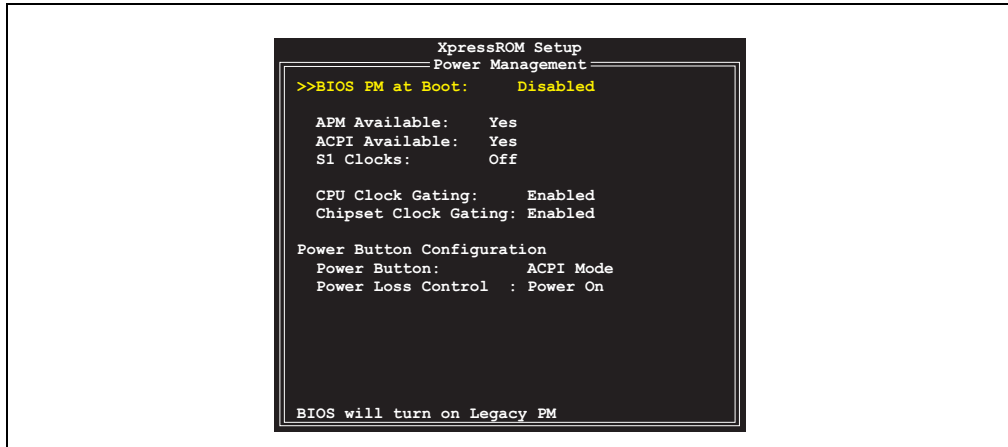


Figure 182: Power management

BIOS setting	Meaning	Setting options	Effect
BIOS PM at boot	Power Management is already enabled in the boot phase.	Enabled	Enables this function.
		Disabled	Disables this function.
APM available	Under this option you can set whether the operating system is allowed to change the BIOS power management settings.	Yes	Enables this function.
		No	Disables this function.
ACPI available	The ACPI (Advanced Configuration and Power Interface) option is an extended PnP and power management function.	Yes	Enables this function.
		No	Disables this function.
S1 clocks	The processor can be "stopped" with this option.	Off	Disables this function.
		On	Enables this function.
CPU clock gating	During power management, the clock lines are turned off for devices connected to the CPU.	Enabled	Enables this function.
		Disabled	Disables this function.
Chipset clock gating	During power management, the clock lines are turned off for devices connected to the chipset.	Enabled	Enables this function.
		Disabled	Disables this function.
Power button	This option determines how the Power button will function.	ACPI mode	When the power button is pressed and held for 4 seconds, the Power Panel is switched off without shutting down the operating system.
		Instant off	Turns off immediately.
Power loss control	This option determines what should occur after a power failure.	Power-on	The device turns back on.
		Stay off	Device remains off.

Table 115: BIOS power management menu

1.4.8 Device information

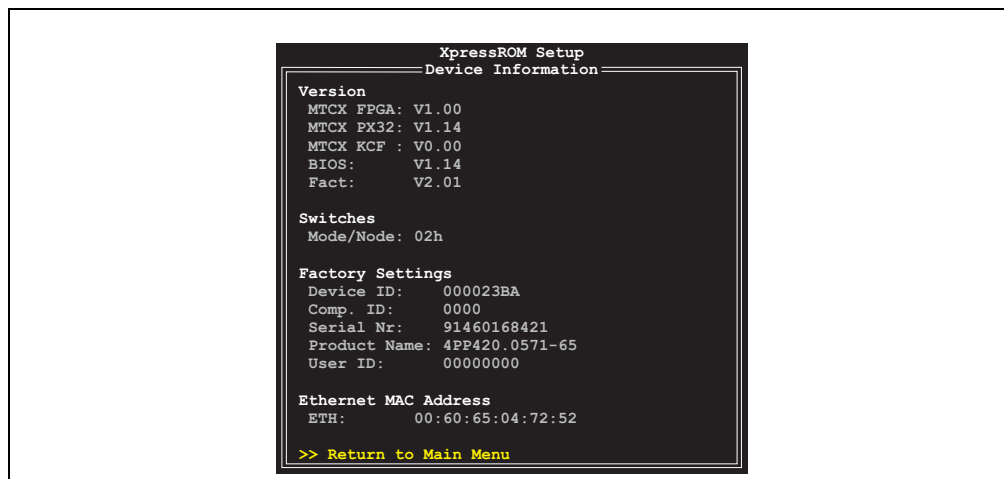


Figure 183: Device information

BIOS setting	Meaning	Setting options	Effect
MTXC FPGA	The FPGA firmware version is displayed here.	None	-
MTCX PX32	The MTCX firmware version is displayed here.	None	-
MTCX KCF	The KCF (Key Configuration File) version is displayed here.	None	-
BIOS	The BIOS version is displayed here.	None	-
FACT	The version of the factory settings is displayed here.	None	-
ETH	The MAC address of the Ethernet interface is displayed here.	None	-
Mode/Node	Displays the current Mode/Node switch position.	None	-
Device ID	Hex value for the device code of the Power Panel device.	None	-
Comp. ID	The compatibility code of the Power Panel device is displayed here.	None	-
Serial no.	The serial number of the Power Panel device is displayed here.	None	-
Product name	The product name of the Power Panel device is displayed here.	None	-
User ID	The User ID of the Power Panel device is displayed here.	None	-

Table 116: BIOS device information menu

1.4.9 Miscellaneous configuration

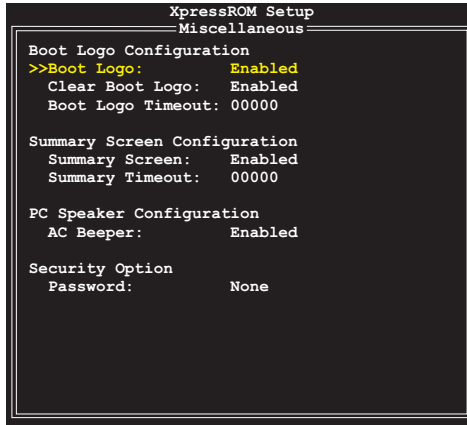


Figure 184: Miscellaneous configuration

BIOS setting	Meaning	Setting options	Effect
Boot logo ¹⁾	Displays a boot logo while the Power Panel is starting.	Disabled	No boot logo displayed during booting.
		Enabled	A B&R boot logo is displayed during booting as long as no customized bitmap is shown.
Clear boot logo	BIOS automatically clears the boot logo after starting in order to reduce the boot time.	Disabled	The boot logo is removed.
		Enabled	Disables this function.
Boot logo timeout	Defines the length of time the message "Press DEL for setup" is shown on the display, and how long the user has to switch to BIOS configuration. By pressing any key the boot can be continued before the timeout has expired.	0	No waiting.
		1-65535 [milliseconds]	The manually set value in milliseconds that must pass before the boot process continues. wird.
Summary screen	Displays information about the BIOS, VGA, VSA versions, devices found, etc..	Disabled	Shows the summary screen.
		Enabled	Hides the summary screen.
Summary screen timeout	Defines the length of time the summary screen is shown. By pressing any key the boot can be continued before the timeout has expired.	0	No waiting.
		1-65535 [milliseconds]	The manually set value in milliseconds that must pass before the boot process continues. wird.
AC beeper	The tone that sounds after startup can be turned on/off here.	Disabled	Disables this function.
		Enabled	Enables this function.

Table 117: BIOS miscellaneous configuration menu

BIOS setting	Meaning	Setting options	Effect
Password	A password for BIOS setup can be specified here. No changes can be made without entering the password.	None	No password.
		Enter password	Enter a password manually (max. 8 characters).

Table 117: BIOS miscellaneous configuration menu (cont.)

1) The standard B&R boot logo is pre-configured upon delivery.

1.4.10 Boot order

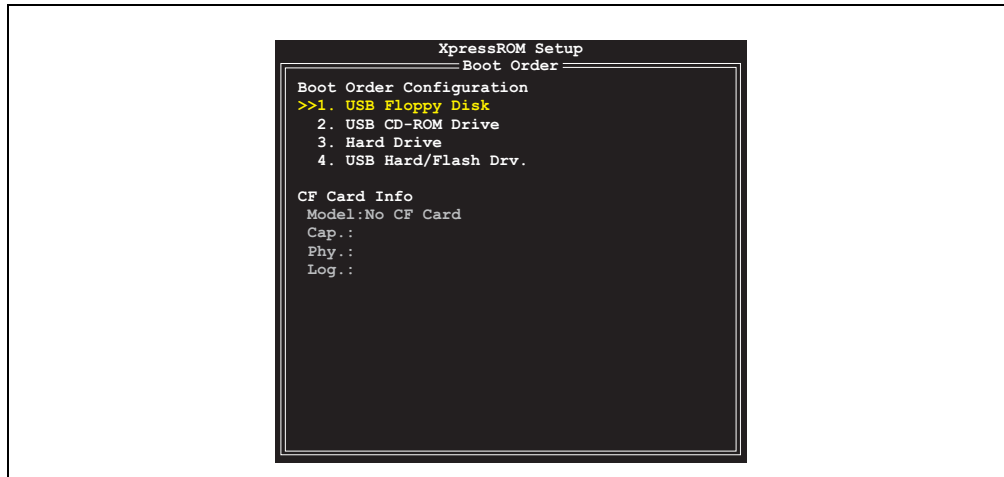


Figure 185: Boot order

BIOS setting	Meaning	Setting options		Effect
Boot order configuration	Configures the order in which memory media is booted. If two identical devices are selected a conflict warning is displayed.	1	USB floppy disk	The device attempts to boot from this drive first.
			USB CD-ROM drive	
			Hard drive	
			USB hard drive / flash drive	
			None	
		2	USB floppy disk	The device attempts to boot from this drive second.
			USB CD-ROM drive	
			Hard drive	
			USB hard drive / flash drive	
			None	
		3	USB floppy disk	The device attempts to boot from this drive third.
			USB CD-ROM drive	
			Hard drive	
			USB hard drive / flash drive	
			None	
		4	USB floppy disk	The device attempts to boot from this drive fourth.
			USB CD-ROM drive	
			Hard drive	
			USB hard drive / flash drive	
			None	
Model number	Displays the CompactFlash model ID.	None		-
Capabilities	Displays the possible data transfer speeds to or from the inserted CompactFlash card.	None		-
Phy. geometry	Displays the physical geometry of the inserted CompactFlash card in cylinders, heads, and number of sectors.	None		-
Log. geometry	Displays the logical geometry of the inserted CompactFlash card in cylinders, heads, and number of sectors.	None		-

Table 118: BIOS drive configuration menu

1.4.11 Load defaults

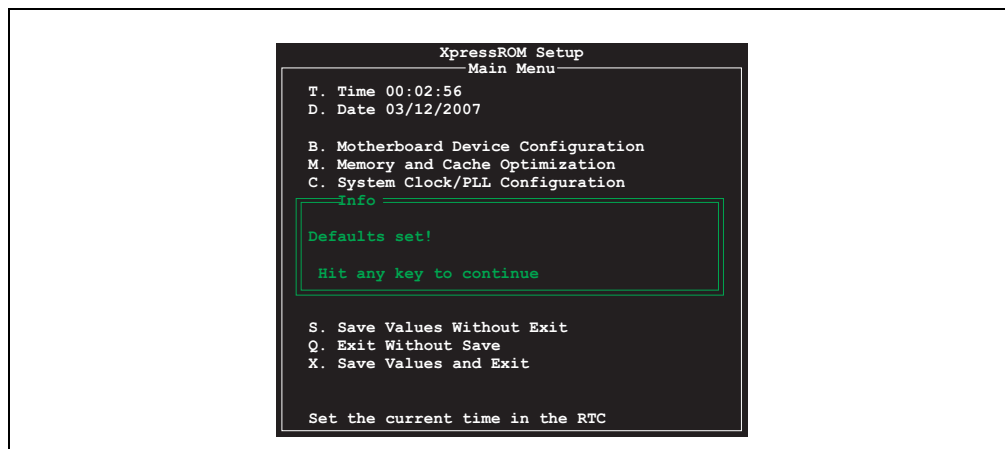


Figure 186: Load defaults

Under this BIOS menu item (shortcut "L"), by pressing any key you can load the values that were set at the time BIOS setup was opened. All changes made up to that point are lost as a result.

Restoring the default BIOS values

The BIOS default values can also be restored without entering the BIOS setup. For procedure, see Section 1.5.8 "Restoring the default BIOS values" on page 295.

1.4.12 Save values without exit

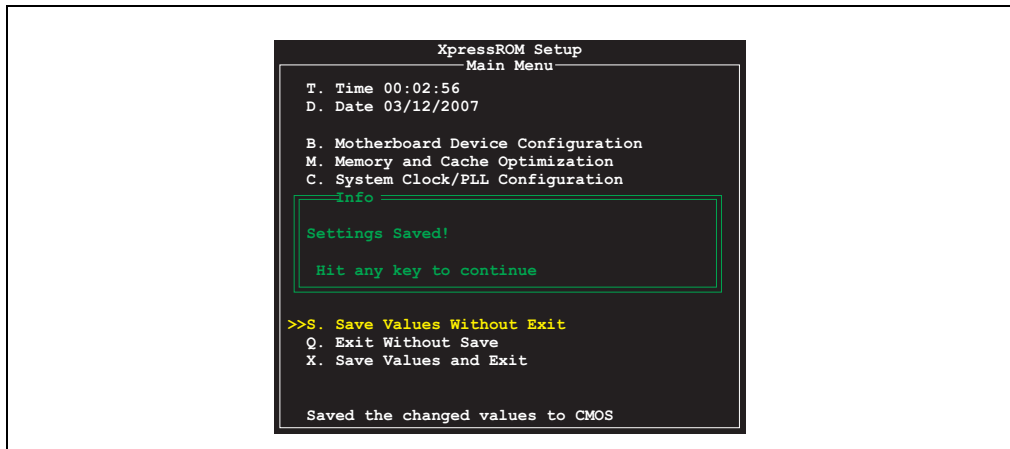


Figure 187: Save values without exit

The BIOS values are saved using this menu item (shortcut "S") by pressing any key. The user can then make additional settings or exit BIOS setup.

1.4.13 Exit without save

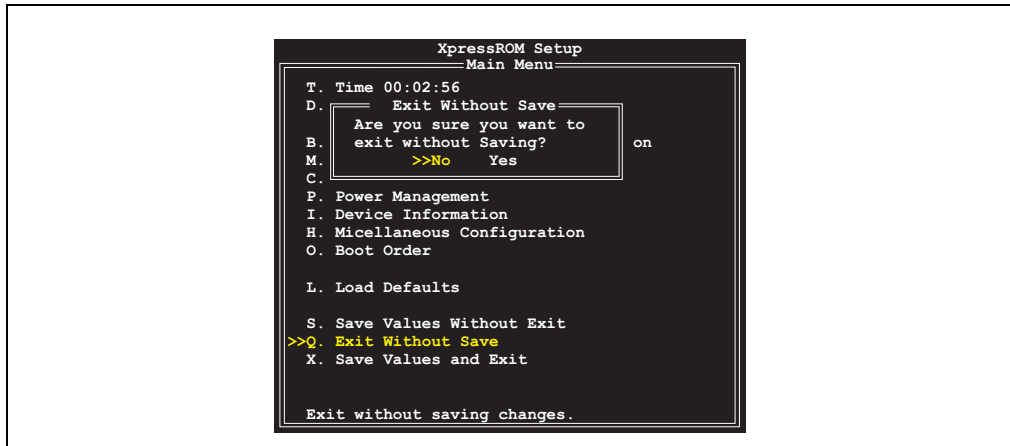


Figure 188: Exit without save

BIOS setup can be exited by selecting "Yes" under this menu item (shortcut "Q") without saving any changes that might have been made. The system is then automatically restarted.

Information:

If using a German keyboard, press the "z" key to enter "y".

1.4.14 Save values and exit

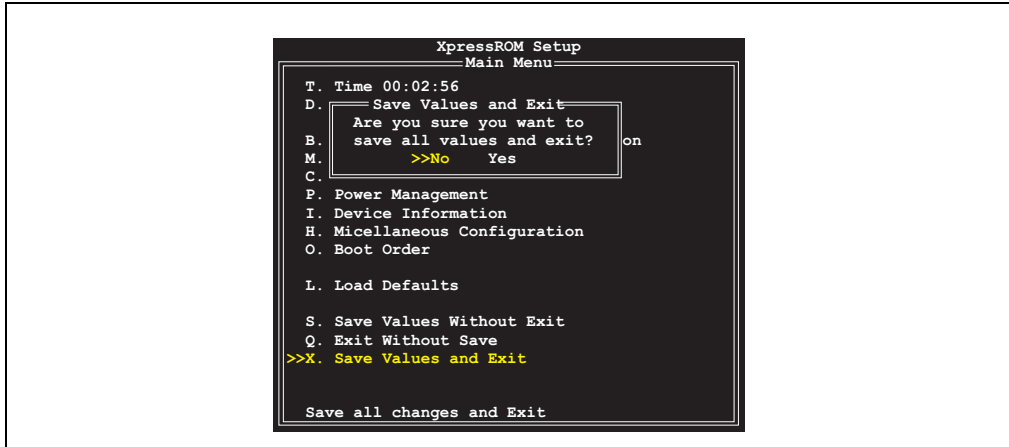


Figure 189: Save values and exit

If "Yes" is selected under this menu item (X shortcut), the system saves the settings, automatically exits BIOS setup, and reboots the system.

Information:

If using a German keyboard, press the "z" key to enter "y".

1.5 BIOS default values

The BIOS default values are the BIOS settings that were already configured when the PPC300 was delivered. The BIOS default values are identical in all variants (QVGA, VGA, SVGA and XGA).

1.5.1 Motherboard device configuration

Drive configuration	Default value
IDE BIOS support	Enabled
DMA/UDMA BIOS support	Enabled
Force mode for CF card	Auto
Floppy BIOS support	Enabled
CD-ROM boot BIOS support	Enabled
USB BIOS support	Enabled
I/O configuration	
COM A	Disabled
COM C	0x3f8 IRQ 4
COM D	0x2f8 IRQ 3
Video and flat panel configuration	
Graphics memory	008
Output display	-
Type	-
Contrast	Auto
Brightness	Auto
PCI configuration	
PCI INTA#	IRQ 10
PCI INTB#	IRQ 11
PCI INTC#	IRQ 10
PCI INTD#	IRQ 11
USB configuration	
OHCI	Enabled
EHCI	Enabled
UDC	Disabled
OTG	Disabled
Overcurrent reporting	Disabled
Port 4 assignment	Host
Thermal configuration	
CPU intern	-
Board I/O	-

Table 119: Motherboard device configuration default values

Drive configuration	Default value
Fan	-
Battery	-

Table 119: Motherboard device configuration default values (cont.)

1.5.2 Memory and cache optimization

Setting	Default value
Cache mode	Write back
Cache allocate	Disabled
Refresh rate	Auto

Table 120: Memory and cache optimization default values

1.5.3 System clock/PLL configuration

Setting	Default value
Clock determined by	H/W strapping
CPU multiplier	500 MHz
RAM multiplier	333 MHz

Table 121: System clock/PLL configuration default values

1.5.4 Power management

Setting	Default value
BIOS PM at boot	Disabled
APM available	Yes
ACPI available	Yes
S1 clocks	Off
CPU clock gating	Enabled
Chipset clock gating	Enabled
Power button	ACPI mode
Power loss control	Power-on

Table 122: Power management default values

1.5.5 Device information

This BIOS page is only provided for information purposes - therefore, no default BIOS values are available.

1.5.6 Miscellaneous configuration

Setting	Default value
Boot logo	Enabled
Clear boot logo	Enabled
Boot logo timeout	00000
Summary screen	Enabled
Summary screen timeout	00000
AC beeper	Enabled
Password	None

Table 123: Miscellaneous configuration default values

1.5.7 Boot order

Setting	Default value
1.	USB floppy disk
2.	USB CD-ROM drive
3.	Hard drive
4.	USB hard drive / flash drive

Table 124: Boot order default values

1.5.8 Restoring the default BIOS values

In the event that the BIOS settings become incorrectly defined (e.g. USB Keyboard Support disabled, crash during operating system startup), the BIOS default values can be restored using the following procedure.

Procedure:

- Switch Mode/Node switches to 0-0.
- Press the reset button three times (procedure: press - wait for beep - press - wait for beep - press - wait for beep).

1.6 Software updates

The following Power Panel device software and firmware can be updated:

- BIOS
- Firmware MTCX
- Firmware aPCI
- User boot logo

Current software can be downloaded directly from the service portal on the B&R homepage (www.br-automation.com).

The version information can be found in the corresponding BIOS setup pages, or via ADI "Control Center" (included in Windows XP embedded and Windows CE).

1.6.1 BIOS upgrade disk

An upgrade might be necessary for the following reason:

- To update implemented functions or to add newly implemented functions or components to the BIOS setup (information about changes can be found in the Readme files of the BIOS upgrade).

A current BIOS upgrade can be downloaded directly from the service portal on the B&R homepage (www.br-automation.com).

Procedure

The following steps should be carried out to upgrade or save BIOS:

- First, a blank HD disk must be made bootable (command line "sys a:" or "format a: /s"). oder „format a: /s“).

Information:

For the upgrade, a boot disk must be created (or a bootable CompactFlash card) with Windows ME, Windows XP or MS-DOS 6.22.

- Copy the contents of the *.zip file to this diskette.
- Insert the diskette into the USB drive and reboot the Power Panel device. See section "Motherboard device configuration - Drive configuration" on page 255 for the necessary settings for the Power Panel device when booting from a diskette.
- After booting from the diskette, the following start menu opens up:

```

Microsoft Windows Startup Menu
=====

1. Update BIOS
2. Save BIOS
3. Exit

Enter a choice: _

```

Figure 190: BIOS upgrade start menu

Item	Menu item	Description
1	Update BIOS	All areas of BIOS are automatically upgraded (default after 5 seconds). Information: Settings that have been changed in BIOS setup must be set again after the update. The update process may not be interrupted. Otherwise, the Power Panel may no longer restart, and would have to be sent to B&R for repair. Try to repeat an interrupted update process WITHOUT restarting the Power Panel, e.g. by starting the batch file UPDBIOS.BAT directly.
2	Save BIOS	BIOS is automatically saved in the SAVED directory. Information: There must be up to 256 KB free space on the disk.
3	Exit	Returns to the shell (MS-DOS).

Table 125: BIOS upgrade menu description

Information:

If you do not press a button within 5 seconds, then step 1 "Update BIOS" is automatically carried out and the Power Panel is automatically updated.

- The system must be rebooted after a successful upgrade.

1.6.2 MTCX Firmware upgrade (MTCX FPGA, MTCX PX32)

A current MTCX Firmware (MTCX FPGA and MTCX PX32) upgrade can be downloaded directly from the service portal on the B&R homepage (www.br-automation.com).

Procedure

1. Copy all files on a bootable diskette.
2. Insert the diskette into floppy drive (USB) connected to the Power Panel and reboot the device.
3. A boot menu with the following options is displayed after booting:
 1. Upgrade MTCX Firmware FPGA and PX32 (PC3F/PC3P)

The MTCX Firmware FPGA and PX32 is automatically updated (default after 5 sec).

Warning!

The update procedure must not be interrupted! Otherwise, the Power Panel may no longer restart, and must be sent to B&R for repair. Try to repeat an interrupted update process WITHOUT restarting the Power Panel, e.g. by starting the batch file UPDMTCX.BAT directly.

2. Exit

Returns to the shell (MS-DOS).

4. Select the action you wish to take.
5. Remove the diskette and restart the device (only after a successful update!).

1.6.3 aPCI firmware upgrade disk

A software tool for backing up or upgrading aPCI firmware can be downloaded directly from the service portal of the B&R homepage (www.br-automation.com).

Procedure

The following steps should be taken to upgrade or save the firmware for aPCI modules:

- First, a blank HD disk must be made bootable (command line "sys a:" or "format a: /s"). oder „format a: /s“).

Information:

For the upgrade, a boot disk must be created (or a bootable CompactFlash card) with Windows ME, Windows XP or MS-DOS 6.22.

- Copy the contents of the *.zip file to this diskette.
- If a user wants to upgrade the aPCI firmware, then aPCI firmware files (FPGA files) for aPCI modules must be copied to this disk. If there are already aPCI modules connected to the Power Panel and BIOS V1.04 is installed, then the file name can be determined automatically by XFLASH.EXE. Otherwise, the filename is queried by XFLASH.EXE or a default file name is used: "apci1.rom" for aPCI slot 1, "apci2.rom" for aPCI slot 2 -> the aPCI firmware file must be renamed beforehand!

Information:

The appropriate aPCI firmware files are available from B&R.

- Insert the diskette into the USB drive and reboot the Power Panel device. See section "Motherboard device configuration - Drive configuration" on page 255 for Power Panel devices for the necessary settings for the Power Panel device when booting from a diskette.
- After booting from the diskette, the following start menu opens up:

```
Microsoft Windows Startup Menu
=====

1. Update FPGA firmware automatically
2. Update FPGA firmware of aPCI slot 1
3. Update FPGA firmware of aPCI slot 2
4. Save FPGA firmware of both aPCI slots
5. Exit

Enter a choice:_
```

Figure 191: aPCI firmware upgrade start menu

Item	Menu item	Description
1	Update FPGA firmware automatically	The firmware for both aPCI slots is automatically updated (default after 5 seconds). Information: According to the inserted modules, the aPCI FPGA firmware files are searched for automatically.
2	Update FPGA firmware of aPCI slot 1	Only firmware from aPCI slot 1 is updated. Information: If no aPCI module is present, the aPCI FPGA firmware file must be renamed "apci1.pci" (for aPCI slot 1) before updating.
3	Update FPGA firmware of aPCI slot 2	Only firmware from aPCI slot 2 is updated. Information: If no aPCI module is present, the aPCI FPGA firmware file must be renamed "apci2.pci" (for aPCI slot 2) before updating.
4	Save FPGA firmware of both aPCI slots	Firmware for both aPCI slots are automatically saved. Information: There must be up to 640 KB free space on the disk.
5	Exit	Returns to the shell (MS-DOS).

Table 126: aPCI firmware upgrade menu description

Information:

If you do not press a button within 5 seconds, then step 1 "Update FPGA firmware automatically" is automatically carried out and the Power Panel is automatically updated.

- The system must be rebooted after a successful upgrade.

1.6.4 User boot logo upgrade disk

A software tool for updating, backing up, or deleting the user boot logo can be downloaded directly from the service portal of the B&R homepage (www.br-automation.com).

Procedure

The following steps should be taken to update, save or delete a user boot:

- First, a blank HD disk must be made bootable (command line "sys a:" or "format a: /s").
oder „format a: /s“).

Information:

For the upgrade, a boot disk must be created (or a bootable CompactFlash card) with Windows ME, Windows XP or MS-DOS 6.22.

- Copy the contents of the *.zip file to this diskette.
- Creates the user boot logo according to section "Guidelines for creating a user boot logo" on page 303 and copies to the disk.
- Insert the diskette into the USB drive and reboot the Power Panel device. See section "Motherboard device configuration - Drive configuration" on page 255 for the necessary settings for the Power Panel device when booting from a diskette.
- After booting from the diskette, the following start menu opens up:

```

Microsoft Windows Startup Menu
=====

1. Update BIOS User Boot Logo
2. Update BIOS Default Boot Logo
3. Save BIOS Boot Logo
4. Delete BIOS Boot Logo
5. Exit

Enter a choice:_

```

Figure 192: User boot logo upgrade start menu

Item	Menu item	Description
1	Update BIOS user boot logo	The user boot logo is automatically updated with the file USERLOGO.ROM (default after 5 seconds).
2	Update BIOS default boot logo	The BIOS default boot logo for the device is automatically updated with the correct resolution.
3	Save BIOS boot logo	The user boot logo is automatically saved in the file BOOTLOGO.SAV. Information: There must be up to 192 KB free space on the disk.
4	Delete BIOS boot logo	An existing user boot logo is deleted in the flash.
5	Exit	Returns to the shell (MS-DOS).

Table 127: User boot logo upgrade menu description

Information:

If you do not press a button within 5 seconds, then step 1 "Update BIOS user boot logo" is automatically carried out and the Power Panel is automatically updated.

- The system must be rebooted after a successful upgrade.
- In the BIOS CMOS setup, the display of the boot logo must be set from "No" to "Yes" (see section 1.3.9 "Miscellaneous configuration" on page 265).

Guidelines for creating a user boot logo

To update the user boot logo, a bitmap must be created according to the following guidelines and then copied to the user boot logo upgrade disk:

- 1) A Windows bitmap with a maximum of 256 colors must be created with the appropriate resolution for the Power Panel: 320x240 (QVGA), 640x480 (VGA), 800x600 (SVGA) or 1024x768 (XGA). The bitmap is not allowed to be compressed.
- 2) Since status messages are output on the top of the display when booting the Power Panel, there should not be any user boot logo pixels positioned here in the bitmap (approximately 10 pixel stripes), as these will be cross-faded. These status messages use bitmap palette index 0 as the background color and index 7 as the foreground color (starting from BIOS V1.05; index 63 with older versions).
- 3) Using the utility USERLOGO.EXE, the bitmap file must then be converted into a ROM file that can be read by BIOS (please refer to the online help for the utility for more instructions about this).
- 4) The userlogo.rom file created by the utility is only permitted to have a maximum size of 192 KB. If this size is exceeded, a warning appears. The user can e.g. reduce the details in the Windows bitmap in order not to exceed the maximum byte size.
- 5) After this, the userlogo.rom file should be copied to the disk.

1.7 CMOS backup

To protect CMOS data, a CMOS backup has been integrated into BIOS. If the BIOS setup was ended using "Save values and exit" and the Power Panel device was successfully restarted, then the CMOS data is burned to flash memory. If the CMOS checksum is incorrect during startup (battery dead) or the Power Panel device cannot be booted correctly three times consecutively, then the salvaged data from flash memory is copied again to CMOS. Setup is back to its original state, except for the time.

1.8 Distribution of resources

1.8.1 RAM address assignment

RAM address	Resource
00000000 - 000003FF	Interrupt vectors
00000400 - 000004FF	BIOS data area
00000500 - 0009FBFF	Freely available for the operating system (MS-DOS program area)
0009FC00 - 0009FFFF	Advanced BIOS data area
000A0000 - 000BFFFF	VGA memory
000C0000 - 000C7FFF	VGA BIOS
000C8000 - 000CBFFF	Reserved
000CC000 - 000EFFFF	XpressROM expansion ROMs. Unused areas can be used for HMA.
000F0000 - 000FFFFF	XpressROM BIOS
00100000 - BC_RAM_TOP	Remaining DRAM and VGA memory
D0000000 - FBFFFFFF	PCI memory and PCI ROM (are dynamically assigned during POST)
FFE00000 - FFFFFFFF	High BIOS area (flash memory)

Table 128: RAM address assignment

1.8.2 DMA channel assignment

DMA channel	Resource
0	Free
1	Free
2	Free
3	Free
4	Free
5	Free
6	Free
7	Free

Table 129: DMA channel assignment

1.8.3 I/O address assignment

I/O address	Resource
0000 - 000F	DMA controller channels 0-3
0020 - 0021	Master programmable interrupt controller
0022 - 0023	CPU configuration registers
0040 - 0043	Programmable interval timer
0060 - 0066	Keyboard controller (emulated by Legacy USB)
0070 - 0071	RTC (real-time clock)
0072 - 0073	Extended RTC (real-time clock)
0080	BIOS POST debug output port
0081 - 0083	DMA channel low page registers
0084	VSA debug output port
0085 - 008F	DMA channel low page registers
0092	Port A control register
00A0 - 00A1	Slave programmable interrupt controller
00C0 - 00CF	DMA controller channels 4-7
00D0 - 00DF	DMA status/control/mode registers channel 0-7
00F0 - 00F1	Co-processor error register
015C - 015D	On-chip SIO configuration
0170 - 0177	Primary IDE
01F0 - 01F7	Primary IDE
0220 - 02E8	Audio (not supported)
02EF - 02FF	COM2
0376 - 0377	Secondary IDE channel
03B0 - 03BB	Video controller
03C0 - 03DF	Video controller
03E8 - 03EF	COM3
03F0 - 03F5	Floppy controller (emulated by Legacy USB)
03F6 - 03F7	Primary IDE
03F8 - 03FF	COM1
0480 - 048F	DMA channel high page registers
04D0 - 04D1	Interrupt edge/level registers
0CF8 - 0CFF	PCI configuration registers

Table 130: I/O address assignment

In addition, the I/O addresses that were selected for additional functions (COM, etc.) are assigned.

1.8.4 Interrupt assignment

Interrupt	Resource
IRQ 0	System timer
IRQ 1	Keyboard (Legacy USB emulation)
IRQ 2	2nd PIC IRQ cascade
IRQ 3	COM2 ¹⁾
IRQ 4	COM1 ¹⁾
IRQ 5	PCI configuration space
IRQ 6	Disk drive
IRQ 7	PCI configuration space
IRQ 8	RTC (real-time clock)
IRQ 9	PCI configuration space
IRQ 10	PCI configuration space
IRQ 11	COM3 ¹⁾
IRQ 12	PS/2 mouse (Legacy USB emulation)
IRQ 13	FPU (co-processor)
IRQ 14	Primary IDE (primary hard disk)
IRQ 15	PCI configuration space

Table 131: Interrupt assignment

1) BIOS setup default setting

2. Power Panel 400 with Automation Runtime

2.1 General

B&R Automation Runtime guarantees a uniform runtime environment for Automation Studio programs on all target systems. This ensures uniform programming and operation on all devices.

Automation Runtime possesses a multitasking operating system adapted specially for use with control technology. The cycle time for your application can be separated among several task classes. Automation Runtime ensures that all application programs are executed within defined time periods, proving itself to be a configurable, deterministic real-time multitasking system.

An extensive project can be divided into small individual tasks. This way of working increases modularity and makes it much easier to maintain projects.

2.1.1 Summary screen

When switching on a Power Panel 400 device, a summary screen displays the most important parameters of an Automation Runtime Power Panel device:

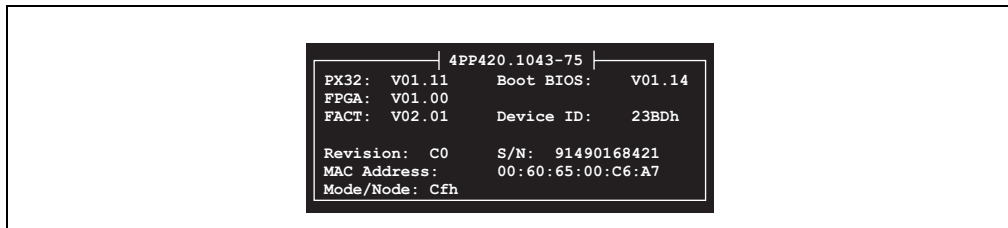


Figure 193: Automation Runtime summary screen - Ex. 4PP420.1043-75

Information	Example value	Meaning
PX32	V01.11	Displays the MTCX PX32 firmware version.
FPGA	V01.00	Displays the MTCX FPGA firmware version.
FACT	V02.01	Displays the factory settings version. These factory settings determine the device ID, display ID, display-specific initialization sequences, and other important parameters. Information: Factory settings are set by B&R and cannot be changed by the user!
Boot BIOS	V01.14	Displays the BIOS boot version.
Device ID	23BDh	Displays the hexadecimal value of the hardware device number.
Revision	C0	Hardware revision of the Power Panel.
S/N	91270168459	Displays the Power Panel device series number.
MAC address	00:60:65:00:C6:A7	Displays the assigned media access control (MAC) address.
Mode/Node	Cfh	Displays the current operating mode switch positions.

Table 132: Automation Runtime summary screen

2.2 Control and visualization with the Power Panel 300 device

The visualization project runs on the Power Panel 300. Serial RS232 or Ethernet TCP/IP provides the communication to the controller system. Flexible programming with frame drivers or Ethernet socket services allows a connection to be made to any control system. I/O peripherals and drives are connected to the controller.

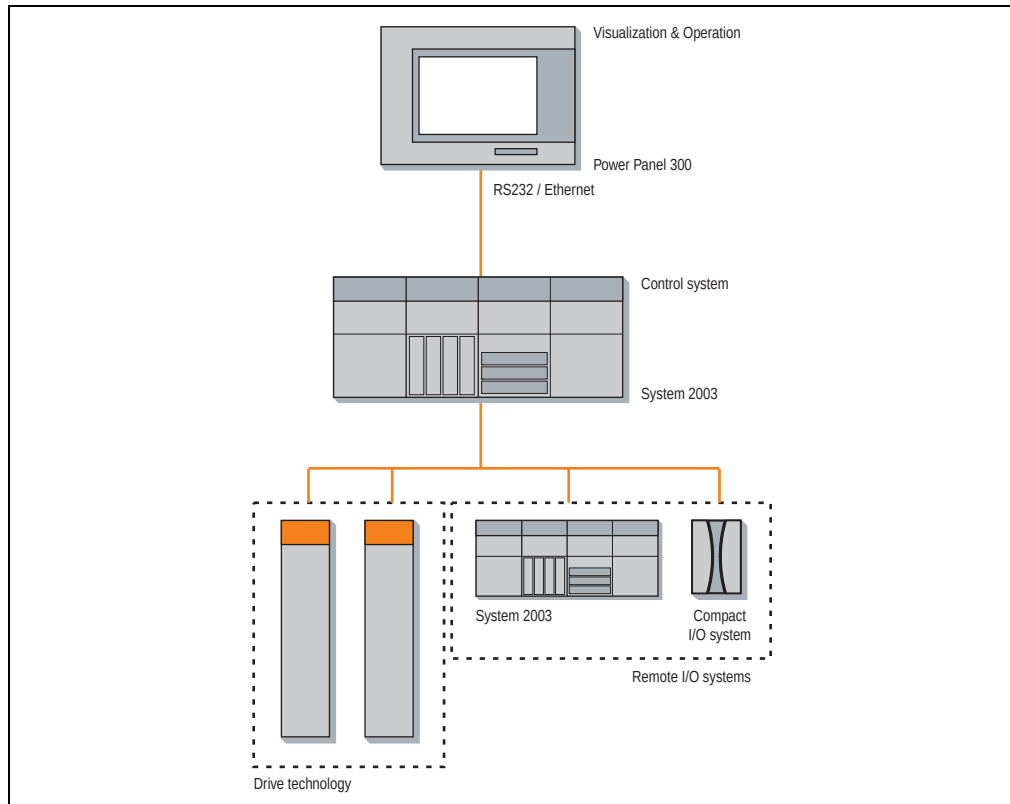


Figure 194: Power Panel 300 as an intelligent visualization system

2.3 Power Panel 400 with Power Panel 300 terminals

Control program and visualization run on the Power Panel 400. I/O peripherals and drives are connected via CAN, X2X and POWERLINK. Other Power Panel 300 units are connected as terminals via Ethernet TCP/IP. The central data storage occurs on the Power Panel 400.

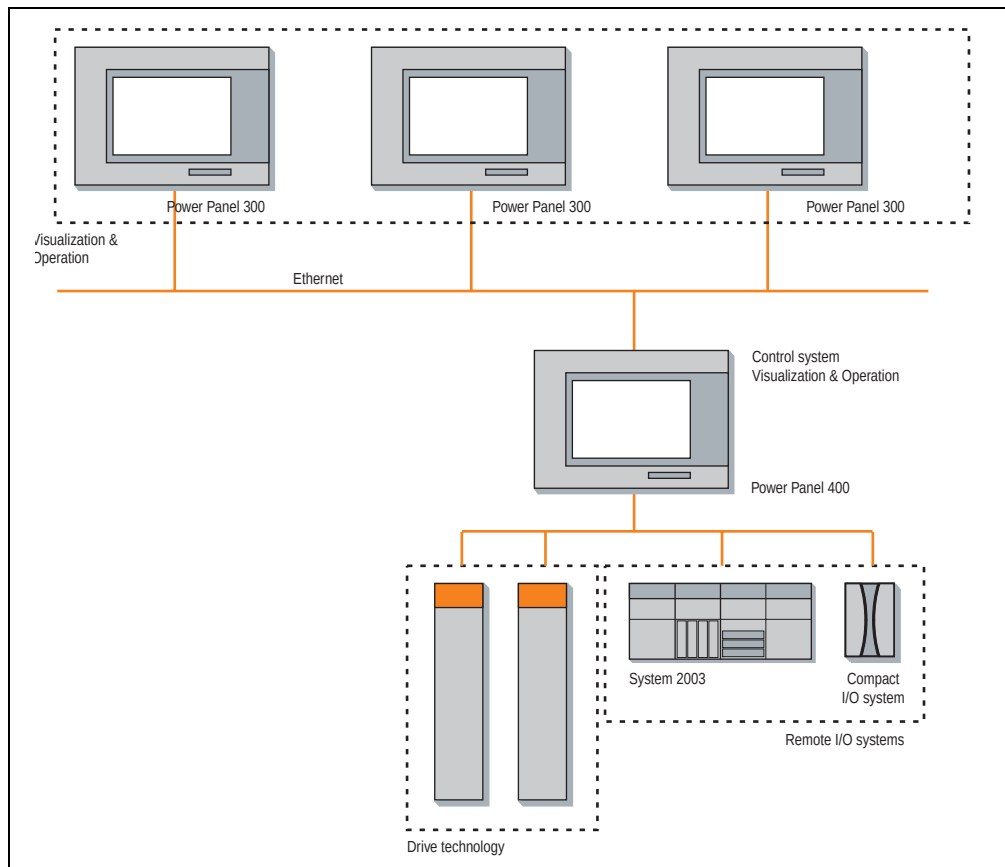


Figure 195: Power Panel 400 with, e.g. Power Panel 300 terminals

A CompactFlash is required in the Power Panel 300 and Power Panel 400 terminal devices.

3. Power Panel 300 with Windows CE



Figure 196: Windows CE logo

Model number	Short description	Note
5SWWCE.0521-ENG	WinCE5.0 Pro PP300 LX800 Microsoft Windows CE 5.0 Professional, English; for PP300 BIOS devices 5PP320.0571-29, 5PP320.0571-39, 5PP320.0573-39, 5PP320.1043-39, 5PP320.1214-39, 5PP320.1505-39, order CompactFlash separately (at least 128 MB).	
5SWWCE.0621-ENG	WinCE5.0 ProPlus PP300 LX800 Microsoft Windows CE 5.0 Professional Plus, English; for PP300 BIOS devices 5PP320.0571-29, 5PP320.0571-39, 5PP320.0573-39, 5PP320.1043-39, 5PP320.1214-39, 5PP320.1505-39, order CompactFlash separately (at least 128 MB).	

Table 133: Model numbers - Windows CE

3.1 General information

Windows CE is an operating system that is optimally tailored to the hardware used. This means that only the functions and modules required by the respective device are included. This makes this operating system extremely robust and stable.

3.1.1 Advantages

- Windows CE is also less expensive than other Windows licenses.
- Internet Explorer 6.0 for Windows® CE - standard components
- Fonts for attractive text display
- TCP/IP for network and Internet communication
- Remote Desktop Protocol (RDP) for thin clients
- ActiveSync for synchronization with the PC
- Windows® Media Player application
- Compact Framework V1.0 Service Pack 2
- Network utilities
- VBScript 6.0

- JScript 6.0
- Viewers for Excel, Word, images, PDFs, PowerPoint (only in Windows CE 5.0 ProPlus)

3.2 Differences between the different CE versions (Pro - ProPlus)

Features	Pro 5SWWCE.0521-ENG	ProPlus 5SWWCE.0621-ENG
Windows CE Version	5.0	
Screen resolution	VGA (TFT), SVGA (TFT), XGA (TFT)	
Color depth ¹⁾	16 bit / 65536 colors	
Graphics card driver	AMD Geode LX graphics card driver with screen rotation without DirectX	
RAM	Automatic detection and use of up to 512 MB RAM	
Boot time	Approx. 20 seconds	
Screen rotation	The desktop can be turned in 90° intervals	
Web browser	Internet Explorer 6.0 for Windows CE	
.NET	Compact Framework 2.0 SP2	
Image size	Approx. 24 MB uncompressed	Approx. 25 MB uncompressed
Custom keys	Supported	
PVI	Yes	
Automation Device Interface	Yes	
Serial interfaces	1 available for use	
PDF, Excel, Word, Power Point and Image viewer	-	Yes

Table 134: Differences between the CE versions (Pro - ProPlus)

1) The color depth depends on the display being used.

3.3 Installation

Windows CE is usually preinstalled at B&R Austria.

3.3.1 B&R eMbedded OS Installer

The B&R eMbedded OS Installer allows you to install existing B&R Windows CE images. The four files (NK.BIN, BLDR, LOGOXRES.BMP, and LOGOQVGA.BMP) must be provided from an already functioning B&R Windows CE installation.

- The B&R eMbedded OS Installer can be downloaded for free from the download area on the B&R homepage (www.br-automation.com). Further information is available in the online help for the B&R eMbedded OS Installer.

4. Power Panel 300 with Windows XP embedded



Figure 197: Windows XP embedded Logo

Model number	Short description	Note
5SWWXP.0421-ENG	WinXPe FP2007 PP300 LX800 Microsoft Windows XP embedded, English, Feature Pack 2007; for PP300 BIOS devices 5PP320.0571-29, 5PP320.0571-39, 5PP320.0573-39, 5PP320.1043-39, 5PP320.1214-39, 5PP320.1505-39, order CompactFlash separately (at least 512 MB). Only delivered with a new Power Panel.	

Table 135: Model number overview - Windows XP embedded

4.1 General information

Windows XP embedded is the most modular version of the Windows XP Professional desktop operating system and makes it possible to quickly develop reliable and advanced embedded devices. Windows XP embedded is based on the same binary files as Windows XP Professional and is optimally tailored to the hardware being used. In other words, only the functions and modules required by the respective device are included. Windows XP embedded is also based on the same reliable code as Windows XP Professional. It provides industry with leading reliability, improvements in security and performance, and the latest technology for Web browsing and extensive device support.

4.2 Features with FP2007 (Feature Pack 2007)

The feature list shows the most important device functions in Windows XP embedded with Feature Pack 2007 (FP2007).

Function	present
Enhanced write filter (EWF)	✓
File Based Write Filter	✓
Page file	configurable
Administrator account	✓
User account	configurable
Explorer shell	✓
Registry Filter	✓
Internet Explorer 6.0 + SP2	✓

Table 136: Device functions in Windows XP embedded with FP2007

Function	present
Internet information service (IIS)	-
Terminal Service	✓
Windows Firewall	✓
MSN-Explorer	-
Outlook Express	-
Administrative Tools	✓
Remote Desktop	✓
Remote Assistance	-
.NET Framework	-
ASP.NET	-
Codepages/User Locale/Keyboard	✓
Disk Management Service	✓
Windows Installer Service	✓
Class Installer	✓
CoDevice Installer	✓
Media Player	-
DirectX	-
Accessories	✓
Number of fonts	89

Table 136: Device functions in Windows XP embedded with FP2007 (cont.)

4.3 Installation

Windows XP embedded is usually preinstalled at B&R Austria on a suitable CompactFlash card (at least 512 MB - must be specified when placing order). The system is then automatically configured after it has been switched on for the first time. This procedure takes approximately 30 minutes, and the device will be rebooted a number of times.

Brief instructions for creating your own Windows XP embedded images or a suitable Target Designer export file can be downloaded from the download area on the B&R homepage (www.br-automation.com).

5. VESA mode support

The following VESA standards (see www.vesa.org) are supported.

VESA mode	Resolution
101h	640 x 480 x 8
103h	800 x 600 x 8
105h	1024 x 768 x 8
107h	1280 x 1024 x 8
110h	640 x 480 x 15
111h	640 x 480 x 16
112h	640 x 480 x 24
113h	800 x 600 x 15
114h	800 x 600 x 16
115h	800 x 600 x 24
116h	1024 x 768 x 15
117h	1024 x 768 x 16
118h	1024 x 768 x 24
119h	1280 x 1024 x 15
11Ah	1280 x 1024 x 16
11Bh	1280 x 1024 x 24
121h	320 x 240 x 8
122h	320 x 240 x 15
123h	320 x 240 x 16
124h	320 x 240 x 24
125h	1152 x 864 x 8
126h	1152 x 864 x 15
127h	1152 x 864 x 16
128h	1152 x 864 x 24
131h	1600 x 1200 x 8
132h	1600 x 1200 x 15
133h	1600 x 1200 x 16
134h	1600 x 1200 x 24
135h	1920 x 1440 x 8
136h	1920 x 1440 x 15
137h	1920 x 1440 x 16
138h	1920 x 1440 x 24

Table 137: Setting options - VESA mode

6. Automation Device Interface - ADI

The ADI (Automation Device Interface) driver enables access to specific functions of B&R devices. Settings for this device can be read and edited using the B&R Control Center applet in the control panel. Control Center is already implemented in the B&R Windows XP embedded and Windows CE operating systems.

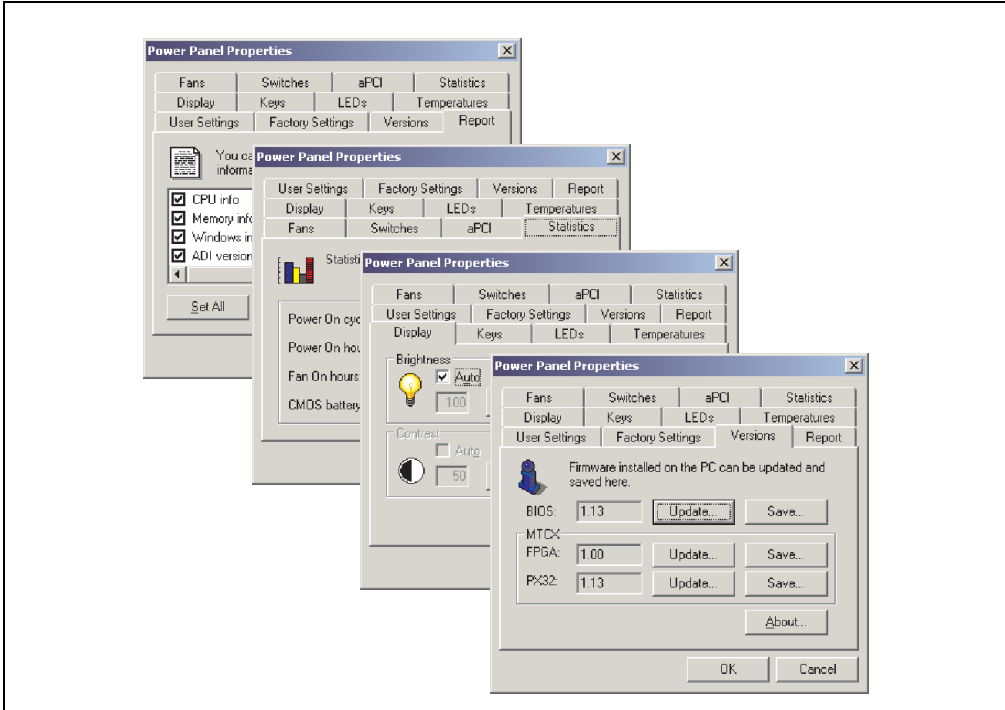


Figure 198: ADI Control Center screenshots (Version 1.20) - example

Features (device dependent)

- Adjusting the display brightness of connected Panels
- Reading device specific keys (in order for this to be possible, a key configuration must be installed that was created with the B&R Key Editor)
- Activation of device specific LEDs on a Mylar keypad
- Reading temperatures, fan speeds, and statistical data
- Reading user settings and factory settings
- Reading software versions
- Updating and securing firmware, boot logo
- Creating reports about the current system (support assistance)

7. B&R Key Editor

On display units, it is often necessary to adjust the function keys and LEDs for the application software being used. With the B&R Key Editor, it is possible to quickly and easily set up the application individually. Power Panel 300/400 devices are supported starting with version 2.60.

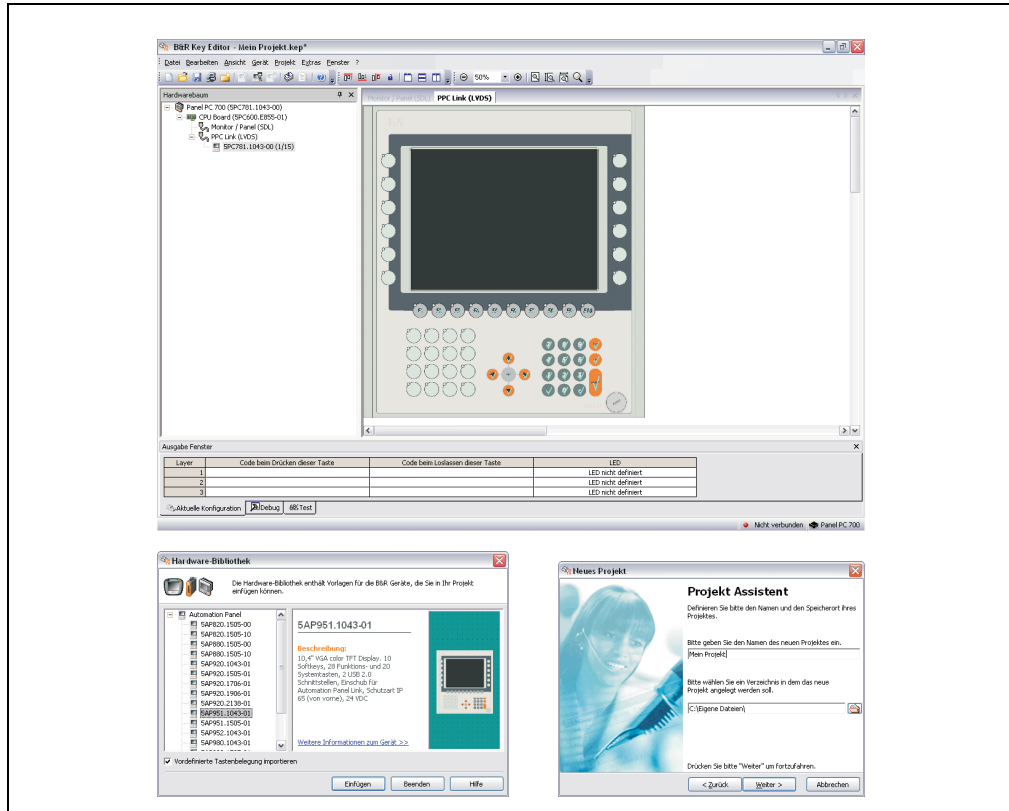


Figure 199: B&R Key Editor screenshots

Features:

- Configuration of normal keys like on a keyboard (A, B, C, etc.)
- Key combinations/shortcuts (CTRL+C, SHIFT+DEL, etc.) on one key
- Special key functions (change brightness, etc.)
- Assign functions to LEDs (HDD access, power, etc.)
- 4 assignments per key possible (using layer function)
- Configuration of panel locking time when multiple Automation Panel 900 devices are connected to Automation PC 620 and Panel PC 700 devices

A detailed guide for configuring keys and LEDs can be found in the B&R Key Editor's online help.

The B&R Key Editor can be downloaded for free from the download area on the B&R homepage (www.br-automation.com). Additionally, it can also be found on the B&R HMI Drivers & Utilities DVD (model number 5SWHMI.0000-00).

Chapter 5 • Standards and certifications

1. Applicable European guidelines

- EMC guidelines 89/336/EWG
- Low-voltage guidelines 73/23/EWG
- Machine guidelines 98/37/EG

2. Overview of standards

The Power Panel 300/400 devices collectively meet the following standards:

Standard	Description
EN 50081-2	Electromagnetic compatibility (EMC), generic emission standard - part 2: Industrial environments (EN 50081-2 has been replaced by EN 61000-6-4)
EN 50082-2	Electromagnetic compatibility (EMC), generic immunity standard - part 2: Industrial environments (EN 50082-2 has been replaced by EN 61000-6-2)
EN 55011 Class A, B	Electromagnetic compatibility (EMC), radio disturbance product standard, industrial, scientific, and medical high-frequency devices (ISM devices), limit values and measurement procedure; group 1 (devices that do not create HF during material processing) and group 2 (devices that create HF during material processing)
EN 55022 Class A, B	Electromagnetic compatibility (EMC), radio disturbance characteristics, information technology equipment (ITE devices), limits and methods of measurement
EN 55024 Class A or B	Electromagnetic compatibility (EMC), immunity characteristics, information technology equipment (ITE devices), limits and methods of measurement
EN 60060-2	High-voltage test techniques - part 2: Measuring systems
EN 60068-2-1	Environmental testing - part 2: Tests; test A: Cold
EN 60068-2-2	Environmental testing - part 2: Tests; test B: Dry heat
EN 60068-2-3	Environmental testing - part 2: Tests; test and guidance: Damp heat, constant
EN 60068-2-6	Environmental testing - part 2: Tests; test: Vibration (sinusoidal)
EN 60068-2-14	Environmental testing - part 2: Tests; test N: Change of temperature
EN 60068-2-27	Environmental testing - part 2: Tests; test and guidance: Shock
EN 60068-2-30	Environmental testing - part 2: Tests; test and guidance: Damp heat, cyclic
EN 60068-2-31	Environmental testing - part 2: Tests; test: Drop and topple, primarily for equipment-type specimens
EN 60068-2-32	Environmental testing - part 2: Tests; test: Free fall
EN 60204-1	Safety of machinery, electrical equipment on machines - part 1: General requirements

Table 138: Overview of standards

Standards and certifications • Overview of standards

Standard	Description
EN 60529	Degrees of protection provided by enclosures (IP code)
EN 61000-4-2	Electromagnetic compatibility (EMC) - part 4-2: Testing and measuring techniques; electrostatic discharge immunity test
EN 61000-4-3	Electromagnetic compatibility (EMC) - part 4-3: Testing and measuring techniques; radiated radio-frequency electromagnetic field immunity test
EN 61000-4-4	Electromagnetic compatibility (EMC) - part 4-4: Testing and measuring techniques; electrical fast transient/burst immunity test
EN 61000-4-5	Electromagnetic compatibility (EMC) - part 4-5: Testing and measuring techniques; surge immunity test
EN 61000-4-6	Electromagnetic compatibility (EMC) - part 4-6: Testing and measuring techniques; immunity to conducted disturbances, induced by radio-frequency fields
EN 61000-4-8	Electromagnetic compatibility (EMC) - part 4-8: Testing and measuring techniques; power frequency magnetic field immunity test
EN 61000-4-11	Electromagnetic compatibility (EMC) - part 4-11: Testing and measuring techniques; voltage dips, short interruptions and voltage variations immunity tests
EN 61000-4-12	Electromagnetic compatibility (EMC) - part 4-12: Testing and measuring techniques; oscillatory waves immunity test
EN 61000-6-2 (EN 50082-2)	Electromagnetic compatibility (EMC), generic immunity standard - part 2: industrial environments (EN 50082-2 has been replaced by EN 61000-6-2)
EN 61000-6-4 (EN 50081-2)	Electromagnetic compatibility (EMC), generic emission standard - part 2: industrial environments (EN 50081-2 has been replaced by EN 61000-6-4)
EN 61131-2 IEC 61131-2	Product standard, programmable logic controllers - part 2: equipment requirements and tests
NEMA 250 Type 4X	UL protection against sprayed water
UL 508	Industrial control equipment (UL = Underwriters Laboratories)
47 CFR	Federal Communications Commission (FCC), 47 CFR Part 15 Subpart B Class A

Table 138: Overview of standards (cont.)

3. Emission requirements

Emissions	Test carried out according to	Limits according to
Network-related emissions	EN 55011 / EN 55022	EN 61000-6-4: Generic standard (industrial areas)
		EN 55011: Industrial, scientific, and medical (ISM) radio-frequency equipment, class A (industrial areas)
		EN 55022: Information technology equipment (ITE devices), class A (industrial areas)
		EN 61131-2: Programmable logic controllers
		47 CFR Part 15 Subpart B Class A (FCC)
Emissions, Electromagnetic emissions	EN 55011 / EN 55022	EN 61000-6-4: Generic standard (industrial areas)
		EN 55011: Industrial, scientific, and medical (ISM) radio-frequency equipment, class A (industrial areas)
		EN 55022: Information technology equipment (ITE devices), class A (industrial areas)
		EN 61131-2: Programmable logic controllers
		47 CFR Part 15 Subpart B Class A (FCC)

Table 139: Overview of limits and testing guidelines for emissions

3.1 Network-related emissions

Test carried out according to EN 55011 / EN 55022	Limits according to EN 61000-6-4	Limits according to EN 55011 class A	Limits according to EN 55022 class A
Power mains connections 150 kHz - 500 kHz	79 dB (μV) quasi-peak value 66 dB (μV) average	79 dB (μV) quasi-peak value 66 dB (μV) average	79 dB (μV) quasi-peak value 66 dB (μV) average
Power mains connections 500 kHz - 30 MHz	73 dB (μV) quasi-peak value 60 dB (μV) average	73 dB (μV) quasi-peak value 60 dB (μV) average	73 dB (μV) quasi-peak value 60 dB (μV) average
Other connections 150 kHz - 500 kHz	-	-	97 - 87 dB (μV) and 53 - 43 dB (μA) quasi-peak value 84 - 74 dB (μV) and 40 - 30 dB (μA) average
Other connections 500 kHz - 30 MHz	-	-	87 dB (μV) and 43 dB (μA) quasi-peak value 74 dB (μV) and 30 dB (μA) average

Table 140: Test requirements - Network-related emissions for industrial areas

Standards and certifications • Emission requirements

Test carried out according to EN 55011 / EN 55022	Limits according to EN 61131-2	Limits according to 47 CFR Part 15 Subpart B class A	
Power mains connections ¹⁾ 150 kHz - 500 kHz	79 dB (μV) quasi-peak value 66 dB (μV) average	79 dB (μV) quasi-peak value 66 dB (μV) average	
Power mains connections 500 kHz - 30 MHz	73 dB (μV) quasi-peak value 60 dB (μV) average	73 dB (μV) quasi-peak value 60 dB (μV) average	
Other connections 150 kHz - 500 kHz	-		
Other connections 500 kHz - 30 MHz	-		

Table 140: Test requirements - Network-related emissions for industrial areas (cont.)

1) AC network connections only with EN 61131-2

3.2 Emissions, electromagnetic emissions

Test carried out according to EN 55011 / EN 55022	Limits according to EN 61000-6-4	Limits according to EN 55011 class A	Limits according to EN 55022 class A
30 MHz - 230 MHz measured at a distance of 10 m	< 40 dB (μV/m) quasi-peak value	< 40 dB (μV/m) quasi-peak value	< 40 dB (μV/m) quasi-peak value
230 MHz - 1 GHz measured at a distance of 10 m	< 47 dB (μV/m) quasi-peak value	< 47 dB (μV/m) quasi-peak value	< 47 dB (μV/m) quasi-peak value
Test carried out according to EN 55011 / EN 55022	Limits according to EN 61131-2		
30 MHz - 230 MHz measured at a distance of 10 m	< 40 dB (μV/m) quasi-peak value		
230 MHz - 1 GHz measured at a distance of 10 m	< 47 dB (μV/m) quasi-peak value		
Test carried out	Limits according to 47 CFR Part 15 Subpart B class A		
30 MHz - 88 MHz measured at a distance of 10 m	< 90 dB (μV/m) quasi-peak value		
88 MHz - 216 MHz measured at a distance of 10 m	< 150 dB (μV/m) quasi-peak value		
216 MHz - 960 MHz measured at a distance of 10 m	< 210 dB (μV/m) quasi-peak value		
>960 MHz measured at a distance of 10 m	< 300 dB (μV/m) quasi-peak value		

Table 141: Test requirements - Electromagnetic emissions for industrial areas

4. Requirements for immunity to disturbances

Immunity	Test carried out according to	Limits according to
Electrostatic discharge (ESD)	EN 61000-4-2	EN 61000-6-2: Generic standard (industrial areas)
		EN 61131-2: Programmable logic controllers
		EN 55024: Information technology equipment (ITE devices)
Immunity against high-frequency electromagnetic fields (HF field)	EN 61000-4-3	EN 61000-6-2: Generic standard (industrial areas)
		EN 61131-2: Programmable logic controllers
		EN 55024: Information technology equipment (ITE devices)
Immunity to high-speed transient electrical disturbances (burst)	EN 61000-4-4	EN 61000-6-2: Generic standard (industrial areas)
		EN 61131-2: Programmable logic controllers
		EN 55024: Information technology equipment (ITE devices)
Immunity to surge voltages	EN 61000-4-5	EN 61000-6-2: Generic standard (industrial areas)
		EN 61131-2: Programmable logic controllers
		EN 55024: Information technology equipment (ITE devices)
Immunity to conducted disturbances	EN 61000-4-6	EN 61000-6-2: Generic standard (industrial areas)
		EN 61131-2: Programmable logic controllers
		EN 55024: Information technology equipment (ITE devices)
Immunity against magnetic fields with electrical frequencies	EN 61000-4-8	EN 61000-6-2: Generic standard (industrial areas)
		EN 61131-2: Programmable logic controllers
		EN 55024: Information technology equipment (ITE devices)
Immunity to voltage dips, short-term interruptions and voltage fluctuations	EN 61000-4-11	EN 61000-6-2: Generic standard (industrial areas)
		EN 61131-2: Programmable logic controllers
		EN 55024: Information technology equipment (ITE devices)
Immunity to damped vibration	EN 61000-4-12	EN 61000-6-2: Generic standard (industrial areas)
		EN 61131-2: Programmable logic controllers

Table 142: Overview of limits and testing guidelines for immunity

Evaluation criteria according to EN 61000-6-2

Criteria A:

The operating equipment must continue to work as intended **during** the test. There should be no interference in the operating behavior and no system failures below a minimum operating quality as defined by the manufacturer.

Criteria B:

The operating equipment must continue to work as intended **after** the test. There should be no interference in the operating behavior and no system failures below a minimum operating quality as defined by the manufacturer.

Criteria C:

A temporary function failure is permitted when the function restores itself, or the function can be restored by activating configuration and control elements.

Criteria D:

Impairment or failure of the function, which can no longer be established (operating equipment destroyed).

4.1 Electrostatic discharge (ESD)

Test carried out according to EN 61000-4-2	Limits according to EN 61000-6-2	Limits according to EN 61131-2	Limits according to EN 55024
Contact discharge to powder-coated and bare metal housing parts	± 4 kV, 10 discharges, criteria B	± 4 kV, 10 discharges, criteria B	± 4 kV, 10 discharges, criteria B
Discharge through the air to plastic housing parts	± 8 kV, 10 discharges, criteria B	± 8 kV, 10 discharges, criteria B	± 8 kV, 10 discharges, criteria B

Table 143: Test requirements - Electrostatic discharge (ESD)

4.2 High-frequency electromagnetic fields (HF field)

Test carried out according to EN 61000-4-3	Limits according to EN 61000-6-2	Limits according to EN 61131-2	Limits according to EN 55024
Housing, completely wired	80 MHz - 1 GHz, 10 V/m, 80% amplitude modulation with 1 kHz, length 3 seconds, criteria A	80 MHz - 1 GHz, 1,4 - 2 GHz, 10 V/m, 80% amplitude modulation with 1 kHz, length 3 seconds, criteria A 800-960 MHz (GSM), 10 V/m, pulse modulation with 50% duty cycle, criteria A	80 MHz - 1 GHz, 1,4 - 2 GHz, 3 V/m, 80 % amplitude modulation with 1 kHz, length 3 seconds, criteria A

Table 144: Test requirements - High-frequency electromagnetic fields (HF field)

4.3 High-speed transient electrical disturbances (burst)

Test carried out according to EN 61000-4-4	Limits according to EN 61000-6-2	Limits according to EN 61131-2	Limits according to EN 55024
AC power I/O	± 2 kV, criteria B	-	± 1 kV, criteria B
AC power inputs	-	± 2 kV, criteria B	-
AC power outputs	-	± 1 kV, criteria B	-
DC power I/O >10 m ¹⁾	± 2 kV, criteria B	-	± 0.5 kV, criteria B
DC power inputs >10 m	-	± 2 kV, criteria B	-
DC power outputs >10 m	-	± 1 kV, criteria B	-
Functional ground connections, signal lines and I/Os >3 m	± 1 kV, criteria B	± 1 kV, criteria B	± 0.5 kV, criteria B
Unshielded AC I/O >3 m	-	± 2 kV, criteria B	-
Analog I/O	± 1 kV, criteria B	± 1 kV, criteria B	-

Table 145: Test requirements - High-speed transient electrical disturbances (burst)

1) For EN 55024 without length limitation.

4.4 Surges

Test carried out according to EN 61000-4-5	Limits according to EN 61000-6-2	Limits according to EN 61131-2	Limits according to EN 55024
AC power I/O, L to L	± 1 kV, criteria B	± 1 kV, criteria B	± 1 kV, criteria B
AC power I/O, L to PE	± 2 kV, criteria B	± 2 kV, criteria B	± 2 kV, criteria B
DC power I/O, L+ to L-, >10 m	± 0.5 kV, criteria B	-	-
DC power I/O, L to PE, >10 m	± 0.5 kV, criteria B	-	± 0.5 kV, criteria B
DC power inputs, L+ to L-	-	± 0.5 kV, criteria B	-
DC power inputs, L to PE	-	± 1 kV, criteria B	-
DC power outputs, L+ to L-	-	± 0.5 kV, criteria B	-
DC power outputs, L to PE	-	± 0.5 kV, criteria B	-
Signal connections >30 m	± 1 kV, criteria B	± 1 kV, criteria B	± 1 kV, criteria B
All shielded cables	-	± 1 kV, criteria B	-

Table 146: Test requirements - Surge voltages

4.5 Conducted disturbances

Test carried out according to EN 61000-4-6	Limits according to EN 61000-6-2	Limits according to EN 61131-2	Limits according to EN 55024
AC power I/O	150 kHz - 80 MHz, 10 V, 80% amplitude modulation with 1 kHz, length 3 seconds, criteria A	150 kHz - 80 MHz, 3 V, 80% amplitude modulation with 1 kHz, length 3 seconds, criteria A	150 kHz - 80 MHz, 3 V, 80% amplitude modulation with 1 kHz, criteria A

Table 147: Test requirements - Conducted disturbances

Standards and certifications • Requirements for immunity to disturbances

Test carried out according to EN 61000-4-6	Limits according to EN 61000-6-2	Limits according to EN 61131-2	Limits according to EN 55024
DC power I/O	150 kHz - 80 MHz, 10 V, 80% amplitude modulation with 1 kHz, length 3 seconds, criteria A	150 kHz - 80 MHz, 3 V, 80% amplitude modulation with 1 kHz, length 3 seconds, criteria A	150 kHz - 80 MHz, 3 V, 80% amplitude modulation with 1 kHz, criteria A
Functional ground connections	0,15 - 80 MHz, 10 V, 80% amplitude modulation with 1 kHz, Length 3 seconds, criteria A	150 kHz - 80 MHz, 3 V, 80% amplitude modulation with 1 kHz, length 3 seconds, criteria A	-
Signal connections >3 m	0,15 - 80 MHz, 10 V, 80% amplitude modulation with 1 kHz, Length 3 seconds, criteria A	150 kHz - 80 MHz, 3 V, 80% amplitude modulation with 1 kHz, length 3 seconds, criteria A	150 kHz - 80 MHz, 3 V, 80% amplitude modulation with 1 kHz, criteria A

Table 147: Test requirements - Conducted disturbances (cont.)

4.6 Magnetic fields with electrical frequencies

Test carried out according to EN 61000-4-8	Limits according to EN 61000-6-2	Limits according to EN 61131-2	Limits according to EN 55024
Test direction x, test in the field of an induction coil 1 m x 1 m	30 A/m, criteria A	30 A/m, criteria A	50 Hz, 1 A/m, criteria A
Test direction y, test in the field of an induction coil 1 m x 1 m	30 A/m, criteria A	30 A/m, criteria A	50 Hz, 1 A/m, criteria A
Test direction z, test in the field of an induction coil 1 m x 1 m	30 A/m, criteria A	30 A/m, criteria A	50 Hz, 1 A/m, criteria A

Table 148: Test requirements - Magnetic fields with electrical frequencies

4.7 Voltage dips, fluctuations, and short-term interruptions

Test carried out according to EN 61000-4-11	Limits according to EN 61000-6-2	Limits according to EN 61131-2	
AC power inputs	Voltage dip 70% (30% reduction), 0.5 periods, criteria B	-	
AC power inputs	Voltage dip 40% (60% reduction), 5 periods, criteria C	-	
AC power inputs	Voltage dip 40% (60% reduction), 50 periods, criteria C	-	
AC power inputs	Voltage interruptions < 5% (> 95% reduction), 250 periods, criteria C	-	
AC power inputs	-	20 interruptions, 0.5 periods, criteria A	
DC power inputs	-	20 interruptions for 10 ms < UN - 15%, criteria A	

Table 149: Test requirements - Voltage dips, fluctuations, and short-term interruptions

4.8 Damped vibration

Test carried out according to EN 61000-4-12	Limits according to EN 61131-2		
Power I/O, L to L	± 1 kV, 1 MHz, repeat rate 400/seconds, length 2 seconds, connection lengths 2 m, criteria B		
Power I/O, L to PE	± 2.5 kV, 1 MHz, repeat rate 400/seconds, length 2 seconds, connection lengths 2 m, criteria B		

Table 150: Test requirements - Damped vibration

5. Mechanical conditions

Vibration	Test carried out according to	Limits according to
Vibration operation	EN 60068-2-6	EN 61131-2: Programmable logic controllers
		EN 60721-3-3 class 3M4
Vibration during transport (packaged)	EN 60068-2-6	EN 60721-3-2 class 2M1
		EN 60721-3-2 class 2M2
		EN 60721-3-2 class 2M3
Shock during operation	EN 60068-2-27	EN 61131-2: Programmable logic controllers
		EN 60721-3-3 class 3M4
Shock during transport (packaged)	EN 60068-2-27	EN 60721-3-2 class 2M1
		EN 60721-3-2 class 2M2
		EN 60721-3-2 class 2M3
		B&R
Toppling (packaged)	EN 60068-2-31	EN 60721-3-2 class 2M1
		EN 60721-3-2 class 2M2
		EN 60721-3-2 class 2M3
Free fall (packaged)	EN 60068-2-32	EN 61131-2: Programmable logic controllers
		B&R

Table 151: Overview of limits and testing guidelines for vibration

5.1 Vibration operation

Test carried out according to EN 60068-2-6	Limits according to EN 61131-2		Limits according to EN 60721-3-3 class 3M4		
Vibration operation: Uninterrupted duty with moveable frequency in all 3 axes (x, y, z), 1 octave per minute	10 sweeps for each axis		10 sweeps for each axis		
	Frequency	Limit value	Frequency	Limit value	
	5 - 9 Hz	Amplitude 3,5 mm	2 - 9 Hz	Amplitude 3 mm	
	9 - 150 Hz	Acceleration 1 g	9 - 200 Hz	Acceleration 1 g	

Table 152: Test requirements - Vibration operation

5.2 Vibration during transport (packaged)

Test carried out according to EN 60068-2-6	Limits according to EN 60721-3-2 class 2M1		Limits according to EN 60721-3-2 class 2M2		Limits according to EN 60721-3-2 class 2M3	
Vibration during transport: Uninterrupted duty with moveable frequency in all 3 axes (x, y, z)	10 sweeps for each axis, packaged		10 sweeps for each axis, packaged		10 sweeps for each axis, packaged	
	Frequency	Limit value	Frequency	Limit value	Frequency	Limit value
	2 - 9 Hz	Amplitude 3,5 mm	2 - 9 Hz	Amplitude 3,5 mm	2 - 8 Hz	Amplitude 7.5 mm
	9 - 200 Hz	Acceleration 1 g	9 - 200 Hz	Acceleration 1 g	8 - 200 Hz	Acceleration 2 g
	200 - 500 Hz	Acceleration 1.5 g	200 - 500 Hz	Acceleration 1.5 g	200 - 500 Hz	Acceleration 4 g

Table 153: Test requirements - Vibration during transport (packaged)

5.3 Shock during operation

Test carried out according to EN 60068-2-27	Limits according to EN 61131-2	Limits according to EN 60721-3-3 class 3M4	
Shock operation: Pulse (half-sine) stress in all 3 axes (x, y, z)	Acceleration 15 g, length 11 ms, 18 shocks	Acceleration 15 g, length 11 ms	

Table 154: Test requirements - Shock operation

5.4 Shock during transport (packaged)

Test carried out according to EN 60068-2-27	Limits according to EN 60721-3-2 class 2M1	Limits according to EN 60721-3-2 class 2M2	Limits according to B&R
Pulse (half-sine) stress in all 3 axes (x, y, z)	Acceleration 10 g, Length 11 ms, each 3 shocks, packaged	Acceleration 30 g, Length 6 ms, each 3 shocks, packaged	Acceleration 30 g, Length 11 ms, each 3 shocks, packaged

Table 155: Test requirements - Shock transport

5.5 Toppling

Test carried out according to EN 60068-2-31	Limits according to EN 60721-3-2 class 2M1		Limits according to EN 60721-3-2 class 2M2		Limits according to EN 60721-3-2 class 2M3	
Toppling and knocking over	Devices: Toppling/knocking over on each edge		Devices: Toppling/knocking over on each edge		Devices: Toppling/knocking over on each edge	
	Weight	Required	Weight	Required	Weight	Required
	< 20 kg	Yes	< 20 kg	Yes	< 20 kg	Yes
	20 - 100 kg	-	20 - 100 kg	Yes	20 - 100 kg	Yes
	> 100 kg	-	> 100 kg	-	> 100 kg	Yes

Table 156: Test requirements - Toppling

5.6 Free fall (packaged)

Test carried out according to EN 60068-2-32	Limits according to EN 61131-2		Limits according to EN 60721-3-2 class 2M1		Limits according to EN 60721-3-2 class 2M2		Limits according to EN 60721-3-2 class 2M3	
Free fall	Devices with delivery packaging each with 5 fall tests		Devices packaged		Devices packaged		Devices packaged	
	Weight	Height	Weight	Height	Weight	Height	Weight	Height
	< 10 kg	1,0 m	< 20 kg	0.25 m	< 20 kg	1.2 m	< 20 kg	1.5 m
	10 - 40 kg	0.5 m	20 - 100 kg	0.25 m	20 - 100 kg	1.0 m	20 - 100 kg	1.2 m
	> 40 kg	0.25 m	> 100 kg	0.1 m	> 100 kg	0.25 m	> 100 kg	0.5 m
	Devices with product packaging each with 5 fall tests							
	Weight	Height						
	< 10 kg	0,3 m						
	10 - 40 kg	0.3 m						
	> 40 kg	0.25 m						
	Limits according to B&R							
	Devices packaged							
	Weight	Height						
	<40 kg	1 m						

Table 157: Test requirements - Toppling

6. Climate conditions

Temperature / humidity	Test carried out according to	Limits according to
Worst case operation	UL 508	UL 508: Industrial control equipment EN 61131-2: Programmable logic controllers
Dry heat	EN 60068-2-2	EN 61131-2: Programmable logic controllers
Dry cold	EN 60068-2-1	EN 61131-2: Programmable logic controllers
Large temperature fluctuations	EN 60068-2-14	EN 61131-2: Programmable logic controllers
Temperature fluctuations in operation	EN 60068-2-14	EN 61131-2: Programmable logic controllers
Humid heat, cyclic	EN 60068-2-30	EN 61131-2: Programmable logic controllers
Humid heat, constant (storage)	EN 60068-2-3	EN 61131-2: Programmable logic controllers
Sprayed water (from front)	NEMA 250 Type 4X	UL 50 - NEMA 250 4X: Degree of protection provided by housing

Table 158: Overview of limits and testing guidelines for temperature and humidity

6.1 Worst case operation

Test carried out according to UL 508	Limits according to UL 508	Limits according to EN 61131-2	
Worst case operation. Operation of the device with the max. ambient temperature specified in the data sheet at the max. specified load	3 hours at max. ambient temperature (min. +40°C) duration approx. 5 hours	3 hours at max. ambient temperature (min. +40°C) duration approx. 5 hours	

Table 159: Test requirements - Worst case operation

6.2 Dry heat

Test carried out according to EN 60068-2-2	Limits according to EN 61131-2		
Dry heat	16 hours at +70°C for 1 cycle, then 1 hour acclimatization and function testing, duration approximately 17 hours		

Table 160: Test requirements - Dry heat

6.3 Dry cold

Test carried out according to EN 60068-2-1	Limits according to EN 61131-2		
Dry cold	16 hours at -40°C for 1 cycle, then 1 hour acclimatization and function testing, duration approximately 17 hours		

Table 161: Test requirements - Dry cold

6.4 Large temperature fluctuations

Test carried out according to EN 60068-2-14	Limits according to EN 61131-2		
Large temperature fluctuations	3 hours at -40°C and 3 hours at +70°C, 2 cycles, then 2 hours acclimatization and function testing, duration approximately 14 hours		

Table 162: Test requirements - Large temperature fluctuations

6.5 Temperature fluctuations in operation

Test carried out according to EN 60068-2-14	Limits according to EN 61131-2		
Open devices: These can also have a housing and are installed in switching cabinets	3 hours at +5° C and 3 hours at 55°C, 5 cycles, temperature gradient 3°C / min, the unit is occasionally supplied with voltage during testing, duration approximately 30 hours		
Closed devices: These are devices whose data sheet specifies a surrounding housing (enclosure) with the corresponding safety precautions	3 hours at +5°C and 3 hours at +55°C, 5 cycles, temperature gradient 3°C / min, the unit is occasionally supplied with voltage during testing, duration approximately 30 hours		

Table 163: Test requirements - Temperature fluctuations in operation

6.6 Humid heat, cyclic

Test carried out according to EN 60068-2-30	Limits according to EN 61131-2		
Alternating climate	24 hours at +25°C / +55°C and 97% / 83% RH, 2 cycles, then 2 hours acclimatization, function testing and insulation, duration approximately 50 hours		

Table 164: Test requirements - Humid heat, cyclic

6.7 Humid heat, constant (storage)

Test carried out according to EN 60068-2-3	Limits according to EN 61131-2		
Humid heat, constant (storage)	48 hours at +40°C and 92.5% RH, then insulation test within 3 hours, duration approximately 49 hours		

Table 165: Test requirements - Humid heat, constant (storage)

6.8 Sprayed water (front side)

Test carried out according to UL 50	Limits according to NEMA 250 Type 4X		
Sprayed water (front side)	Spraying using a 25.4 mm (diameter) water jet nozzle Distance: 3 to 3.7 meters (all angles) Water flow: 246 liters/minute Duration: 48 seconds, 5 seconds minimum		

Table 166: Test requirements - Sprayed water (front side)

7. Safety

Safety	Test carried out according to	Limits according to
Ground resistance	EN 61131-2	EN 60204-1: Electrical equipment of machines
		EN 61131-2: Programmable logic controllers
Insulation resistance		EN 60204-1: Electrical equipment of machines
High voltage	EN 60060-1	EN 61131-2: Programmable logic controllers
		UL 508: Industrial control equipment

Table 167: Overview of limits and testing guidelines for safety

7.1 Ground resistance

Test carried out according to EN 61131-2	Limits according to EN 60204-1 ¹⁾		Limits according to EN 61131-2
Ground resistance: housing (from any metal part to the ground terminal)	Smallest effective cross section of the protective ground conductor for the branch being tested	Maximum measured voltage drop at a test current of 10 A	Test current 30 A for 2 min, < 0.1 Ohm
	1.0 mm ²	3.3 V	
	1.5 mm ²	2.6 V	
	2.5 mm ²	1.9 V	
	4.0 mm ²	1.4 V	
	> 6.0 mm ²	1.0 V	

Table 168: Test requirements - Ground resistance

1) See EN 60204-1:1997 page 62, table 9.

7.2 Insulation resistance

Test carried out	Limits according to EN 60204-1 ¹⁾		
Insulation resistance: main circuits to protective ground conductor	> 1 MOhm at 500 VDC voltage		

Table 169: Test requirements - Insulation resistance

1) See EN 60204-1:1997 page 62, table 9.

7.3 High voltage

Test carried out according to EN 60060-1	Limits according to EN 61131-2 ¹⁾				Limits according to UL 508		
High voltage: Primary circuit to secondary circuit and to protective ground circuit (transformers, coils, varistors, capacitors and components used to protect against over-voltage can be removed before the test)	Input voltage	Test voltage			Input voltage	Test voltage	
		1.2/50 μs voltage surge peak	AC, 1 min	DC, 1 min		AC, 1 min	DC, 1 min
	0 - 50 VAC 0 - 60 VDC	850 V	510 V	720 V	≤ 50 V	500 V	707 V
	50 - 100 VAC 60 - 100 VDC	1360 V	740 V	1050 V	> 50 V	1000 V + 2 x U _N	(1000 V + 2 x U _N) x 1.414
	100 - 150 VAC 100 - 150 VDC	2550 V	1400 V	1950 V			
	150 - 300 VAC 150 - 300 VDC	4250 V	2300 V	3250 V			
	300 - 600 VAC 300 - 600 VDC	6800 V	3700 V	5250 V			
	600 - 1000 VAC 600 - 1000 VDC	10200 V	5550 V	7850 V			

Table 170: Test requirements - High voltage

1) See EN 61131-2:2003 page 104, table 59.

7.4 Voltage range

Test carried out according to	Limits according to EN 61131-2			
Supply voltage	Measurement value	Tolerance min/max		
	24 VDC 48 VDC 125 VDC	-15% +20%		
	24 VAC 48 VAC 100 VAC 110 VAC 120 VAC 200 VAC 230 VAC 240 VAC 400 VAC	15% +10%		

Table 171: Test requirements - Voltage range

8. Other tests

Other tests	Test carried out according to	Limits according to
Function test	-	-
Optical test	-	-
Hot spot measurement	-	-
Protection type	-	EN 60529: Degrees of protection provided by enclosures (IP code)
Mounting dimensions	-	B&R

Table 172: Overview of limits and testing guidelines for other tests

8.1 Protection type

Test carried out according to	Limits according to EN 60529	Limits according to EN 60529	
Protection of the operating equipment	IP2. Protection against large solid foreign bodies ≈ 12.5 mm diameter	IP.6 Protection against large solid foreign bodies: dust-proof	
Protection of personnel	IP2. Protection against touching dangerous parts with finger	IP.6 Protection against touching dangerous parts with conductor	
Protection against water permeation with damaging consequences	IP.0 Not protected	IP.5 Protected against sprayed water	

Table 173: Test requirements - Protection

9. International certifications

B&R products and services comply with applicable standards. They are international standards from organizations such as ISO, IEC and CENELEC, as well as national standards from organizations such as UL, CSA, FCC, VDE, ÖVE, etc. We give special consideration to the reliability of our products in an industrial environment.

Certifications	
USA and Canada 	All important B&R products are tested and listed by Underwriters Laboratories and checked quarterly by a UL Inspector. This mark is valid for the USA and Canada and simplifies certification of your machines and systems in these areas.
Europe 	All harmonized EN standards for the applicable guidelines are met.

Table 174: International certifications

Chapter 6 • Accessories

1. Overview

Model number	Product ID	Note
0AC201.9	Lithium batteries, 5 pcs. Lithium batteries, 5 pcs., 3 V / 950 mAh, button cell	
4A0006.00-000	Lithium battery (1x) Lithium battery, 1 pc., 3 V / 950 mAh, button cell	
0TB103.9	Plug 24V 5.08 3-pin screw clamps 24 VDC 3-pin connector, female. Screw clamps, 3.31 mm ² , protected against vibration by the screw flange	
0TB103.91	Plug 24V 5.08 3-pin cage clamps 24 VDC 3-pin connector, female. Cage clamps, 3.31 mm ² , protected against vibration by the screw flange	
5AC900.057X-00	Legend strips 3x 5.7" vertical1 Legend strip template for Power Panel 4PP451.0571-65. For 3 devices.	
5AC900.057X-01	Legend strips 2x 5.7" horizontal2 Legend strip template for Power Panel 4PP452.0571-65. For 2 devices.	
5AC900.104X-00	Legend strip 1x 10.4" Vertical1 Legend strip template for Power Panel 4PP451.1043-75 and 4PP481.1043-B5. For 1 device.	
5AC900.104X-01	Legend strip 1x 10.4" Horizontal2 Legend strip template for Power Panel 4PP482.1043-75. For 1 device.	
5AC900.104X-02	Legend strips 3x 10.4" Horizontal1 Legend strip template for Power Panel 4PP480.1043-75. For 3 devices.	
5AC900.150X-00	Legend strips 4x 15" Legend strip template for Power Panel 4PP481.1505-75 and 4PP480.1505-75. For 4 devices.	
5CFCRD.0064-03	CompactFlash 64 MB SSI CompactFlash card with 64 MB SLC NAND flash and IDE/ATA interface	
5CFCRD.0128-03	CompactFlash 128 MB SSI CompactFlash card with 128 MB SLC NAND flash and IDE/ATA interface	
5CFCRD.0256-03	CompactFlash 256 MB SSI CompactFlash card with 256 MB SLC NAND flash and IDE/ATA interface	
5CFCRD.0512-03	CompactFlash 512 MB SSI CompactFlash card with 512 MB SLC NAND flash and IDE/ATA interface	
5CFCRD.1024-03	CompactFlash 1024 MB SSI CompactFlash card with 1024 MB SLC NAND flash and IDE/ATA interface	
5CFCRD.2048-03	CompactFlash 2048 MB SSI CompactFlash card with 2048 MB SLC NAND flash and IDE/ATA interface	

Table 175: Model numbers - Accessories

Accessories • Overview

Model number	Product ID	Note
5CFCRD.4096-03	CompactFlash 4096 MB SSI CompactFlash card with 4096 MB SLC NAND flash and IDE/ATA interface	
5CFCRD.8192-03	CompactFlash 8192 MB SSI CompactFlash card with 8192 MB SLC NAND flash and IDE/ATA interface	
5MMUSB.2048-00	USB flash drive 2 GB SanDisk USB 2.0 flash drive 2 GB	
9A0017.01	RS232 DB9 null modem cable 0.6 m Null modem cable RS232 0.6 m to connect UPS and IPC (9-pin DSUB socket - 9-pin DSUB socket)	
9A0017.02	RS232 DB9 null modem cable 1.8 m Null modem cable RS232 1.8 m to connect UPS and IPC (9-pin DSUB socket - 9-pin DSUB socket)	

Table 175: Model numbers - Accessories

2. Replacement CMOS batteries

The lithium battery is needed for buffering the BIOS CMOS data, the real-time clock, and SRAM data.

The battery is subject to wear and must be replaced when the battery power ("Bad" status) is insufficient (see "Changing the battery" on page 364).

2.1 Order data

Model number	Description	Figure
0AC201.9	Lithium batteries, 5 pcs., 3 V / 950 mAh button cell	
4A0006.00-000	Lithium battery, 1 piece, 3 V / 950 mAh button cell	

Table 176: Order data - Lithium batteries

2.2 Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those for the entire device. For the entire device where this accessory is installed, refer to the data provided specifically for the entire device.

The technical data is current as of when this manual was printed. We reserve the right to make changes.

Features	0AC201.9	4A0006.00-000
Capacity	950 mAh	
Voltage	3 V	
Self discharge at 23°C	< 1% per year	
Storage time	Max. 3 years at 30°C	
Environmental characteristics		
Storage temperature	-20°C to +60°C	
Relative humidity	0 to 95%, non-condensing	

Table 177: Technical data - Lithium batteries

2.3 Contents of delivery

Amount	Component
1 or 5	Lithium batteries

Table 178: Contents of delivery for lithium batteries

3. TB103 3-pin supply voltage connector

3.1 General

This single row 3-pin terminal block is mainly used to connect the supply voltage.

3.2 Order data

Model number	Description	Figure
0TB103.9	Plug for the 24 V supply voltage (screw clamps)	 0TB103.9
0TB103.91	Plug for the 24 V supply voltage (cage clamps)	
		 0TB103.91

Table 179: Order data - TB103 supply plug

3.3 Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from those for the entire device. For the entire device where this accessory is installed, refer to the data provided specifically for the entire device.

The technical data is current as of when this manual was printed. We reserve the right to make changes.

Name	0TB103.9	0TB103.91
Number of pins	3	
Type of terminal	Screw clamps	Cage clamps
Distance between contacts	5,08 mm	
Resistance between contacts	$\leq 5 \text{ m}\Omega$	
Nominal voltage according to VDE / UL, CSA	250 V / 300 V	
Current load according to VDE / UL, CSA	14,5 A / 10 A per contact	
Terminal size	0,08 mm ² - 3.31 mm ²	
Cable type	Copper wires only (no aluminum wires!)	

Table 180: Technical data - TB103 supply plug

3.4 Contents of delivery

Amount	Component
1	Supply plug in desired design.

Table 181: Contents of delivery - TB103 supply plug

4. Legend strip templates

Power Panel devices with keys are delivered with partially pre-labeled key legend strips (F1, F2, etc.). The key legend strip slots are accessible on the back of the Power Panel device (above and below).

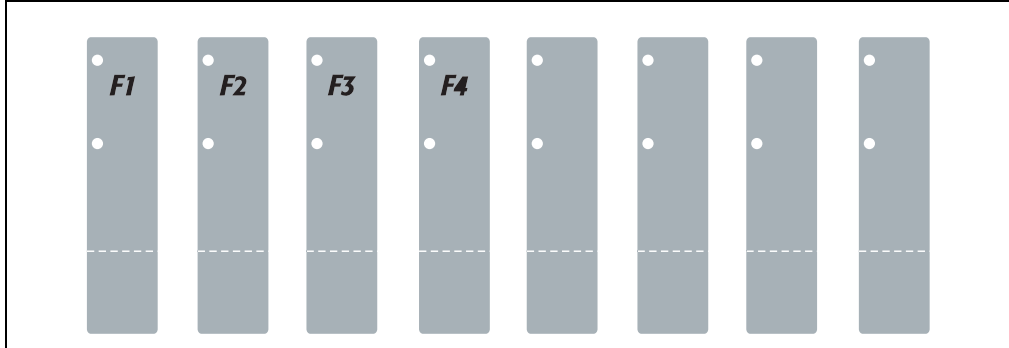


Figure 200: Legend strip templates

Printable legend strips (A4 format) can be ordered from B&R (see table 182 "Order data - Legend strip templates" on page 343). They can be printed using a standard laser printer (b/w or color) in a temperature range from -40 °C to +125 °C. A print template (available for Corel Draw version 7, 9 and 10) for the respective legend strip template can be downloaded from the B&R homepage www.br-automation.com.

4.1 Order data

Model number	Description	Figure
5AC900.057X-00	Legend strips 3x 5.7" vertical1 Legend strip template for Power Panel 4PP451.0571-65. For 3 devices.	Examples of legend strip templates
5AC900.057X-01	Legend strips 2x 5.7" horizontal2 Legend strip template for Power Panel 4PP452.0571-65. For 2 devices.	
5AC900.104X-00	Legend strip 1x 10.4" Vertical1 Legend strip template for Power Panel 4PP451.1043-75 and 4PP481.1043-B5. For 1 device.	
5AC900.104X-01	Legend strip 1x 10.4" Horizontal2 Legend strip template for Power Panel 4PP482.1043-75. For 1 device.	
5AC900.104X-02	Legend strips 3x 10.4" Horizontal1 Legend strip template for Power Panel 4PP480.1043-75. For 3 devices.	
5AC900.150X-00	Legend strips 4x 15" Legend strip template for Power Panel 4PP481.1505-75 and 4PP480.1505-75. For 4 devices.	

Table 182: Order data - Legend strip templates

5. CompactFlash cards 5CFCRD.xxxx-03

5.1 General information

CompactFlash cards are easy-to-exchange storage media. Due to their robustness against environmental influences (e.g. temperature, shock, vibration, etc.), CompactFlash cards are ideal for use as storage media in industrial environments.

5.2 Order data

Model number	Description	Figure
5CFCRD.0064-03	CompactFlash 64 MB SSI	 Example: 256 MB CompactFlash card
5CFCRD.0128-03	CompactFlash 128 MB SSI	
5CFCRD.0256-03	CompactFlash 256 MB SSI	
5CFCRD.0512-03	CompactFlash 512 MB SSI	
5CFCRD.1024-03	CompactFlash 1024 MB SSI	
5CFCRD.2048-03	CompactFlash 2048 MB SSI	
5CFCRD.4096-03	CompactFlash 4096 MB SSI	
5CFCRD.8192-03	CompactFlash 8192 MB SSI	

Table 183: Order data - CompactFlash cards

5.3 Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from the entire device. For the entire device where this accessory is installed, refer to the data provided specifically for the entire device.

The technical data is current as of when this manual was printed. We reserve the right to make changes.

Features	5CFCRD.xxxx-03
MTBF (at 25°C)	> 4000000 hours
Maintenance	None
Data reliability	< 1 unrecoverable error in 10^{14} bit read accesses
Write/erase procedures	> 2,000,000 times
Data retention	10 years
Mechanical characteristics	5CFCRD.xxxx-03

Table 184: Technical data - CompactFlash cards 5CFCRD.xxxx-03

Dimensions	
Length	36,4 ± 0,15 mm
Width	42,8 ± 0,10 mm
Thickness	3,3 ± 0,10 mm
Weight	11,4 grams
Environmental characteristics	
Ambient temperature	
Operation	0°C to +70°C
Storage	-50°C to +100°C
Transport	-50°C to +100°C
Relative humidity	
Operation / Storage	8% to 95%, non-condensing
Vibration	
Operation	Maximum 16.3 g (point to point)
Storage / Transport	Maximum 30 g (point to point)
Shock	
Operation	Maximum 1000 g
Storage / Transport	Maximum 3,000 g
Altitude	Maximum 80,000 feet (24,383 meters)

Table 184: Technical data - CompactFlash cards 5CFCRD.xxxx-03 (cont.)

5.3.1 Temperature humidity diagram - Operation and storage

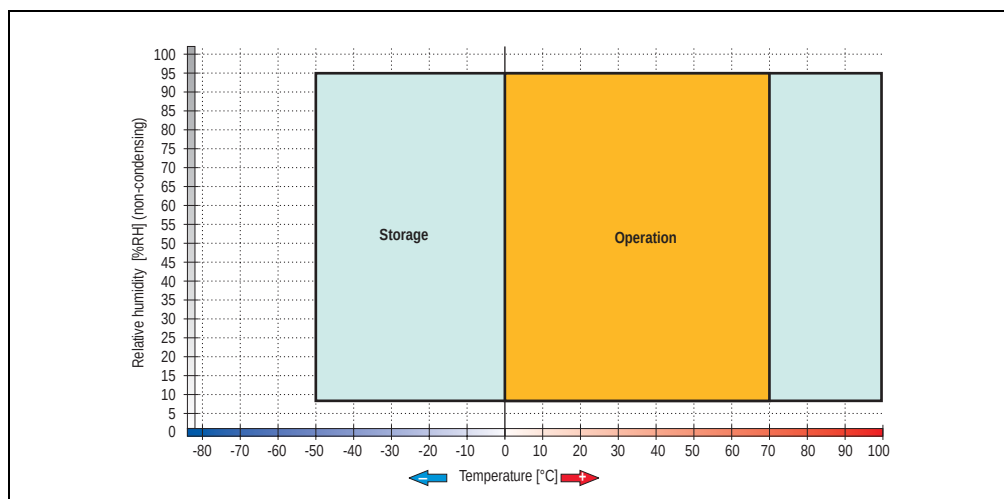


Figure 201: Temperature humidity diagram - CompactFlash cards 5CFCRD.xxxx-03

5.4 Contents of delivery

Amount	Component
1	CompactFlash card in desired size

Table 185: Contents of delivery - CompactFlash cards 5CFCRD.xxxx-03

5.5 Dimensions

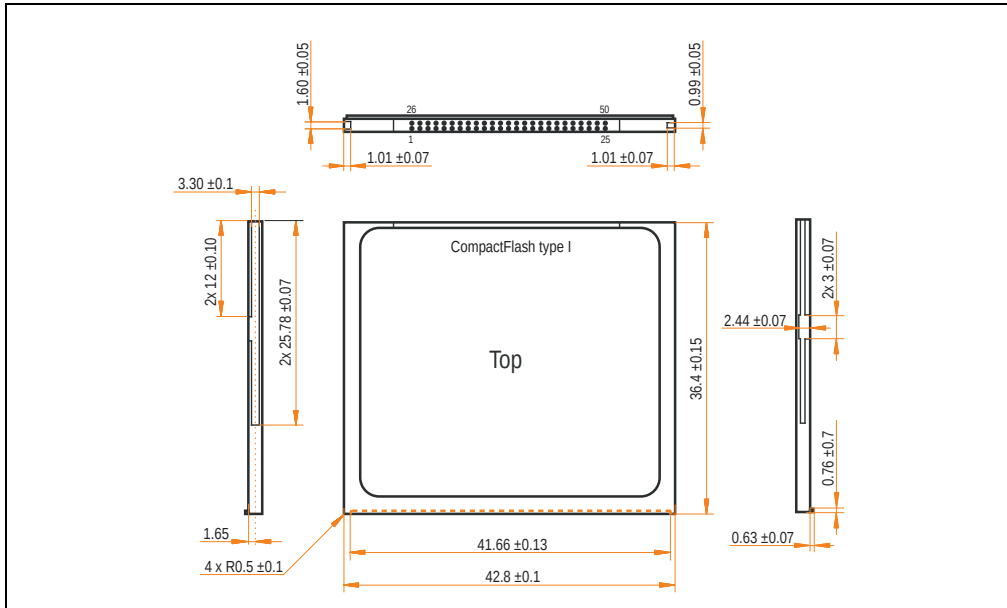


Figure 202: Dimensions - CompactFlash card Type I

5.6 Calculating the lifespan

Silicon Systems provides a 9-page "white paper" for the lifespan calculation for CompactFlash cards (see following pages). This document can also be found on the Silicon Systems homepage (www.siliconsystems.com).

Information:

A software tool for calculating the statistical lifespan of the Silicon Systems CompactFlash cards in various settings can be downloaded from the B&R Homepage (www.br-automation.com).



Advanced Storage Technology



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ENDURANCE CONSIDERATIONS

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Revision D

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SILICONSYSTEMS, INC.

Figure 203: Silicon Systems white paper - page 1 of 9



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INTRODUCTION

SiliconSystems' SiliconDrive™ technology is specifically designed to meet the high performance and high reliability requirements of Enterprise System OEMs in the netcom, military, industrial, interactive kiosk and medical markets. One of the measures of storage reliability in Enterprise System OEM applications is endurance – the number of write/erase cycles that can be performed before the storage product "wears out."

BACKGROUND

It is important to note that endurance is not just a function of the storage media. Rather, it is the combination of the storage media and the controller technology that determines the endurance. For example, magnetic media is an order of magnitude less reliable than NAND flash, yet the controller technology employed by rotating hard drives can compensate for this deficiency to yield reliability results that meet those of solid-state storage.

[NOTE: This is a completely different discussion from the mechanical reliability involving rotating hard drives versus solid-state storage that has no moving parts. This is just an example of how a controller, if it is good enough, can compensate for the deficiencies of the media].

Write/erase cycle endurance for solid-state storage is specified in many ways by many different vendors. Some specify the endurance at the physical block level, while others specify at the logical block level. Still others specify it at the card or drive level. Since endurance is also related to data retention, endurance can be specified at a higher level if the data retention specification is lower. For these reasons, it is often difficult to make an "apples to apples" comparison of write/erase endurance by solely relying on these numbers in a datasheet.

A better way to judge endurance is to break the specification down into the main components that affect the endurance calculation:

1. Storage Media
2. Wear Leveling Algorithm
3. Error Correction Capabilities

Other factors that affect endurance include the amount of spare sectors available and whether or not the write is done using a file system or direct logical block addressing. While these issues can contribute to the overall endurance calculation, their effects on the resulting number is much lower than the three parameters above. Each of those factors will be examined individually, assuming ten-year data retention.

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STORAGE MEDIA

The scope of this white paper is confined to non-volatile storage – systems that do not lose their data when the power is turned off. The dominant technology for non-volatile solid-state storage is NAND flash. While NOR flash is also a possible solution, implementation of NOR technology is generally confined to applications like cell phones that require the functionality of DRAM, boot PROM and storage component in a single chip. The economies of scale and component densities of NAND relative to NOR make it the ideal solution for non-volatile, solid-state storage subsystems.

The two dominant NAND technologies available today are SLC (single-level cell, sometimes called binary) and MLC (multi-level cell). SLC technology stores one bit per cell and MLC stores two bits. A comparison of SLC and MLC is shown in figure 1.

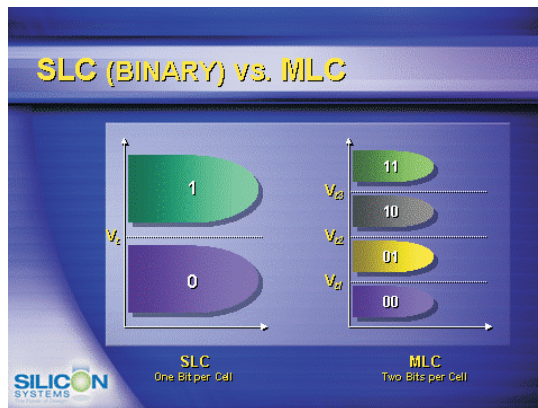


Figure 1

SLC NAND is generally specified at 100,000 write/erase cycles per block with 1-bit ECC (this is explained below). MLC NAND is specified at 10,000 write/erase cycles per block with ECC. The MLC datasheet does not specify a number of bits of ECC required. Therefore, when using the same controller, a storage device using SLC will have an endurance value roughly 10x that of a similar MLC-based product. In order to achieve maximum endurance, capacity and speed, SiliconSystems currently uses SLC NAND in our SiliconDrive technology.



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A more thorough discussion of SLC vs. MLC can be found from the component manufacturers:

Samsung: <http://www.samsung.com>

Toshiba: <http://www.toshiba.com>

WEAR LEVELING

Wear leveling is defined as the allowing data writes to be evenly distributed over the entire storage device. More precisely, wear leveling is an algorithm by which the controller in the storage device re-maps logical block addresses to different physical block addresses in the solid-state storage array. The frequency of this re-map, the algorithm to find the "least worn" area to which to write and any data swapping capabilities are generally considered proprietary intellectual property of the controller vendor.

It is important to note that the wear leveling is done in the solid-state memory controller and is independent of the host system. The host system performs its reads and writes to logical block addresses only, so as far as the host is concerned, the data stays in the same place.

To illustrate the effects of wear leveling on overall endurance, assume three different storage devices with the following characteristics:

1. Flash Card with No Wear Leveling
2. Flash Card with Dynamic Wear Leveling
3. SiliconDrive with Static Wear Leveling

In addition, assume that all three storage devices use the same solid-state storage technologies (SLC or MLC – for purposes of this discussion, it doesn't matter). All three devices will have 75% of the capacity as static data, which is defined below:

Static Data: Any data on a solid-state storage device that does not change. Examples include: operating system files, look-up tables and executable files.

Finally, the same type of write is performed to all three systems. The host system is writing a single block of data to the same logical block address over and over again.

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No Wear Leveling

Figure 2 shows a normalized distribution of writes to a flash card that does not use wear leveling. In this instance, the data gets written to the same physical block. Once that physical block wears out and all spare blocks are exhausted (see discussion below), the device ceases to operate, even though only a small percentage of the card was used.

In this instance, the endurance of the card is only dependent on the type of flash used and any error correction capabilities in excess of one byte per sector. Early flash cards did not use wear leveling and thus failed in write-intensive applications. For this reason, flash cards with no wear leveling are only useful in consumer electronic applications.

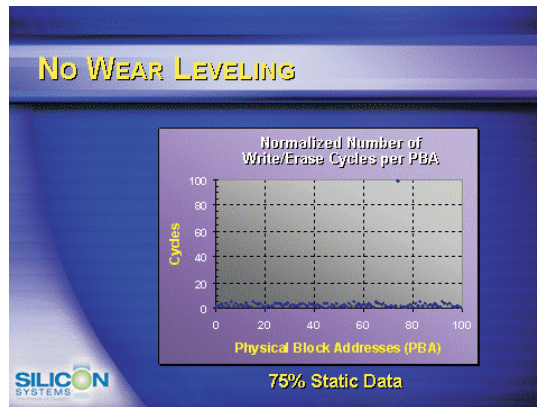


Figure 2



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Dynamic Wear Leveling

Figure 3 shows a normalized distribution of writes to a flash card that employs dynamic wear leveling. This algorithm only wear levels over "free" or "dynamic" data areas. That is to say, if there is static data as defined above, this area is never involved in the wear leveling process. In the current example, since 75% of the flash card is used for static data, only 25% of the card is available for wear leveling. The endurance of the card is calculated to be 25 times better than for the card with no wear leveling, but only one-fourth that of static wear leveling.

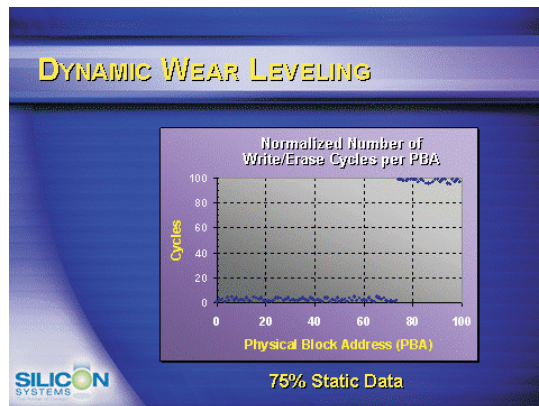


Figure 3



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Static Wear Leveling

Figure 4 shows a normalized distribution of writes to a SiliconDrive that employs static wear leveling. This algorithm evenly distributes the data over the entire SiliconDrive. The algorithm searches for the least-used physical blocks and writes the data to that location. If that location is empty, the write occurs normally. If that location contains static data, the static data is moved to a more heavily-used location prior to the new data being written. The endurance of the SiliconDrive is calculated to be 100 times better than for the card with no wear leveling and four times the endurance of the card that uses dynamic wear leveling.

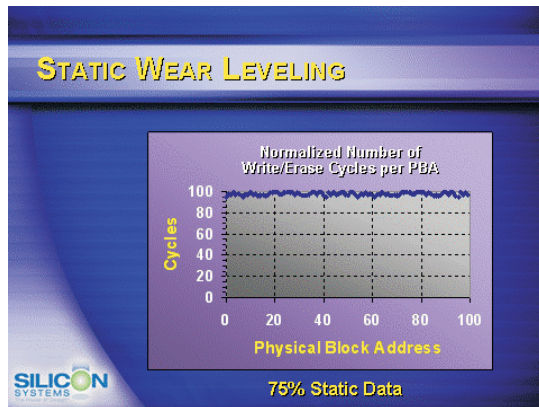


Figure 4



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ERROR CORRECTION

Part of the solid-state memory components specification is related to error correction. For example, SLC NAND components are specified at 100,000 write/erase cycles with one-bit ECC. It goes to reason that the specification increases with a better error correction algorithm. Most flash cards employ error correction algorithms ranging from two-bit to four-bit correction. SiliconSystems' SiliconDrive technology uses six-bit correction.

The term six-bit correction may be slightly confusing. Six-bit correction really defines the capability of correcting up to six bytes in a 512-byte sector. Since a byte is eight bits, this really means the SiliconDrive can correct 48 bits as long as those bits are confined to six bytes in the sector. The same definition holds for two-bit and four-bit correction.

The relationship between the number of bytes per sector the controller can correct does not appear to be directly proportional to the overall endurance, since the bit error rate of the NAND flash is not linear. To state it another way, six-bit error correction is not necessarily three times better than two-bit ECC. In most cases, it is significantly better than that.

SUMMARY OF MEDIA, WEAR LEVELING AND ECC

The matrix below summarizes the effects of the different items discussed above. In the table, a "1" indicates the best possible scenario, and a "10" indicates the least desirable in terms of endurance.

N = No Wear Leveling; D = Dynamic Wear Leveling; S = Static Wear Leveling

ECC	SLC NAND			MLC NAND		
	N	D	S	N	D	S
2-bit	6	5	4	10	9	8
4-bit	5	4	2	9	8	7
6-bit	4	3	1*	8	7	6

* SiliconSystems' SiliconDrive Configuration

Figure 210: Silicon Systems white paper - page 8 of 9



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ENDURANCE CALCULATIONS

To get an idea of how long a solid-state storage device will last in an application, the following calculations can be used. Note: These calculations are valid only for products that use either dynamic or static wear leveling. Use the solid-state memory component specifications for products that do not use wear leveling.

To calculate the expected life in years a product will last:

$$\text{Years} = \frac{(\alpha - \beta) \times \lambda \times (1 - \varphi)}{(\omega \times \xi) \times k}$$

Where:

- α = Capacity in MB (when converting from MB to GB, MB = GB x 1,024)
- β = Amount of Static Data in MB (this value should be 0 for static wear leveling)
- λ = Endurance Specification
- φ = Safety Margin
- ω = File Size in MB (when converting from KB to MB, KB = MB x 1,024)
- ξ = Number of Writes of file size ω per minute
- k = Number of minutes per year = 525,600

To calculate the number of data transactions:

$$\text{Transactions} = \frac{(\alpha - \beta) \times \lambda \times (1 - \varphi)}{\omega}$$

Where:

- α = Capacity in MB (when converting from MB to GB, MB = GB x 1,024)
- β = Amount of Static Data in MB (this value should be 0 for static wear leveling)
- λ = Endurance Specification
- φ = Safety Margin Percentage (usually 25%)
- ω = File Size in MB (when converting from KB to MB, KB = MB x 1,024)

The information contained in this bulletin ("Information") is for general guidance on matters of interest relating to the products referred to herein. While SiliconSystems and the author of this bulletin have made every attempt to ensure the accuracy of the Information, SiliconSystems, its officers, and employees shall not be responsible for any errors or omissions, or for the results obtained from the use of this Information. All Information is provided "as is," with no guarantee of completeness, accuracy, timeliness or of the results obtained from the use of this Information, and without warranty of any kind, express or implied. In no event shall SiliconSystems or its employees be liable for any decision made or action taken in reliance on the Information or for any consequential, special or similar damages, even if advised of the possibility of such damages.

Figure 211: Silicon Systems white paper - page 9 of 9

6. USB flash drive

Information:

We reserve the right to supply alternative products due to the vast quantity of flash drives available on the market and their corresponding short product lifecycle. As a result, it may be necessary (e.g. Therefore, the following measures might be necessary in order to boot from these flash drives (e.g. the SanDisk Cruzer Micro flash drive with 2 GB):

- The flash drive must be reformatted or in some cases even re-partitioned (set active partition).
- The flash drive must be at the top of the BIOS boot order, or alternatively the IDE controllers can also be deactivated in the BIOS. This can be avoided in most cases if a "fdisk /mbr" command is also executed on the USB flash drive.

6.1 General information

USB flash drives are easy-to-exchange storage media. Because of the fast data transfer (USB 2.0), the USB flash drives are ideal for use as a portable memory medium. Without requiring additional drivers ("Hot Plug & Play" - except with Windows 98SE), the USB flash drive can be converted immediately into an additional drive where data can be read or written. Only USB flash drives from the memory specialists [SanDisk](#) are used.

6.2 Order data

Model number	Description	Figure
5MMUSB.2048-00	USB flash drive 2 GB SanDisk Cruzer Micro	

Table 186: Order data - USB flash drives

6.3 Technical data

Information:

The following characteristics, features and limit values only apply to this accessory and can deviate from the entire device. For the entire device where this accessory is installed, refer to the data provided specifically for the entire device.

The technical data is current as of when this manual was printed. We reserve the right to make changes.

Features	5MMUSB.2048-00
LED	1 LED (green), signals data transfer (send and receive)
Power supply Current requirements	Via the USB port 650 µA sleep mode, 150 mA read/write
Interface Type Transfer rate Sequential reading Sequential writing Connection	USB specification 2.0 high speed device, mass storage class, USB-IF and WHQL certified USB 1.1 and 2.0-compatible Up to 480 Mbit (high speed) Max. 8.7 MB/second Max. 1.7 MB/second To each USB type A interface
MTBF (at 25°C)	100000 hours
Data retention	10 years
Maintenance	None
Operating system support	Windows CE 5.0 and Windows XP embedded
Mechanical characteristics	
Dimensions Length Width Thickness	52,2 mm 19 mm 7,9 mm
Environmental characteristics	
Ambient temperature Operation Storage Transport	0°C to +45°C -20°C to +60°C -20°C to +60°C
Relative humidity Operation Storage Transport	10% to 90%, non-condensing 5% to 90%, non-condensing 5% to 90%, non-condensing
Vibration Operation Storage Transport	2 g (10 to 500 Hz), oscillation rate 1/minute 4 g (10 to 500 Hz), oscillation rate 1/minute 4 g (10 to 500 Hz), oscillation rate 1/minute
Shock Operation Storage Transport	40 g and 11 ms duration (all axes) 80 g and 11 ms duration (all axes) 80 g and 11 ms duration (all axes)

Table 187: Technical data - USB flash drive 5MMUSB.2048-00

Features	5MMUSB.2048-00
Altitude	
Operation	3048 meters
Storage	12192 meters
Transport	12192 meters

Table 187: Technical data - USB flash drive 5MMUSB.2048-00 (cont.)

6.3.1 Temperature humidity diagram - Operation and storage

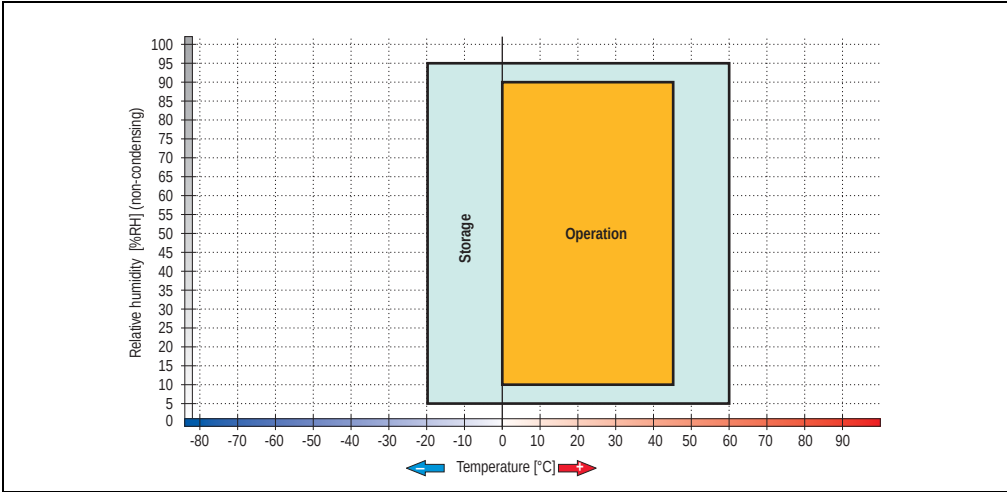


Figure 212: Temperature humidity diagram - USB flash drives - 5MMUSB.2048-00

6.4 Contents of delivery

SanDisk Cruzer Micro
1 USB flash drive in desired size + 2 replacement covers (blue and pink) + 1 strap ¹⁾
 +  + 

Table 188: Contents of delivery - USB flash drive 5MMUSB.2048-00

1) Due to a change in the contents of delivery from the manufacturer, it is possible that the USB flash drive (with white cap) is delivered without the replacement covers or strap.

6.5 Creating a bootable USB flash drive

When used in connection with an Automation PC 620 / Panel PC 700, it is possible to boot the system from one of the flash drives available from B&R. The flash drive must be specially prepared for this.

6.5.1 Requirements

The following peripherals are required for creating a bootable flash drive:

- B&R USB flash drive (see model numbers for USB flash drives in chapter 1, section 5.7)
- Automation PC 620 or Panel PC 700
- USB floppy drive (external or slide-in USB floppy 5AC600.FDDS-00)
- PS/2 or USB keyboard
- A start disk created using MS-DOS 6.22 or Windows 98 - 1.44MB HDD (Windows Millennium, NT4.0, 2000, XP start disks cannot be used).
The tools "format.com" and "fdisk.exe" must be located on the diskette!

6.5.2 Procedure

- Plug in the flash drive and boot from the start disk.
- Set active partition on the flash drive using "fdisk" and follow the further instructions.
- Reboot the system from the start disk.
- Format and simultaneously transfer the system files to the flash drive with the command "format c: /s".

7. Null modem cable 9A0017.0x

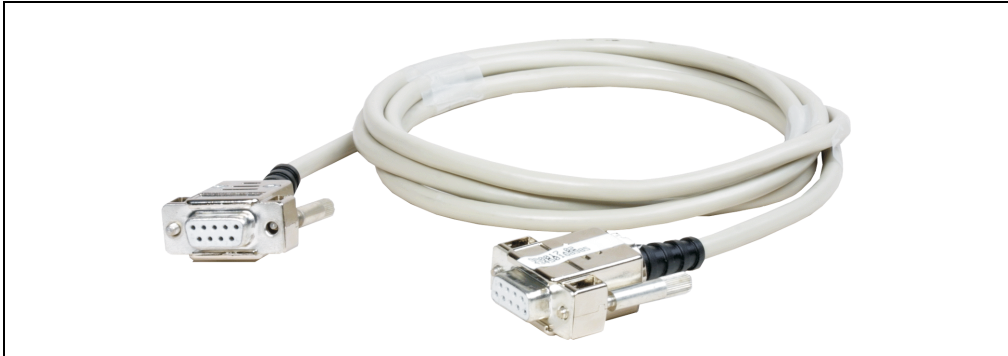


Figure 213: Null modem cable 9A0017.0x

7.1 Order data

Model number	Description	Note
9A0017.01	RS232 DB9 null modem cable 0.6 m Null modem cable RS232 0.6 m to connect UPS and IPC (9-pin DSUB socket - 9-pin DSUB socket).	
9A0017.02	RS232 DB9 null modem cable 1.8 m Null modem cable RS232 1.8 m to connect UPS and IPC (9-pin DSUB socket - 9-pin DSUB socket).	

Table 189: Model numbers - USB cables

7.2 Technical data

Features	9A0017.01	9A0017.02
Length	0,6 m ± 10 mm	1,8 m ± 30 mm
Outer diameter	Max. 5 mm	
Shielding	Entire cable	
Connector type	2 9-pin DSUB sockets - female	
Wire cross section	AWG 22,	
Flexibility	Flexible	
Flex radius	Min. 100 mm	

Table 190: Technical data - Null modem cable

7.3 Cable specifications

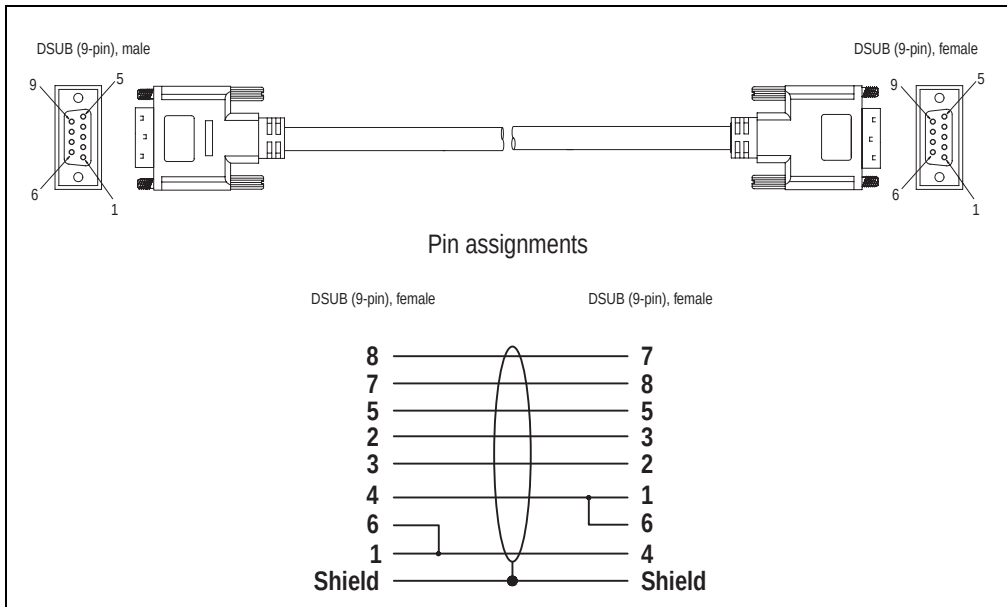


Figure 214: Pin assignments - null modem cable

Chapter 7 • Maintenance / Servicing

1. Cleaning

Danger!

Power Panel devices may only be cleaned when switched off. This is to prevent unintended functions from being triggered when touching the touch screen or pressing the buttons.

A moist towel should be used to clean the Power Panel device. When moistening the cloth, use only water with detergent, screen cleaning agent, or alcohol (ethanol). The cleaning agent should be applied to the cloth beforehand, not sprayed directly on the Power Panel device! Never use aggressive solvents, chemicals, scouring agents, pressurized air or steam jet.

Information:

Displays with touch screens should be cleaned at regular intervals.

2. Changing the battery

2.1 General Information

The battery guarantees buffering of the internal real-time clock (RTC), SRAM data, and individually saved BIOS settings. The buffer duration of the battery is 4 years in devices without SRAM (at 50°C, 8.5 µA of the supplied components and a self discharge of 40%) and at least 3 years in devices with SRAM (at 50°C, 18.5 µA of the supplied components and a self discharge of 40%).

Changing the battery is only necessary for devices with a lithium battery (see section "Technical data" on page 29 for Power Panel devices).

Battery check

The battery status (good or bad) is checked every time the device is turned on, as well as every 24 hours. The check involves applying a load to the battery for a short time (approx. 1 second), followed by an evaluation. The evaluated battery status is displayed in the BIOS Setup pages and in the B&R Control Center (ADI driver), but can also be read in a customer application via the ADI Library.

Battery status	Meaning
OK	Data buffering is guaranteed
Bad	Data buffering is guaranteed for approx. another 500 hours from the point in time that the battery capacity is determined to be BAD (insufficient).

Table 191: Meaning of battery status OK - Bad

From the point when battery capacity is recognized as insufficient, data buffering is guaranteed for approximately another 500 hours.

Information:

The battery should only be changed by qualified personnel.

Technical data

See section 2 "Replacement CMOS batteries" on page 339.

2.2 Procedure for changing the battery

- Disconnect the power supply to the Power Panel
- Touch the housing or ground connection (not the power supply!) in order to discharge any electrostatic charge from your body.
- Remove the battery cover: The battery cover is found on the rear side of the Power Panel device.

0 aPCI slot Power Panel devices	1 or 2 aPCI slot Power Panel devices
	

Table 192: Changing the battery

- Carefully remove the used battery from the holder by pulling the removal strip.
- Do not touch the new battery with pliers or uninsulated tweezers -> risk of short circuiting. The battery should not be held by its edges.

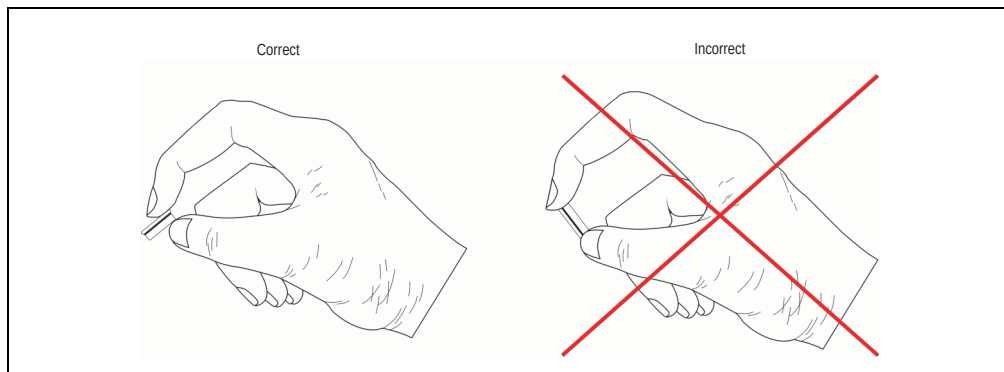


Figure 215: Battery handling

- Insert the new battery with correct polarity. The correct positioning of the removal strip must be taken into consideration.
- Put on the battery cover and fasten the screws.
- Reconnect the power supply to the Power Panel.
- The data and time in BIOS may have to be set again (see section "Power Panel 300 with BIOS" on page 247).

Warning!

Lithium batteries are considered hazardous waste. Used batteries should be disposed of accordingly.

3. Preventing after-image effect in LCD/TFT monitors

After-image effect (after images, display memory effect, image retention or also image sticking) occurs in LCD/TFT monitors when a static image is displayed for a long period of time. This static screen content causes the build-up of parasitic capacities within the LCD components that prevent the liquid crystal molecules from returning to their original states. This condition may arise, is not predictable and depends on the following factors:

- Type of image displayed
- Color composition of the image
- Length of image output
- Ambient temperature

3.1 What measures can be taken against this?

There is no total solution, however, measures can be taken to significantly reduce this effect:

- Avoid static pictures or screen content
- Use screen savers (moving) when the display is not in use
- Frequent picture change
- Shut off the display when not in use

Turning off the background lighting (backlight) does not influence the prevention of the after-image effect.

Appendix A

1. Touch screen

1.1 Elo Accu Touch

Information:

The following characteristics, features, and limit values only apply to this individual component and can deviate from those for the entire device. For the entire device in which this individual component is used, refer to the data given specifically for the entire device.

Elo Accu touch screen	Specifications
Manufacturer	Elo
Accuracy For < 18" diagonals For > 18" diagonals	Typically < 0.080 inches (2.032 mm) Maximum error in all directions 0,180 inches (4.752 mm) Maximum 1% of the diagonal for the active area of the touch screens
Response time	< 10 ms
Release pressure	< 113 grams
Resolution	4096 x 4096 touch points
Light permeability	Up to 80% ± 5%
Temperature Operation Storage Transport	- 10°C to + 50°C - 40°C to + 71°C - 40°C to + 71°C
Relative humidity Operation Storage Transport	Max. 90% at max. 35°C Max. 90% at max. 35°C for 240 hours, non-condensing Max. 90% at max. 35°C for 240 hours, non-condensing
Waterproofing	IP65
Lifespan	35 million contacts on the same point
Chemical resistance ¹⁾	Acetone, ammonia-based glass cleaner, normal food and drinks, hexane, methylene chloride, methyl ethyl ketone, mineral spirits, turpentine, isopropyl alcohol
Activation	Finger, pointer, credit card, glove

Table 193: Technical data - Elo Accu touch screen 5-wire

1) The active area of the touch screen is resistant to these chemicals for a timeframe of one hour at 21°C.

1.1.1 Temperature humidity diagram - Operation and storage

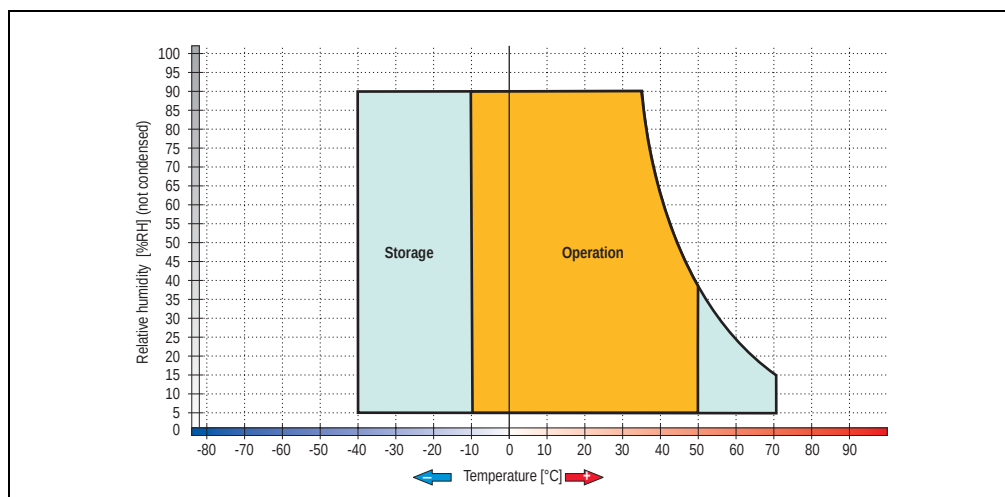


Figure 216: Temperature humidity diagram - Elo Accu touch screen

Temperature data is for operation at 500 meters. Derating the max. ambient temperature - typically 1 °C per 1000 meters (from 500 meters above sea level).

1.1.2 Cleaning

The touch screen should be cleaned with a moist lint-free cloth. When moistening the cloth, use only water with detergent, screen cleaning agent, or alcohol (ethanol). The cleaning agent should be applied to the cloth beforehand and not sprayed directly onto the touch screen itself. Never use aggressive solvents, chemicals, scouring agents, pressurized air or steam jet.

2. Mylar

The Mylar conforms to DIN 42115 (section 2). This means it is resistant to exposure to the following chemicals for a 24-hour period with no visible signs of damage:

Information:

The following characteristics, features, and limit values only apply to this individual component and can deviate from those for the entire device. For the entire device in which this individual component is used, refer to the data given specifically for the entire device.

Ethanol Cyclohexanol Diacetone alcohol Glycol Isopropanol Glycerine Methanol Triacetin Dowandol DRM/PM	Formaldehyde 37%-42% Acetaldehyde Aliphatic hydrocarbons Toluene Xylene White spirits	1.1.1. Trichloroethane Ethyl acetate Diethyl ether N-Butyl acetate Amyl acetate Butylcellosolve Ether
Acetone Methyl ethyl ketone Dioxan Cyclohexanone MIBK Isophorone	Formic acid <50% Acetic acid <50% Phosphoric acid <30% Hydrochloric acid <36% Nitric acid <10% Trichloroacetic acid <50% Sulphuric acid <10%	Sodium hypochlorite <20% Hydrogen peroxide <25% Potassium carbonate Washing agents Fabric conditioner Ferric chloride Ferrous chloride (FeCl ₂) Ferrous chloride (FeCl ₃) Dibutyl phthalate Diocetyl phthalate Sodium carbonate
Ammonia <40% Caustic soda <40% Potassium hydroxide Alkali carbonate Bichromate Potassium Acetonitrile Sodium bisulphate	Cutting oil Diesel oil Linseed oil Paraffin oil Blown castor oil Silicon oil Turpentine oil substitute Universal brake fluid Aviation fuel Petrol Water Sea water Decon	

Table 194: Chemical resistance of the mylar

The Mylar conforms to DIN 42115 section 2 for exposure to glacial acetic acid for less than one hour without visible damage.

3. Perspectives

The perspectives can be seen in the technical data for the individual components.

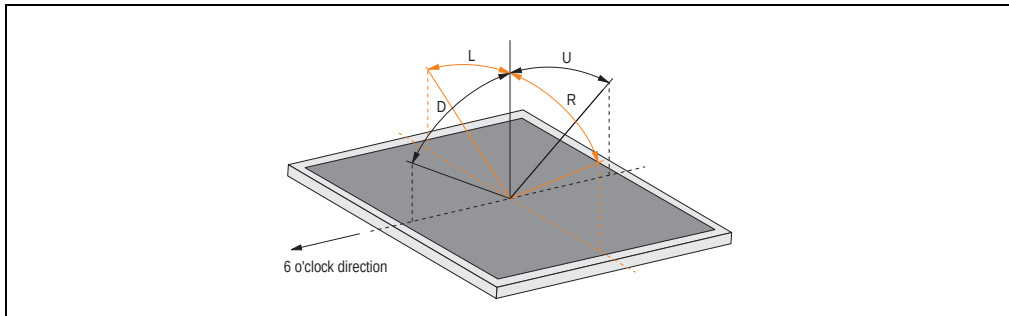


Figure 217: Viewing angles

4. Mounting compatibilities

This section describes the compatibility of the installation dimensions for the Power Panel 100/200, Power Panel 300/400, Automation Panel 900 and Panel PC 700 units according to the respective device diagonals.

The outer dimensions of the device types are identical for the respective diagonals.
The different device types are abbreviated as follows:

Device type	Abbreviation
Power Panel 100/200	PP100/200
Power Panel 300/400	PP300/400
Automation Panel 900	AP900
Panel PC 700	PPC700

Table 195: Product abbreviations

4.1 Compatibility overview

The following table offers a brief overview of the devices PP100/200, PP300/400, AP900 and PPC700. Detailed information can be found in the section "Compatibility details" on page 373.

Compatibility between the device types is represented on each line by matching symbols.

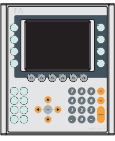
Size	Format	Image	Compatible	PP100/200	PP300/400	AP900	PPC700
5.7"	Horizontal1		Outer dimensions	■	■	-	-
			Installation dimensions	●	●	-	-
	Horizontal2		Outer dimensions	■	■	-	-
			Installation dimensions	●	●	-	-
	Vertical1		Outer dimensions	■	■	-	-
			Installation dimensions	●	●	-	-

Table 196: Device compatibility overview

Appendix A • Mounting compatibilities

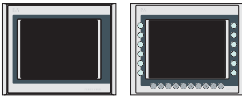
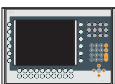
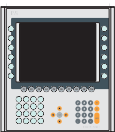
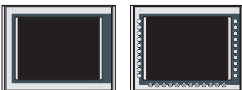
Size	Format	Image	Compatible	PP100/200	PP300/400	AP900	PPC700
10.4"	Horizontal1		Outer dimensions	■	■	■	■
			Installation dimensions	●	●	●	●
	Horizontal2		Outer dimensions	■	■	■	■
			Installation dimensions	●	●	▲	▲
	Vertical1		Outer dimensions	■	■	■	■
			Installation dimensions	●	●	▲	▲
12.1"	Horizontal1		Outer dimensions	■	■	■	■
			Installation dimensions	●	●	▲	▲
15"	Horizontal1		Outer dimensions	■	■	■	■
			Installation dimensions	●	●	●	●
	Vertical1		Outer dimensions	■	■	■	■
			Installation dimensions	●	●	●	●

Table 196: Device compatibility overview

4.2 Compatibility details

The measurement values (all in mm) in the following figures have the following meaning.

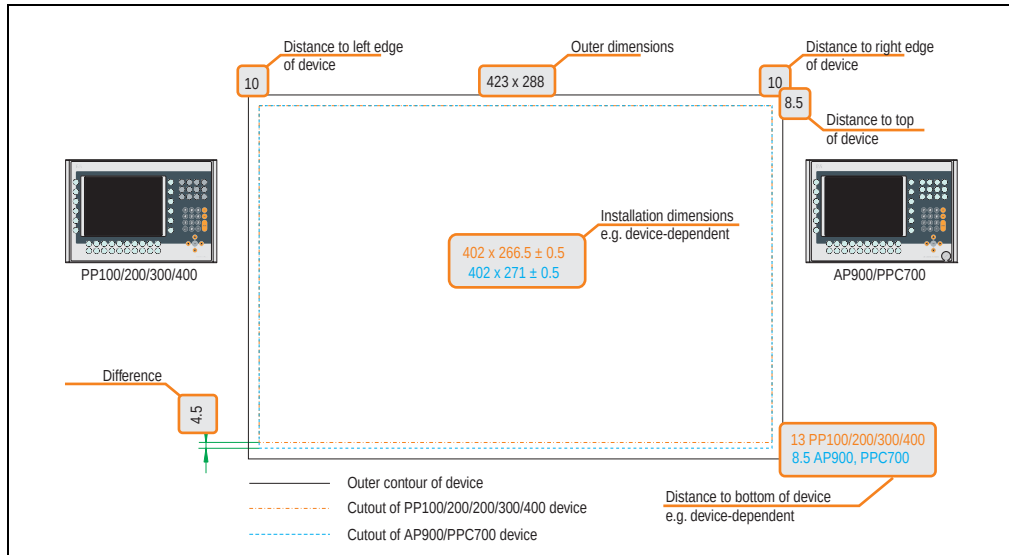


Figure 218: Compatibility details - figure structure

4.2.1 5.7" devices

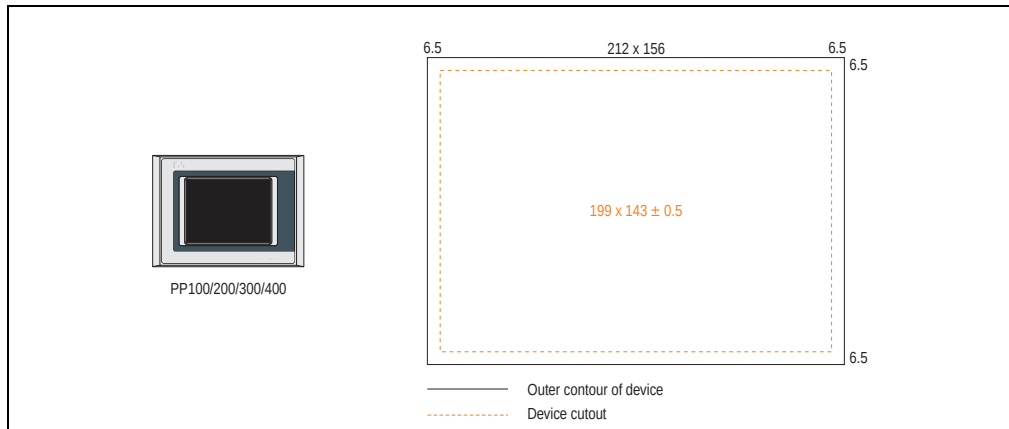


Figure 219: Mounting compatibility - 5.7" device format - Horizontal1

5.7" Power Panel 100/200 and Power Panel 300/400 devices in **Horizontal1** format are 100% mounting compatible.

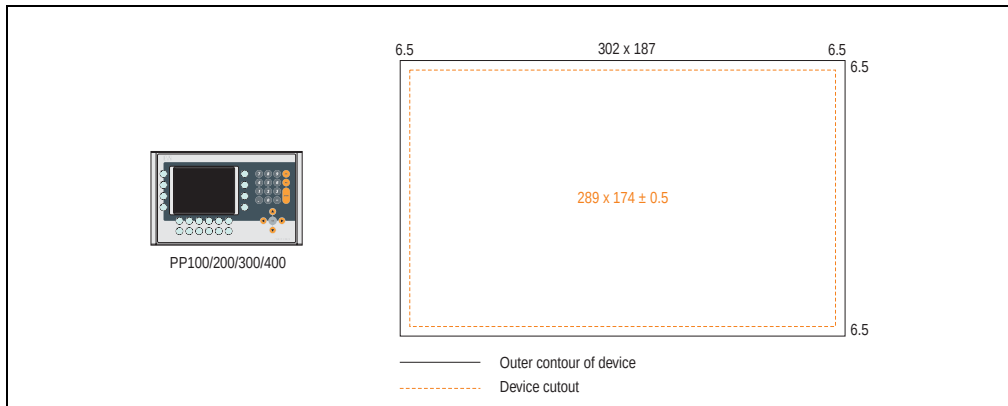


Figure 220: Mounting compatibility - 5.7" device format - Horizontal2

5.7" Power Panel 100/200 and Power Panel 300/400 devices in **Vertical1** format are 100% mounting compatible.

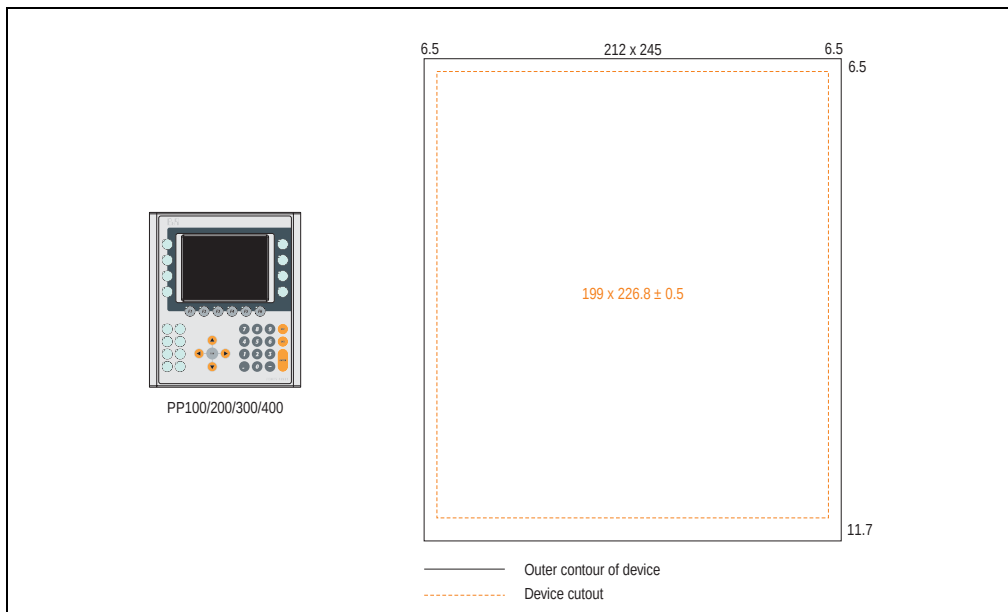


Figure 221: Mounting compatibility - 5.7" device format - Vertical1

5.7" Power Panel 100/200 and Power Panel 300/400 devices in **Vertical1** format are 100% mounting compatible.

4.2.2 10.4" devices

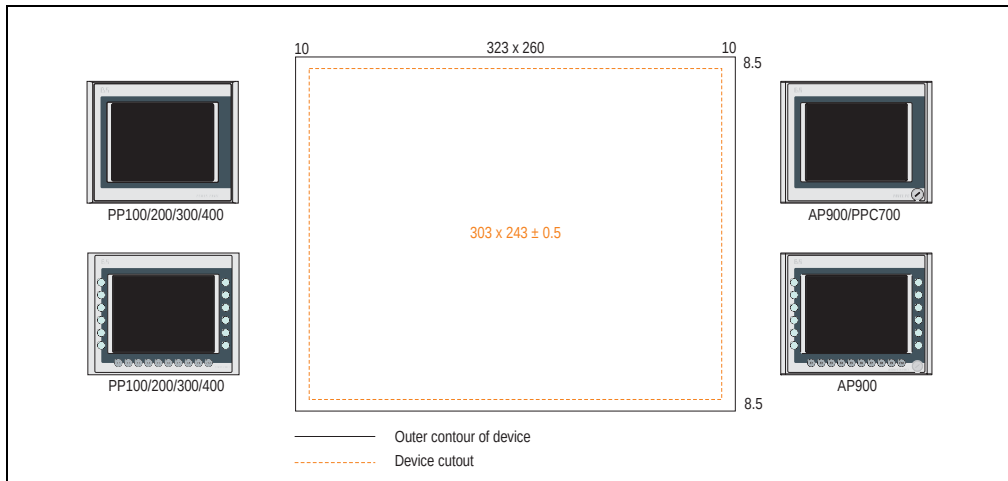


Figure 222: Mounting compatibility - 10.4" device format - Horizontal1

10.4" Power Panel 100/200, Power Panel 300/400, Automation Panel 900 and Panel PC 700 devices in **Horizontal1** format are 100% mounting compatible.

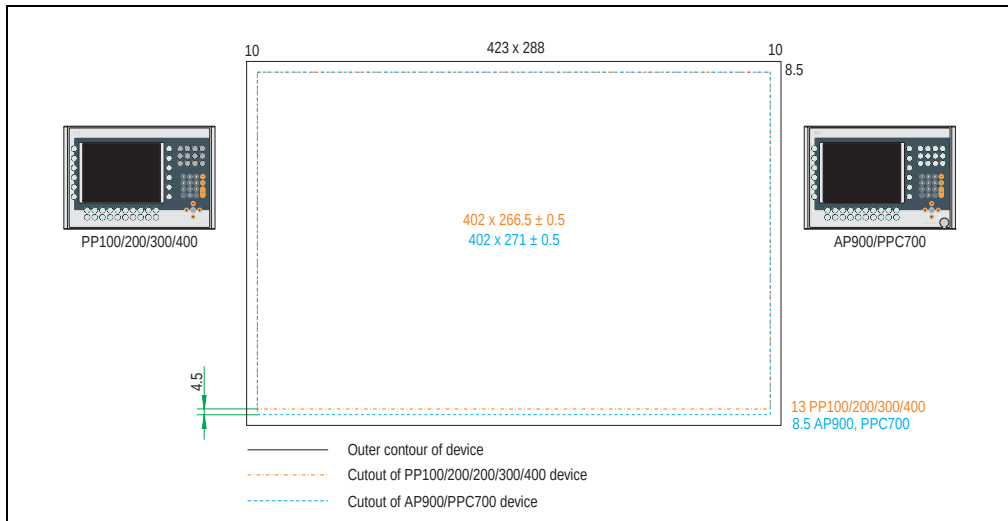


Figure 223: Mounting compatibility - 10.4" device format - Horizontal2

10.4" Power Panel 100/200 and Power Panel 300/400 are not 100% mounting compatible with the **Horizontal2** format Automation Panel 900 and Panel PC 700 devices. The Automation Panel 900 and Panel PC 700 devices require a cutout that is 4.5 mm larger vertically (lower edge).

The larger cutout can be conditionally used for all devices:

- When mounting, make sure that the PP100/200/300/400 devices are placed and mounted as close to the center of the cutout as possible. Failure to do so can prevent the retaining clips from holding firmly, which means that a firm seal is no longer guaranteed with the gasket (IP65).

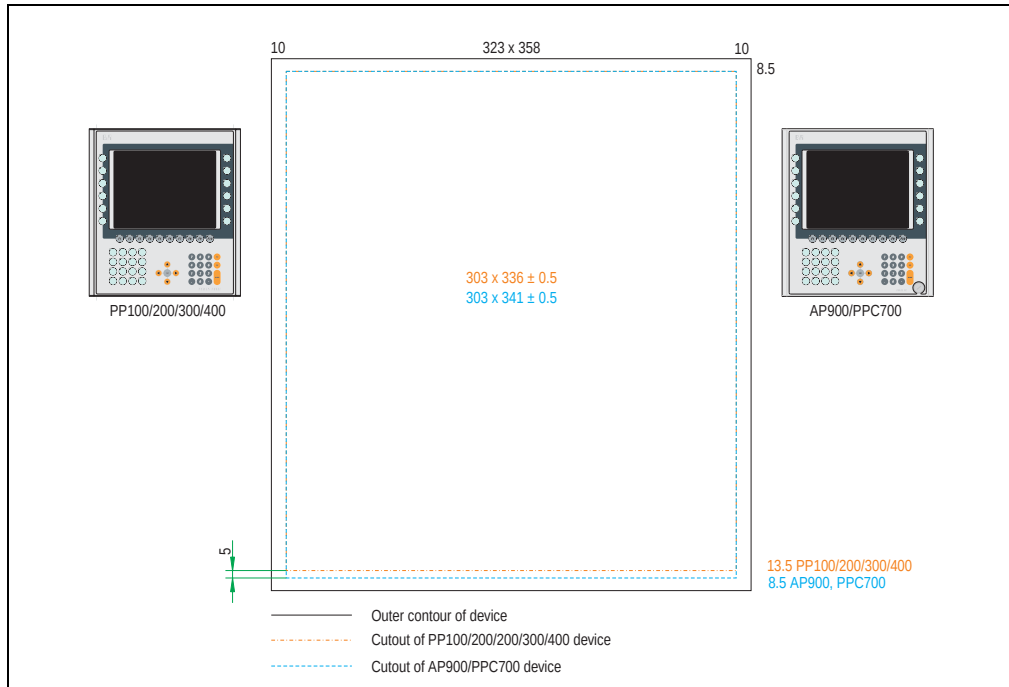


Figure 224: Mounting compatibility - 10.4" device format - Vertical1

10.4" Power Panel 100/200 and Power Panel 300/400 are not 100% mounting compatible with the **Vertical1** format for the Automation Panel 900 and Panel PC 700 devices. The Automation Panel 900 and Panel PC 700 devices require a cutout that is 5 mm larger vertically (lower edge).

The larger cutout can be conditionally used for all devices:

- When mounting, make sure that the PP100/200/300/400 devices are placed and mounted as close to the center of the cutout as possible. Failure to do so can prevent the retaining clips from holding firmly, which means that a firm seal is no longer guaranteed with the gasket (IP65).

4.2.3 12.1" devices

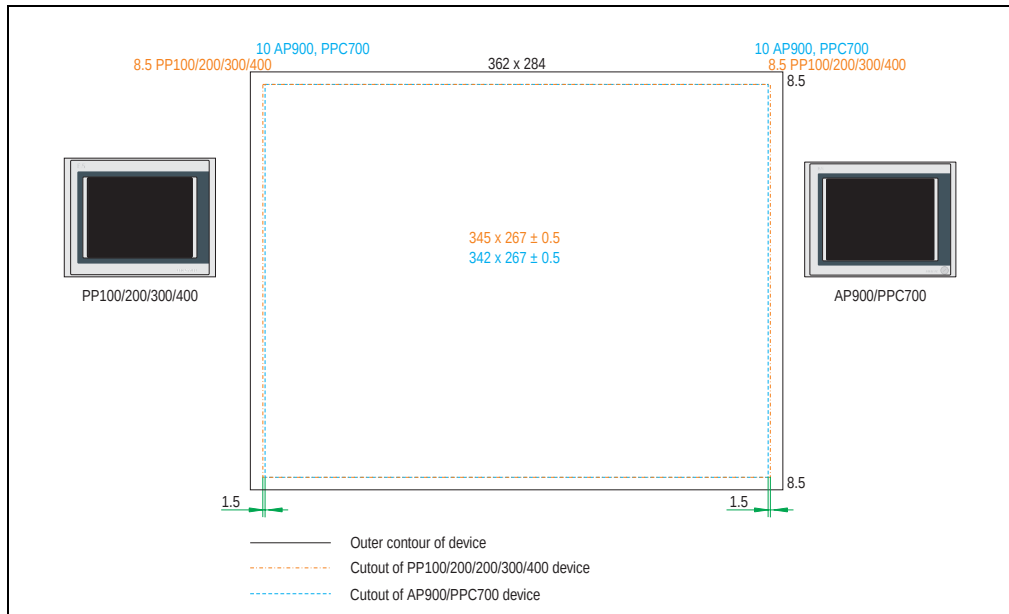


Figure 225: Mounting compatibility - 12.1" device format - Horizontal1

12.1" Power Panel 100/200 and Power Panel 300/400 are *not 100% mounting compatible* with the **Horizontal1** format for the Automation Panel 900 and Panel PC 700 devices. The Power Panel 100/200 and Power Panel 300/400 devices require a cut that is 1.5 mm wider (left and right).

The larger cutout can be conditionally used for all devices:

- When mounting, make sure that the AP900 and PPC700 devices can be placed and mounted as close to the center of the cutout as possible.

4.2.4 15" devices

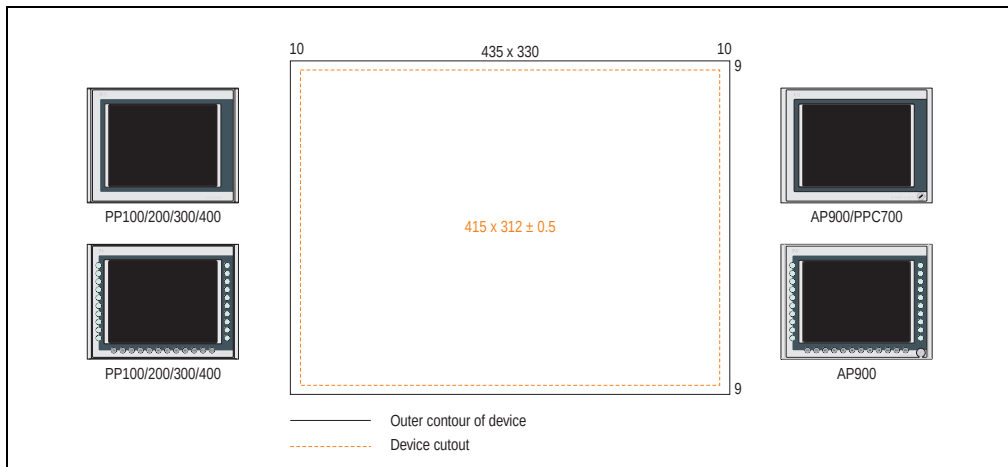


Figure 226: Mounting compatibility - 15" device format - Horizontal1

15" Power Panel 100/200, Power Panel 300/400, Automation Panel 900 and Panel PC 700 devices in **Horizontal1** format are 100% mounting compatible.

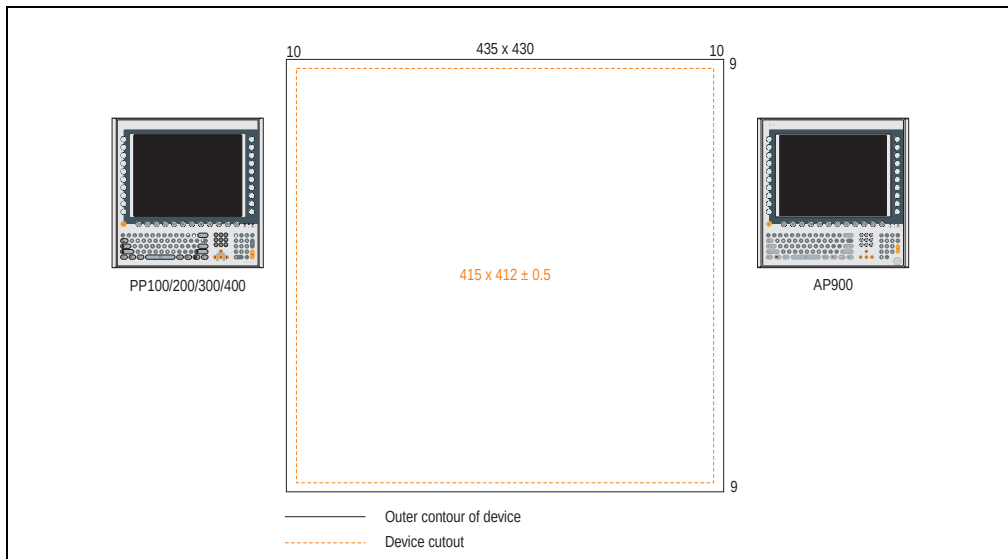


Figure 227: Mounting compatibility - 15" device format - Vertical1

15" Power Panel 100/200, Power Panel 300/400, Automation Panel 900 and Panel PC 700 devices in **Vertical1** format are 100% mounting compatible.

5. Glossary

A

ACPI

Abbreviation for "**A**dvanced **C**onfiguration and **P**ower **I**nterface". Configuration interface that enables the operating system to control the power supply for each device connected to the PC. With ACPI, the computer's BIOS is only responsible for the details of communication with the hardware.

Automation Runtime

A uniform runtime system for all B&R automation components.

B

BIOS

An abbreviation for "**B**asic **I**nterface **O**utput **S**ystem". Core software for computer systems with essential routines for controlling input and output processes on hardware components, for performing tests after system start, and for loading the operating system. Although BIOS is used to configure a system's performance, the user does not usually come into contact with it.

Bit

Binary digit > binary position, binary character, smallest discrete unit of information. A bit can have the value 0 or 1.

Bit rate

The number of bits that can be transferred within a specified time unit. 1 bit/sec = 1 baud.

Bootstrap loader

A program that automatically runs when the computer is switched on or restarted. After some basic hardware tests have been carried out, the bootstrap loader starts a larger loader and hands over control to it, which in turn boots the operating system. The bootstrap loader is typically found in ROM on the computer.

Byte

Data format [1 byte = 8 bits] and a unit for characterizing information amounts and memory capacity. The following units are the commonly used units of progression: KB, MB, GB.

B&R Automation Runtime

Windows-based program for creating installation disks to install B&R Automation Runtime™ on the target system.

C**Cache**

Background memory, also known as non-addressable memory or fast buffer memory. It is used to relieve the fast main memory of a computer. For example, data that should be output to slower components by the working memory (e.g. disk storage, printers) is stored temporarily in cache memory and output from there at an appropriate speed for the target devices.

CE mark

A CE mark for a product. It consists of the letters "CE" and indicates conformity to all EU guidelines for the labeled product. It indicates that the individual or corporate body who has performed or attached the label assures that the product conforms to all EU guidelines for complete harmonization. It also indicates that all mandatory conformity evaluation procedures have taken place.

CMOS

"CMOS" is a battery powered memory area where fundamental parameters of an IBM (or compatible) personal computer are stored. Information such as the type of hard drive, size of the working memory and the current date and time are required when booting the computer. As the name suggests, the memory is based on CMOS technology standards.

COM

A device name used to access serial ports in MS-DOS. The first serial port can be accessed under COM1, the second under COM2, etc. A modem, mouse, or serial printer is typically connected to a serial port.

CompactFlash®

CompactFlash memory cards [CF cards] are removable, nonvolatile mass storage systems with very small dimensions [43 x 36 x 3.3 mm, approximately half the size of a credit card]. In addition to the flash memory chips, the controller is also present on the cards. CF cards provide complete PC card / ATA functionality and compatibility. A 50-pin CF card can be simply inserted in a passive 68-pin type II adapter card. It conforms to all electrical and mechanical PC card interface specifications. CF cards were launched by SanDisk back in 1994. Currently, memory capacities reach up to 8 GB per unit. Since 1995, CompactFlash Association [CFA] has been looking after standardization and the worldwide distribution of CF technology.

Controller

A device component which allows access to other devices on a computer subsystem. A disk controller, for example, allows access to hard disks and disk drives and is responsible both for physical and logic drive access.

CPU

An abbreviation for "**C**entral **P**rocessing **U**nit". Interprets and executes commands. It is also known as a "microprocessor" or "processor" for short. A processor is able to receive, decode and execute commands, as well as transfer information to and from other resources via the computer bus.

CTS

An abbreviation for "**C**lear **T**o **S**end". A signal used when transferring serial data from modem to computer, indicating its readiness to send the data. CTS is a hardware signal which is transferred via line number 5 in compliance with the RS-232-C standard.

D

DCD

An abbreviation for "**D**ata **C**arrier **D**etected". A signal used in serial communication that is sent by the modem to the computer it is connected to, indicating that it is ready for transfer.

DDR SDRAM

Abbreviation for "**D**ouble **D**ata **R**ate **S**ynchronous **D**ynamic **R**andom **A**ccess **M**emory".

DMA

Direct **M**emory **A**ccess >. Accelerated direct access to a computer's RAM by bypassing the CPU.

DRAM

An abbreviation for "**D**ynamic **R**andom **A**ccess **M**emory". Dynamic RAM consists of an integrated semiconductor circuit that stores information based on the capacitor principle. Capacitors lose their charge in a relatively short time. Therefore, dynamic RAM circuit boards must contain a logic that allows continual recharging of RAM chips. Since the processor cannot access dynamic RAM while it is being recharged, one or more waiting states can occur when reading or writing data. Although it is slower, dynamic RAM is used more often than static RAM since the simple design of the circuits means that it can store four times more data than static RAM.

DSR

An abbreviation for "**D**ata **S**et **R**eady". A signal used in serial data transfer that is sent by the modem to the computer it is connected to, indicating its readiness for processing. DSR is a hardware signal which is sent via line number 6 in compliance with the RS-232-C standard.

DTR

An abbreviation for "**Data Terminal Ready**". A signal used in serial data transfer that is sent by the computer to the modem it is connected to, indicating the computer's readiness to accept incoming signals.

E

EDID data

Abbreviation for "**Extended Display Identification Data**". EDID data contains the characteristics of monitors / TFT displays transferred as 128 KB data blocks to the graphics card via the Display Data Channel (DDC). This EDID data can be used to set the graphics card to the monitor properties.

EMC

"**Electromagnetic Compatibility**". The ability of a device or a system to function satisfactorily in its electromagnetic environment without introducing intolerable electromagnetic disturbances to anything in that environment [IEV 161-01-07].

Encode, encoding

When processing information, it is often necessary to change the information from one form of representation to another. This conversion process is called encoding, and the rules used to assign one character set to another are referred to as encoding rules. A differentiation is made between ambiguous and unambiguous encoding depending on if one set is a direct reflection of the other. Most codes use unambiguous encoding with one set directly reflecting the other. A differentiation is also made between redundant and non-redundant encoding. With non-redundant encoding, the full range of the available character set is used, i.e. each code is defined. With redundant encoding, the available character set also contains codes that are not used. This differentiation is important during data transfer when detecting and, if necessary, correcting data transfer errors.

EPROM

Erasable PROM >(completely with ultraviolet light).

Ethernet

An IEEE 802.3 standard for networks. Ethernet uses bus or star topology and controls the traffic on communication lines using the access procedure CSMA/CD (Carrier Sense Multiple Access with Collision Detection). Network nodes are connected using coaxial cables, fiber optic cables or twisted pair cabling. Data transfer on an Ethernet network takes place in frames of variable lengths that consist of supply and controller information as well as 1500 bytes of data. The Ethernet standard provides base band transfers at 10 megabit and 100 megabit per second.

F**FIFO**

An abbreviation for "**F**irst **I**n **F**irst **O**ut". A queuing organization method whereby elements are removed in the same order as they were inserted. The first element inserted is the first one removed. Such an organization method is typical for a list of documents that are waiting to be printed.

Firmware

Programs stored permanently in read-only memory. Firmware is software used to operate computer-controlled devices that generally stays in the device throughout its lifespan or over a long period of time. Such software includes operating systems for CPUs and application programs for industrial PCs as well as programmable logic controllers (e.g. the software in a washing machine controller). This software is written in read-only memory (ROM, PROM, EPROM) and cannot be easily replaced.

G**GB**

Gigabyte (1 GB = 230 or 1,073,741,824 bytes)

H**Handshake**

Method of synchronization for data transfer when data is sent at irregular intervals. The sender signals that data can be sent, and the receiver signals when new data can be received.

I**IDE**

An abbreviation for "**I**ntegrated **D**rive **E**lectronics". A drive interface where the controller electronics are integrated in the drive.

Interface

From the hardware point of view, an interface is the connection point between two modules/devices/systems. The units on both sides of the interface are connected by the interface lines so that data, addresses, and control signals can be exchanged. The term interface includes all functional, electrical and constructive conditions [encoding, signal level, pin assignments] that characterize the connection point between the modules, devices, or systems. Depending on the type of data transfer, a differentiation is made between parallel [e.g. Centronics, IEEE 488] and serial interfaces [e.g. V.24, TTY, RS232, RS422, RS485], which are set up for different transfer speeds and transfer distances. From the point of view of software, the term "interface" describes the transfer point between program modules using specified rules for transferring the program data.

ISO

International Organization for Standardization > Worldwide federation of national standardization institutions from over 130 countries. ISO is not an acronym for the name of the organization; it is derived from the Greek word "isos", meaning "equal" (www.iso.ch).

L

LCD

An abbreviation for "**L**iquid **C**rystal **D**isplay". A display type, based on liquid crystals that have a polarized molecular structure and are enclosed between two transparent electrodes as a thin layer. If an electrical field is applied to the electrodes, the molecules align themselves with the field and form crystalline arrangements that polarize the light passing through. A polarization filter, which is arranged using lamellar electrodes, blocks the polarized light. In this way, a cell (pixel) containing liquid crystals can be switched on using electrode gates, thus coloring this pixel black. Some LCD displays have an electroluminescent plate behind the LCD screen for lighting. Other types of LCD displays can use color.

LED

An abbreviation for "**L**ight **E**mitting **D**iode". A semiconductor diode which converts electrical energy into light. LEDs work on the principle of electroluminescence. They are highly efficient because they do not produce much heat in spite of the amount of light they emit. For example, "operational status indicators" on floppy disk drives are LEDs.

M

MB

Megabyte (1 MB = 220 or 1,048,576 bytes).

Microprocessor

Highly integrated circuit with the functionality of a CPU, normally housed on a single chip. It comprises a control unit, arithmetic and logic unit, several registers and a link system for connecting memory and peripheral components. The main performance features are the internal and external data bus and address bus widths, the command set and the clock frequency. Additionally, a choice can be made between CISC and RISC processors. The first commercially available worldwide microprocessor was the Intel 4004. It came on the market in 1971.

MTBF

An abbreviation for "**M**ean **t**ime **b**etween **f**ailure". The average time which passes before a hardware component fails and repair is needed. This time is usually expressed in thousands or ten thousands of hours, sometimes known as power-on hours (POH).

Multitasking

Multitasking is an operating mode in an operating system that allows several computer tasks to be executed virtually simultaneously.

N**Node**

Branching point in a network.

P**PnP**

An abbreviation for "**Plug and Play**". Specifications developed by Intel. Using Plug and Play allows a PC to automatically configure itself so that it can communicate with peripheral devices (e.g. monitors, modems, and printers). Users can connect a peripheral device (plug) and it immediately runs (play) without having to manually configure the system. A Plug and Play PC requires a BIOS that supports Plug and Play and a respective expansion card.

POH

An abbreviation for "**Power On Hours**". See MTBF.

POST

An abbreviation for "**Power-On Self Test**". A set of routines that are stored in ROM on the computer and that test different system components, e.g. RAM, disk drive and the keyboard in order to determine that the connection is operating correctly and ready for operation. POST routines notify the user of problems that occur. This is done using several signal tones or by displaying a message that frequently accompanies a diagnosis value on the standard output or standard error devices (generally the monitor). If the POST runs successfully, control is transferred over to the system's bootstrap loader.

Power Panel

Power Panel is part of the B&R product family and is a combination of an operator panel and controller in one device. This covers the PP21 and PP41 products.

Q**QVGA**

Abbreviation for **Quarter Video Graphics Array**. Usually a screen resolution of 320 × 240 pixels.

R**RAM**

An abbreviation for "**R**andom **A**ccess **M**emory". Semiconductor memory which can be read or written to by the microprocessor or other hardware components. Memory locations can be accessed in any order. The various ROM memory types do allow random access, but they cannot be written to. The term RAM refers to a more temporary memory that can be written to as well as read.

ROM

An abbreviation for "**Read-Only Memory**". Semiconductor memory where programs or data were permanently stored during the production process.

RS232

Recommended Standard Number 232. Oldest and most widespread interface standard, also called a V.24 interface. All signals are referenced to ground making this an unbalanced interface. High level: -3 ... -30 V, low level: +3 ... +30 V. Cable lengths up to 15 m, transfer rates up to 20 kBit/s. For point-to-point connections between 2 participants.

RTS

An abbreviation for "**Request To Send**". A signal used in serial data transfer for requesting send permission. For example, it is sent from a computer to the modem connected to it. The RTS signal is assigned to pin 4 according to the hardware specifications of the RS-232-C standard.

RXD

An abbreviation for "**Receive (RX) Data**". A line for transferring serial data received from one device to another, e.g. from a modem to a computer. For connections complying with the RS-232-C standard, the RXD is connected to pin 3 of the plug.

S

SDRAM

An abbreviation for "**Synchronous Dynamic Random Access Memory**". A construction of dynamic semiconductor components (DRAM) that can operate with higher clock rates than conventional DRAM switching circuits. This is made possible using block access. For each access, the DRAM determines the next memory addresses to be accessed.

SRAM

An abbreviation for "**Static Random Access Memory**". A semiconductor memory (RAM) made up of certain logic circuits (flip-flop) that only keeps stored information while powered. In computers, static RAM is generally only used for cache memory.

SVGA

Abbreviation for »**Super Video Graphics Array**«; Graphics standard with a resolution of at least 800×600 pixels and at least 256 colors.

T

TCP/IP

Transmission Control Protocol/Internet Suit of Protocols. Network protocol that has become the generally accepted standard for data exchange in heterogeneous networks. TCP/IP is used both in local networks for communication between various computer and also for LAN to WAN access.

TFT display

LCD (Liquid Crystal Display) technology where the display consists of a large grid of LCD cells. Each pixel is represented by a cell, whereby electrical fields produced in the cells are supported by thin film transistors (TFT) that result in an active matrix. In its simplest form, there is exactly one thin film transistor per cell. Displays with an active matrix are generally used in laptops and notebooks because they are thin, offer high-quality color displays and can be viewed from all angles.

Touch screen

Screen with touch sensors for activating an item with the finger.

TXD

An abbreviation for "**Transmit (TX) Data**". A line for the transfer of serial data sent from one device to another, e.g. from a computer to a modem. For connections complying with the RS-232-C standard, the TXD is connected to pin 2 of the plug.

U**UART**

An abbreviation for "**Universal Asynchronous Receiver-Transmitter**". A module generally consisting of a single integrated circuit that combines the circuits required for asynchronous serial communication for both sending and receiving. UART represents the most common type of circuit in modems for connecting to a personal computer.

UDMA

An abbreviation for "**Ultra Direct Memory Access**". A special IDE data transfer mode that allows high data transfer rates for drives. There have been many variations in recent times.

UDMA33 mode transfers 33 megabytes per second.

UDMA66 mode transfers 66 megabytes per second.

UDMA100 mode transfers 100 megabytes per second.

Both the mainboard and the hard drive must support the specification to implement modifications.

USB

An abbreviation for "**Universal Serial Bus**". A serial bus with a bandwidth of up to 12 megabits per second (Mbit/s) for connecting a peripheral device to a microcomputer. Up to 127 devices can be connected to the system using a single multipurpose connection, the USB bus (e.g. external CD drives, printers, modems as well as the mouse and keyboard). This is done by connecting the devices in a row. USB allows devices to be changed when the power supply is switched on (hot plugging) and multi-layered data flow.

V

VGA

An abbreviation for "**V**ideo **G**raphics **A**dapter". A video adapter which can handle all EGA (Enhanced Graphics Adapter) video modes and adds several new modes.

Visual Components

Integrated in B&R Automation Studio. Visual Components can be used to configure visualization projects that use text and graphics.

W

Windows CE

Compact 32-bit operating system with multitasking and multithreading that Microsoft developed especially for the OEM market. It can be ported for various processor types and has a high degree of real-time capability. The development environment uses proven, well-established development tools. It is an open and scalable Windows operating system platform for many different devices. Examples of such devices are handheld PCs, digital wireless receivers, intelligent mobile phones, multimedia consoles, etc. In embedded systems, Windows CE is also an excellent choice for automation technology.

X

XGA

An abbreviation for "**EX**tended **G**raphics **A**rray". An expanded standard for graphics controllers and monitors that was introduced by IBM in 1990. This standard supports 640x480 resolution with 65,536 colors or 1024x768 resolution with 256 colors. This standard is generally used in workstation systems.

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